

## PIC16C5X

### EPROM/ROM-Based 8-Bit CMOS Microcontroller Series

#### **Devices Included in this Data Sheet:**

- PIC16C52
- PIC16C54s
- PIC16CR54s
- PIC16C55s
- PIC16C56s
- PIC16CR56s
- PIC16C57s
- PIC16CR57s
- PIC16C58s
- PIC16CR58s

Note: The letter "s" used following the part numbers throughout this document indicate plural, meaning there is more than one part variety for the indicated device.

### **High-Performance RISC CPU:**

- · Only 33 single word instructions to learn
- All instructions are single cycle (200 ns) except for program branches which are two-cycle
- Operating speed: DC 20 MHz clock input DC - 200 ns instruction cycle

| Device     | Pins | I/O | EPROM/<br>ROM | RAM |
|------------|------|-----|---------------|-----|
| PIC16C52   | 18   | 12  | 384           | 25  |
| PIC16C54   | 18   | 12  | 512           | 25  |
| PIC16C54A  | 18   | 12  | 512           | 25  |
| PIC16C54B  | 18   | 12  | 512           | 25  |
| PIC16CR54A | 18   | 12  | 512           | 25  |
| PIC16CR54B | 18   | 12  | 512           | 25  |
| PIC16C55   | 28   | 20  | 512           | 24  |
| PIC16C55A  | 28   | 20  | 512           | 24  |
| PIC16C56   | 18   | 12  | 1K            | 25  |
| PIC16C56A  | 18   | 12  | 1K            | 25  |
| PIC16CR56A | 18   | 12  | 1K            | 25  |
| PIC16C57   | 28   | 20  | 2K            | 72  |
| PIC16C57C  | 28   | 20  | 2K            | 72  |
| PIC16CR57B | 28   | 20  | 2K            | 72  |
| PIC16CR57C | 28   | 20  | 2K            | 72  |
| PIC16C58A  | 18   | 12  | 2K            | 73  |
| PIC16C58B  | 18   | 12  | 2K            | 73  |
| PIC16CR58A | 18   | 12  | 2K            | 73  |
| PIC16CR58B | 18   | 12  | 2K            | 73  |

- 12-bit wide instructions
- · 8-bit wide data path
- · Seven or eight special function hardware registers
- Two-level deep hardware stack
- Direct, indirect and relative addressing modes for data and instructions

### **Peripheral Features:**

- 8-bit real time clock/counter (TMR0) with 8-bit programmable prescaler
- · Power-On Reset (POR)
- Device Reset Timer (DRT)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Programmable code-protection
- · Power saving SLEEP mode
- Selectable oscillator options:
  - RC: Low-cost RC oscillator
- XT: Standard crystal/resonator
- HS: High-speed crystal/resonator
- LP: Power saving, low-frequency crystal

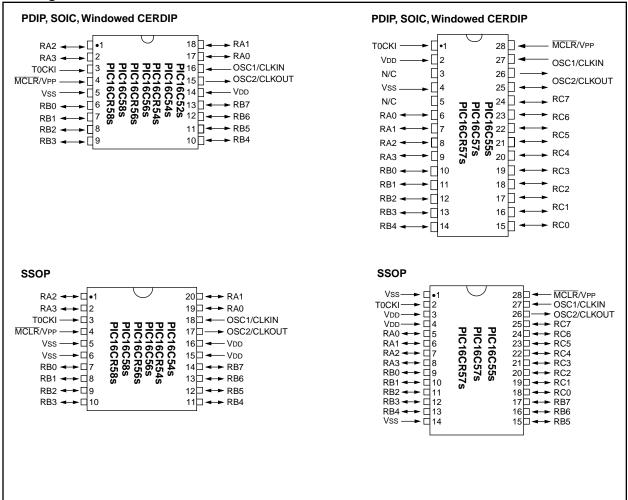
### **CMOS Technology:**

- Low-power, high-speed CMOS EPROM/ROM technology
- · Fully static design
- Wide-operating voltage and temperature range:
  - EPROM Commercial/Industrial 2.0V to 6.25V
  - ROM Commercial/Industrial 2.0V to 6.25V
  - EPROM Extended 2.5V to 6.0V
  - ROM Extended 2.5V to 6.0V
- · Low-power consumption
  - < 2 mA typical @ 5V, 4 MHz
  - 15 μA typical @ 3V, 32 kHz
  - < 0.6 μA typical standby current (with WDT disabled) @ 3V, 0°C to 70°C

Note: In this document, figure and table titles refer to all varieties of the part number indicated, (i.e., The title "Figure 14-1: Load Conditions - PIC16C54A", also refers to PIC16LC54A and PIC16LV54A parts).

### PIC16C5X

### **Pin Diagrams**



### **Device Differences**

| Device     | Voltage<br>Range | Oscillator<br>Selection<br>(Program) | Oscillator | Process<br>Technology<br>(Microns) | ROM<br>Equivalent | MCLR<br>Filter    |
|------------|------------------|--------------------------------------|------------|------------------------------------|-------------------|-------------------|
| PIC16C52   | 3.0-6.25         | User                                 | See Note 1 | 0.9                                | _                 | No                |
| PIC16C54   | 2.5-6.25         | Factory                              | See Note 1 | 1.2                                | PIC16CR54A        | No                |
| PIC16C54A  | 2.0-6.25         | User                                 | See Note 1 | 0.9                                | _                 | No                |
| PIC16C54B  | 3.0-5.5          | User                                 | See Note 1 | 0.7                                | PIC16CR54B        | Yes               |
| PIC16C55   | 2.5-6.25         | Factory                              | See Note 1 | 1.7                                | _                 | No                |
| PIC16C55A  | 3.0-5.5          | User                                 | See Note 1 | 0.7                                | _                 | Yes               |
| PIC16C56   | 2.5-6.25         | Factory                              | See Note 1 | 1.7                                | _                 | No                |
| PIC16C56A  | 3.0-5.5          | User                                 | See Note 1 | 0.7                                | PIC16CR56A        | Yes               |
| PIC16C57   | 2.5-6.25         | Factory                              | See Note 1 | 1.2                                | _                 | No                |
| PIC16C57C  | 3.0-5.5          | User                                 | See Note 1 | 0.7                                | PIC16CR57C        | Yes               |
| PIC16CR57C | 2.5-5.5          | Factory                              | See Note 1 | 0.7                                | NA                | Yes               |
| PIC16C58A  | 2.0-6.25         | User                                 | See Note 1 | 0.9                                | PIC16CR58A        | No <sup>(2)</sup> |
| PIC16C58B  | 3.0-5.5          | User                                 | See Note 1 | 0.7                                | PIC16CR58B        | Yes               |
| PIC16CR54A | 2.5-6.25         | Factory                              | See Note 1 | 1.2                                | NA                | Yes               |
| PIC16CR54B | 2.5-5.5          | Factory                              | See Note 1 | 0.7                                | NA                | Yes               |
| PIC16CR56A | 2.5-5.5          | Factory                              | See Note 1 | 0.7                                | NA                | Yes               |
| PIC16CR57B | 2.5-6.25         | Factory                              | See Note 1 | 0.9                                | NA                | Yes               |
| PIC16CR58A | 2.5-6.25         | Factory                              | See Note 1 | 0.9                                | NA                | Yes               |
| PIC16CR58B | 2.5-5.5          | Factory                              | See Note 1 | 0.7                                | NA                | Yes               |

**Note 1:** If you change from this device to another device, please verify oscillator characteristics in your application.

Note 2: In PIC16LV58A,  $\overline{MCLR}$  Filter = Yes

### PIC16C5X

### **Table of Contents**

| 1.0   | General Description  | 5   |
|-------|--|-----|
| 2.0   | PIC16C5X Device Varieties  | 7   |
| 3.0   | Architectural Overview   | 9   |
| 4.0   | Memory Organization  | 15  |
| 5.0   | I/O Ports  | 25  |
| 6.0   | Timer0 Module and TMR0 Register                                    | 27  |
| 7.0   | Special Features of the CPU  | 31  |
| 8.0   | Instruction Set Summary  | 43  |
| 9.0   | Development Support  | 55  |
| 10.0  | Electrical Characteristics - PIC16C52                              | 59  |
| 11.0  | Electrical Characteristics - PIC16C54/55/56/57                     | 67  |
| 12.0  | DC and AC Characteristics - PIC16C54/55/56/57                      | 81  |
| 13.0  | Electrical Characteristics - PIC16CR54A                            | 89  |
| 14.0  | Electrical Characteristics - PIC16C54A                             | 103 |
| 15.0  | Electrical Characteristics - PIC16CR57B                            | 117 |
| 16.0  | Electrical Characteristics - PIC16C58A                             | 131 |
| 17.0  | Electrical Characteristics - PIC16CR58A                            |     |
| 18.0  | DC and AC Characteristics - PIC16C54A/CR57B/C58A/CR58A             | 159 |
| 19.0  | Electrical Characteristics - PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B | 171 |
| 20.0  | DC and AC Characteristics - PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B  | 183 |
| 21.0  | Packaging Information  | 193 |
| Apper | ndix A: Compatibility  | 205 |
| Index |  | 207 |
| PIC16 | 6C5X Product Identification System                                 | 215 |
| PIC16 | 6C54/55/56/57 Product Identification System                        | 216 |

### 1.0 GENERAL DESCRIPTION

The PIC16C5X from Microchip Technology is a family of low-cost, high performance, 8-bit, fully static, EPROM/ ROM-based CMOS microcontrollers. It employs a RISC architecture with only 33 single word/single cycle instructions. All instructions are single cycle (200 ns) except for program branches which take two cycles. The PIC16C5X delivers performance an order of magnitude higher than its competitors in the same price category. The 12-bit wide instructions are highly symmetrical resulting in 2:1 code compression over other 8-bit microcontrollers in its class. The easy to use and easy to remember instruction set reduces development time significantly.

The PIC16C5X products are equipped with special features that reduce system cost and power requirements. The Power-On Reset (POR) and Device Reset Timer (DRT) eliminate the need for external reset circuitry. There are four oscillator configurations to choose from, including the power-saving LP (Low Power) oscillator and cost saving RC oscillator. Power saving SLEEP mode, Watchdog Timer and code protection features improve system cost, power and reliability.

The UV erasable CERDIP packaged versions are ideal for code development, while the cost-effective One Time Programmable (OTP) versions are suitable for production in any volume. The customer can take full advantage of Microchip's price leadership in OTP microcontrollers while benefiting from the OTP's flexibility.

The PIC16C5X products are supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a 'C' compiler, fuzzy logic support tools, a low-cost development programmer, and a full featured programmer. All the tools are supported on IBM® PC and compatible machines.

### 1.1 Applications

The PIC16C5X series fits perfectly in applications ranging from high-speed automotive and appliance motor control to low-power remote transmitters/receivers, pointing devices and telecom processors. The EPROM technology makes customizing application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages, for through hole or surface mounting, make this microcontroller series perfect for applications with space limitations. Low-cost, low-power, high performance, ease of use and I/O flexibility make the PIC16C5X series very versatile even in areas where no microcontroller use has been considered before (e.g., timer functions, replacement of "glue" logic in larger systems, coprocessor applications).

TABLE 1-1: PIC16C5X FAMILY OF DEVICES

|             |                                      | PIC16C52            | PIC16C54s                           | PIC16CR54s                          | PIC16C55s                           | PIC16C56s                           |
|-------------|--------------------------------------|---------------------|-------------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| Clock       | Maximum Frequency of Operation (MHz) | 4                   | 20                                  | 20                                  | 20                                  | 20                                  |
|             | EPROM Program Memory (x12 words)     | 384                 | 512                                 | _                                   | 512                                 | 1K                                  |
| Memory      | ROM Program Memory (x12 words)       |                     |                                     | 512                                 | _                                   | _                                   |
|             | RAM Data Memory (bytes)              | 25                  | 25                                  | 25                                  | 24                                  | 25                                  |
| Peripherals | Timer Module(s)                      | TMR0                | TMR0                                | TMR0                                | TMR0                                | TMR0                                |
|             | I/O Pins                             | 12                  | 12                                  | 12                                  | 20                                  | 12                                  |
|             | Number of Instructions               | 33                  | 33                                  | 33                                  | 33                                  | 33                                  |
| Features    | Packages                             | 18-pin DIP,<br>SOIC | 18-pin DIP,<br>SOIC;<br>20-pin SSOP | 18-pin DIP,<br>SOIC;<br>20-pin SSOP | 28-pin DIP,<br>SOIC;<br>28-pin SSOP | 18-pin DIP,<br>SOIC;<br>20-pin SSOP |

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer (except PIC16C52), selectable code protect and high I/O current capability.

|             |                                      | PIC16CR56s                          | PIC16C57s                           | PIC16CR57s                          | PIC16C58s                           | PIC16CR58s                          |
|-------------|--------------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| Clock       | Maximum Frequency of Operation (MHz) | 20                                  | 20                                  | 20                                  | 20                                  | 20                                  |
|             | EPROM Program Memory (x12 words)     | _                                   | 2K                                  | _                                   | 2K                                  | _                                   |
| Memory      | ROM Program Memory (x12 words)       | 1K                                  | _                                   | 2K                                  | _                                   | 2K                                  |
|             | RAM Data Memory (bytes)              | 25                                  | 72                                  | 72                                  | 73                                  | 73                                  |
| Peripherals | Timer Module(s)                      | TMR0                                | TMR0                                | TMR0                                | TMR0                                | TMR0                                |
|             | I/O Pins                             | 12                                  | 20                                  | 20                                  | 12                                  | 12                                  |
|             | Number of Instructions               | 33                                  | 33                                  | 33                                  | 33                                  | 33                                  |
| Features    | Packages                             | 18-pin DIP,<br>SOIC;<br>20-pin SSOP | 28-pin DIP,<br>SOIC;<br>28-pin SSOP | 28-pin DIP,<br>SOIC;<br>28-pin SSOP | 18-pin DIP,<br>SOIC;<br>20-pin SSOP | 18-pin DIP,<br>SOIC;<br>20-pin SSOP |

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer (except PIC16C52), selectable code protect and high I/O current capability.

### 2.0 PIC16C5X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in this section. When placing orders, please use the PIC16C5X Product Identification System at the back of this data sheet to specify the correct part number.

For the PIC16C5X family of devices, there are four device types, as indicated in the device number:

- C, as in PIC16C54. These devices have EPROM program memory and operate over the standard voltage range.
- LC, as in PIC16LC54A. These devices have EPROM program memory and operate over an extended voltage range.
- 3. **LV**, as in PIC16LV54A. These devices have EPROM program memory and operate over a 2.0V to 3.8V range.
- CR, as in PIC16CR54A. These devices have ROM program memory and operate over the standard voltage range.
- 5. **LCR**, as in PIC16LCR54B. These devices have ROM program memory and operate over an extended voltage range.

### 2.1 <u>UV Erasable Devices (EPROM)</u>

The UV erasable versions, offered in CERDIP packages, are optimal for prototype development and pilot programs

UV erasable devices can be programmed for any of the four oscillator configurations. Microchip's PICSTART® and PRO MATE® programmers both support programming of the PIC16C5X. Third party programmers also are available; refer to the Third Party Guide for a list of sources.

### 2.2 <u>One-Time-Programmable (OTP)</u> Devices

The availability of OTP devices is especially useful for customers expecting frequent code changes and updates.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must be programmed.

### 2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration bit options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

### 2.4 <u>Serialized</u> <u>Quick-Turnaround-Production</u> (SQTP SM) Devices

Microchip offers the unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential. The devices are identical to the OTP devices but with all EPROM locations and configuration bit options already programmed by the factory.

Serial programming allows each device to have a unique number which can serve as an entry code, password or ID number.

### 2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, giving the customer a low cost option for high volume, mature products.

### PIC16C5X

**NOTES:** 

### 3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16C5X family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16C5X uses a Harvard architecture in which program and data are accessed on separate buses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched on the same bus. Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 12-bits wide making it possible to have all single word instructions. A 12-bit wide program memory access bus fetches a 12-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (33) execute in a single cycle (200ns @ 20MHz) except for program branches.

The PIC16C52 addresses 384 x 12 of program memory, the PIC16C54s/CR54s and PIC16C55s address 512 x 12 of program memory, the PIC16C56s/CR56s address 1K X 12 of program memory, and the PIC16C57s/CR57s and PIC16C58s/CR58s address 2K x 12 of program memory. All program memory is internal.

The PIC16C5X can directly or indirectly address its register files and data memory. All special function registers including the program counter are mapped in the data memory. The PIC16C5X has a highly orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16C5X simple yet efficient. In addition, the learning curve is reduced significantly.

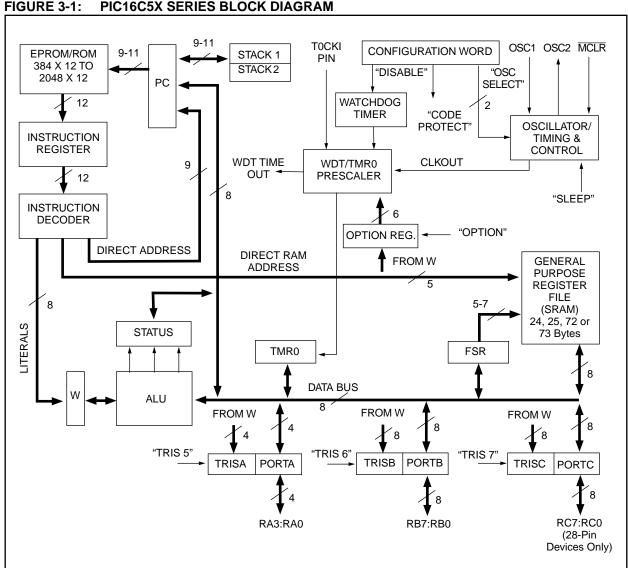
The PIC16C5X device contains an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the W (working) register. The other operand is either a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBWF and ADDWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with the corresponding device pins described in Table 3-1.



PIC16C5X SERIES BLOCK DIAGRAM

TABLE 3-1: PINOUT DESCRIPTION - PIC16C52, PIC16C54s, PIC16CR54s, PIC16CR56s, PIC16CR56s, PIC16CR58s

| Name        | DIP, SOIC<br>No. | SSOP<br>No. | I/O/P<br>Type | Input<br>Levels | Description  |
|-------------|------------------|-------------|---------------|-----------------|--|
| RA0         | 17               | 19          | I/O           | TTL             | Bi-directional I/O port  |
| RA1         | 18               | 20          | I/O           | TTL             | ·  |
| RA2         | 1                | 1           | I/O           | TTL             |  |
| RA3         | 2                | 2           | I/O           | TTL             |  |
| RB0         | 6                | 7           | I/O           | TTL             | Bi-directional I/O port  |
| RB1         | 7                | 8           | I/O           | TTL             | ·  |
| RB2         | 8                | 9           | I/O           | TTL             |  |
| RB3         | 9                | 10          | I/O           | TTL             |  |
| RB4         | 10               | 11          | I/O           | TTL             |  |
| RB5         | 11               | 12          | I/O           | TTL             |  |
| RB6         | 12               | 13          | I/O           | TTL             |  |
| RB7         | 13               | 14          | I/O           | TTL             |  |
| T0CKI       | 3                | 3           | I             | ST              | Clock input to Timer0. Must be tied to Vss or VDD, if not in use, to reduce current consumption.   |
| MCLR/VPP    | 4                | 4           | I             | ST              | Master clear (reset) input/programming voltage input. This pin is an active low reset to the device. Voltage on the MCLR/VPP pin must not exceed VDD to avoid unintended entering of programming mode.   |
| OSC1/CLKIN  | 16               | 18          | I             | ST              | Oscillator crystal input/external clock source input.  |
| OSC2/CLKOUT | 15               | 17          | 0             |                 | Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate. |
| VDD         | 14               | 15,16       | Р             | _               | Positive supply for logic and I/O pins.  |
| Vss         | 5                | 5,6         | Р             | _               | Ground reference for logic and I/O pins.   |

Legend: I = input, O = output, I/O = input/output,

P = power, — = Not Used, TTL = TTL input,

ST = Schmitt Trigger input

### PIC16C5X

TABLE 3-2: PINOUT DESCRIPTION - PIC16C55s, PIC16C57s, PIC16CR57s

| Name        | DIP, SOIC<br>No. | SSOP<br>No. | I/O/P<br>Type | Input<br>Levels | Description  |
|-------------|------------------|-------------|---------------|-----------------|--|
| RA0         | 6                | 5           | I/O           | TTL             | Bi-directional I/O port  |
| RA1         | 7                | 6           | I/O           | TTL             | ·  |
| RA2         | 8                | 7           | I/O           | TTL             |  |
| RA3         | 9                | 8           | I/O           | TTL             |  |
| RB0         | 10               | 9           | I/O           | TTL             | Bi-directional I/O port  |
| RB1         | 11               | 10          | I/O           | TTL             | ·  |
| RB2         | 12               | 11          | I/O           | TTL             |  |
| RB3         | 13               | 12          | I/O           | TTL             |  |
| RB4         | 14               | 13          | I/O           | TTL             |  |
| RB5         | 15               | 15          | I/O           | TTL             |  |
| RB6         | 16               | 16          | I/O           | TTL             |  |
| RB7         | 17               | 17          | I/O           | TTL             |  |
| RC0         | 18               | 18          | I/O           | TTL             | Bi-directional I/O port  |
| RC1         | 19               | 19          | I/O           | TTL             | ·  |
| RC2         | 20               | 20          | I/O           | TTL             |  |
| RC3         | 21               | 21          | I/O           | TTL             |  |
| RC4         | 22               | 22          | I/O           | TTL             |  |
| RC5         | 23               | 23          | I/O           | TTL             |  |
| RC6         | 24               | 24          | I/O           | TTL             |  |
| RC7         | 25               | 25          | I/O           | TTL             |  |
| T0CKI       | 1                | 2           | I             | ST              | Clock input to Timer0. Must be tied to Vss or VDD if not in use to reduce current consumption.   |
| MCLR        | 28               | 28          | I             | ST              | Master clear (reset) input. This pin is an active low reset to the device.   |
| OSC1/CLKIN  | 27               | 27          | 1             | ST              | Oscillator crystal input/external clock source input.  |
| OSC2/CLKOUT | 26               | 26          | 0             | _               | Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate. |
| VDD         | 2                | 3,4         | Р             | _               | Positive supply for logic and I/O pins.  |
| Vss         | 4                | 1,14        | Р             | _               | Ground reference for logic and I/O pins.   |
| N/C         | 3,5              |             | _             | _               | Unused, do not connect   |

Legend: I = input, O = output, I/O = input/output,

P = power, --- = Not Used,

TTL = TTL input, ST = Schmitt Trigger input

#### 3.1 **Clocking Scheme/Instruction Cycle**

The clock input (OSC1/CLKIN pin) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the program counter is incremented every Q1, and the instruction is fetched from program memory and latched into instruction register in Q4. It is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-2 and Example 3-1.

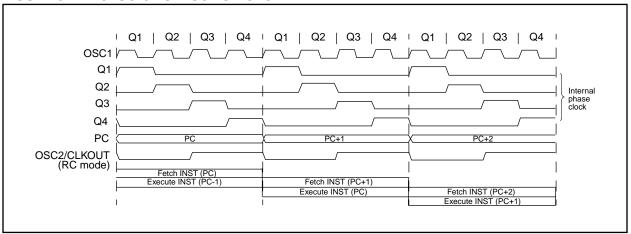
#### 3.2 **Instruction Flow/Pipelining**

An Instruction Cycle consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO) then two cycles are required to complete the instruction (Example 3-1).

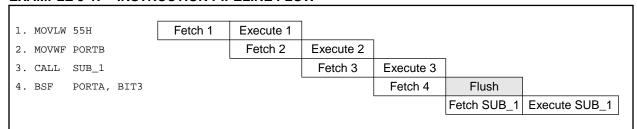
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).





#### **EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW**



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

**Preliminary** © 1997 Microchip Technology Inc. DS30453A-page 13

### PIC16C5X

**NOTES:** 

### 4.0 MEMORY ORGANIZATION

PIC16C5X memory is organized into program memory and data memory. For devices with more than 512 bytes of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS register bits. For devices with a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

### 4.1 Program Memory Organization

The PIC16C52 has a 9-bit Program Counter (PC) capable of addressing a 384 x 12 program memory space (Figure 4-1). The PIC16C54s, PIC16CR54s and PIC16C55s have a 9-bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 4-2). The PIC16C56s and PIC16CR56s have a 10-bit Program Counter (PC) capable of addressing a 1K x 12 program memory space (Figure 4-3). The PIC16CR57s, PIC16C58s and PIC16CR58s have an 11-bit Program Counter capable of addressing a 2K x 12 program memory space (Figure 4-4). Accessing a location above the physically implemented address will cause a wraparound.

The reset vector for the PIC16C52 is at 17Fh. A NOP at the reset vector location will cause a restart at location 000h. The reset vector for the PIC16C54s, PIC16CR54s and PIC16C55s is at 1FFh. The reset vector for the PIC16C56s and PIC16CR56s is at 3FFh. The reset vector for the PIC16C57s, PIC16CR57s, PIC16CR57s, and PIC16CR58s is at 7FFh.

FIGURE 4-1: PIC16C52 PROGRAM MEMORY MAP AND STACK

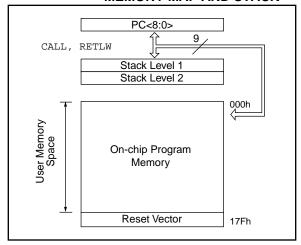


FIGURE 4-2: PIC16C54s/CR54s/C55s PROGRAM MEMORY MAP AND STACK

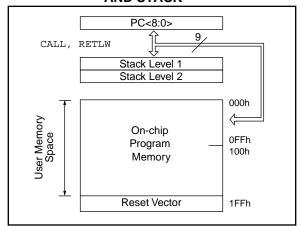


FIGURE 4-3: PIC16C56s/CR56s
PROGRAM MEMORY MAP
AND STACK

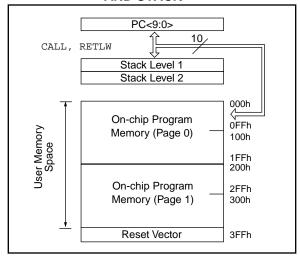
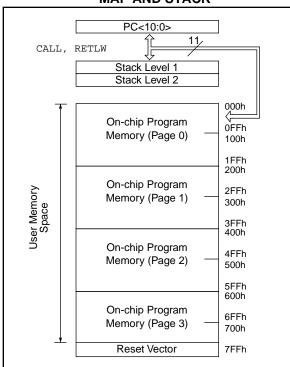


FIGURE 4-4: PIC16C57s/CR57s/C58s/ CR58s PROGRAM MEMORY MAP AND STACK



### 4.2 <u>Data Memory Organization</u>

Data memory is composed of registers, or bytes of RAM. Therefore, data memory for a device is specified by its register file. The register file is divided into two functional groups: special function registers and general purpose registers.

The special function registers include the TMR0 register, the Program Counter (PC), the Status Register, the I/O registers (ports), and the File Select Register (FSR). In addition, special purpose registers are used to control the I/O port configuration and prescaler options.

The general purpose registers are used for data and control information under command of the instructions.

For the PIC16C52, PIC16C54s, PIC16CR54s, PIC16C56s and PIC16CR56s, the register file is composed of 7 special function registers and 25 general purpose registers (Figure 4-5).

For the PIC16C55s, the register file is composed of 8 special function registers and 24 general purpose registers.

For the PIC16C57s and PIC16CR57s, the register file is composed of 8 special function registers, 24 general purpose registers and up to 48 additional general purpose registers that may be addressed using a banking scheme (Figure 4-6).

For the PIC16C58s and PIC16CR58s, the register file is composed of 7 special function registers, 25 general purpose registers and up to 48 additional general purpose registers that may be addressed using a banking scheme (Figure 4-7).

### 4.2.1 GENERAL PURPOSE REGISTER FILE

The register file is accessed either directly or indirectly through the file select register FSR (Section 4.7).

FIGURE 4-5: PIC16C52, PIC16C54s,
PIC16CR54s, PIC16C55s,
PIC16C56s, PIC16CR56s
REGISTER FILE MAP

| KLOISTER FILL WAF  |                                 |  |  |  |  |  |  |
|--|---------------------------------|--|--|--|--|--|--|
| File Address   |                                 |  |  |  |  |  |  |
| 00h  | INDF <sup>(1)</sup>             |  |  |  |  |  |  |
| 01h  | TMR0                            |  |  |  |  |  |  |
| 02h  | PCL                             |  |  |  |  |  |  |
| 03h  | STATUS                          |  |  |  |  |  |  |
| 04h  | FSR                             |  |  |  |  |  |  |
| 05h  | PORTA                           |  |  |  |  |  |  |
| 06h  | PORTB                           |  |  |  |  |  |  |
| 07h  | PORTC <sup>(2)</sup>            |  |  |  |  |  |  |
| 0Fh<br>10h   | General<br>Purpose<br>Registers |  |  |  |  |  |  |
| 1Fh  |                                 |  |  |  |  |  |  |
| Note 1: Not a physical register. See Section 4.7 2: PIC16C55s only, others are a general purpose register. |                                 |  |  |  |  |  |  |

FIGURE 4-6: PIC16C57s/CR57s REGISTER FILE MAP

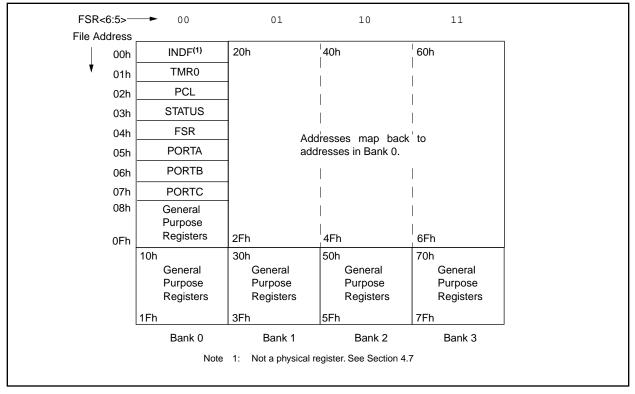
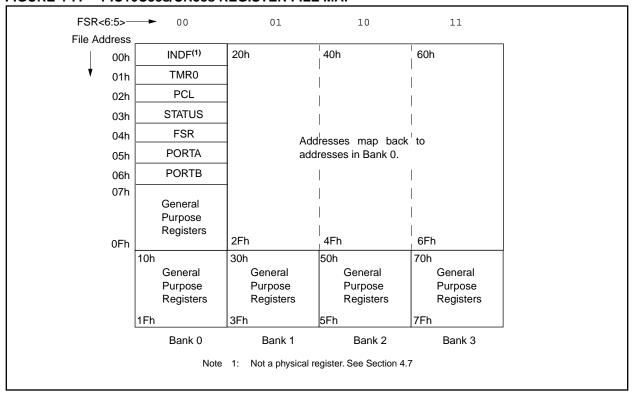


FIGURE 4-7: PIC16C58s/CR58s REGISTER FILE MAP



#### 4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions to control the operation of the device (Table 4-1). The special registers can be classified into two sets. The special function registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section for each peripheral feature.

TABLE 4-1: SPECIAL FUNCTION REGISTER SUMMARY

| Address            | Name   | Bit 7     | Bit 6                                       | Bit 5       | Bit 4       | Bit 3    | Bit 2       | Bit 1      | Bit 0    | Value on<br>Power-On<br>Reset | Value on MCLR and WDT Reset |
|--------------------|--------|-----------|---|-------------|-------------|----------|-------------|------------|----------|-------------------------------|-----------------------------|
| N/A                | TRIS   | I/O cont  | I/O control registers (TRISA, TRISB, TRISC) |             |             |          |             |            |          |                               | 1111 1111                   |
| N/A                | OPTION | Contains  | s control b                                 | oits to cor | ifigure Tin | ner0 and | Timer0/W    | DT presc   | aler     | 11 1111                       | 11 1111                     |
| 00h                | INDF   | Uses co   | ntents of                                   | FSR to a    | ddress da   | ta memoi | ry (not a p | hysical re | egister) | xxxx xxxx                     | uuuu uuuu                   |
| 01h                | TMR0   | 8-bit rea | 8-bit real-time clock/counter               |             |             |          |             |            |          | xxxx xxxx                     | uuuu uuuu                   |
| 02h <sup>(1)</sup> | PCL    | Low ord   | er 8 bits o                                 | of PC       |             |          |             |            |          | 1111 1111                     | 1111 1111                   |
| 03h                | STATUS | PA2       | PA1   | PA0         | TO          | PD       | Z           | DC         | С        | 0001 1xxx                     | 000q quuu                   |
| 04h                | FSR    | Indirect  | data men                                    | nory addre  | ess pointe  | er       |             |            |          | 1xxx xxxx                     | 1uuu uuuu                   |
| 05h                | PORTA  | _         | _   | _           | _           | RA3      | RA2         | RA1        | RA0      | xxxx                          | uuuu                        |
| 06h                | PORTB  | RB7       | RB6   | RB5         | RB4         | RB3      | RB2         | RB1        | RB0      | xxxx xxxx                     | uuuu uuuu                   |
| 07h <sup>(2)</sup> | PORTC  | RC7       | RC6   | RC5         | RC4         | RC3      | RC2         | RC1        | RC0      | xxxx xxxx                     | uuuu uuuu                   |

Legend: Shaded boxes = unimplemented or unused, - = unimplemented, read as '0' (if applicable)

 $\rm x$  = unknown,  $\rm u$  = unchanged,  $\rm q$  = see the tables in Section 7.7 for possible values.

Note 1: The upper byte of the Program Counter is not directly accessible. See Section 4.5 for an explanation of how to access these bits.

2: File address 07h is a general purpose register on the PIC16C52, PIC16C54s, PIC16CR54s, PIC16C56s, PIC16CR56s, PIC16CS8s and PIC16CR58s.

### 4.3 STATUS Register

This register contains the arithmetic status of the ALU, the RESET status, and the page preselect bits for program memories larger than 512 words.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are

not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the STATUS register as 000u uluu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF and MOVWF instructions be used to alter the STATUS register because these instructions do not affect the Z, DC or C bits from the STATUS register. For other instructions, which do affect STATUS bits, see Section 8.0, Instruction Set Summary.

### FIGURE 4-8: STATUS REGISTER (ADDRESS:03h)

|          |   |                          |     | •                      |   |       |                        |  |  |  |  |
|----------|---|--------------------------|-----|------------------------|---|-------|------------------------|--|--|--|--|
| R/W-0    | R/W-0   | R/W-0                    | R-1 | R-1                    | R/W-x   | R/W-x | R/W-x                  |  |  |  |  |
| PA2      | PA1   | PA0                      | TO  | PD                     | Z   | DC    | С                      | R = Readable bit                           |  |  |  |
| bit7     | 6   | 5                        | 4   | 3                      | 2   | 1     | bit0                   | W = Writable bit                           |  |  |  |
|          |   | - n = Value at POR reset |     |                        |   |       |                        |  |  |  |  |
| bit 7:   | t 7: PA2: This bit unused at this time. Use of the PA2 bit as a general purpose read/write bit is not recommended, since this may affect upward compatibility with future products.   |                          |     |                        |   |       |                        |  |  |  |  |
| bit 6-5: | bit 6-5: PA1:PA0: Program page preselect bits (PIC16C56s/CR56s)(PIC16C57s/CR57s)(PIC16C58s/CR58s)  00 = Page 0 (000h - 1FFh) - PIC16C56s/CR56s, PIC16C57s/CR57s, PIC16C58s/CR58s  01 = Page 1 (200h - 3FFh) - PIC16C56s/CR56s, PIC16C57s/CR57s, PIC16C58s/CR58s  10 = Page 2 (400h - 5FFh) - PIC16C57s/CR57s, PIC16C58s/CR58s  11 = Page 3 (600h - 7FFh) - PIC16C57s/CR57s, PIC16C58s/CR58s  Each page is 512 words.  Using the PA1:PA0 bits as general purpose read/write bits in devices which do not use them for program page preselect is not recommended since this may affect upward compatibility with future products. |                          |     |                        |   |       |                        |  |  |  |  |
| bit 4:   | TO: Time-out bit  1 = After power-up, CLRWDT instruction, or SLEEP instruction  0 = A WDT time-out occurred   |                          |     |                        |   |       |                        |  |  |  |  |
| bit 3:   | <b>PD</b> : Power-<br>1 = After po<br>0 = By exe  | ower-up or               |     |                        | tion  |       |                        |  |  |  |  |
| bit 2:   |   |                          |     | •                      | ition is zero<br>ition is not ze                  | ro    |                        |  |  |  |  |
| bit 1:   | 0 = The result of an arithmetic or logic operation is not zero  1: DC: Digit carry/borrow bit (for ADDWF and SUBWF instructions)  ADDWF  1 = A carry from the 4th low order bit of the result occurred  0 = A carry from the 4th low order bit of the result did not occur  SUBWF  1 = A borrow from the 4th low order bit of the result did not occur  0 = A borrow from the 4th low order bit of the result occurred  |                          |     |                        |   |       |                        |  |  |  |  |
| bit 0:   | C: Carry/bo<br>ADDWF<br>1 = A carry<br>0 = A carry  | occurred                 |     | <b>SUBWF</b> 1 = A box | RRF, RLF instr<br>rrow did not c<br>rrow occurred | occur | RRF or R<br>Load bit w | <b>LF</b><br>vith LSb or MSb, respectively |  |  |  |

### 4.4 **OPTION Register**

The OPTION register is a 6-bit wide, write-only register which contains various control bits to configure the Timer0/WDT prescaler and Timer0.

By executing the <code>OPTION</code> instruction, the contents of the W register will be transferred to the <code>OPTION</code> register. A RESET sets the <code>OPTION<5:0></code> bits.

### FIGURE 4-9: OPTION REGISTER

| U-0      | U-0          | W-1                            | W-1               | W-1         | W-1           | W-1         | W-1  |   |  |  |  |  |
|----------|--------------|--------------------------------|-------------------|-------------|---------------|-------------|------|---|--|--|--|--|
| _        | _            | T0CS                           | T0SE              | PSA         | PS2           | PS1         | PS0  | W = Writable bit                                  |  |  |  |  |
| oit7     | 6            | 5                              | 4                 | 3           | 2             | 1           | bit0 | U = Unimplemented bit<br>- n = Value at POR reset |  |  |  |  |
| bit 7-6: | Unimpleme    | ented.                         |                   |             |               |             |      | -11 = value at FOR leset                          |  |  |  |  |
| bit 5:   | •            | r0 clock sou                   | ca salac          | t hit       |               |             |      |   |  |  |  |  |
| DIL J.   |              | n on TOCKI                     |                   | l Dit       |               |             |      |   |  |  |  |  |
|          |              | instruction c                  |                   | k (CLKOUT   | )             |             |      |   |  |  |  |  |
| bit 4:   |              |                                | •                 | `           | ,             |             |      |   |  |  |  |  |
| DIL 4.   |              | r0 source ed<br>ent on high-to |                   |             | CKI nin       |             |      |   |  |  |  |  |
|          |              | ent on low-to-                 |                   |             |               |             |      |   |  |  |  |  |
| bit 3:   |              |                                | _                 |             |               |             |      |   |  |  |  |  |
| DIL 3.   |              | aler assignm<br>er assigned t  |                   | T (not impl | emented on    | PIC16C52)   |      |   |  |  |  |  |
|          |              | er assigned t                  |                   |             | cincinca on   | 1 10 10032) |      |   |  |  |  |  |
| bit 2-0: |              | rescaler rate                  |                   |             |               |             |      |   |  |  |  |  |
| DIL 2-0. |              |                                |                   |             |               |             |      |   |  |  |  |  |
|          | Bit Value    | Timer0 Ra                      | te WD7            | Rate (not   | implemented   | on PIC16C   | 252) |   |  |  |  |  |
|          | 000          | 1:2                            | 1:                | 1           |               |             |      |   |  |  |  |  |
|          | 001          | 1:4                            | 1:                | 2           |               |             |      |   |  |  |  |  |
|          | 010          | 1:8                            | 1:                | -           |               |             |      |   |  |  |  |  |
|          | 011 1:16 1:8 |                                |                   |             |               |             |      |   |  |  |  |  |
|          |              | _                              |                   | -           | 100 1:32 1:16 |             |      |   |  |  |  |  |
|          | 100          | 1:32                           | 1:                | 16          |               |             |      |   |  |  |  |  |
|          | 100<br>101   | 1 : 32<br>1 : 64               | 1 :<br>1 :        | 16<br>32    |               |             |      |   |  |  |  |  |
|          | 100          | 1:32                           | 1 :<br>1 :<br>1 : | 16          |               |             |      |   |  |  |  |  |

### 4.5 **Program Counter**

As a program instruction is executed, the Program Counter (PC) will contain the address of the next program instruction to be executed. The PC value is increased by one every instruction cycle, unless an instruction changes the PC.

For a GOTO instruction, bits 8:0 of the PC are provided by the GOTO instruction word. The PC Latch (PCL) is mapped to PC<7:0> (Figure 4-10 and Figure 4-11).

For the PIC16C56s, PIC16CR56s, PIC16C57s, PIC16CR57s, PIC16C58s and PIC16CR58s, a page number must be supplied as well. Bit5 and bit6 of the STATUS register provide page information to bit9 and bit10 of the PC (Figure 4-11 and Figure 4-12).

For a CALL instruction, or any instruction where the PCL is the destination, bits 7:0 of the PC again are provided by the instruction word. However, PC<8> does not come from the instruction word, but is always cleared (Figure 4-10 and Figure 4-11).

Instructions where the PCL is the destination, or Modify PCL instructions, include MOVWF PC, ADDWF PC, and BSF PC, 5.

For the PIC16C56s, PIC16CR56s, PIC16C57s, PIC16CR57s, PIC16C58s and PIC16CR58s, a page number again must be supplied. Bit5 and bit6 of the STATUS register provide page information to bit9 and bit10 of the PC (Figure 4-11 and Figure 4-12).

instruction, or any Modify PCL instruction, all subroutine calls or computed jumps are limited to the first 256 locations of any program memory page (512 words long).

FIGURE 4-10: LOADING OF PC BRANCH INSTRUCTIONS -PIC16C52, PIC16C54s, PIC16CR54s, PIC16C55s

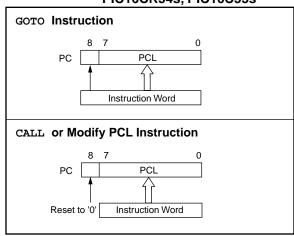


FIGURE 4-11: LOADING OF PC
BRANCH INSTRUCTIONS PIC16C56s/PIC16CR56s

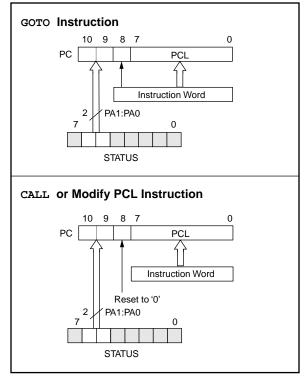
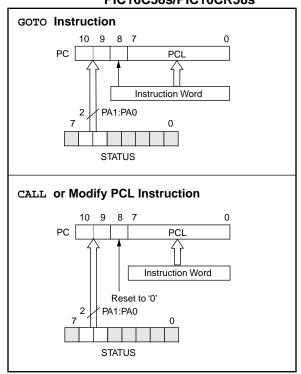


FIGURE 4-12: LOADING OF PC
BRANCH INSTRUCTIONS PIC16C57s/PIC16CR57s, AND
PIC16C58s/PIC16CR58s



For the RETLW instruction, the PC is loaded with the Top Of Stack (TOS) contents. All of the devices covered in this data sheet have a two-level stack. The stack has the same bit width as the device PC.

### 4.5.1 PAGING CONSIDERATIONS – PIC16C56s/CR56s, PIC16C57s/CR57s AND PIC16C58s/CR58s

If the Program Counter is pointing to the last address of a selected memory page, when it increments it will cause the program to continue in the next higher page. However, the page preselect bits in the STATUS register will not be updated. Therefore, the next GOTO, CALL, or Modify PCL instruction will send the program to the page specified by the page preselect bits (PA0 or PA1:PA0).

For example, a NOP at location 1FFh (page 0) increments the PC to 200h (page 1). A GOTO xxx at 200h will return the program to address xxxh on page 0 (assuming that PA1:PA0 are clear).

To prevent this, the page preselect bits must be updated under program control.

#### 4.5.2 EFFECTS OF RESET

The Program Counter is set upon a RESET, which means that the PC addresses the last location in the last page i.e., the reset vector.

The STATUS register page preselect bits are cleared upon a RESET, which means that page 0 is pre-selected.

Therefore, upon a RESET, a GOTO instruction at the reset vector location will automatically cause the program to jump to page 0.

### 4.6 Stack

PIC16C5X devices have a 9-bit, 10-bit or 11-bit wide, two-level hardware push/pop stack (Figure 4-2, Figure 4-1, and Figure 4-3 respectively).

A CALL instruction will *push* the current value of stack 1 into stack 2 and then push the current program counter value, incremented by one, into stack level 1. If more than two sequential CALL's are executed, only the most recent two return addresses are stored.

A RETLW instruction will *pop* the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential RETLW's are executed, the stack will be filled with the address previously stored in level 2. Note that the W register will be loaded with the literal value specified in the instruction. This is particularly useful for the implementation of data look-up tables within the program memory.

### 4.7 <u>Indirect Data Addressing; INDF and FSR Registers</u>

The INDF register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR register (FSR is a *pointer*). This is indirect addressing.

### **EXAMPLE 4-1: INDIRECT ADDRESSING**

- Register file 05 contains the value 10h
- Register file 06 contains the value 0Ah
- · Load the value 05 into the FSR register
- A read of the INDF register will return the value of 10h
- Increment the value of the FSR register by one (FSR = 06)
- A read of the INDR register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF register indirectly results in a no-operation (although STATUS bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 4-2.

# EXAMPLE 4-2: HOW TO CLEAR RAM USING INDIRECT ADDRESSING

|          | movlw | 0x10  | ;initialize pointer  |
|----------|-------|-------|----------------------|
|          | movwf | FSR   | ; to RAM             |
| NEXT     | clrf  | INDF  | clear INDF register; |
|          | incf  | FSR,F | ;inc pointer         |
|          | btfsc | FSR,4 | ;all done?           |
|          | goto  | NEXT  | ;NO, clear next      |
| CONTINUE |       |       |                      |
|          | :     |       | YES, continue        |

The FSR is either a 5-bit (PIC16C52, PIC16C54s, PIC16CR54s, PIC16C55s), 6-bit (PIC16C56s, PIC16CR56s), or 7-bit (PIC16C57s, PIC16CR57s, PIC16CR58s, PIC16CR58s) wide register. It is used in conjunction with the INDF register to indirectly address the data memory area.

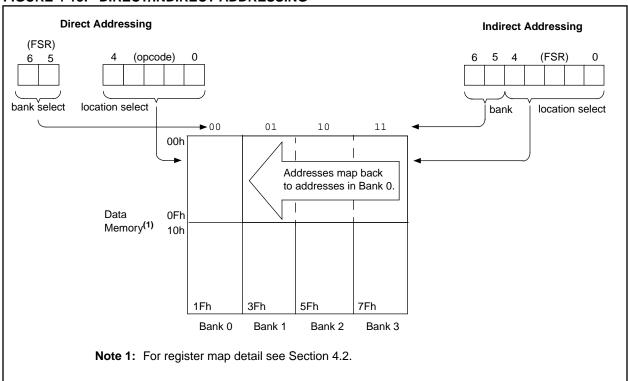
The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

PIC16C52, PIC16C54s, PIC16CR54s, PIC16C55s: Do not use banking. FSR<6:5> are unimplemented and read as '1's.

**PIC16C56s, PIC16CR56s:** FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = bank 0, 01 = bank 1, 10 = invalid, 11 = invalid).

PIC16C57s, PIC16CR57s, PIC16C58s, PIC16CR58s: FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = bank 0, 01 = bank 1, 10 = bank 2, 11 = bank 3).

FIGURE 4-13: DIRECT/INDIRECT ADDRESSING



### **5.0 I/O PORTS**

As with any other register, the I/O registers can be written and read under program control. However, read instructions (e.g., MOVF PORTB, W) always read the I/O pins independent of the pin's input/output modes. On RESET, all I/O ports are defined as input (inputs are at hi-impedance) since the I/O control registers (TRISA, TRISB, TRISC) are all set.

#### 5.1 PORTA

PORTA is a 4-bit I/O register. Only the low order 4 bits are used (RA3:RA0). Bits 7-4 are unimplemented and read as '0's.

#### 5.2 PORTB

PORTB is an 8-bit I/O register (PORTB<7:0>).

#### 5.3 PORTC

PORTC is an 8-bit I/O register for PIC16C55s, PIC16C57s and PIC16CR57s.

PORTC is a general purpose register for PIC16C52, PIC16C54s, PIC16CR54s, PIC16C56s, PIC16C58s and PIC16CR58s.

### 5.4 TRIS Registers

The output driver control registers are loaded with the contents of the W register by executing the TRIS f instruction. A '1' from a TRIS register bit puts the corresponding output driver in a hi-impedance mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer.

Note: A read of the ports reads the pins, not the output data latches. That is, if an output driver on a pin is enabled and driven high, but the external system is holding it low, a read of the port will indicate that the pin is low.

The TRIS registers are "write-only" and are set (output drivers disabled) upon RESET.

### 5.5 **I/O Interfacing**

The equivalent circuit for an I/O port pin is shown in Figure 5-1. All ports may be used for both input and output operation. For input operations these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF PORTB, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit (in TRISA, TRISB) must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin can be programmed individually as input or output.

FIGURE 5-1: EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN

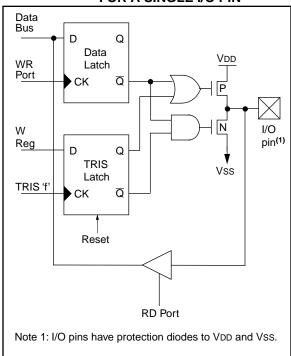


TABLE 5-1: SUMMARY OF PORT REGISTERS

| Address | Name  | Bit 7    | Bit 6                                | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on<br>Power-On<br>Reset | Value on MCLR and WDT Reset |
|---------|-------|----------|--------------------------------------|-------|-------|-------|-------|-------|-------|-------------------------------|-----------------------------|
| N/A     | TRIS  | I/O cont | I/O control registers (TRISA, TRISB) |       |       |       |       |       |       | 1111 1111                     | 1111 1111                   |
| 05h     | PORTA | _        | _                                    | _     | _     | RA3   | RA2   | RA1   | RA0   | xxxx                          | uuuu                        |
| 06h     | PORTB | RB7      | RB6                                  | RB5   | RB4   | RB3   | RB2   | RB1   | RB0   | xxxx xxxx                     | uuuu uuuu                   |
| 07h     | PORTC | RC7      | RC6                                  | RC5   | RC4   | RC3   | RC2   | RC1   | RC0   | xxxx xxxx                     | uuuu uuuu                   |

Legend: Shaded boxes = unimplemented, read as '0',

- = unimplemented, read as '0', x = unknown, u = unchanged

### 5.6 <u>I/O Programming Considerations</u>

### 5.6.1 BI-DIRECTIONAL I/O PORTS

Some instructions operate internally as read followed by write operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation and re-write the result. Caution must be used when these instructions are applied to a port where one or more pins are used as input/outputs. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU, bit5 to be set and the PORTB value to be written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (say bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Example 5-1 shows the effect of two sequential read-modify-write instructions (e.g.,  ${\tt BCF}$ ,  ${\tt BSF}$ , etc.) on an I/O port.

A pin actively outputting a high or a low should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

# EXAMPLE 5-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

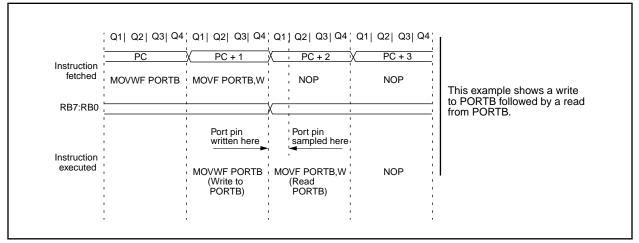
```
;Initial PORT Settings
; PORTB<7:4> Inputs
; PORTB<3:0> Outputs
;PORTB<7:6> have external pull-ups and are
;not connected to other circuitry
                    PORT latch PORT pins
 BCF
        PORTB. 7
                   ;01pp pppp
                                 11pp pppp
                                 11pp pppp
 BCF
        PORTB, 6
                   ;10pp pppp
 MOVLW 03Fh
  TRIS
        PORTR
                   ;10pp pppp
                                 10pp pppp
```

;Note that the user may have expected the pin ;values to be 00pp pppp. The 2nd BCF caused ;RB7 to be latched as the pin value (High).

### 5.6.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-2). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should allow the pin voltage to stabilize (load dependent) before the next instruction, which causes that file to be read into the CPU, is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.





### 6.0 TIMERO MODULE AND TMRO REGISTER

The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
  - Readable and writable
- · 8-bit software programmable prescaler
- · Internal or external clock select
  - Edge select for external clock

Figure 6-1 is a simplified block diagram of the Timer0 module, while Figure 6-2 shows the electrical structure of the Timer0 input.

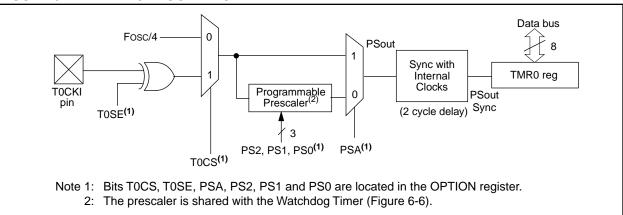
Timer mode is selected by clearing the TOCS bit (OPTION<5>). In timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 6-3 and Figure 6-4). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The incrementing edge is determined by the source edge select bit T0SE (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 6.1.

The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both. The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4,..., 1:256 are selectable. Section 6.2 details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 6-1.

#### FIGURE 6-1: TIMERO BLOCK DIAGRAM



### FIGURE 6-2: ELECTRICAL STRUCTURE OF TOCKI PIN

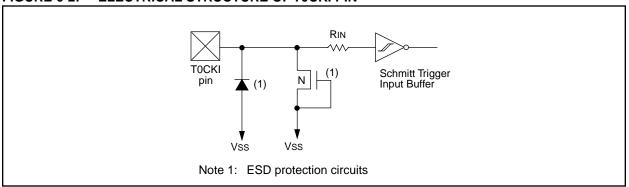


FIGURE 6-3: TIMERO TIMING: INTERNAL CLOCK/NO PRESCALE

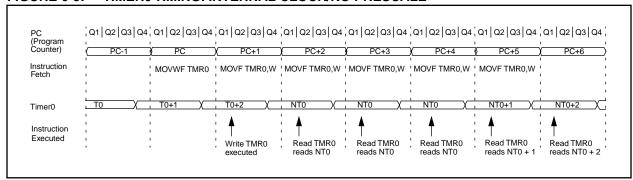


FIGURE 6-4: TIMERO TIMING: INTERNAL CLOCK/PRESCALE 1:2

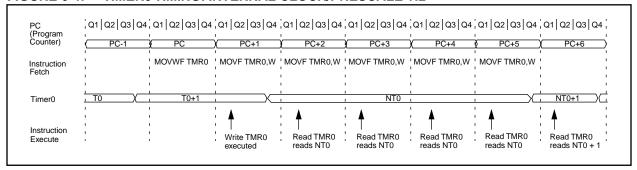


TABLE 6-1: REGISTERS ASSOCIATED WITH TIMERO

| Address | Name   | Bit 7  | Bit 6                                  | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0     | Value on<br>Power-On<br>Reset | Value on MCLR and WDT Reset |
|---------|--------|--------|--|-------|-------|-------|-------|-------|-----------|-------------------------------|-----------------------------|
| 01h     | TMR0   | Timer0 | Timer0 - 8-bit real-time clock/counter |       |       |       |       |       | xxxx xxxx | uuuu uuuu                     |                             |
| N/A     | OPTION | _      | _                                      | T0CS  | T0SE  | PSA   | PS2   | PS1   | PS0       | 11 1111                       | 11 1111                     |

Legend: Shaded cells: Unimplemented bits,

<sup>-</sup> = unimplemented, x = unknown, u = unchanged,

### 6.1 <u>Using Timer0 with an External Clock</u>

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

#### 6.1.1 EXTERNAL CLOCK SYNCHRONIZATION

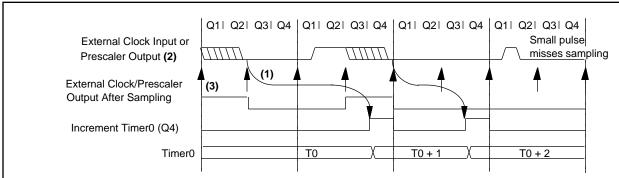
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-5). Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

### 6.1.2 TIMERO INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 6-5 shows the delay from the external clock edge to the timer incrementing.





- Note 1: Delay from clock input change to Timer0 increment is 3Tosc to 7Tosc. (Duration of Q = Tosc).

  Therefore, the error in measuring the interval between two edges on Timer0 input =  $\pm$  4Tosc max.
  - 2: External clock if no prescaler selected, Prescaler output otherwise.
  - 3: The arrows indicate the points in time where sampling occurs.

### 6.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer (WDT) (WDT postscaler not implemented on PIC16C52), respectively (Section 6.1.2). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT, and vice-versa.

The PSA and PS2:PS0 bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1,x, etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a RESET, the prescaler contains all  $^{\prime}$ 0's.

#### 6.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on the fly" during program execution). To avoid an unintended device RESET, the

following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

### EXAMPLE 6-1: CHANGING PRESCALER (TIMER0→WDT)

| 1.CLRWDT |             | ;Clear WDT              |
|----------|-------------|-------------------------|
| 2.CLRF   | TMR0        | Clear TMR0 & Prescaler  |
| 3.MOVLW  | '00xx1111'b | These 3 lines (5, 6, 7) |
| 4.OPTION |             | ; are required only if  |
|          |             | ; desired               |
| 5.CLRWDT |             | ;PS<2:0> are 000 or 001 |
| 6.MOVLW  | '00xx1xxx'b | ;Set Postscaler to      |
| 7.OPTION |             | ; desired WDT rate      |
|          |             |                         |

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 6-2. This sequence must be used even if the WDT is disabled. A CLRWDT instruction should be executed before switching the prescaler.

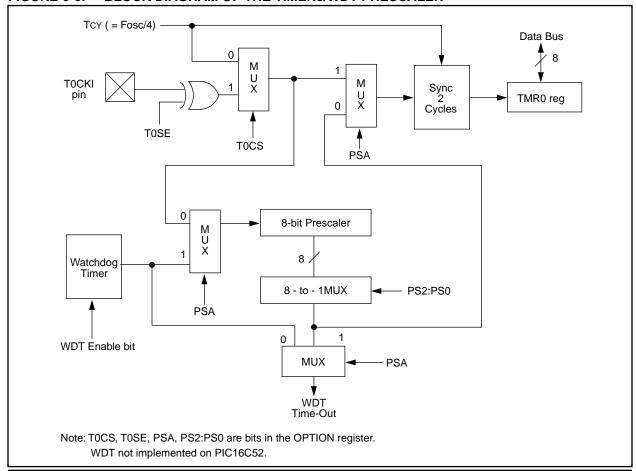
### EXAMPLE 6-2: CHANGING PRESCALER (WDT→TIMER0)

CLRWDT ;Clear WDT and ;prescaler

MOVLW 'xxxx0xxx' ;Select TMR0, new ;prescale value and ;clock source

OPTION

FIGURE 6-6: BLOCK DIAGRAM OF THE TIMERO/WDT PRESCALER



### 7.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits that deal with the needs of real-time applications. The PIC16C5X family of microcontrollers has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These features are:

- · Oscillator selection
- Reset
- · Power-On Reset (POR)
- Device Reset Timer (DRT)
- Watchdog Timer (WDT) (not implemented on PIC16C52)
- SLEEP
- · Code protection
- ID locations (not implemented on PIC16C52)

The PIC16C5X Family has a Watchdog Timer which can be shut off only through configuration bit WDTE. It runs off of its own RC oscillator for added reliability. There is an 18 ms delay provided by the Device Reset Timer (DRT), intended to keep the chip in reset until the crystal oscillator is stable. With this timer on-chip, most applications need no external reset circuitry.

The SLEEP mode is designed to offer a very low current power-down mode. The user can wake up from SLEEP through external reset or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

### 7.1 Configuration Bits

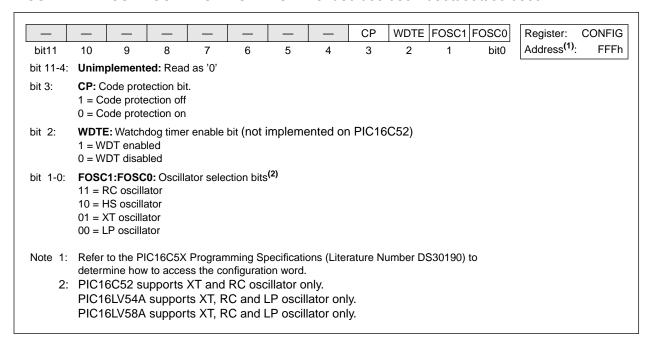
Configuration bits can be programmed to select various device configurations. Two bits are for the selection of the oscillator type and one bit is the Watchdog Timer enable bit. Nine bits are code protection bits (Figure 7-1 and Figure 7-2) for the PIC16C54, PIC16CR54, PIC16CR56, PIC16CR56, PIC16CR58, and PIC16CR58 devices.

QTP or ROM devices have the oscillator configuration programmed at the factory and these parts are tested accordingly (see "Product Identification System" diagrams in the back of this data sheet).

FIGURE 7-1: CONFIGURATION WORD FOR PIC16CR54A/C54B/CR54B/C56A/CR56A/CR57B/C58B/CR58A/CR58B

| СР        | СР   | СР | СР | СР | СР | СР | СР | СР | WDTE | FOSC1 | FOSC0 | Register:                | CONFIG |
|-----------|--|----|----|----|----|----|----|----|------|-------|-------|--------------------------|--------|
| bit11     | 10   | 9  | 8  | 7  | 6  | 5  | 4  | 3  | 2    | 1     | bit0  | Address <sup>(1)</sup> : |        |
| bit 11-3: | 3: <b>CP:</b> Code protection bits 1 = Code protection off 0 = Code protection on  |    |    |    |    |    |    |    |      |       |       |                          |        |
| bit 2:    | WDTE: Watchdog timer enable bit 1 = WDT enabled 0 = WDT disabled   |    |    |    |    |    |    |    |      |       |       |                          |        |
| bit 1-0:  | FOSC1:FOSC0: Oscillator selection bits  11 = RC oscillator  10 = HS oscillator  01 = XT oscillator  00 = LP oscillator                             |    |    |    |    |    |    |    |      |       |       |                          |        |
| Note 1:   | <ol> <li>Refer to the PIC16C5X Programming Specification (Literature Number DS30190) to determine how to access the configuration word.</li> </ol> |    |    |    |    |    |    |    |      |       |       |                          |        |

### FIGURE 7-2: CONFIGURATION WORD FOR PIC16C52/C54/C54A/C55/C56/C57/C58A



### 7.2 Oscillator Configurations

### 7.2.1 OSCILLATOR TYPES

PIC16C5Xs can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1:FOSC0) to select one of these four modes:

LP: Low Power CrystalXT: Crystal/Resonator

• HS: High Speed Crystal/Resonator

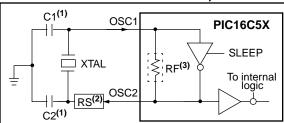
RC: Resistor/Capacitor

**Note:** Not all oscillator selections available for all parts. See Section 7.1.

### 7.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 7-3). The PIC16C5X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source drive the OSC1/CLKIN pin (Figure 7-4).

FIGURE 7-3: CRYSTAL OPERATION
(OR CERAMIC RESONATOR)
(HS, XT OR LP OSC
CONFIGURATION)



Note 1: See Capacitor Selection tables for recommended values of C1 and C2.

- A series resistor (RS) may be required for AT strip cut crystals.
- 3: RF varies with the crystal chosen (approx. value = 10  $M\Omega$ ).

FIGURE 7-4: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)

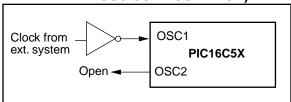


TABLE 7-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS - PIC16C5X, PIC16CR5X

| Osc<br>Type | Resonator<br>Freq | Cap. Range<br>C1 | Cap. Range<br>C2 |
|-------------|-------------------|------------------|------------------|
| XT          | 455 kHz           | 22-100 pF        | 22-100 pF        |
|             | 2.0 MHz           | 15-68 pF         | 15-68 pF         |
|             | 4.0 MHz           | 15-68 pF         | 15-68 pF         |
| HS          | 4.0 MHz           | 15-68 pF         | 15-68 pF         |
|             | 8.0 MHz           | 10-68 pF         | 10-68 pF         |
|             | 16.0 MHz          | 10-22 pF         | 10-22 pF         |

These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

TABLE 7-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR - PIC16C5X. PIC16CR5X

|             |                       | 10000, 1101     |                  |
|-------------|-----------------------|-----------------|------------------|
| Osc<br>Type | Resonator<br>Freq     | Cap.Range<br>C1 | Cap. Range<br>C2 |
| LP          | 32 kHz <sup>(1)</sup> | 15 pF           | 15 pF            |
|             | 100 kHz               | 15-30 pF        | 30-47 pF         |
|             | 200 kHz               | 15-30 pF        | 15-82 pF         |
| XT          | 100 kHz               | 15-30 pF        | 200-300 pF       |
|             | 200 kHz               | 15-30 pF        | 100-200 pF       |
|             | 455 kHz               | 15-30 pF        | 15-100 pF        |
|             | 1 MHz                 | 15-30 pF        | 15-30 pF         |
|             | 2 MHz                 | 15-30 pF        | 15-30 pF         |
|             | 4 MHz                 | 15-47 pF        | 15-47 pF         |
| HS          | 4 MHz                 | 15-30 pF        | 15-30 pF         |
|             | 8 MHz                 | 15-30 pF        | 15-30 pF         |
|             | 20 MHz                | 15-30 pF        | 15-30 pF         |

Note 1: For VDD > 4.5V, C1 =  $C2 \approx 30$  pF is recommended.

These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

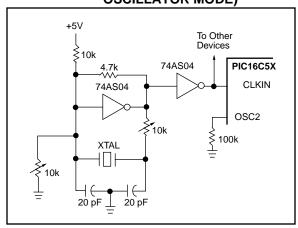
Note: If you change from this device to another device, please verify oscillator characteristics in your application.

### 7.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator or a simple oscillator circuit with TTL gates can be used as an external crystal oscillator circuit. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used: one with parallel resonance, or one with series resonance.

Figure 7-5 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k $\Omega$  resistor provides the negative feedback for stability. The 10 k $\Omega$  potentiometers bias the 74AS04 in the linear region. This circuit could be used for external oscillator designs.

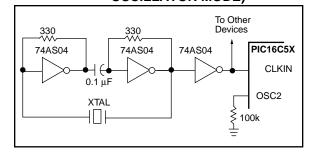
FIGURE 7-5: EXTERNAL PARALLEL
RESONANT CRYSTAL
OSCILLATOR CIRCUIT
(USING XT, HS OR LP
OSCILLATOR MODE)



Note: If you change from this device to another device, please verify oscillator characteristics in your application.

This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330  $\Omega$  resistors provide the negative feedback to bias the inverters in their linear region.

# FIGURE 7-6: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT (USING XT, HS OR LP OSCILLATOR MODE)



Note: If you change from this device to another device, please verify oscillator characteristics in your application.

#### 7.2.4 RC OSCILLATOR

For timing insensitive applications, the RC device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used.

Figure 7-7 shows how the R/C combination is connected to the PIC16C5X. For Rext values below 2.2 k $\Omega$ , the oscillator operation may become unstable, or stop completely. For very high Rext values (e.g., 1 M $\Omega$ ) the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend keeping Rext between 3 k $\Omega$  and 100 k $\Omega$ .

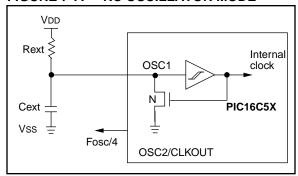
Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

The Electrical Specifications sections show RC frequency variation from part to part due to normal process variation.

Also, see the Electrical Specifications sections for variation of oscillator frequency due to VDD for given Rext/Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic.

FIGURE 7-7: RC OSCILLATOR MODE



Note: If you change from this device to another device, please verify oscillator characteristics in your application.

### 7.3 Reset

PIC16C5X devices may be reset in one of the following ways:

- Power-On Reset (POR)
- MCLR reset (normal operation)
- MCLR wake-up reset (from SLEEP)
- WDT reset (normal operation)
- WDT wake-up reset (from SLEEP)

Table 7-3 shows these reset conditions for the PCL and STATUS registers.

Some registers are not affected in any reset condition. Their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on Power-On Reset (POR), MCLR or WDT reset. A MCLR or WDT wake-up from SLEEP also results in a device reset, and not a continuation of operation before SLEEP.

The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits (STATUS <4:3>) are set or cleared depending on the different reset conditions (Section 7.7). These bits may be used to determine the nature of the reset.

Table 7-4 lists a full description of reset states of all registers. Figure 7-8 shows a simplified block diagram of the on-chip reset circuit.

TABLE 7-3: RESET CONDITIONS FOR SPECIAL REGISTERS

| Condition                     | PCL<br>Addr: 02h | STATUS<br>Addr: 03h  |
|-------------------------------|------------------|----------------------|
| Power-On Reset                | 1111 1111        | 0001 1xxx            |
| MCLR reset (normal operation) | 1111 1111        | 000u uuuu(1)         |
| MCLR wake-up (from SLEEP)     | 1111 1111        | 0001 0uuu            |
| WDT reset (normal operation)  | 1111 1111        | 0000 1uuu <b>(2)</b> |
| WDT wake-up (from SLEEP)      | 1111 1111        | 0000 0uuu            |

Legend: u = unchanged, x = unknown, - = unimplemented read as '0'.

Note 1: TO and PD bits retain their last value until one of the other reset conditions occur.

2: The CLRWDT instruction will set the  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits.

TABLE 7-4: RESET CONDITIONS FOR ALL REGISTERS

| Register                       | Address | Power-On Reset | MCLR or WDT Reset |
|--------------------------------|---------|----------------|-------------------|
| W                              | N/A     | xxxx xxxx      | uuuu uuuu         |
| TRIS                           | N/A     | 1111 1111      | 1111 1111         |
| OPTION                         | N/A     | 11 1111        | 11 1111           |
| INDF                           | 00h     | xxxx xxxx      | uuuu uuuu         |
| TMR0                           | 01h     | xxxx xxxx      | uuuu uuuu         |
| PCL <sup>(1)</sup>             | 02h     | 1111 1111      | 1111 1111         |
| STATUS <sup>(1)</sup>          | 03h     | 0001 1xxx      | 000q quuu         |
| FSR                            | 04h     | 1xxx xxxx      | luuu uuuu         |
| PORTA                          | 05h     | xxxx           | uuuu              |
| PORTB                          | 06h     | xxxx xxxx      | uuuu uuuu         |
| PORTC <sup>(2)</sup>           | 07h     | xxxx xxxx      | uuuu uuuu         |
| General Purpose Register Files | 07-7Fh  | xxxx xxxx      | uuuu uuuu         |

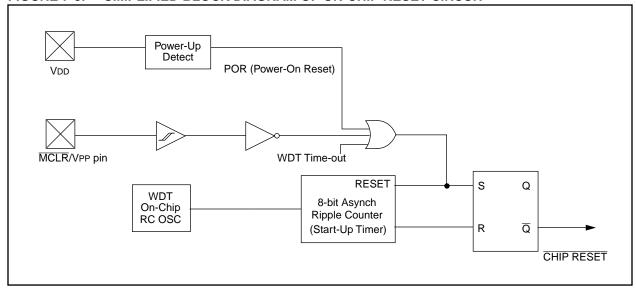
Legend: u = unchanged, x = unknown, - = unimplemented, read as '0',

q = see tables in Section 7.7 for possible values.

Note 1: See Table 7-3 for reset value for specific conditions.

2: General purpose register file on PIC16C52/C54s/CR54s/C56s/CR56s/C58s/CR58s

FIGURE 7-8: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



### 7.4 Power-On Reset (POR)

The PIC16C5X family incorporates on-chip Power-On Reset (POR) circuitry which provides an internal chip reset for most power-up situations. To use this feature, the user merely ties the MCLR/VPP pin to VDD. A simplified block diagram of the on-chip Power-On Reset circuit is shown in Figure 7-8.

The Power-On Reset circuit and the Device Reset Timer (Section 7.5) circuit are closely related. On power-up, the reset latch is set and the DRT is reset. The DRT timer begins counting once it detects MCLR to be high. After the time-out period, which is typically 18 ms, it will reset the reset latch and thus end the on-chip reset signal.

A power-up example where  $\overline{MCLR}$  is not tied to VDD is shown in Figure 7-10. VDD is allowed to rise and stabilize before bringing  $\overline{MCLR}$  high. The chip will actually come out of reset TDRT msec after  $\overline{MCLR}$  goes high.

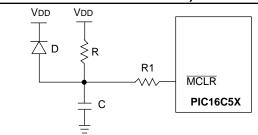
In Figure 7-11, the on-chip Power-On Reset feature is being used (MCLR and VDD are tied together). The VDD is stable before the start-up timer times out and there is no problem in getting a proper reset. However, Figure 7-12 depicts a problem situation where VDD rises too slowly. The time between when the DRT senses a high on the MCLR/VPP pin, and when the MCLR/VPP pin (and VDD) actually reach their full value, is too long. In this situation, when the start-up timer times out, VDD has not reached the VDD (min) value and the chip is, therefore, not guaranteed to function correctly. For such situations, we recommend that external RC circuits be used to achieve longer POR delay times (Figure 7-9).

Note: When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be meet to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For more information on PIC16C5X POR, see *Power-Up Considerations* - AN522 in the <u>Embedded Control Handbook</u>.

The POR circuit does not produce an internal reset when VDD declines.

FIGURE 7-9: EXTERNAL POWER-ON
RESET CIRCUIT (FOR SLOW
VDD POWER-UP)



- External Power-On Reset circuit is required only if VDD power-up is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
- R < 40 kΩ is recommended to make sure that voltage drop across R does not violate the device electrical specification.
- R1 =  $100\Omega$  to 1 k $\Omega$  will limit any current flowing into  $\overline{MCLR}$  from external capacitor C in the event of  $\overline{MCLR}$  pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

© 1997 Microchip Technology Inc. Preliminary DS30453A-page 37

FIGURE 7-10: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD)

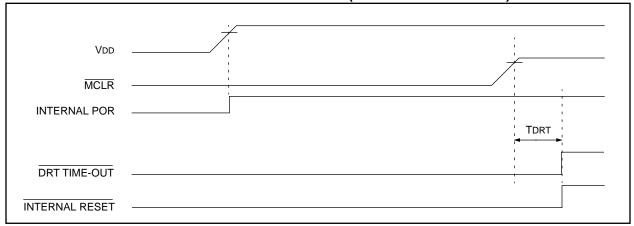


FIGURE 7-11: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): FAST VDD RISE TIME

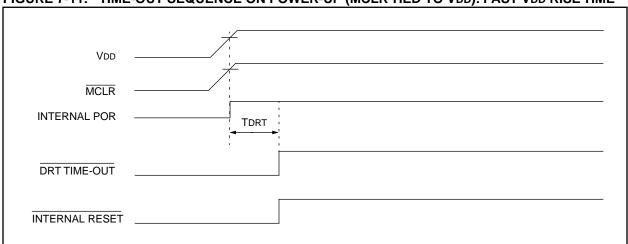
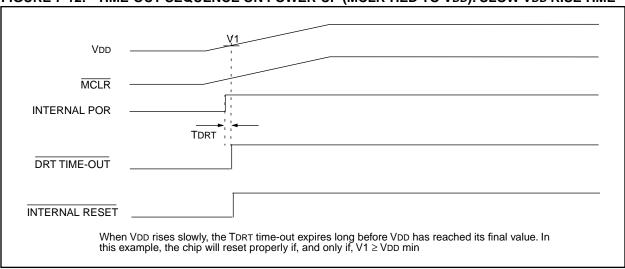


FIGURE 7-12: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): SLOW VDD RISETIME



### 7.5 Device Reset Timer (DRT)

The Device Reset Timer (DRT) provides a fixed 18 ms nominal time-out on reset. The DRT operates on an internal RC oscillator. The processor is kept in RESET as long as the DRT is active. The DRT delay allows VDD to rise above VDD min., and for the oscillator to stabilize.

Oscillator circuits based on crystals or ceramic resonators require a certain time after power-up to establish a stable oscillation. The on-chip DRT keeps the device in a RESET condition for approximately 18 ms after the voltage on the MCLR/VPP pin has reached a logic high (VIH) level. Thus, external RC networks connected to the MCLR input are not required in most cases, allowing for savings in cost-sensitive and/or space restricted applications.

The Device Reset time delay will vary from chip to chip due to VDD, temperature, and process variation. See AC parameters for details.

The DRT will also be triggered upon a Watchdog Timer time-out. This is particularly important for applications using the WDT to wake the PIC16C5X from SLEEP mode automatically.

# 7.6 <u>Watchdog Timer (WDT) (not implemented on PIC16C52)</u>

The Watchdog Timer (WDT) is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run even if the clock on the OSC1/CLKIN and OSC2/CLKOUT pins have been stopped, for example, by execution of a SLEEP instruction. During normal operation or SLEEP, a WDT reset or wake-up reset generates a device RESET.

The  $\overline{\text{TO}}$  bit (STATUS<4>) will be cleared upon a Watchdog Timer reset.

The WDT can be permanently disabled by programming the configuration bit WDTE as a '0' (Section 7.1). Refer to the PIC16C5X Programming Specifications (Literature Number DS30190) to determine how to access the configuration word.

#### 7.6.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). If a longer time-out period is desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT (under software control) by writing to the OPTION register. Thus, time-out a period of a nominal 2.3 seconds can be realized. These periods vary with temperature, VDD and part-to-part process variations (see DC specs).

Under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT time-out occurs.

### 7.6.2 WDT PROGRAMMING CONSIDERATIONS

The CLRWDT instruction clears the WDT and the postscaler, if assigned to the WDT, and prevents it from timing out and generating a device RESET.

The SLEEP instruction resets the WDT and the postscaler, if assigned to the WDT. This gives the maximum SLEEP time before a WDT wake-up reset.

© 1997 Microchip Technology Inc. **Preliminary** DS30453A-page 39

FIGURE 7-13: WATCHDOG TIMER BLOCK DIAGRAM

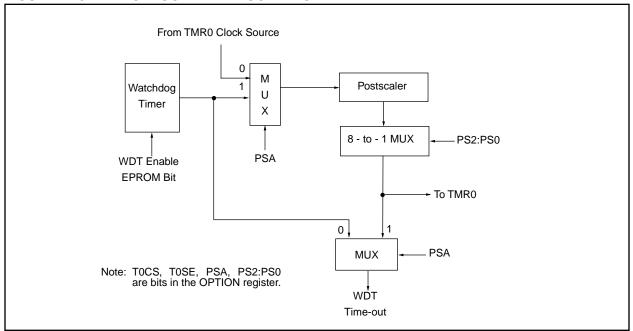


TABLE 7-5: SUMMARY OF REGISTERS ASSOCIATED WITH THE WATCHDOG TIMER

| Address | Name   | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on<br>Power-On<br>Reset | Value on MCLR and WDT Reset |
|---------|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------------------|-----------------------------|
| N/A     | OPTION | _     | _     | T0CS  | T0SE  | PSA   | PS2   | PS1   | PS0   | 11 1111                       | 11 1111                     |

 $\begin{array}{ll} \mbox{Legend:} & \mbox{Shaded boxes} = \mbox{Not used by Watchdog Timer,} \\ & - = \mbox{unimplemented, read as '0', $u$} = \mbox{unchanged} \\ \end{array}$ 

# 7.7 <u>Time-Out Sequence and Power Down</u> Status Bits (TO/PD)

The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits in the STATUS register can be tested to determine if a RESET condition has been caused by a power-up condition, a  $\overline{\text{MCLR}}$  or Watchdog Timer (WDT) reset, or a  $\overline{\text{MCLR}}$  or WDT wake-up reset.

TABLE 7-6: TO/PD STATUS AFTER RESET

| TO | PD | RESET was caused by              |
|----|----|----------------------------------|
| 1  | 1  | Power-up (POR)                   |
| u  | u  | MCLR reset (normal operation)(1) |
| 1  | 0  | MCLR wake-up reset (from SLEEP)  |
| 0  | 1  | WDT reset (normal operation)     |
| 0  | 0  | WDT wake-up reset (from SLEEP)   |

Legend: u = unchanged

Note 1: The TO and PD bits maintain their status (u) until a reset occurs. A low-pulse on the MCLR input does not change the TO and PD status bits.

These STATUS bits are only affected by events listed in Table 7-7.

TABLE 7-7: EVENTS AFFECTING TO/PD STATUS BITS

| Event              | TO | PD | Remarks         |
|--------------------|----|----|-----------------|
| Power-up           | 1  | 1  |                 |
| WDT Time-out       | 0  | u  | No effect on PD |
| SLEEP instruction  | 1  | 0  |                 |
| CLRWDT instruction | 1  | 1  |                 |

Legend: u = unchanged

A WDT time-out will occur regardless of the status of the  $\overline{\text{TO}}$  bit. A SLEEP instruction will be executed, regardless of the status of the  $\overline{\text{PD}}$  bit. Table 7-6 reflects the status of  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  after the corresponding event.

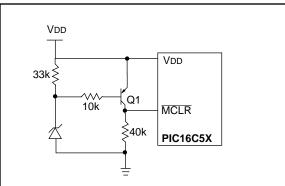
Table 7-3 lists the reset conditions for the special function registers, while Table 7-4 lists the reset conditions for all the registers.

#### 7.8 Reset on Brown-Out

A brown-out is a condition where device power (VDD) dips below its minimum value, but not to zero, and then recovers. The device should be reset in the event of a brown-out.

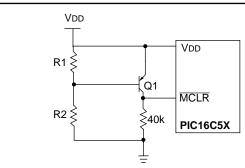
To reset PIC16C5X devices when a brown-out occurs, external brown-out protection circuits may be built, as shown in Figure 7-14 and Figure 7-15.

FIGURE 7-14: BROWN-OUT PROTECTION CIRCUIT 1



This circuit will activate reset when VDD goes below Vz + 0.7V (where Vz = Zener voltage).

# FIGURE 7-15: BROWN-OUT PROTECTION CIRCUIT 2



This brown-out circuit is less expensive, although less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

### 7.9 Power-Down Mode (SLEEP)

A device may be powered down (SLEEP) and later powered up (Wake-up from SLEEP).

#### 7.9.1 SLEEP

The Power-Down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the  $\overline{\text{TO}}$  bit (STATUS<4>) is set, the  $\overline{\text{PD}}$  bit (STATUS<3>) is cleared and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, driving low, or hi-impedance).

It should be noted that a RESET generated by a WDT time-out does not drive the MCLR/VPP pin low.

For lowest current consumption while powered down, the T0CKI input should be at VDD or Vss and the MCLR/VPP pin must be at a logic high level (VIH MCLR).

#### 7.9.2 WAKE-UP FROM SLEEP

The device can wake up from SLEEP through one of the following events:

- 1. An external reset input on MCLR/VPP pin.
- A Watchdog Timer time-out reset (if WDT was enabled).

Both of these events cause a device reset. The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits can be used to determine the cause of device reset. The  $\overline{\text{TO}}$  bit is cleared if a WDT time-out occurred (and caused wake-up). The  $\overline{\text{PD}}$  bit, which is set on power-up, is cleared when SLEEP is invoked.

The WDT is cleared when the device wakes from sleep, regardless of the wake-up source.

### 7.10 Program Verification/Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

**Note:** Microchip does not recommend code protecting windowed devices.

# 7.11 <u>ID Locations (not implemented on PIC16C52)</u>

Four memory locations are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify.

Use only the lower 4 bits of the ID locations and always program the upper 8 bits as '1's.

Note: Microchip will assign a unique pattern number for QTP and SQTP requests and for ROM devices. This pattern number will be unique and traceable to the submitted

### 8.0 INSTRUCTION SET SUMMARY

Each PIC16C5X instruction is a 12-bit word divided into an OPCODE, which specifies the instruction type, and one or more operands which further specify the operation of the instruction. The PIC16C5X instruction set summary in Table 8-2 groups the instructions into byte-oriented, bit-oriented, and literal and control operations. Table 8-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator is used to specify which one of the 32 file registers is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8 or 9-bit constant or literal value.

TABLE 8-1: OPCODE FIELD DESCRIPTIONS

| Field         | Description  |
|---------------|--|
| f             | Register file address (0x00 to 0x7F)   |
| W             | Working register (accumulator)   |
| b             | Bit address within an 8-bit file register  |
| k             | Literal field, constant data or label  |
| x             | Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools. |
| d             | Destination select; d = 0 (store result in W) d = 1 (store result in file register 'f') Default is d = 1   |
| label         | Label name   |
| TOS           | Top of Stack   |
| PC            | Program Counter  |
| WDT           | Watchdog Timer Counter   |
| TO            | Time-Out bit   |
| PD            | Power-Down bit   |
| dest          | Destination, either the W register or the specified register file location   |
| []            | Options  |
| ( )           | Contents   |
| $\rightarrow$ | Assigned to  |
| <>            | Register bit field   |
| €             | In the set of  |
| italics       | User defined term (font is courier)  |

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1  $\mu s$ . If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2  $\mu s$ .

Figure 8-1 shows the three general formats that the instructions can have. All examples in the figure use the following format to represent a hexadecimal number:

0xhhh

where 'h' signifies a hexadecimal digit.

# FIGURE 8-1: GENERAL FORMAT FOR INSTRUCTIONS

| INSTRU   | CHONS                                  |  |  |  |  |  |  |
|--|--|--|--|--|--|--|--|
| Byte-oriented file register o  | Byte-oriented file register operations |  |  |  |  |  |  |
| 11 6 5   | 4 0                                    |  |  |  |  |  |  |
| OPCODE d   | f (FILE #)                             |  |  |  |  |  |  |
| d = 0 for destination W d = 1 for destination f f = 5-bit file register address      |  |  |  |  |  |  |  |
| Bit-oriented file register ope   | erations                               |  |  |  |  |  |  |
| 11 8 7   | 5 4 0                                  |  |  |  |  |  |  |
| OPCODE b (B  | IT #) f (FILE #)                       |  |  |  |  |  |  |
| b = 3-bit bit address<br>f = 5-bit file register ad<br>Literal and control operation |  |  |  |  |  |  |  |
| 11 8   | 7 0                                    |  |  |  |  |  |  |
| OPCODE   | k (literal)                            |  |  |  |  |  |  |
| k = 8-bit immediate va   | k = 8-bit immediate value              |  |  |  |  |  |  |
| Literal and control operations - GOTO instruction                                    |  |  |  |  |  |  |  |
| 11 9   | 8 0                                    |  |  |  |  |  |  |
| OPCODE k (literal)   |  |  |  |  |  |  |  |
| k = 9-bit immediate value  |  |  |  |  |  |  |  |

© 1997 Microchip Technology Inc. Preliminary DS30453A-page 43

TABLE 8-2: INSTRUCTION SET SUMMARY

| Mnemonic, |         |                              | 12-Bit Opcode |      | ode  | Status |          |       |
|-----------|---------|------------------------------|---------------|------|------|--------|----------|-------|
| Operar    |         | Description                  | Cycles        | MSb  |      | LSb    | Affected | Notes |
| ADDWF     | f,d     | Add W and f                  | 1             | 0001 | 11df | ffff   | C,DC,Z   | 1,2,4 |
| ANDWF     | f,d     | AND W with f                 | 1             | 0001 | 01df | ffff   | Z        | 2,4   |
| CLRF      | f       | Clear f                      | 1             | 0000 | 011f | ffff   | Z        | 4     |
| CLRW      | _       | Clear W                      | 1             | 0000 | 0100 | 0000   | Z        |       |
| COMF      | f, d    | Complement f                 | 1             | 0010 | 01df | ffff   | Z        |       |
| DECF      | f, d    | Decrement f                  | 1             | 0000 | 11df | ffff   | Z        | 2,4   |
| DECFSZ    | f, d    | Decrement f, Skip if 0       | 1(2)          | 0010 | 11df | ffff   | None     | 2,4   |
| INCF      | f, d    | Increment f                  | 1             | 0010 | 10df | ffff   | Z        | 2,4   |
| INCFSZ    | f, d    | Increment f, Skip if 0       | 1(2)          | 0011 | 11df | ffff   | None     | 2,4   |
| IORWF     | f, d    | Inclusive OR W with f        | 1             | 0001 | 00df | ffff   | Z        | 2,4   |
| MOVF      | f, d    | Move f                       | 1             | 0010 | 00df | ffff   | Z        | 2,4   |
| MOVWF     | f       | Move W to f                  | 1             | 0000 | 001f | ffff   | None     | 1,4   |
| NOP       | _       | No Operation                 | 1             | 0000 | 0000 | 0000   | None     |       |
| RLF       | f, d    | Rotate left f through Carry  | 1             | 0011 | 01df | ffff   | С        | 2,4   |
| RRF       | f, d    | Rotate right f through Carry | 1             | 0011 | 00df | ffff   | С        | 2,4   |
| SUBWF     | f, d    | Subtract W from f            | 1             | 0000 | 10df | ffff   | C,DC,Z   | 1,2,4 |
| SWAPF     | f, d    | Swap f                       | 1             | 0011 | 10df | ffff   | None     | 2,4   |
| XORWF     | f, d    | Exclusive OR W with f        | 1             | 0001 | 10df | ffff   | Z        | 2,4   |
| BIT-ORIEN | TED FIL | E REGISTER OPERATIONS        |               |      |      |        |          |       |
| BCF       | f, b    | Bit Clear f                  | 1             | 0100 | bbbf | ffff   | None     | 2,4   |
| BSF       | f, b    | Bit Set f                    | 1             | 0101 | bbbf | ffff   | None     | 2,4   |
| BTFSC     | f, b    | Bit Test f, Skip if Clear    | 1 (2)         | 0110 | bbbf | ffff   | None     |       |
| BTFSS     | f, b    | Bit Test f, Skip if Set      | 1 (2)         | 0111 | bbbf | ffff   | None     |       |
| LITERAL A | ND CO   | NTROL OPERATIONS             |               |      |      |        |          |       |
| ANDLW     | k       | AND literal with W           | 1             | 1110 | kkkk | kkkk   | Z        |       |
| CALL      | k       | Call subroutine              | 2             | 1001 | kkkk | kkkk   | None     | 1     |
| CLRWDT    | k       | Clear Watchdog Timer         | 1             | 0000 | 0000 | 0100   | TO, PD   |       |
| GOTO      | k       | Unconditional branch         | 2             | 101k | kkkk | kkkk   | None     |       |
| IORLW     | k       | Inclusive OR Literal with W  | 1             | 1101 | kkkk | kkkk   | Z        |       |
| MOVLW     | k       | Move Literal to W            | 1             | 1100 | kkkk | kkkk   | None     |       |
| OPTION    | k       | Load OPTION register         | 1             | 0000 | 0000 | 0010   | None     |       |
| RETLW     | k       | Return, place Literal in W   | 2             | 1000 | kkkk | kkkk   | None     |       |
| SLEEP     | _       | Go into standby mode         | 1             | 0000 | 0000 | 0011   | TO, PD   |       |
| TRIS      | f       | Load TRIS register           | 1             | 0000 | 0000 | Offf   | None     | 3     |
| XORLW     | k       | Exclusive OR Literal to W    | 1             | 1111 | kkkk | kkkk   | Z        |       |

Note 1: The 9th bit of the program counter will be forced to a '0' by any instruction that writes to the PC except for GOTO. (See individual device data sheets, Memory Section/Indirect Data Addressing, INDF and FSR Registers)

<sup>2:</sup> When an I/O register is modified as a function of itself (e.g. MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

<sup>3:</sup> The instruction TRIS f, where f = 5 or 6 causes the contents of the W register to be written to the tristate latches of PORTA or B respectively. A '1' forces the pin to a hi-impedance state and disables the output buffers.

<sup>4:</sup> If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared (if assigned to TMR0).

| ADDWF                         | Add W and f   |  |  |  |  |  |
|-------------------------------|---|--|--|--|--|--|
| Syntax:                       | [ label ] ADDWF f,d   |  |  |  |  |  |
| Operands:                     | $0 \le f \le 31$<br>$d \in [0,1]$   |  |  |  |  |  |
| Operation:                    | $(W) + (f) \to (dest)$  |  |  |  |  |  |
| Status Affected:              | C, DC, Z  |  |  |  |  |  |
| Encoding:                     | 0001 11df ffff  |  |  |  |  |  |
| Description:                  | Add the contents of the W register and register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is '1' the result is stored back in register 'f'. |  |  |  |  |  |
| Words:                        | 1   |  |  |  |  |  |
| Cycles:                       | 1   |  |  |  |  |  |
| Example:                      | ADDWF FSR, 0  |  |  |  |  |  |
| Before Instru<br>W =<br>FSR = | 0x17  |  |  |  |  |  |
| After Instruct W = FSR =      | tion<br>0xD9<br>0xC2  |  |  |  |  |  |

| ANDLW                | And literal with W  |                   |      |  |  |  |  |
|----------------------|---|-------------------|------|--|--|--|--|
| Syntax:              | [ label ] ANDLW k   |                   |      |  |  |  |  |
| Operands:            | $0 \le k \le 255$   | $0 \le k \le 255$ |      |  |  |  |  |
| Operation:           | (W).AND. (k)  | $\rightarrow$ (V  | V)   |  |  |  |  |
| Status Affected:     | Z   |                   |      |  |  |  |  |
| Encoding:            | 1110 k  | ckk               | kkkk |  |  |  |  |
| Description:         | The contents of the W register are AND'ed with the eight-bit literal 'k'. The result is placed in the W register. |                   |      |  |  |  |  |
| Words:               | 1   |                   |      |  |  |  |  |
| Cycles:              | 1   |                   |      |  |  |  |  |
| Example:             | ANDLW 0x5   | 5F                |      |  |  |  |  |
| Before Instru        | iction  |                   |      |  |  |  |  |
| W =                  | 0xA3  |                   |      |  |  |  |  |
| After Instruc<br>W = | ion<br>0x03   |                   |      |  |  |  |  |

| ANDWF                          | AND W with f  |  |  |  |  |  |  |
|--------------------------------|---|--|--|--|--|--|--|
| Syntax:                        | [ label ] ANDWF f,d   |  |  |  |  |  |  |
| Operands:                      | $0 \le f \le 31$<br>$d \in [0,1]$   |  |  |  |  |  |  |
| Operation:                     | (W) .AND. (f) $\rightarrow$ (dest)  |  |  |  |  |  |  |
| Status Affected:               | Z   |  |  |  |  |  |  |
| Encoding:                      | 0001 01df ffff  |  |  |  |  |  |  |
| Description:                   | The contents of the W register are AND'ed with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is '1' the result is stored back in register 'f'. |  |  |  |  |  |  |
| Words:                         | 1   |  |  |  |  |  |  |
| Cycles:                        | 1   |  |  |  |  |  |  |
| Example:                       | ANDWF FSR, 1  |  |  |  |  |  |  |
| Before Instru<br>W =<br>FSR =  | 0x17  |  |  |  |  |  |  |
| After Instruct<br>W =<br>FSR = | ion<br>0x17<br>0x02   |  |  |  |  |  |  |

| BCF                                   | Bit Clear                           | r f            |          |  |  |
|---------------------------------------|-------------------------------------|----------------|----------|--|--|
| Syntax:                               | [ label ]                           | BCF f,b        | )        |  |  |
| Operands:                             | $0 \le f \le 31$<br>$0 \le b \le 7$ |                |          |  |  |
| Operation:                            | $0 \rightarrow (f < b$              | >)             |          |  |  |
| Status Affected:                      | None                                |                |          |  |  |
| Encoding:                             | 0100                                | bbbf           | ffff     |  |  |
| Description:                          | Bit 'b' in re                       | egister 'f' is | cleared. |  |  |
| Words:                                | 1                                   |                |          |  |  |
| Cycles:                               | 1                                   |                |          |  |  |
| Example:                              | BCF                                 | FLAG_REC       | 3, 7     |  |  |
| Before Instruction<br>FLAG_REG = 0xC7 |                                     |                |          |  |  |
| After Instruc                         | After Instruction                   |                |          |  |  |

 $FLAG_REG = 0x47$ 

| BSF                                   | Bit Set f                                    |                   |      |  |  |  |  |
|---------------------------------------|--|-------------------|------|--|--|--|--|
| Syntax:                               | [ label ]                                    | [ label ] BSF f,b |      |  |  |  |  |
| Operands:                             | $0 \le f \le 31$ $0 \le b \le 7$             |                   |      |  |  |  |  |
| Operation:                            | $1 \rightarrow (f < b >)$                    |                   |      |  |  |  |  |
| Status Affected:                      | : None                                       |                   |      |  |  |  |  |
| Encoding:                             | 0101   | bbbf              | ffff |  |  |  |  |
| Description:                          | Description: Bit 'b' in register 'f' is set. |                   |      |  |  |  |  |
| Words:                                | 1  |                   |      |  |  |  |  |
| Cycles:                               | Cycles: 1                                    |                   |      |  |  |  |  |
| Example:                              | ample: BSF FLAG_REG, 7                       |                   |      |  |  |  |  |
| Before Instruction<br>FLAG_REG = 0x0A |  |                   |      |  |  |  |  |
| After Instruction<br>FLAG_REG = 0x8A  |  |                   |      |  |  |  |  |

| BTFSC   | Bit Test f, Skip if Clear  |                                    |                        |  |  |  |
|---|--|------------------------------------|------------------------|--|--|--|
| Syntax:   | [ label ]  | BTFSC                              | f,b                    |  |  |  |
| Operands:   | $0 \le f \le 31$ $0 \le b \le 7$   |                                    |                        |  |  |  |
| Operation:  | skip if $(f < b >) = 0$  |                                    |                        |  |  |  |
| Status Affected:                                  | None   |                                    |                        |  |  |  |
| Encoding:   | 0110   | bbbf                               | ffff                   |  |  |  |
| Description:                                      | If bit 'b' in register 'f' is 0 then the next instruction is skipped.  If bit 'b' is 0 then the next instruction fetched during the current instruction execution is discarded, and an NOP is executed instead, making this a 2 cycle instruction. |                                    |                        |  |  |  |
| Words:  | 1  |                                    |                        |  |  |  |
| Cycles:   | 1(2)   |                                    |                        |  |  |  |
| Example:  | HERE<br>FALSE<br>TRUE  | BTFSC<br>GOTO<br>•                 | FLAG,1<br>PROCESS_CODE |  |  |  |
| Before Instru<br>PC                               | uction<br>=  | address (HERE)                     |                        |  |  |  |
| After Instruc<br>if FLAG<<br>PC<br>if FLAG<<br>PC | 1> = =   | 0,<br>address (<br>1,<br>address ( |                        |  |  |  |

| BTFSS                               | Bit Test f, Skip if Set   |  |
|-------------------------------------|---|--|
| Syntax:                             | [ label ] BTFSS f,b   |  |
| Operands:                           | $0 \le f \le 31$<br>$0 \le b < 7$   |  |
| Operation:                          | skip if $(f < b >) = 1$   |  |
| Status Affected:                    | None  |  |
| Encoding:                           | 0111 bbbf ffff  |  |
| Description:                        | If bit 'b' in register 'f' is '1' then the next instruction is skipped.  If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and an NOP is executed instead, making this a 2 cycle instruction. |  |
| Words:                              | 1   |  |
| Cycles:                             | 1(2)  |  |
| Example:                            | HERE BTFSS FLAG,1 FALSE GOTO PROCESS_CODE TRUE •  |  |
| Before Instru                       | ection  |  |
| PC PC                               | = address (HERE)  |  |
| After Instruct If FLAG< PC If FLAG< | ion<br>1> = 0,<br>= address (FALSE);<br>1> = 1,   |  |
| PC                                  | = address (TRUE)  |  |
|                                     |   |  |

| CALL                  | Subroutine Call  |  |  |
|-----------------------|--|--|--|
| Syntax:               | [ label ] CALL k   |  |  |
| Operands:             | $0 \le k \le 255$  |  |  |
| Operation:            | (PC) + 1 $\rightarrow$ Top of Stack;<br>k $\rightarrow$ PC<7:0>;<br>(STATUS<6:5>) $\rightarrow$ PC<10:9>;<br>0 $\rightarrow$ PC<8>   |  |  |
| Status Affected:      | None   |  |  |
| Encoding:             | 1001 kkkk kkkk   |  |  |
| Description:          | Subroutine call. First, return address (PC+1) is pushed onto the stack. The eight bit immediate address is loaded into PC bits <7:0>. The upper bits PC<10:9> are loaded from STA-TUS<6:5>, PC<8> is cleared. CALL is a two cycle instruction. |  |  |
| Words:                | 1  |  |  |
| Cycles:               | 2  |  |  |
| Example:              | HERE CALL THERE  |  |  |
| Before Instru<br>PC = | action address (HERE)  |  |  |
|                       | tion address (THERE) address (HERE + 1)  |  |  |

| CLRF                         | Cle   | ar f   |                                 |              |         |
|------------------------------|-------|--|---------------------------------|--------------|---------|
| Syntax:                      | [ lab | [ label ] CLRF f   |                                 |              |         |
| Operands:                    | 0 ≤   | f ≤ 3  | 1                               |              |         |
| Operation:                   |       | $\begin{array}{l} 00h \rightarrow (f); \\ 1 \rightarrow Z \end{array}$ |                                 |              |         |
| Status Affected:             | Z     |  |                                 |              |         |
| Encoding:                    | 00    | 00   | 011f                            | ffff         |         |
| Description:                 |       |  | ents of registation bit is set. | ster 'f' are | cleared |
| Words:                       | 1     |  |                                 |              |         |
| Cycles:                      | 1     |  |                                 |              |         |
| Example:                     | CLR   | F  | FLAG_REC                        | 3            |         |
| Before Instru<br>FLAG_R      |       |  | 0x5A                            |              |         |
| After Instruc<br>FLAG_R<br>7 |       | =  | 0x00                            |              |         |

| CLRW                 | Clear W  |  |  |
|----------------------|--|--|--|
| Syntax:              | [label] CLRW   |  |  |
| Operands:            | None   |  |  |
| Operation:           | $\begin{array}{l} 00h \rightarrow (W); \\ 1 \rightarrow Z \end{array}$ |  |  |
| Status Affected:     | Z  |  |  |
| Encoding:            | 0000 0100 0000   |  |  |
| Description:         | The W register is cleared. Zero bit (Z) is set.                        |  |  |
| Words:               | 1  |  |  |
| Cycles:              | 1  |  |  |
| Example:             | CLRW   |  |  |
| Before Instru<br>W = | uction<br>0x5A   |  |  |
| After Instruc        | tion   |  |  |
| W = Z =              | 0x00<br>1  |  |  |

| CLRWDT                              | Clear Wa   | atchdog 1  | Γimer                    |                      |
|-------------------------------------|--|--|--------------------------|----------------------|
| Syntax:                             | [ label ]  | CLRWD  | Γ                        |                      |
| Operands:                           | None   |  |                          |                      |
| Operation:                          | $\begin{array}{l} \text{00h} \rightarrow \text{WDT}; \\ \text{0} \rightarrow \text{WDT prescaler (if assigned)}; \\ \text{1} \rightarrow \overline{\text{TO}}; \\ \text{1} \rightarrow \overline{\text{PD}} \end{array}$ |  | gned);                   |                      |
| Status Affected:                    | TO, PD   |  |                          |                      |
| Encoding:                           | 0000   | 0000   | 0100                     |                      |
| Description:                        | WDT. It als<br>prescaler   | NDT instruction in in | he prescal<br>d to the W | er, if the<br>DT and |
| Words:                              | 1  |  |                          |                      |
| Cycles:                             | 1  |  |                          |                      |
| Example:                            | CLRWDT   |  |                          |                      |
| Before Instru<br>WDT cou            |  | ?  |                          |                      |
| After Instruc WDT cou WDT pre TO PD | unter =  | 0x00<br>0<br>1   |                          |                      |

| COMF                       | Complement f  |  |  |
|----------------------------|---|--|--|
| Syntax:                    | [ label ] COMF f,d  |  |  |
| Operands:                  | $0 \le f \le 31$<br>$d \in [0,1]$   |  |  |
| Operation:                 | $(\bar{f}) 	o (dest)$   |  |  |
| Status Affected:           | Z   |  |  |
| Encoding:                  | 0010 01df ffff  |  |  |
| Description:               | The contents of register 'f' are complemented. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'. |  |  |
| Words:                     | 1   |  |  |
| Cycles:                    | 1   |  |  |
| Example:                   | COMF REG1,0   |  |  |
| Before Instru<br>REG1      | ection = 0x13   |  |  |
| After Instruc<br>REG1<br>W | ion<br>= 0x13<br>= 0xEC   |  |  |

| DECF                      | Decreme  | ent f                             |      |  |
|---------------------------|--|-----------------------------------|------|--|
| Syntax:                   | [ label ]  | [ label ] DECF f,d                |      |  |
| Operands:                 | $0 \le f \le 3^{n}$ $d \in [0,1]$  | $0 \le f \le 31$<br>$d \in [0,1]$ |      |  |
| Operation:                | $(f) - 1 \rightarrow$  | (dest)                            |      |  |
| Status Affected:          | Z  |                                   |      |  |
| Encoding:                 | 0000   | 11df                              | ffff |  |
| Description:              | Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'. |                                   |      |  |
| Words:                    | 1  |                                   |      |  |
| Cycles:                   | 1  |                                   |      |  |
| Example:                  | DECF   | CNT,                              | 1    |  |
| Before Instru<br>CNT<br>Z | uction<br>= 0x01<br>= 0  |                                   |      |  |
| After Instruc<br>CNT<br>Z | tion<br>= 0x00<br>= 1  | )                                 |      |  |

| DECFSZ  | Decreme   | nt f, Skip   | o if O   |  |
|---|---|--|--|--|
| Syntax:   | [ label ] DECFSZ f,d  |  |  |  |
| Operands:   | $0 \le f \le 31$  |  |  |  |
|   | $d \in [0,1]$   |  |  |  |
| Operation:  | $\text{(f)}-1\rightarrow$   | d; skip  | if result =  | = 0  |
| Status Affected:                                      | None  |  |  |  |
| Encoding:   | 0010  | 11df   | ffff   | ]  |
| Description:  | The contermented. If the W reginglaced back lifthe result which is all and an NC ing it a two | 'd' is 0 the<br>ster. If 'd' is<br>ck in regist<br>It is 0, the<br>ready fetc<br>DP is exect | result is p<br>s 1 the res<br>er 'f'.<br>next instru<br>hed, is dis<br>uted instea | placed in<br>sult is<br>uction,<br>scarded |
| Words:  | 1   |  |  |  |
| Cycles:   | 1(2)  |  |  |  |
| Example:  | HERE<br>CONTINUE  | DECFSZ<br>GOTO<br>•<br>•   | CNT,   | 1  |
| Before Instru<br>PC                                   | ction<br>= addre  | ess (HER   | Œ)   |  |
| After Instruct<br>CNT<br>if CNT<br>PC<br>if CNT<br>PC | = CNT<br>= 0,<br>= addre<br>≠ 0,  | -1;<br>ess (CONT<br>ess (HERE  |  |  |
| gото  | Uncondi   | tional Br  | anch   |  |
| Syntax:   | [ label ]   | GOTO   | k  |  |
| Operands:   | $0 \le k \le 5$   | 11   |  |  |
|   |   |  |  |  |

| Syntax:          | [ label ]   | GOTO                                  | k   |
|------------------|---|---------------------------------------|---|
| Operands:        | $0 \le k \le 5$   | 11                                    |   |
| Operation:       | $k \rightarrow PC<8:0>$ ;<br>STATUS<6:5> $\rightarrow PC<10:9>$ |                                       |   |
| Status Affected: | None  |                                       |   |
| Encoding:        | 101k  | kkkk                                  | kkkk  |
| Description:     | 9-bit imme<br>bits <8:0>  | ediate valu<br>. The uppe<br>m STATUS | ional branch. The e is loaded into PC er bits of PC are S<6:5>. GOTO is a |
| Words:           | 1   |                                       |   |
| Cycles:          | 2   |                                       |   |
| Example:         | GOTO THI  | ERE                                   |   |
| After Instruc    | tion  |                                       |   |

PC = address (THERE)

| INCF   | Increment f  |
|--|--|
| Syntax:  | [ label ] INCF f,d   |
| Operands:  | $0 \le f \le 31$<br>$d \in [0,1]$  |
| Operation:   | (f) + 1 $\rightarrow$ (dest)   |
| Status Affected:                                       | Z  |
| Encoding:  | 0010 10df ffff   |
| Description:   | The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. |
| Words:   | 1  |
| Cycles:  | 1  |
| Example:   | INCF CNT, 1  |
| Before Instru<br>CNT<br>Z<br>After Instruc<br>CNT<br>7 | = 0xFF<br>= 0  |
| _  | = •  |

| INCFSZ   | Increment f, Skip if 0  |
|--|---|
| Syntax:  | [ label ] INCFSZ f,d  |
| Operands:  | $0 \le f \le 31$<br>$d \in [0,1]$   |
| Operation:   | (f) + 1 $\rightarrow$ (dest), skip if result = 0  |
| Status Affected:                                     | None  |
| Encoding:  | 0011 11df ffff  |
| Description:   | The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.  If the result is 0, then the next instruction, which is already fetched, is discarded and an NOP is executed instead making it a two cycle instruction. |
| Words:   | 1   |
| Cycles:  | 1(2)  |
| Example:   | HERE INCFSZ CNT, 1 GOTO LOOP  CONTINUE • • •  |
| Before Instru<br>PC                                  | uction = address (HERE)   |
| After Instruc<br>CNT<br>if CNT<br>PC<br>if CNT<br>PC | tion = CNT + 1; = 0, = address (CONTINUE); ≠ 0, = address (HERE +1)   |

| IORLW                  | Inclusive OR literal with W  |
|------------------------|--|
| Syntax:                | [label] IORLW k  |
| Operands:              | $0 \leq k \leq 255$  |
| Operation:             | (W) .OR. (k) $\rightarrow$ (W)   |
| Status Affected:       | Z  |
| Encoding:              | 1101 kkkk kkkk   |
| Description:           | The contents of the W register are OR'ed with the eight bit literal 'k'. The result is placed in the W register. |
| Words:                 | 1  |
| Cycles:                | 1  |
| Example:               | IORLW 0x35   |
| Before Instru<br>W =   | oction<br>0x9A   |
| After Instruct W = Z = | ion<br>0xBF<br>0   |

| IORWF  | Inclusive                      | e OR W v   | vith f                   |        |
|--|--------------------------------|--|--------------------------|--------|
| Syntax:  | [ label ]                      | IORWF  | f,d                      |        |
| Operands:  | $0 \le f \le 31$ $d \in [0,1]$ | l  |                          |        |
| Operation:   | (W).OR.                        | $(f) \rightarrow (de:$   | st)                      |        |
| Status Affected:   | Z                              |  |                          |        |
| Encoding:  | 0001                           | 00df   | ffff                     | ]      |
| Description:   | ter 'f'. If 'd'<br>the W reg   | OR the Willis 0 the resister. If 'd' incherion is the contract of the contract | sult is places 1 the res | ced in |
| Words:   | 1                              |  |                          |        |
| Cycles:  | 1                              |  |                          |        |
| Example:   | IORWF                          |  | RESULT,                  | 0      |
| Before Instru<br>RESULT<br>W<br>After Instruct<br>RESULT<br>W<br>Z | = 0x13<br>= 0x91               |  |                          |        |

# PIC16C5X

| MOVF                  | Move f   |
|-----------------------|--|
| Syntax:               | [ label ] MOVF f,d   |
| Operands:             | $0 \le f \le 31$<br>$d \in [0,1]$  |
| Operation:            | $(f) \to (dest)$   |
| Status Affected:      | Z  |
| Encoding:             | 0010 00df ffff   |
| Description:          | The contents of register 'f' is moved to destination 'd'. If 'd' is 0, destination is the W register. If 'd' is 1, the destination is file register 'f'. 'd' is 1 is useful to test a file register since status flag Z is affected. |
| Words:                | 1  |
| Cycles:               | 1  |
| Example:              | MOVF FSR, 0  |
| After Instruct<br>W = | tion<br>value in FSR register  |

| MOVLW                 | Move Lit           | eral to W           | ,                                      |  |
|-----------------------|--------------------|---------------------|--|--|
| Syntax:               | [ label ]          | MOVLW               | k                                      |  |
| Operands:             | $0 \le k \le 2$    | $0 \leq k \leq 255$ |  |  |
| Operation:            | $k \to \text{(W)}$ |                     |  |  |
| Status Affected:      | None               |                     |  |  |
| Encoding:             | 1100               | kkkk                | kkkk                                   |  |
| Description:          | Ū                  |                     | is loaded into the t cares will assem- |  |
| Words:                | 1                  |                     |  |  |
| Cycles:               | 1                  |                     |  |  |
| Example:              | MOVLW              | 0x5A                |  |  |
| After Instruct<br>W = | ion<br>0x5A        |                     |  |  |

| MOVWF                         | Move W to f                                    |
|-------------------------------|--|
| Syntax:                       | [ label ] MOVWF f                              |
| Operands:                     | $0 \le f \le 31$                               |
| Operation:                    | (W) 	o (f)                                     |
| Status Affected:              | None   |
| Encoding:                     | 0000 001f ffff                                 |
| Description:                  | Move data from the W register to register 'f'. |
| Words:                        | 1  |
| Cycles:                       | 1  |
| Example:                      | MOVWF TEMP_REG                                 |
| Before Instru<br>TEMP_R<br>W  |  |
| After Instruct<br>TEMP_R<br>W |  |

| NOP              | No Oper   | ation  |      |
|------------------|-----------|--------|------|
| Syntax:          | [ label ] | NOP    |      |
| Operands:        | None      |        |      |
| Operation:       | No opera  | ation  |      |
| Status Affected: | None      |        |      |
| Encoding:        | 0000      | 0000   | 0000 |
| Description:     | No opera  | ation. |      |
| Words:           | 1         |        |      |
| Cycles:          | 1         |        |      |
| Example:         | NOP       |        |      |
|                  |           |        |      |

| OPTION             | Load OPTION Register     |                          |      |          |
|--------------------|--------------------------|--------------------------|------|----------|
| Syntax:            | [ label ]                | OPTION                   | 1    |          |
| Operands:          | None                     |                          |      |          |
| Operation:         | $(W) \rightarrow OPTION$ |                          |      |          |
| Status Affected:   | None                     |                          |      |          |
| Encoding:          | 0000                     | 0000                     | 0010 |          |
| Description:       |                          | nt of the W<br>PTION reg | Ū    | s loaded |
| Words:             | 1                        |                          |      |          |
| Cycles:            | 1                        |                          |      |          |
| Example            | OPTION                   |                          |      |          |
| Before Instruction |                          |                          |      |          |
| W                  | = 0x07                   |                          |      |          |
| After Instruct     |                          |                          |      |          |

| RETLW                                  | Return with  | Liter             | al in W  |
|--|--|-------------------|--|
| Syntax:                                | [label] RE   | TLW               | k  |
| Operands:                              | $0 \le k \le 255$  |                   |  |
| Operation:                             | $\begin{array}{l} k \rightarrow \text{(W);} \\ \text{TOS} \rightarrow \text{PC} \end{array}$ |                   |  |
| Status Affected:                       | None   |                   |  |
| Encoding:                              | 1000 kk  | kk                | kkkk   |
| Description:                           | bit literal 'k'. The loaded from the   | ne proq<br>ie top | ded with the eight<br>gram counter is<br>of the stack (the<br>s is a two cycle |
| Words:                                 | 1  |                   |  |
| Cycles:                                | 2  |                   |  |
| Example:                               | CALL TABLE  • •  | ;tab<br>;val      | ow has table   |
| TABLE                                  | ADDWF PC RETLW k1 RETLW k2  RETLW kx   | ;Beg              | offset<br>in table<br>d of table   |
| Before Instru<br>W =<br>After Instruct | 0x07   |                   |  |
| W =                                    | value of K8  |                   |  |

| RLF   | Rotate Left f through Carry   |  |  |
|---|---|--|--|
| Syntax:   | [ label ] RLF f,d   |  |  |
| Operands:   | $0 \le f \le 31$<br>$d \in [0,1]$   |  |  |
| Operation:  | See description below   |  |  |
| Status Affected:                                    | С   |  |  |
| Encoding:   | 0011 01df ffff  |  |  |
| Description:  | The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'. |  |  |
| Words:  | 1   |  |  |
| Cycles:   | 1   |  |  |
| Example:  | RLF REG1,0  |  |  |
| Before Instru<br>REG1<br>C<br>After Instruc<br>REG1 | = 1110 0110<br>= 0  |  |  |
| W<br>C  | = 1100 1100<br>= 1  Rotate Right f through Carry  |  |  |
| Syntax:   | [label] RRF f,d   |  |  |

| RRF                              | Rotate Right f through Carry   |
|----------------------------------|--|
| Syntax:                          | [ label ] RRF f,d  |
| Operands:                        | $0 \le f \le 31$<br>$d \in [0,1]$  |
| Operation:                       | See description below  |
| Status Affected:                 | С  |
| Encoding:                        | 0011 00df ffff   |
| Description:                     | The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. |
|                                  | C register 'f'   |
| Words:                           | 1  |
| Cycles:                          | 1  |
| Example:                         | RRF REG1,0   |
| Before Instru<br>REG1<br>C       | ction = 1110 0110 = 0  |
| After Instruct<br>REG1<br>W<br>C | ion = 1110 0110 = 0111 0011 = 0  |

| SLEEP            | Enter SLEEP Mode  |   |             |          |
|------------------|---|---|-------------|----------|
| Syntax:          | [label]   | SLEEP                                       |             |          |
| Operands:        | None  |   |             |          |
| Operation:       | $\begin{array}{c} 00h \rightarrow W \\ 0 \rightarrow WD \\ 1 \rightarrow \overline{TO}; \\ 0 \rightarrow \overline{PD} \end{array}$ | /DT;<br>T prescal                           | er;         |          |
| Status Affected: | $\overline{TO}$ , $\overline{PD}$   |   |             |          |
| Encoding:        | 0000  | 0000  | 0011        |          |
| Description:     | power dov   | status bit (<br>wn status b<br>and its pre  | oit (PD) is | cleared. |
|                  | with the o  | essor is put<br>scillator sto<br>.EEP for m | opped. Se   | e sec-   |
| Words:           | 1   |   |             |          |
| Cycles:          | 1   |   |             |          |
| Example:         | SLEEP   |   |             |          |

| SUBWF                           | Subtract W from f   |
|---------------------------------|---|
| Syntax:                         | [ <i>label</i> ] SUBWF f,d  |
| Operands:                       | $0 \le f \le 31$<br>$d \in [0,1]$   |
| Operation:                      | $(f)-(W)\to(dest)$  |
| Status Affected:                | C, DC, Z  |
| Encoding:                       | 0000 10df ffff  |
| Description:                    | Subtract (2's complement method) the W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'. |
| Words:                          | 1   |
| Cycles:                         | 1   |
| Example 1:                      | SUBWF REG1, 1   |
| Before Instru<br>REG1<br>W<br>C | uction = 3 = 2 = ?  |
| After Instruc<br>REG1<br>W<br>C | tion = 1 = 2 = 1 ; result is positive   |
| Example 2:                      |   |
| Before Instru<br>REG1<br>W<br>C | uction = 2 = 2 = ?  |
| After Instruc<br>REG1           | = 0   |
| W<br>C                          | = 2<br>= 1 ; result is zero   |
| Example 3:                      |   |
| Before Instru<br>REG1<br>W<br>C | uction<br>= 1<br>= 2<br>= ?   |
| After Instruc<br>REG1<br>W<br>C | tion = FF = 2 = 0 ; result is negative  |

| SWAPF                      | Swap Nibbles in f  |  |  |
|----------------------------|--|--|--|
| Syntax:                    | [label] SWAPF f,d  |  |  |
| Operands:                  | $0 \le f \le 31$<br>$d \in [0,1]$  |  |  |
| Operation:                 | $(f<3:0>) \rightarrow (dest<7:4>);$<br>$(f<7:4>) \rightarrow (dest<3:0>)$  |  |  |
| Status Affected:           | None   |  |  |
| Encoding:                  | 0011 10df ffff   |  |  |
| Description:               | The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'. |  |  |
| Words:                     | 1  |  |  |
| Cycles:                    | 1  |  |  |
| Example                    | SWAPF REG1, 0  |  |  |
| Before Instru<br>REG1      | uction<br>= 0xA5   |  |  |
| After Instruc<br>REG1<br>W | tion<br>= 0xA5<br>= 0X5A   |  |  |

| TRIS             | Load TRIS Register   |  |  |  |  |  |  |
|------------------|--|--|--|--|--|--|--|
| Syntax:          | [label] TRIS f   |  |  |  |  |  |  |
| Operands:        | f = 5, 6 or 7  |  |  |  |  |  |  |
| Operation:       | $\text{(W)} \rightarrow \text{TRIS register f}$                                  |  |  |  |  |  |  |
| Status Affected: | None   |  |  |  |  |  |  |
| Encoding:        | 0000 0000 Offf   |  |  |  |  |  |  |
| Description:     | TRIS register 'f' (f = 5, 6, or 7) is loaded with the contents of the W register |  |  |  |  |  |  |
| Words:           | 1  |  |  |  |  |  |  |
| Cycles:          | 1  |  |  |  |  |  |  |
| Example          | TRIS PORTA   |  |  |  |  |  |  |
| Before Instru    | uction   |  |  |  |  |  |  |
| W                | = 0XA5   |  |  |  |  |  |  |
| After Instruct   |  |  |  |  |  |  |  |
| TRISA            | = 0XA5   |  |  |  |  |  |  |

| XORLW                | Exclusiv        | e OR lite                  | ral with      | W          |  |  |  |
|----------------------|-----------------|----------------------------|---------------|------------|--|--|--|
| Syntax:              | [label]         | [label] XORLW k            |               |            |  |  |  |
| Operands:            | $0 \le k \le 2$ | 55                         |               |            |  |  |  |
| Operation:           | (W) .XOF        | $R. k \rightarrow (W)$     | <b>'</b> )    |            |  |  |  |
| Status Affected:     | Z               |                            |               |            |  |  |  |
| Encoding:            | 1111 kkkk kkkk  |                            |               |            |  |  |  |
| Description:         | XOR'ed w        | ents of the vith the eight | ht bit litera | I 'k'. The |  |  |  |
| Words:               | 1               |                            |               |            |  |  |  |
| Cycles:              | 1               |                            |               |            |  |  |  |
| Example:             | XORLW           | 0xAF                       |               |            |  |  |  |
| Before Instru<br>W = | uction<br>0xB5  |                            |               |            |  |  |  |
| After Instruc<br>W = | tion<br>0x1A    |                            |               |            |  |  |  |

| XORWF                      | Exclusiv                       | e OR W   | with f                      |                        |
|----------------------------|--------------------------------|--|-----------------------------|------------------------|
| Syntax:                    | [ label ]                      | XORWF  | f,d                         |                        |
| Operands:                  | $0 \le f \le 31$ $d \in [0,1]$ |  |                             |                        |
| Operation:                 | (W) .XOF                       | R. (f) $\rightarrow$ (c                                  | lest)                       |                        |
| Status Affected:           | Z                              |  |                             |                        |
| Encoding:                  | 0001                           | 10df   | ffff                        |                        |
| Description:               | register wiresult is st        | OR the co<br>ith register<br>ored in the<br>It is stored | 'f'. If 'd' is<br>W registe | 0 the<br>er. If 'd' is |
| Words:                     | 1                              |  |                             |                        |
| Cycles:                    | 1                              |  |                             |                        |
| Example                    | XORWF                          | REG,1  |                             |                        |
| Before Instru<br>REG<br>W  | oction<br>= 0xAF<br>= 0xB5     |  |                             |                        |
| After Instruct<br>REG<br>W | tion<br>= 0x1A<br>= 0xB5       |  |                             |                        |

# PIC16C5X

**NOTES:** 

# 9.0 DEVELOPMENT SUPPORT

# 9.1 <u>Development Tools</u>

The PIC16/17 microcontrollers are supported with a full range of hardware and software development tools:

- PICMASTER/PICMASTER CE Real-Time In-Circuit Emulator
- ICEPIC Low-Cost PIC16C5X and PIC16CXXX In-Circuit Emulator
- PRO MATE® II Universal Programmer
- PICSTART<sup>®</sup> Plus Entry-Level Prototype Programmer
- PICDEM-1 Low-Cost Demonstration Board
- PICDEM-2 Low-Cost Demonstration Board
- PICDEM-3 Low-Cost Demonstration Board
- MPASM Assembler
- MPLAB™ SIM Software Simulator
- MPLAB-C (C Compiler)
- Fuzzy Logic Development System (fuzzyTECH<sup>®</sup>-MP)

# 9.2 PICMASTER: High Performance Universal In-Circuit Emulator with MPLAB IDE

The PICMASTER Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for all microcontrollers in the PIC12C5XX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX families. PICMASTER is supplied with the MPLAB™ Integrated Development Environment (IDE), which allows editing, "make" and download, and source debugging from a single environment.

Interchangeable target probes allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the PICMASTER allows expansion to support all new Microchip microcontrollers.

The PICMASTER Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC compatible 386 (and higher) machine platform and Microsoft Windows® 3.x environment were chosen to best make these features available to you, the end user.

A CE compliant version of PICMASTER is available for European Union (EU) countries.

# 9.3 ICEPIC: Low-Cost PIC16CXXX In-Circuit Emulator

ICEPIC is a low-cost in-circuit emulator solution for the Microchip PIC16C5X and PIC16CXXX families of 8-bit OTP microcontrollers.

ICEPIC is designed to operate on PC-compatible machines ranging from 286-AT<sup>®</sup> through Pentium™ based machines under Windows 3.x environment. ICEPIC features real time, non-intrusive emulation.

### 9.4 PRO MATE II: Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In standalone mode the PRO MATE II can read, verify or program PIC16C5X, PIC16CXXX, PIC17CXX and PIC14000 devices. It can also set configuration and code-protect bits in this mode.

# 9.5 <u>PICSTART Plus Entry Level</u> <u>Development System</u>

The PICSTART programmer is an easy-to-use, low-cost prototype programmer. It connects to the PC via one of the COM (RS-232) ports. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. PICSTART Plus is not recommended for production programming.

PICSTART Plus supports all PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX and PIC17CXX devices with up to 40 pins. Larger pin count devices such as the PIC16C923 and PIC16C924 may be supported with an adapter socket.

# 9.6 PICDEM-1 Low-Cost PIC16/17 Demonstration Board

The PICDEM-1 is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The users can program the sample microcontrollers provided with the PICDEM-1 board, on a PRO MATE II or PICSTART-Plus programmer, and easily test firmware. The user can also connect the PICDEM-1 board to the PICMASTER emulator and download the firmware to the emulator for testing. Additional prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push-button switches and eight LEDs connected to PORTB.

# 9.7 <u>PICDEM-2 Low-Cost PIC16CXX</u> Demonstration Board

The PICDEM-2 is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-2 board, on a PRO MATE II programmer or PICSTART-Plus, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-2 board to test firmware. Additional prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push-button switches, a potentiometer for simulated analog input, a Serial EEPROM to demonstrate usage of the I<sup>2</sup>C bus and separate headers for connection to an LCD module and a keypad.

# 9.8 PICDEM-3 Low-Cost PIC16CXXX Demonstration Board

The PICDEM-3 is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with a LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-3 board, on a PRO MATE II programmer or PICSTART Plus with an adapter socket, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-3 board to test firmware. Additional prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include

an RS-232 interface, push-button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM-3 board is an LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM-3 provides an additional RS-232 interface and Windows 3.1 software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

### 9.9 MPLAB Integrated Development Environment Software

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- · A full featured editor
- · Three operating modes
  - editor
  - emulator
  - simulator
- · A project manager
- · Customizable tool bar and key mapping
- · A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- · Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PIC16/17 tools (automatically updates all project information)
- · Debug using:
  - source files
  - absolute listing file
- Transfer data dynamically via DDE (soon to be replaced by OLE)
- · Run up to four emulators on the same PC

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

#### 9.10 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PC-hosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from PICMASTER, Microchip's Universal Emulator System.

MPASM has the following features to assist in developing software for specific use applications.

- Provides translation of Assembler source code to object code for all Microchip microcontrollers.
- · Macro assembly capability.
- Produces all the files (Object, Listing, Symbol, and special) required for symbolic debug with Microchip's emulator systems.
- Supports Hex (default), Decimal and Octal source and listing formats.

MPASM provides a rich directive language to support programming of the PIC16/17. Directives are helpful in making the development of your assemble source code shorter and more maintainable.

# 9.11 Software Simulator (MPLAB-SIM)

The MPLAB-SIM Software Simulator allows code development in a PC host environment. It allows the user to simulate the PIC16/17 series microcontrollers on an instruction level. On any given instruction, the user may examine or modify any of the data areas or provide external stimulus to any of the pins. The input/output radix can be set by the user and the execution can be performed in; single step, execute until break, or in a trace mode.

MPLAB-SIM fully supports symbolic debugging using MPLAB-C and MPASM. The Software Simulator offers the low cost flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

### 9.12 C Compiler (MPLAB-C)

The MPLAB-C Code Development System is a complete 'C' compiler and integrated development environment for Microchip's PIC16/17 family of microcontrollers. The compiler provides powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compiler provides symbol information that is compatible with the MPLAB IDE memory display.

# 9.13 <u>Fuzzy Logic Development System</u> (<u>fuzzyTECH-MP</u>)

fuzzyTECH-MP fuzzy logic development tool is available in two versions - a low cost introductory version, MP Explorer, for designers to gain a comprehensive working knowledge of fuzzy logic system design; and a full-featured version, fuzzyTECH-MP, edition for implementing more complex systems.

Both versions include Microchip's fuzzyLAB<sup>TM</sup> demonstration board for hands-on experience with fuzzy logic systems implementation.

# 9.14 <u>MP-DriveWay™ – Application Code</u> Generator

MP-DriveWay is an easy-to-use Windows-based Application Code Generator. With MP-DriveWay you can visually configure all the peripherals in a PIC16/17 device and, with a click of the mouse, generate all the initialization and many functional code modules in C language. The output is fully compatible with Microchip's MPLAB-C C compiler. The code produced is highly modular and allows easy integration of your own code. MP-DriveWay is intelligent enough to maintain your code through subsequent code generation.

# 9.15 <u>SEEVAL® Evaluation and Programming System</u>

The SEEVAL SEEPROM Designer's Kit supports all Microchip 2-wire and 3-wire Serial EEPROMs. The kit includes everything necessary to read, write, erase or program special features of any Microchip SEEPROM product including Smart Serials™ and secure serials. The Total Endurance™ Disk is included to aid in tradeoff analysis and reliability calculations. The total kit can significantly reduce time-to-market and result in an optimized system.

# 9.16 <u>Keeloq® Evaluation and</u> Programming Tools

KEELOQ evaluation and programming tools support Microchips HCS Secure Data Products. The HCS evaluation kit includes an LCD display to show changing codes, a decoder to decode transmissions, and a programming interface to program test transmitters.

© 1997 Microchip Technology Inc. Preliminary DS30453A-page 57

TABLE 9-1: DEVELOPMENT TOOLS FROM MICROCHIP

|             |   | PIC12C5XX | PIC14000 | PIC16C5X | PIC16CXXX | PIC16C6X | PIC16C7XX | PIC16C8X    | PIC16C9XX | PIC17C4X | PIC17C75X         | 24CXX<br>25CXX<br>93CXX | HCS200<br>HCS300<br>HCS301 |
|-------------|---|-----------|----------|----------|-----------|----------|-----------|-------------|-----------|----------|-------------------|-------------------------|----------------------------|
| roducts     | PICMASTER®/<br>PICMASTER-CE<br>In-Circuit Emulator            | >         | 7        | 7        | ,         | 7        | 7         | 7           | 7         | 7        | Available<br>3Q97 |                         |                            |
| Fmulator F  | ICEPIC Low-Cost<br>In-Circuit Emulator                        | 7         |          | 7        | 7         | 7        | 7         | 7           |           |          |                   |                         |                            |
| '           | MPLAB™<br>Integrated<br>Development<br>Environment            | 7         | 7        | 7        | 7         | 7        | 7         | 7           | 7         | 7        | 7                 |                         |                            |
| slo         | MPLAB™ C<br>Compiler  | 7         | >        | >        | 7         | 7        | 7         | >           | >         | >        | >                 |                         |                            |
| oT əาswitoč | fuzzyTECH®-MP<br>Explorer/Edition<br>Fuzzy Logic<br>Dev. Tool | >         | 7        | 7        | 7         | 7        | 7         | >           | 7         | >        |                   |                         |                            |
| 3           | MP-DriveWay™<br>Applications<br>Code Generator                |           |          | 7        | 7         | 7        | 7         | 7           |           | 7        |                   |                         |                            |
|             | Total Endurance™<br>Software Model                            |           |          |          |           |          |           |             |           |          |                   | 7                       |                            |
|             | PICSTART®<br>Lite Ultra Low-Cost<br>Dev. Kit                  |           |          | •        |           | 7        | >         | <b>&gt;</b> |           |          |                   |                         |                            |
| สเมเลยเร    | PICSTART <sup>®</sup><br>Plus Low-Cost<br>Universal Dev. Kit  | 7         | 7        | >        | >         | 7        | >         | >           | >         | 7        | >                 |                         |                            |
| Progr       | PRO MATE <sup>®</sup> II<br>Universal<br>Programmer           | >         | 7        | >        | 7         | 7        | >         | 7           | 7         | <b>,</b> | >                 | 7                       | 7                          |
|             | KEELOQ <sup>®</sup><br>Programmer                             |           |          |          |           |          |           |             |           |          |                   |                         | 7                          |
|             | SEEVAL <sup>®</sup><br>Designers Kit                          |           |          |          |           |          |           |             |           |          |                   | >                       |                            |
| ards        | PICDEM-1  |           |          | 7        | 7         |          |           | 7           |           | 7        |                   |                         |                            |
| 0 B 0       | PICDEM-2  |           |          |          |           | >        | >         |             |           |          |                   |                         |                            |
| məq         | PICDEM-3  |           |          |          |           |          |           |             | >         |          |                   |                         |                            |
|             | KEELOQ®<br>Evaluation Kit                                     |           |          |          |           |          |           |             |           |          |                   |                         | 7                          |

PIC16C52 PIC16C5X

# 10.0 ELECTRICAL CHARACTERISTICS - PIC16C52

# **Absolute Maximum Ratings†**

| Ambient Temperature under bias   | 55°C to +125°C                                    |
|--|---|
| Storage Temperature  | 65°C to +150°C                                    |
| Voltage on VDD with respect to Vss   |   |
| Voltage on MCLR with respect to Vss  | 0 V to +14 \                                      |
| Voltage on all other pins with respect to Vss  | 0.6 V to (VDD + 0.6 V                             |
| Total Power Dissipation <sup>(1)</sup>   | 800 mW  |
| Max. Current out of Vss pin  | 150 m/  |
| Max. Current into Vdd pin  | 50 m <i>A</i>                                     |
| Max. Current into an input pin (T0CKI only)  | ±500 μΑ   |
| Input Clamp Current, Iik (Vi < 0 or Vi > VDD)  | ±20 mA  |
| Output Clamp Current, lok (Vo < 0 or Vo > VDD)   | ±20 mA  |
| Max. Output Current sunk by any I/O pin  | 10 m <i>F</i>                                     |
| Max. Output Current sourced by any I/O pin   | 10 m <i>F</i>                                     |
| Max. Output Current sourced by a single I/O port (PORTA or B)  | 10 m/   |
| Max. Output Current sunk by a single I/O port (PORTA or B)   | 10 m/   |
| <b>Note 1:</b> Power Dissipation is calculated as follows: Pdis = VdD x {Idd $- \sum IdH$ } + $\sum {(Vd) = VdD =$ | $VDD - VOH) \times IOH\} + \sum (VOL \times IOL)$ |

<sup>†</sup>NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16C5X PIC16C52

# 10.1 <u>DC Characteristics:</u> <u>PIC16C52-04 (Commercial)</u> <u>PIC16C52-04I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins                 |     |     | ard Operating Tempe | _       | 0°C ≤    | (unless otherwise specified)<br>ETA ≤ +70°C (commercial)<br>ETA ≤ +85°C (industrial) |
|---|-----|-----|---------------------|---------|----------|--|
| Characteristic  | Sym | Min | Typ <sup>(1)</sup>  | Max     | Units    | Conditions   |
| Supply Voltage  | VDD | 3.0 |                     | 6.25    | V        | Fosc = DC to 4 MHz   |
| RAM Data Retention Voltage <sup>(2)</sup>               | Vdr |     | 1.5*                |         | V        | Device in SLEEP Mode   |
| Supply Current <sup>(3,4)</sup>                         | IDD |     | 1.8                 | 3.3     | mA       | Fosc = 4 MHz, VDD = 5.5 V  |
| Power Down Current <sup>(5)</sup> Commercial Industrial | IPD |     | 0.6<br>0.6          | 9<br>12 | μΑ<br>μΑ | VDD = 3.0 V<br>VDD = 3.0 V   |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: For RC option, does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C52 PIC16C5X

# 10.2 <u>DC Characteristics:</u> <u>PIC16C52-04 (Commercial)</u> <u>PIC16C52-04I (Industrial)</u>

DC Characteristics
All Pins Except
Power Supply Pins

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial)

Operating Voltage VDD range is described in Section 10.1.

| Operating Voltage VDD range is described in Section 10.1. |      |            |                    |          |       |  |
|---|------|------------|--------------------|----------|-------|--|
| Characteristic  | Sym  | Min        | Typ <sup>(1)</sup> | Max      | Units | Conditions   |
| Input Low Voltage   | VIL  |            |                    |          |       |  |
| I/O ports   |      | Vss        |                    | 0.2 VDD  | V     | Pin at hi-impedance                                  |
| MCLR (Schmitt Trigger)                                    |      | Vss        |                    | 0.15 VDD | V     | ·  |
| T0CKI (Schmitt Trigger)                                   |      | Vss        |                    | 0.15 VDD | V     |  |
| OSC1 (Schmitt Trigger)                                    |      | Vss        |                    | 0.15 VDD | V     | RC <sup>(4)</sup> option only                        |
|   |      | Vss        |                    | 0.3 VDD  | V     | XT option  |
| Input High Voltage  | VIH  |            |                    |          |       |  |
| I/O ports   |      | 0.45 VDD   |                    | VDD      | V     | For all VDD <sup>(5)</sup>                           |
|   |      | 2.0        |                    | VDD      | V     | $4.0 \text{ V} < \text{VDD} \le 5.5 \text{ V}^{(5)}$ |
|   |      | 0.36 VDD   |                    | VDD      | V     | VDD > 5.5 V  |
| MCLR (Schmitt Trigger)                                    |      | 0.85 VDD   |                    | VDD      | V     |  |
| T0CKI (Schmitt Trigger)                                   |      | 0.85 VDD   |                    | VDD      | V     |  |
| OSC1 (Schmitt Trigger)                                    |      | 0.85 VDD   |                    | VDD      | V     | RC <sup>(4)</sup> option only                        |
|   |      | 0.7 VDD    |                    | VDD      | V     | XT option  |
| Hysteresis of Schmitt                                     | VHYS | 0.15VDD*   |                    |          | V     |  |
| Trigger inputs  |      |            |                    |          |       |  |
| Input Leakage Current <sup>(2,3)</sup>                    | lı∟  |            |                    |          |       | For VDD ≤ 5.5 V                                      |
| I/O ports   |      | <b>–</b> 1 | 0.5                | +1       | μΑ    | VSS ≤ VPIN ≤ VDD,                                    |
|   |      |            |                    |          |       | Pin at hi-impedance                                  |
| MCLR  |      | <b>–</b> 5 |                    |          | μΑ    | VPIN = VSS + 0.25 V                                  |
|   |      |            | 0.5                | +5       | μΑ    | VPIN = VDD   |
| TOCKI   |      | -3         | 0.5                | +3       | μA    | VSS ≤ VPIN ≤ VDD                                     |
| OSC1  |      | -3         | 0.5                | +3       | μΑ    | VSS ≤ VPIN ≤ VDD,                                    |
|   |      |            |                    |          |       | XT option  |
| Output Low Voltage  | Vol  |            |                    |          |       |  |
| I/O ports   |      |            |                    | 0.6      | V     | IOL = 2.0  mA, VDD = 4.5  V                          |
| OSC2/CLKOUT   |      |            |                    | 0.6      | V     | IOL = 1.6  mA, VDD = 4.5  V,                         |
|   |      |            |                    |          |       | RC option  |
| Output High Voltage                                       | Voн  |            |                    |          |       |  |
| I/O ports <sup>(3)</sup>                                  |      | VDD - 0.7  |                    |          | V     | IOH = $-2.0 \text{ mA}$ , VDD = $4.5 \text{ V}$      |
| OSC2/CLKOUT   |      | VDD - 0.7  |                    |          | V     | IOH = $-1.0$ mA, VDD = $4.5$ V, RC option            |
|   |      |            |                    |          |       | <u>'</u>   |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

<sup>2:</sup> The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

<sup>3:</sup> Negative current is defined as coming out of the pin.

<sup>4:</sup> For RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C52 be driven with external clock in RC mode.

<sup>5:</sup> The user may use the better of the two specifications.

PIC16C5X PIC16C52

# 10.3 <u>Timing Parameter Symbology and Load Conditions</u>

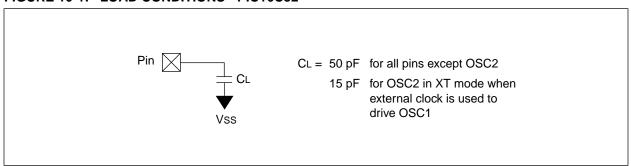
The timing parameter symbols have been created following one of the following formats:

# 1. TppS2ppS

2. TppS

| Т     |  |     | ·            | _ |
|-------|--|-----|--------------|---|
| F     | Frequency                                | Т   | Time         |   |
| Lower | case subscripts (pp) and their meanings: |     |              |   |
| pp    |  |     |              |   |
| 2     | to                                       | mc  | MCLR         |   |
| ck    | CLKOUT                                   | osc | oscillator   |   |
| су    | cycle time                               | os  | OSC1         |   |
| drt   | device reset timer                       | tO  | T0CKI        |   |
| io    | I/O port                                 |     |              |   |
| Upper | case letters and their meanings:         |     |              |   |
| S     |  |     |              |   |
| F     | Fall                                     | P   | Period       |   |
| Н     | High                                     | R   | Rise         |   |
| 1     | Invalid (Hi-impedance)                   | V   | Valid        |   |
| L     | Low                                      | Z   | Hi-impedance |   |

# FIGURE 10-1: LOAD CONDITIONS - PIC16C52



PIC16C52 PIC16C5X

# 10.4 Timing Diagrams and Specifications

# FIGURE 10-2: EXTERNAL CLOCK TIMING - PIC16C52

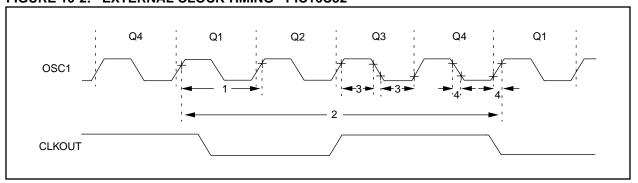


TABLE 10-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C52

| AC Characteristics | Standard Operating Conditions (unless otherwise specified)              |
|--------------------|---|
|                    | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +85 $^{\circ}$ C (industrial)          |
|                    | Operating Voltage VDD range is described in Section 10.1.               |

| Parameter<br>No. | Sym        | Characteristic                          | Min | Тур <sup>(1)</sup> | Max    | Units | Conditions    |
|------------------|------------|---|-----|--------------------|--------|-------|---------------|
|                  | Fosc       | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4      | MHz   | XT osc mode   |
|                  |            | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4      | MHz   | RC osc mode   |
|                  |            |   | 0.1 | _                  | 4      | MHz   | XT osc mode   |
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>    | 250 | _                  | _      | ns    | RC osc mode   |
|                  |            |   | 250 | _                  | _      | ns    | XT osc mode   |
|                  |            | Oscillator Period <sup>(2)</sup>        | 250 | _                  | _      | ns    | RC osc mode   |
|                  |            |   | 250 | _                  | 10,000 | ns    | XT osc mode   |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup>   | _   | 4/Fosc             | _      | _     |               |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time        | 85* | _                  | _      | ns    | XT oscillator |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time       |     | _                  | 25*    | ns    | XT oscillator |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TcY) equals four times the input oscillator time base period.

PIC16C5X PIC16C52



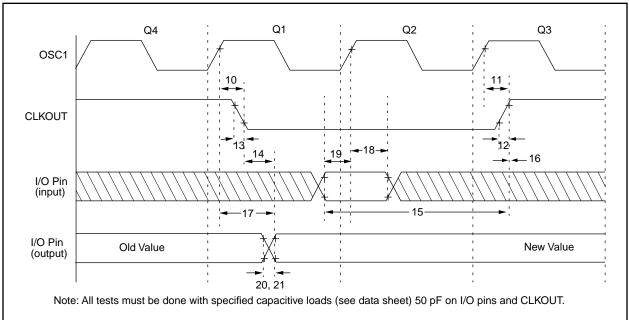


TABLE 10-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C52

| AC Chara         | racteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) Operating Voltage VDD range is described in Section 10.1. |   |              |                    |      |       |  |  |
|------------------|---|---|--------------|--------------------|------|-------|--|--|
| Parameter<br>No. | Sym   | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |  |  |
| 10               | TosH2ckL  | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                                       | _            | 15                 | 30** | ns    |  |  |
| 11               | TosH2ckH  | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                                       | _            | 15                 | 30** | ns    |  |  |
| 12               | TckR  | CLKOUT rise time <sup>(2)</sup>                                       | _            | 5                  | 15** | ns    |  |  |
| 13               | TckF  | CLKOUT fall time <sup>(2)</sup>                                       | _            | 5                  | 15** | ns    |  |  |
| 14               | TckL2ioV  | CLKOUT↓ to Port out valid <sup>(2)</sup>                              | _            | _                  | 40** | ns    |  |  |
| 15               | TioV2ckH  | Port in valid before CLKOUT <sup>(2)</sup>                            | 0.25 TCY+30* | _                  | _    | ns    |  |  |
| 16               | TckH2ioI  | Port in hold after CLKOUT <sup>(2)</sup>                              | 0*           | _                  | _    | ns    |  |  |
| 17               | TosH2ioV  | OSC1 <sup>↑</sup> (Q1 cycle) to Port out valid <sup>(3)</sup>         | _            | _                  | 100* | ns    |  |  |
| 18               | TosH2ioI  | OSC1 <sup>↑</sup> (Q2 cycle) to Port input invalid (I/O in hold time) | TBD          |                    | _    | ns    |  |  |
| 19               | TioV2osH  | Port input valid to OSC1↑ (I/O in setup time)                         | TBD          |                    | _    | ns    |  |  |
| 20               | TioR  | Port output rise time <sup>(3)</sup>                                  | _            | 10                 | 25** | ns    |  |  |
| 21               | TioF  | Port output fall time <sup>(3)</sup>                                  | _            | 10                 | 25** | ns    |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 10-1 for loading conditions.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C52 PIC16C5X

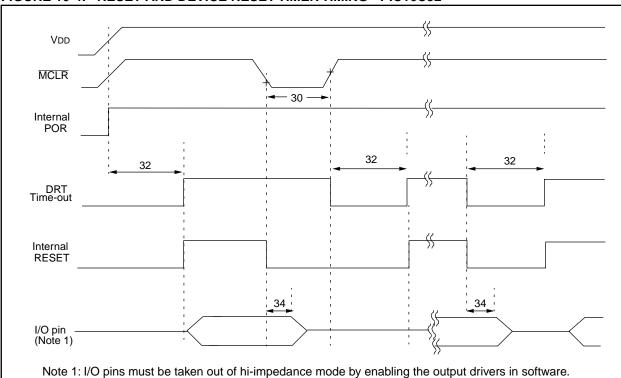


FIGURE 10-4: RESET AND DEVICE RESET TIMER TIMING - PIC16C52

TABLE 10-3: RESET AND DEVICE RESET TIMER - PIC16C52

| AC Charac     | teristics          |                                | Ta ≤ +7<br>Ta ≤ +8 | 70°C (co<br>35°C (in | mmerci<br>dustrial) | al)   |                        |
|---------------|--------------------|--------------------------------|--------------------|----------------------|---------------------|-------|------------------------|
| Parameter No. | Sym Characteristic |                                |                    | Typ <sup>(1)</sup>   | Max                 | Units | Conditions             |
| 30            | TmcL               | MCLR Pulse Width (low)         | 100*               | _                    | _                   | ns    | VDD = 5 V              |
| 32            | TDRT               | Device Reset Timer Period      | 9*                 | 18*                  | 30*                 | ms    | VDD = 5 V (Commercial) |
| 34            | Tioz               | I/O Hi-impedance from MCLR Low | _                  | _                    | 100*                | ns    |                        |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C5X PIC16C52

# FIGURE 10-5: TIMERO CLOCK TIMINGS - PIC16C52

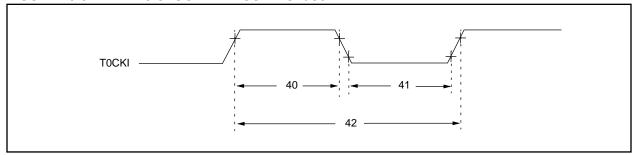


TABLE 10-4: TIMERO CLOCK REQUIREMENTS - PIC16C52

| AC            | Chara | Operating Tempera                     | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \leq TA \leq +70^{\circ}C$ (commercial) $-40^{\circ}C \leq TA \leq +85^{\circ}C$ (industrial)  Operating Voltage VDD range is described in Section 10.1. |                    |     |       |  |  |  |  |
|---------------|-------|---------------------------------------|--|--------------------|-----|-------|--|--|--|--|
| Parameter No. | Sym   | Characteristic                        | Min  | Typ <sup>(1)</sup> | Max | Units | Conditions   |  |  |  |
| 40            | Tt0H  | T0CKI High Pulse Width - No Prescaler | 0.5 Tcy + 20*  | _                  | _   | ns    |  |  |  |  |
|               |       | - With Prescaler                      | 10*  | _                  | _   | ns    |  |  |  |  |
| 41            | Tt0L  | T0CKI Low Pulse Width - No Prescaler  | 0.5 Tcy + 20*  | _                  | _   | ns    |  |  |  |  |
|               |       | - With Prescaler                      | 10*  | _                  | _   | ns    |  |  |  |  |
| 42            | Tt0P  | T0CKI Period                          | 20 or <u>TCY + 40</u> *<br>N   | _                  | _   | ns    | Whichever is greater.<br>N = Prescale Value<br>(1, 2, 4,, 256) |  |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C54/55/56/57 PIC16C5X

# 11.0 ELECTRICAL CHARACTERISTICS - PIC16C54/55/56/57

# **Absolute Maximum Ratings†**

ing this pin directly to Vss

| Ambient Temperature under bias  | –55°C to +125°C                      |
|---|--------------------------------------|
| Storage Temperature   | 65°C to +150°C                       |
| Voltage on VDD with respect to Vss  | 0V to +7.5V                          |
| Voltage on MCLR with respect to Vss <sup>(2)</sup>  | 0V to +14\                           |
| Voltage on all other pins with respect to Vss   |                                      |
| Total Power Dissipation <sup>(1)</sup>  | 800 mW                               |
| Max. Current out of Vss pin   | 150 mA                               |
| Max. Current into VDD pin   | 100 mA                               |
| Max. Current into an input pin (T0CKI only)   | ±500 μΑ                              |
| Input Clamp Current, IIK (VI < 0 or VI > VDD)   | ±20 mA                               |
| Output Clamp Current, IOK (VO < 0 or VO > VDD)  | ±20 mA                               |
| Max. Output Current sunk by any I/O pin   | 25 mA                                |
| Max. Output Current sourced by any I/O pin  | 20 mA                                |
| Max. Output Current sourced by a single I/O port (PORTA, B or C)  | 40 mA                                |
| Max. Output Current sunk by a single I/O port (PORTA, B or C)   | 50 mA                                |
| <b>Note 1:</b> Power Dissipation is calculated as follows: Pdis = VDD x {IDD $- \sum IOH$ } + $\sum {(VDD - \sum IOH)}$   | - VOH) x IOH} + $\Sigma$ (VOL x IOL) |
| <b>Note 2:</b> Voltage spikes below Vss at the $\overline{MCLR}$ pin, inducing currents greater than 80 m a series resistor of 50 to 100 $\Omega$ should be used when applying a "low" level to the | ·                                    |

<sup>†</sup>NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16C54/55/56/57

TABLE 11-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS (RC, XT & 10) AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16C5X-RC  | PIC16C5X-XT  | PIC16C5X-10  |
|-----|--|--|--|
| RC  | VDD: 3.0 V to 6.25 V<br>IDD: 3.3 mA max. at 5. V<br>IPD: 9 μA max. at 3.0 V, WDT dis<br>Freq: 4 MHz max. | N/A  | N/A  |
| ХТ  | VDD: 3.0V to 6.25V IDD: 1.8 mA typ. at 5.5V IPD: 0.6 µA typ. at 3.0V WDT dis Freq: 4 MHz max.            | VDD: 3.0V to 6.25V IDD: 3.3 mA max. at 5.5V IPD: 9 μA max. at 3.0V, WDT dis Freq: 4 MHz max.             | N/A  |
| HS  | N/A  | N/A  | VDD: 4.5V to 5.5V<br>IDD: 10 mA max. at 5.5V<br>IPD: 9 μA max. at 3.0V, WDT dis<br>Freq: 10 MHz max.                                   |
| LP  | VDD: 2.5V to 6.25V IDD: 15 $\mu$ A typ. at 3.0V IPD: 0.6 $\mu$ A typ. at 3.0V, WDT dis Freq: 40 kHz max. | VDD: 2.5V to 6.25V IDD: 15 $\mu$ A typ. at 3.0V IPD: 0.6 $\mu$ A typ. at 3.0V, WDT dis Freq: 40 kHz max. | VDD: $2.5V$ to $6.25V$ IDD: $15~\mu\text{A}$ typ. at $3.0V$ IPD: $0.6~\mu\text{A}$ typ. at $3.0V$ , WDT dis Freq: $40~\text{kHz}$ max. |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

TABLE 11-2: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS (HS, LP & JW) AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16C5X-HS  | PIC16C5X-LP  | PIC16C5X/JW  |
|-----|--|--|--|
| RC  | N/A  | N/A  | VDD: 3.0V to 6.25V<br>IDD: 3.3 mA max. at 5.5V<br>IPD: 9 μA max. at 3.0V, WDT dis<br>Freq: 4 MHz max.          |
| хт  | N/A  | N/A  | VDD: 3.0V to 6.25V<br>IDD: 3.3 mA max. at 5.5V<br>IPD: 9 μA max. at 3.0V, WDT dis<br>Freq: 4 MHz max.          |
| HS  | VDD: 4.5V to 5.5V<br>IDD: 20 mA max. at 5.5V<br>IPD: 9 μA max. at 3.0V, WDT dis<br>Freq: 20 MHz max.     | N/A  | VDD: 4.5V to 5.5V<br>IDD: 20 mA max. at 5.5V<br>IPD: 9 μA max. at 3.0V, WDT dis<br>Freq: 20 MHz max.           |
| LP  | VDD: 2.5V to 6.25V IDD: 15 $\mu$ A typ. at 3.0V IPD: 0.6 $\mu$ A typ. at 3.0V, WDT dis Freq: 40 kHz max. | VDD: 2.5V to 6.25V IDD: 32 $\mu$ A max. at 32 kHz, 3.0V IPD: 9 $\mu$ A max. at 3.0V, WDT dis Freq: 40 kHz max. | VDD: 2.5V to 6.25V IDD: 32 $\mu$ A max. at 32 kHz, 3.0V IPD: 9 $\mu$ A max. at 3.0V, WDT dis Freq: 40 kHz max. |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

### 11.1 DC Characteristics: PIC16C5X-RC, XT, 10, HS, LP (Commercial)

| DC Characteristics<br>Power Supply Pins       |      | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ |                    |      |       |  |  |
|---|------|--|--------------------|------|-------|--|--|
| Characteristic                                | Sym  | Min  | Typ <sup>(1)</sup> | Max  | Units | Conditions                                       |  |
| Supply Voltage                                | VDD  |  |                    |      |       |  |  |
| PIC16C5X-RC                                   |      | 3.0  |                    | 6.25 | V     | Fosc = DC to 4 MHz                               |  |
| PIC16C5X-XT                                   |      | 3.0  |                    | 6.25 | V     | Fosc = DC to 4 MHz                               |  |
| PIC16C5X-10                                   |      | 4.5  |                    | 5.5  | V     | Fosc = DC to 10 MHz                              |  |
| PIC16C5X-HS                                   |      | 4.5  |                    | 5.5  | V     | Fosc = DC to 20 MHz                              |  |
| PIC16C5X-LP                                   |      | 2.5  |                    | 6.25 | V     | Fosc = DC to 40 kHz                              |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR  |  | 1.5*               |      | V     | Device in SLEEP Mode                             |  |
| VDD Start Voltage to ensure<br>Power-On Reset | VPOR |  | Vss                |      | V     | See Section 7.4 for details on Power-On Reset    |  |
| VDD Rise Rate to ensure Power-On Reset        | SVDD | 0.05*  |                    |      | V/ms  | See Section 7.4 for details on<br>Power-On Reset |  |
| Supply Current <sup>(3)</sup>                 | IDD  |  |                    |      |       |  |  |
| PIC16C5X-RC <sup>(4)</sup>                    |      |  | 1.8                | 3.3  | mA    | Fosc = 4 MHz, VDD = 5.5V                         |  |
| PIC16C5X-XT                                   |      |  | 1.8                | 3.3  | mA    | Fosc = 4 MHz, VDD = 5.5V                         |  |
| PIC16C5X-10                                   |      |  | 4.8                | 10   | mA    | Fosc = 10 MHz, VDD = 5.5V                        |  |
| PIC16C5X-HS                                   |      |  | 4.8                | 10   | mA    | Fosc = 10 MHz, VDD = 5.5V                        |  |
|   |      |  | 9.0                | 20   | mA    | Fosc = 20 MHz, VDD = 5.5V                        |  |
| PIC16C5X-LP                                   |      |  | 15                 | 32   | μΑ    | Fosc = 32 kHz, VDD = 3.0V,<br>WDT disabled       |  |
| Power Down Current <sup>(5)</sup>             | IPD  |  |                    |      |       |  |  |
|   |      |  | 4.0                | 12   | μΑ    | VDD = 3.0V, WDT enabled                          |  |
|   |      |  | 0.6                | 9    | μΑ    | VDD = 3.0V, WDT disabled                         |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

### 11.2 DC Characteristics: PIC16C5X-RCI, XTI, 10I, HSI, LPI (Industrial)

| DC Characteristics<br>Power Supply Pins       |      | Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ |                    |      |       |  |  |
|---|------|---|--------------------|------|-------|--|--|
| Characteristic                                | Sym  | Min   | Typ <sup>(1)</sup> | Max  | Units | Conditions                                       |  |
| Supply Voltage                                | VDD  |   |                    |      |       |  |  |
| PIC16C5X-RCI                                  |      | 3.0   |                    | 6.25 | V     | Fosc = DC to 4 MHz                               |  |
| PIC16C5X-XTI                                  |      | 3.0   |                    | 6.25 | V     | Fosc = DC to 4 MHz                               |  |
| PIC16C5X-10I                                  |      | 4.5   |                    | 5.5  | V     | Fosc = DC to 10 MHz                              |  |
| PIC16C5X-HSI                                  |      | 4.5   |                    | 5.5  | V     | Fosc = DC to 20 MHz                              |  |
| PIC16C5X-LPI                                  |      | 2.5   |                    | 6.25 | V     | Fosc = DC to 40 kHz                              |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR  |   | 1.5*               |      | V     | Device in SLEEP mode                             |  |
| VDD Start Voltage to ensure<br>Power-On Reset | VPOR |   | Vss                |      | V     | See Section 7.4 for details on Power-On Reset    |  |
| VDD Rise Rate to ensure<br>Power-On Reset     | SVDD | 0.05*   |                    |      | V/ms  | See Section 7.4 for details on<br>Power-On Reset |  |
| Supply Current <sup>(3)</sup>                 | IDD  |   |                    |      |       |  |  |
| PIC16C5X-RCI <sup>(4)</sup>                   |      |   | 1.8                | 3.3  | mA    | Fosc = 4 MHz, VDD = 5.5V                         |  |
| PIC16C5X-XTI                                  |      |   | 1.8                | 3.3  | mA    | Fosc = 4 MHz, VDD = 5.5V                         |  |
| PIC16C5X-10I                                  |      |   | 4.8                | 10   | mA    | Fosc = 10 MHz, VDD = 5.5V                        |  |
| PIC16C5X-HSI                                  |      |   | 4.8                | 10   | mA    | Fosc = 10 MHz, VDD = 5.5V                        |  |
|   |      |   | 9.0                | 20   | mA    | Fosc = 20 MHz, VDD = 5.5V                        |  |
| PIC16C5X-LPI                                  |      |   | 15                 | 40   | μΑ    | Fosc = 32 kHz, VDD = 3.0V,<br>WDT disabled       |  |
| Power Down Current <sup>(5)</sup>             | IPD  |   |                    |      |       |  |  |
|   |      |   | 4.0                | 14   | μΑ    | VDD = 3.0V, WDT enabled                          |  |
|   |      |   | 0.6                | 12   | μA    | VDD = 3.0V, WDT disabled                         |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

### 11.3 DC Characteristics: PIC16C5X-RCE, XTE, 10E, HSE, LPE (Extended)

| DC Characteristics<br>Power Supply Pins       |      | Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ |                    |     |       |   |  |  |
|---|------|--|--------------------|-----|-------|---|--|--|
| Characteristic                                | Sym  | Min  | Typ <sup>(1)</sup> | Max | Units | Conditions                                    |  |  |
| Supply Voltage                                | VDD  |  |                    |     |       |   |  |  |
| PIC16C5X-RCE                                  |      | 3.25   |                    | 6.0 | V     | Fosc = DC to 4 MHz                            |  |  |
| PIC16C5X-XTE                                  |      | 3.25   |                    | 6.0 | V     | Fosc = DC to 4 MHz                            |  |  |
| PIC16C5X-10E                                  |      | 4.5  |                    | 5.5 | V     | Fosc = DC to 10 MHz                           |  |  |
| PIC16C5X-HSE                                  |      | 4.5  |                    | 5.5 | V     | Fosc = DC to 16 MHz                           |  |  |
| PIC16C5X-LPE                                  |      | 2.5  |                    | 6.0 | V     | Fosc = DC to 40 kHz                           |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR  |  | 1.5*               |     | V     | Device in SLEEP mode                          |  |  |
| VDD Start Voltage to ensure<br>Power-On Reset | VPOR |  | Vss                |     | V     | See Section 7.4 for details on Power-On Reset |  |  |
| VDD rise rate to ensure<br>Power-On Reset     | SVDD | 0.05*  |                    |     | V/ms  | See Section 7.4 for details on Power-On Reset |  |  |
| Supply Current <sup>(3)</sup>                 | IDD  |  |                    |     |       |   |  |  |
| PIC16C5X-RCE <sup>(4)</sup>                   |      |  | 1.8                | 3.3 | mA    | Fosc = 4 MHz, VDD = 5.5V                      |  |  |
| PIC16C5X-XTE                                  |      |  | 1.8                | 3.3 | mA    | Fosc = 4 MHz, VDD = 5.5V                      |  |  |
| PIC16C5X-10E                                  |      |  | 4.8                | 10  | mA    | Fosc = 10 MHz, VDD = 5.5V                     |  |  |
| PIC16C5X-HSE                                  |      |  | 4.8                | 10  | mA    | Fosc = 10 MHz, VDD = 5.5V                     |  |  |
|   |      |  | 9.0                | 20  | mA    | Fosc = 16 MHz, VDD = 5.5V                     |  |  |
| PIC16C5X-LPE                                  |      |  | 19                 | 55  | μΑ    | Fosc = 32 kHz, VDD = 3.25V,<br>WDT disabled   |  |  |
| Power Down Current <sup>(5)</sup>             | IPD  |  |                    |     |       |   |  |  |
|   |      |  | 5.0                | 22  | μΑ    | VDD = 3.25V, WDT enabled                      |  |  |
|   |      |  | 0.8                | 18  | μΑ    | VDD = 3.25V, WDT disabled                     |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

#### 11.4 DC Characteristics: PIC16C5X-RC, XT, 10, HS, LP (Commercial) PIC16C5X-RCI, XTI, 10I, HSI, LPI (Industrial)

**DC Characteristics All Pins Except Power Supply Pins**  Standard Operating Conditions (unless otherwise specified)

**Operating Temperature**  $0^{\circ}C \leq TA \leq +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

Operating Voltage VDD range is described in Section 11.1, Section 11.2 and

Section 11.3.

| Characteristic  | Sym  | Min  | Typ <sup>(1)</sup>       | Max  | Units                      | Conditions  |
|---|------|--|--------------------------|--|----------------------------|---|
| Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger)   | VIL  | Vss<br>Vss<br>Vss<br>Vss   |                          | 0.2 VDD<br>0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.3 VDD | V<br>V<br>V                | Pin at hi-impedance  PIC16C5X-RC only <sup>(4)</sup> PIC16C5X-XT, 10, HS, LP  |
| Input High Voltage I/O ports  MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) | VIH  | 0.45 VDD<br>2.0<br>0.36 VDD<br>0.85 VDD<br>0.85 VDD<br>0.85 VDD<br>0.7 VDD |                          | VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD          | V V V V V V V              | For all $V_{DD}^{(5)}$<br>$4.0V < V_{DD} \le 5.5V^{(5)}$<br>$V_{DD} > 5.5V$<br>PIC16C5X-RC only <sup>(4)</sup><br>PIC16C5X-XT, 10, HS, LP   |
| Hysteresis of Schmitt<br>Trigger inputs   | VHYS | 0.15VDD*   |                          |  | V                          |   |
| Input Leakage Current <sup>(2,3)</sup> I/O ports  MCLR  T0CKI OSC1                                  | lιL  | -1<br>-5<br>-3<br>-3   | 0.5<br>0.5<br>0.5<br>0.5 | +1<br>+5<br>+3<br>+3                                   | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | For VDD $\leq$ 5.5V<br>VSS $\leq$ VPIN $\leq$ VDD,<br>Pin at hi-impedance<br>VPIN = VSS + 0.25V<br>VPIN = VDD<br>VSS $\leq$ VPIN $\leq$ VDD<br>VSS $\leq$ VPIN $\leq$ VDD,<br>PIC16C5X-XT, 10, HS, LP |
| Output Low Voltage I/O ports OSC2/CLKOUT  | Vol  |  |                          | 0.6<br>0.6   | V<br>V                     | IOL = 8.7 mA, VDD = 4.5V<br>IOL = 1.6 mA, VDD = 4.5V,<br>PIC16C5X-RC  |
| Output High Voltage I/O ports <sup>(3)</sup> OSC2/CLKOUT  | Voн  | VDD - 0.7<br>VDD - 0.7   |                          |  | V<br>V                     | IOH = -5.4 mA, VDD = 4.5V<br>IOH = -1.0 mA, VDD = 4.5V,<br>PIC16C5X-RC  |

<sup>\*</sup> These parameters are characterized but not tested.

- 3: Negative current is defined as coming out of the pin.
- 4: For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

<sup>2:</sup> The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input

#### 11.5 DC Characteristics: PIC16C5X-RC, XT, 10, HS, LP (Extended)

Standard Operating Conditions (unless otherwise specified) **DC Characteristics**  $-40^{\circ}C \le TA \le +125^{\circ}C$ Operating Temperature **All Pins Except** Operating Voltage VDD range is described in Section 11.1, Section 11.2 and **Power Supply Pins** Section 11.3. \_ (1) \_\_\_ . . . . . .

| Characteristic  | Sym  | Min  | Typ <sup>(1)</sup>       | Max   | Units                      | Conditions   |
|---|------|--|--------------------------|---|----------------------------|--|
| Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger)   | VIL  | Vss<br>Vss<br>Vss<br>Vss<br>Vss  |                          | 0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.3 VDD | V<br>V<br>V<br>V           | Pin at hi-impedance  PIC16C5X-RC only <sup>(4)</sup> PIC16C5X-XT, 10, HS, LP   |
| Input High Voltage I/O ports  MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) | ViH  | 0.45 VDD<br>2.0<br>0.36 VDD<br>0.85 VDD<br>0.85 VDD<br>0.85 VDD<br>0.7 VDD |                          | VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD           | V<br>V<br>V<br>V<br>V      | For all $V_{DD}^{(5)}$<br>$4.0V < V_{DD} \le 5.5V^{(5)}$<br>$V_{DD} > 5.5 V$<br>PIC16C5X-RC only <sup>(4)</sup><br>PIC16C5X-XT, 10, HS, LP   |
| Hysteresis of Schmitt<br>Trigger inputs   | VHYS | 0.15VDD*   |                          |   | V                          |  |
| Input Leakage Current (2,3) I/O ports  MCLR  TOCKI OSC1   | lıL. | -1<br>-5<br>-3<br>-3   | 0.5<br>0.5<br>0.5<br>0.5 | +1<br>+5<br>+3<br>+3                                    | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | For VDD $\leq$ 5.5 V<br>VSS $\leq$ VPIN $\leq$ VDD,<br>Pin at hi-impedance<br>VPIN = VSS + 0.25V<br>VPIN = VDD<br>VSS $\leq$ VPIN $\leq$ VDD<br>VSS $\leq$ VPIN $\leq$ VDD,<br>PIC16C5X-XT, 10, HS, LP |
| Output Low Voltage I/O ports OSC2/CLKOUT  | VoL  |  |                          | 0.6<br>0.6  | V<br>V                     | IOL = 8.7 mA, VDD = 4.5V<br>IOL = 1.6 mA, VDD = 4.5V,<br>PIC16C5X-RC   |
| Output High Voltage I/O ports <sup>(3)</sup> OSC2/CLKOUT  | Vон  | VDD - 0.7<br>VDD - 0.7   |                          |   | V<br>V                     | IOH = -5.4 mA, VDD = 4.5V<br>IOH = -1.0 mA, VDD = 4.5V,<br>PIC16C5X-RC   |

<sup>\*</sup> These parameters are characterized but not tested.

- 3: Negative current is defined as coming out of the pin.
- 4: For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

<sup>2:</sup> The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input

# 11.6 <u>Timing Parameter Symbology and Load Conditions</u>

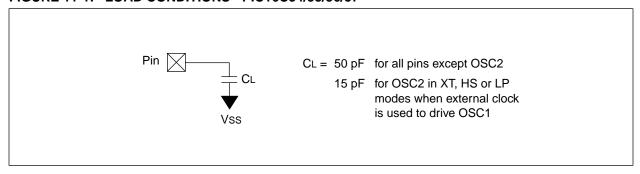
The timing parameter symbols have been created following one of the following formats:

#### 1. TppS2ppS

2. TppS

| Т     |   |     |                |  |
|-------|---|-----|----------------|--|
| F     | Frequency                               | T   | Time           |  |
| Lower | case subscripts (pp) and their meanings | S:  |                |  |
| рр    |   |     |                |  |
| 2     | to                                      | mc  | MCLR           |  |
| ck    | CLKOUT                                  | osc | oscillator     |  |
| су    | cycle time                              | os  | OSC1           |  |
| drt   | device reset timer                      | t0  | T0CKI          |  |
| io    | I/O port                                | wdt | watchdog timer |  |
| Upper | case letters and their meanings:        | ·   |                |  |
| S     |   |     |                |  |
| F     | Fall                                    | P   | Period         |  |
| Н     | High                                    | R   | Rise           |  |
| I     | Invalid (Hi-impedance)                  | V   | Valid          |  |
| L     | Low                                     | Z   | Hi-impedance   |  |

#### FIGURE 11-1: LOAD CONDITIONS - PIC16C54/55/56/57



#### 11.7 <u>Timing Diagrams and Specifications</u>

# FIGURE 11-2: EXTERNAL CLOCK TIMING - PIC16C54/55/56/57

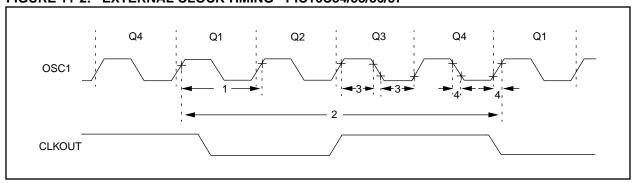


TABLE 11-3: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54/55/56/57

AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)  $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)  $-40^{\circ}C \le TA \le +125^{\circ}C$  (extended)

Operating Voltage VDD range is described in Section 11.1, Section 11.2 and Section 11.3

| Parameter No. | Sym  | Characteristic                          | Min | Тур <sup>(1)</sup> | Max | Units | Conditions               |
|---------------|------|---|-----|--------------------|-----|-------|--------------------------|
|               | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4   | MHz   | XT osc mode              |
|               |      |   | DC  | _                  | 10  | MHz   | 10 MHz mode              |
|               |      |   | DC  | _                  | 20  | MHz   | HS osc mode (Com/Indust) |
|               |      |   | DC  | _                  | 16  | MHz   | HS osc mode (Extended)   |
|               |      |   | DC  | _                  | 40  | kHz   | LP osc mode              |
|               |      | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4   | MHz   | RC osc mode              |
|               |      |   | 0.1 | _                  | 4   | MHz   | XT osc mode              |
|               |      |   | 4   | _                  | 10  | MHz   | 10 MHz mode              |
|               |      |   | 4   | _                  | 20  | MHz   | HS osc mode (Com/Indust) |
|               |      |   | 4   | _                  | 16  | MHz   | HS osc mode (Extended)   |
|               |      |   | DC  | _                  | 40  | kHz   | LP osc mode              |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TCY) equals four times the input oscillator time base period.

#### TABLE 11-3: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54/55/56/57 (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 11.1, Section 11.2 and Section 11.3

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Тур <sup>(1)</sup> | Max    | Units | Conditions               |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|--------------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode              |
|                  |            |                                       | 100  | _                  | _      | ns    | 10 MHz mode              |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (Com/Indust) |
|                  |            |                                       | 62.5 | _                  | _      | ns    | HS osc mode (Extended)   |
|                  |            |                                       | 25   | _                  | _      | μs    | LP osc mode              |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode              |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode              |
|                  |            |                                       | 100  | _                  | 250    | ns    | 10 MHz mode              |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (Com/Indust) |
|                  |            |                                       | 62.5 | _                  | 250    | ns    | HS osc mode (Extended)   |
|                  |            |                                       | 25   | _                  | _      | μs    | LP osc mode              |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      | _     |                          |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 85*  | _                  | _      | ns    | XT oscillator            |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator            |
|                  |            |                                       | 2*   | _                  | _      | μs    | LP oscillator            |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator            |
|                  |            |                                       | _    | _                  | 25*    | ns    | HS oscillator            |
|                  |            |                                       | _    | _                  | 50*    | ns    | LP oscillator            |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
- When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**AC Characteristics** 

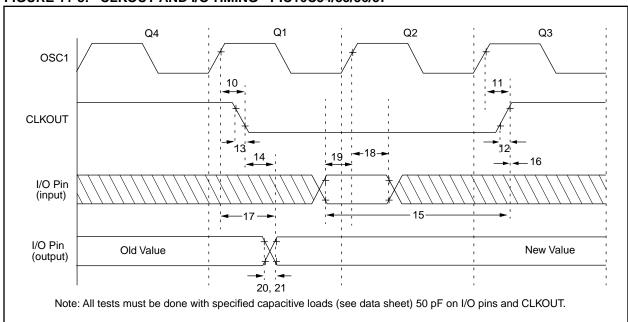


FIGURE 11-3: CLKOUT AND I/O TIMING - PIC16C54/55/56/57

TABLE 11-4: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C54/55/56/57

| Operating Temperature $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C} \text{ (commercial)} \\ -40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C} \text{ (industrial)} \\ -40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C} \text{ (extended)}$ Operating Voltage VDD range is described in Section 11.1, Section 11.2 Section 11.3 |          |   |              |                    |      |       |  |
|---|----------|---|--------------|--------------------|------|-------|--|
| Parameter<br>No.  | Sym      | Characteristic  | Min          | Typ <sup>(1)</sup> | Max  | Units |  |
| 10  | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                           | _            | 15                 | 30** | ns    |  |
| 11  | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                           | _            | 15                 | 30** | ns    |  |
| 12  | TckR     | CLKOUT rise time <sup>(2)</sup>                           | _            | 5                  | 15** | ns    |  |
| 13  | TckF     | CLKOUT fall time <sup>(2)</sup>                           | _            | 5                  | 15** | ns    |  |
| 14  | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>                  | _            | _                  | 40** | ns    |  |
| 15  | TioV2ckH | Port in valid before CLKOUT <sup>(2)</sup>                | 0.25 TCY+30* | _                  | _    | ns    |  |
| 16  | TckH2ioI | Port in hold after CLKOUT <sup>(2)</sup>                  | 0*           | _                  | _    | ns    |  |
| 17  | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid <sup>(3)</sup>         | _            | _                  | 100* | ns    |  |
| 18  | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time) | TBD          | _                  | _    | ns    |  |
| 19  | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)             | TBD          | _                  | _    | ns    |  |
| 20  | TioR     | Port output rise time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |  |
| 21  | TioF     | Port output fall time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |  |

Standard Operating Conditions (unless otherwise specified)

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 11-1 for loading conditions.

<sup>\*</sup> These parameters are characterized but not tested.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 11-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16C54/55/56/57

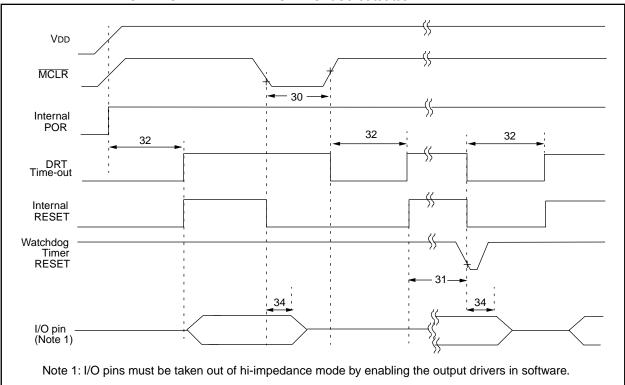


TABLE 11-5: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C54/55/56/57

# AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial) -40°C  $\le TA \le +125^{\circ}C$  (extended)

Operating Voltage VDD range is described in Section 11.1, Section 11.2 and Section 11.3

| Parameter No. | Sym  | Characteristic                                | Min  | Typ <sup>(1)</sup> | Max  | Units | Conditions              |
|---------------|------|---|------|--------------------|------|-------|-------------------------|
| 30            | TmcL | MCLR Pulse Width (low)                        | 100* | _                  |      | ns    | VDD = 5.0V              |
| 31            | Twdt | Watchdog Timer Time-out Period (No Prescaler) | 9*   | 18*                | 30*  | ms    | VDD = 5.0V (Commercial) |
| 32            | TDRT | Device Reset Timer Period                     | 9*   | 18*                | 30*  | ms    | VDD = 5.0V (Commercial) |
| 34            | Tioz | I/O Hi-impedance from MCLR Low                |      | _                  | 100* | ns    |                         |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 11-5: TIMERO CLOCK TIMINGS - PIC16C54/55/56/57

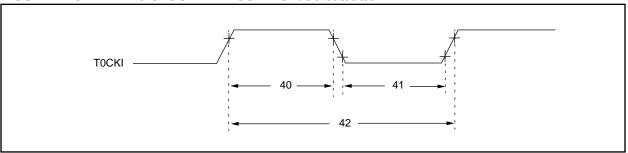


TABLE 11-6: TIMERO CLOCK REQUIREMENTS - PIC16C54/55/56/57

| AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ (extended) Operating Voltage VDD range is described in Section 11.1, Sec Section 11.3 |      |                   |                      |                              | ercial)<br>rial)<br>ded) |     |       |   |
|--|------|-------------------|----------------------|------------------------------|--------------------------|-----|-------|---|
| Parameter No.  | Sym  | Characteristic    |                      | Min                          | Typ <sup>(1)</sup>       | Max | Units | Conditions  |
| 40   | TtOH | T0CKI High Pulse  | Width - No Prescaler | 0.5 Tcy + 20*                | _                        | _   | ns    |   |
|  |      |                   | - With Prescaler     | 10*                          | _                        | _   | ns    |   |
| 41   | Tt0L | T0CKI Low Pulse V | Vidth - No Prescaler | 0.5 Tcy + 20*                | _                        | _   | ns    |   |
|  |      |                   | - With Prescaler     | 10*                          | _                        | _   | ns    |   |
| 42   | Tt0P | T0CKI Period      |                      | 20 or <u>Tcy + 40</u> *<br>N | _                        | _   | ns    | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C54/55/56/57

**NOTES:** 

#### 12.0 DC AND AC CHARACTERISTICS - PIC16C54/55/56/57

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean +  $3\sigma$ ) and (mean -  $3\sigma$ ) respectively, where  $\sigma$  is standard deviation.

Fosc Frequency normalized to +25°C Fosc (25°C) 1.10 Rext  $\geq$  10 k $\Omega$ 1.08 Cext = 100 pF1.06 1.04 1.02 1.00 0.98 VDD = 5.5 V0.96 0.94 VDD = 3.5 V0.92 0.90 0.88 0 10 20 25 30 40 50 60 70 T(°C)

FIGURE 12-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

TABLE 12-1: RC OSCILLATOR FREQUENCIES

| Cext   | Rext  |            | erage<br>② 5 V, 25°C |
|--------|-------|------------|----------------------|
| 20 pF  | 3.3 k | 4.973 MHz  | ± 27%                |
|        | 5 k   | 3.82 MHz   | ± 21%                |
|        | 10 k  | 2.22 MHz   | ± 21%                |
|        | 100 k | 262.15 kHz | ± 31%                |
| 100 pF | 3.3 k | 1.63 MHz   | ± 13%                |
|        | 5 k   | 1.19 MHz   | ± 13%                |
|        | 10 k  | 684.64 kHz | ± 18%                |
|        | 100 k | 71.56 kHz  | ± 25%                |
| 300 pF | 3.3 k | 660 kHz    | ± 10%                |
|        | 5.0 k | 484.1 kHz  | ± 14%                |
|        | 10 k  | 267.63 kHz | ± 15%                |
|        | 160 k | 29.44 kHz  | ± 19%                |

The frequencies are measured on DIP packages.

The percentage variation indicated here is part-to-part variation due to normal process distribution. The variation indicated is  $\pm 3$  standard deviation from average value for VDD = 5 V.

PIC16C54/55/56/57

FIGURE 12-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 20 PF

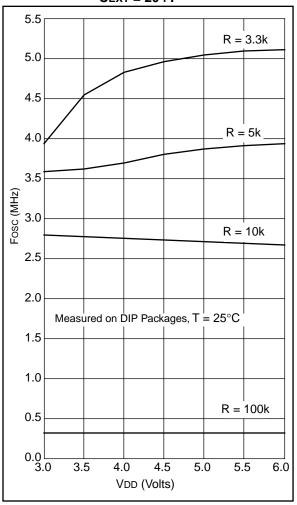


FIGURE 12-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 100 PF

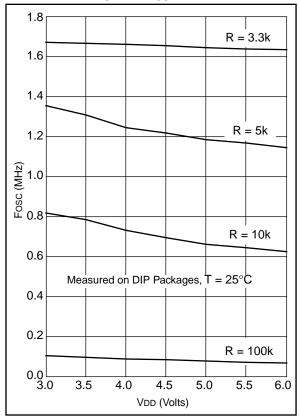


FIGURE 12-4: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD,

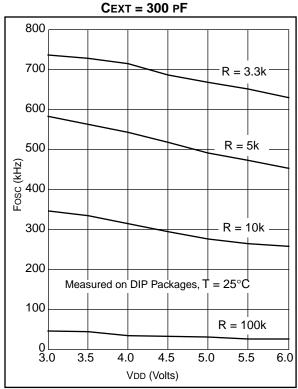


FIGURE 12-5: TYPICAL IPD vs. VDD, WATCHDOG DISABLED

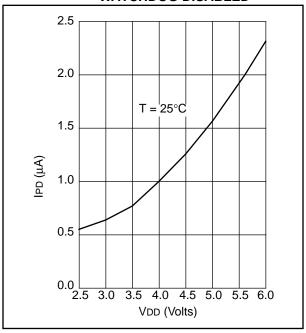


FIGURE 12-6: MAXIMUM IPD vs. VDD, WATCHDOG DISABLED

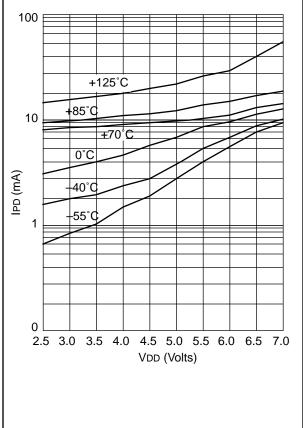


FIGURE 12-7: TYPICAL IPD vs. VDD, WATCHDOG ENABLED

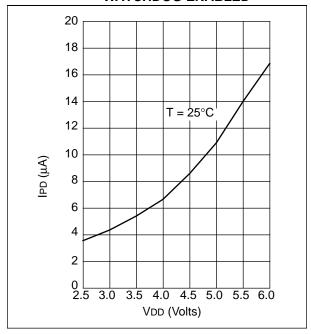
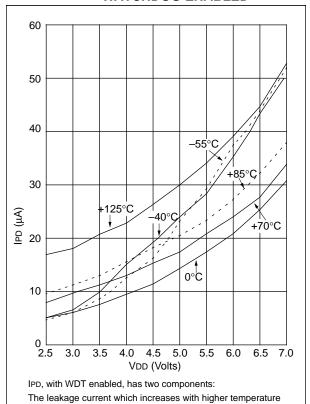


FIGURE 12-8: MAXIMUM IPD vs. VDD, WATCHDOG ENABLED



and the operating current of the WDT logic which increases with lower temperature. At  $-40^{\circ}$ C, the latter dominates

explaining the apparently anomalous behavior.

FIGURE 12-9: VTH (INPUT THRESHOLD VOLTAGE) OF I/O PINS vs. VDD

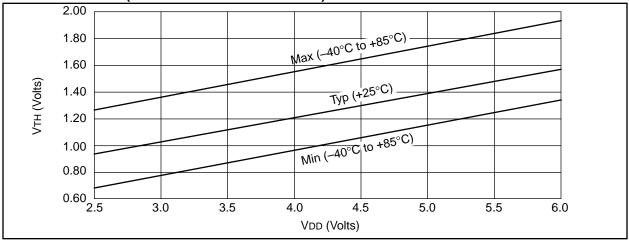


FIGURE 12-10: VIH, VIL OF MCLR, TOCKI AND OSC1 (IN RC MODE) vs. VDD

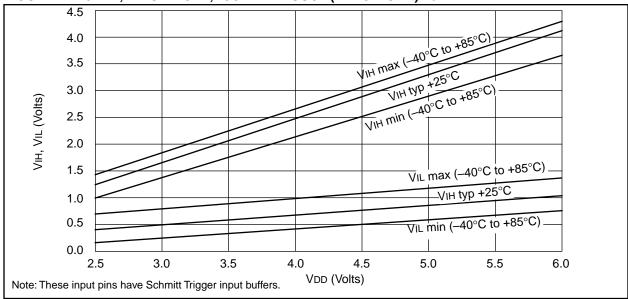
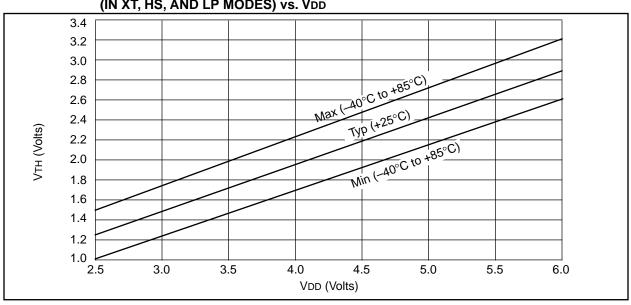


FIGURE 12-11: VTH (INPUT THRESHOLD VOLTAGE) OF OSC1 INPUT (IN XT, HS, AND LP MODES) vs. VDD





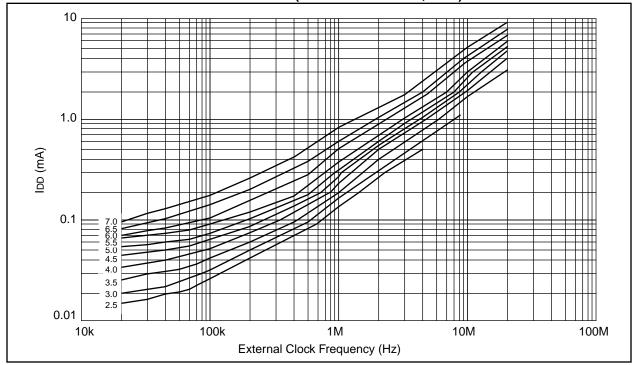
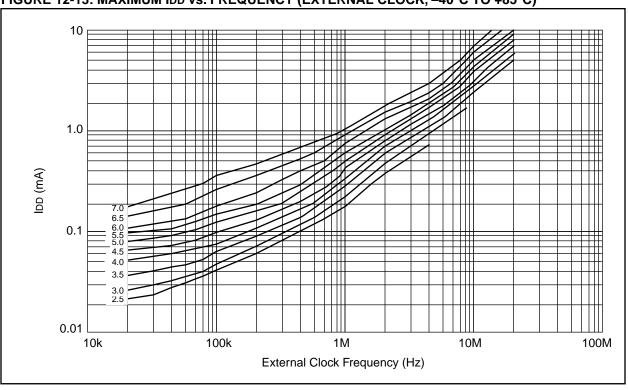


FIGURE 12-13: MAXIMUM IDD vs. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C)



10 1.0 loo (mA) 7.0 6.5 6.0 5.5 5.0 4.5 4.0 3.5 3.0 0.1 0.01 10k 100k 100M 1M 10M External Clock Frequency (Hz)

FIGURE 12-14: MAXIMUM IDD vs. FREQUENCY (EXTERNAL CLOCK -55°C TO +125°C)

FIGURE 12-15: WDT TIMER TIME-OUT PERIOD vs. VDD

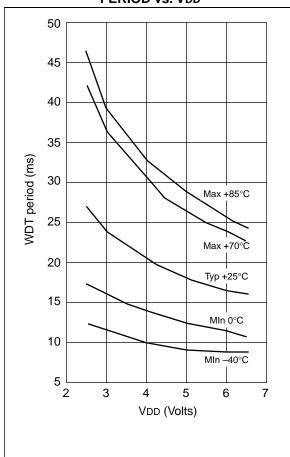


FIGURE 12-16: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. VDD

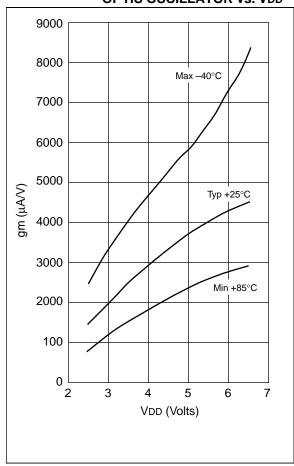


FIGURE 12-17: TRANSCONDUCTANCE (gm)
OF LP OSCILLATOR vs. VDD

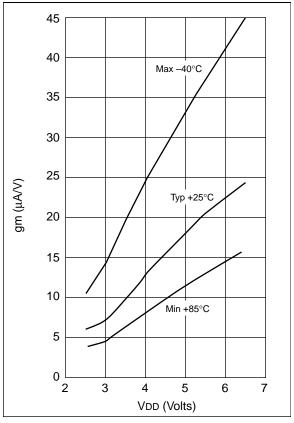


FIGURE 12-18: IOH vs. VOH, VDD = 3 V

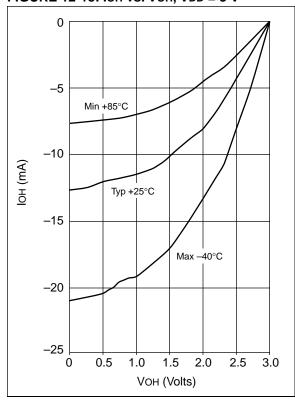


FIGURE 12-19: TRANSCONDUCTANCE (gm)
OF XT OSCILLATOR vs. VDD

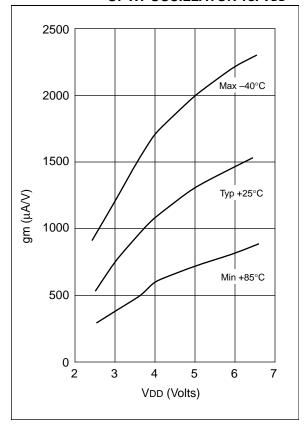
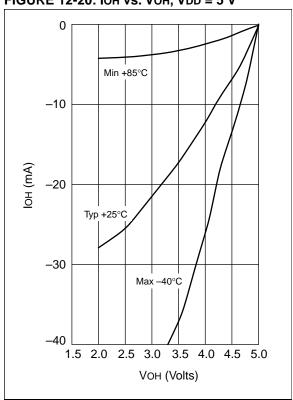


FIGURE 12-20: IOH vs. VOH, VDD = 5 V



PIC16C54/55/56/57

FIGURE 12-21: IOL vs. Vol, VDD = 3 V

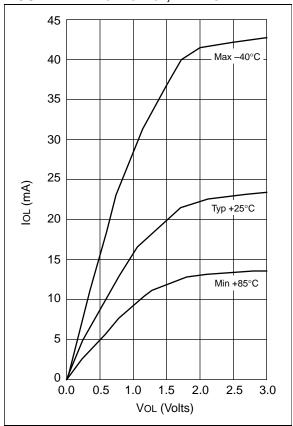


TABLE 12-2: INPUT CAPACITANCE FOR PIC16C54/56

| Pin         | Typical Capacitance (pF) |          |  |  |  |
|-------------|--------------------------|----------|--|--|--|
| PIII        | 18L PDIP                 | 18L SOIC |  |  |  |
| RA port     | 5.0                      | 4.3      |  |  |  |
| RB port     | 5.0                      | 4.3      |  |  |  |
| MCLR        | 17.0                     | 17.0     |  |  |  |
| OSC1        | 4.0                      | 3.5      |  |  |  |
| OSC2/CLKOUT | 4.3                      | 3.5      |  |  |  |
| TOCKI       | 3.2                      | 2.8      |  |  |  |

All capacitance values are typical at 25°C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

FIGURE 12-22: IOL vs. Vol, VDD = 5 V

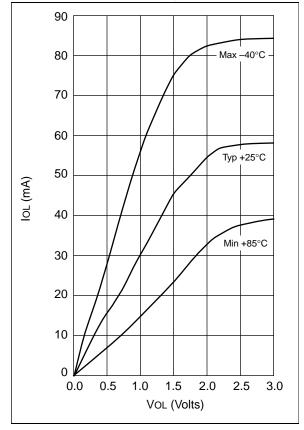


TABLE 12-3: INPUT CAPACITANCE FOR PIC16C55/57

|             | Typical Capacitance (pF) |          |  |  |  |
|-------------|--------------------------|----------|--|--|--|
| Pin         | 28L PDIP<br>(600 mil)    | 28L SOIC |  |  |  |
| RA port     | 5.2                      | 4.8      |  |  |  |
| RB port     | 5.6                      | 4.7      |  |  |  |
| RC port     | 5.0                      | 4.1      |  |  |  |
| MCLR        | 17.0                     | 17.0     |  |  |  |
| OSC1        | 6.6                      | 3.5      |  |  |  |
| OSC2/CLKOUT | 4.6                      | 3.5      |  |  |  |
| T0CKI       | 4.5                      | 3.5      |  |  |  |

All capacitance values are typical at 25°C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

PIC16CR54A PIC16C5X

### 13.0 ELECTRICAL CHARACTERISTICS - PIC16CR54A

# **Absolute Maximum Ratings†**

this pin directly to Vss.

| Ambient Temperature under bias  | –55°C to +125°C                        |
|---|--|
| Storage Temperature   | 65°C to +150°C                         |
| Voltage on VDD with respect to Vss  | 0 to +7.5\                             |
| Voltage on MCLR with respect to Vss <sup>(2)</sup>  | 0 to +14\                              |
| Voltage on all other pins with respect to Vss   | 0.6V to (VDD + 0.6V                    |
| Total Power Dissipation <sup>(1)</sup>  | 800 mV                                 |
| Max. Current out of Vss pin   | 150 m/                                 |
| Max. Current into VDD pin   | 50 m <i>A</i>                          |
| Max. Current into an input pin (T0CKI only)   | ±500 μΑ                                |
| Input Clamp Current, Iik (VI < 0 or VI > VDD)   | ±20 m/                                 |
| Output Clamp Current, loк (V0 < 0 or V0 > VDD)  | ±20 m/                                 |
| Max. Output Current sunk by any I/O pin   | 25 m <i>A</i>                          |
| Max. Output Current sourced by any I/O pin  | 20 m/                                  |
| Max. Output Current sourced by a single I/O port (PORTA or B)   | 40 m <i>A</i>                          |
| Max. Output Current sunk by a single I/O port (PORTA or B)  | 50 m <i>A</i>                          |
| <b>Note 1:</b> Power Dissipation is calculated as follows: PDIS = VDD x {IDD - $\Sigma$ IOH} + $\Sigma$ {(  | VDD-VOH) x IOH} + $\Sigma$ (VOL x IOL) |
| <b>Note 2:</b> Voltage spikes below Vss at the MCLR pin, inducing currents greater than 8 a series resistor of 50 to 100Ω should be used when applying a low level to t | <u>·</u>                               |

<sup>†</sup>NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 13-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16CR54A-04   | PIC16CR54A-10  | PIC16CR54A-20  | PIC16LCR54A-04  |
|-----|---|--|--|---|
| RC  | VDD: 2.5 V to 6.25 V IDD: 3.6 mA max at 6.0 V IPD: 6.0 μA max at 2.5 V, WDT dis Freq: 4 MHz max               | N/A  | N/A  | N/A   |
| XT  | VDD: 2.5 V to 6.25 V<br>IDD: 3.6 mA max at 6.0 V<br>IPD: 6.0 μA max at 2.5 V,<br>WDT dis<br>Freq: 4.0 MHz max | N/A  | N/A  | N/A   |
| HS  | N/A   | VDD: 4.5 V to 5.5 V IDD: 10 mA max at 5.5 V IPD: 6.0 μA max at 2.5 V, WDT dis Freq: 10 MHz max | VDD: 4.5 V to 5.5 V<br>IDD: 10 mA max at 5.5 V<br>IPD: 6.0 μA max at 2.5 V,<br>WDT dis<br>Freq: 20 MHz max | N/A   |
| LP  | N/A   | N/A  | N/A  | VDD: 2.0 V to 6.25 V<br>IDD: 20 μA max at 32 kHz,<br>2.0 V<br>IPD: 6.0 μA max at 2.5 V,<br>WDT dis<br>Freq: 200 kHz max |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

PIC16CR54A PIC16C5X

### 13.1 <u>DC Characteristics:</u> <u>PIC16CR54A-04, 10, 20 (Commercial)</u> PIC16CR54A-04I, 10I, 20I (Industrial)

| DC Characteristics<br>Power Supply Pins          |      |            |                                 |                               |                            |  |  |  |
|--|------|------------|---------------------------------|-------------------------------|----------------------------|--|--|--|
| Characteristic                                   | Sym  | Min        | Typ <sup>(1)</sup>              | Max                           | Units                      | Conditions   |  |  |
| Supply Voltage<br>RC and XT options<br>HS option | VDD  | 2.5<br>4.5 |                                 | 6.25<br>5.5                   | V                          |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>        | Vdr  |            | 1.5*                            |                               | V                          | Device in SLEEP mode   |  |  |
| VDD Start Voltage to ensure<br>Power-on Reset    | VPOR |            | Vss                             |                               | V                          | See Section 7.4 for details on Power-on Reset  |  |  |
| VDD Rise Rate to ensure<br>Power-on Reset        | SVDD | 0.05*      |                                 |                               | V/ms                       | See Section 7.4 for details on Power-on Reset  |  |  |
| RC <sup>(4)</sup> and XT options  HS option      | ldd  |            | 2.0<br>0.8<br>90<br>4.8         | 3.6<br>1.8<br>350<br>10       | mA<br>mA<br>μA<br>mA       | Fosc = 4.0 MHz, VDD = 6.0V<br>Fosc = 4.0 MHz, VDD = 3.0V<br>Fosc = 200 kHz, VDD = 2.5V<br>Fosc = 10 MHz, VDD = 5.5V                    |  |  |
| Tio option                                       |      |            | 9.0                             | 20                            | mA                         | Fosc = 20 MHz, VDD = 5.5V  |  |  |
| Power-Down Current <sup>(5)</sup> Commercial     | IPD  |            | 1.0<br>2.0<br>3.0<br>5.0        | 6.0<br>8.0*<br>15<br>25       | μΑ<br>μΑ<br>μΑ<br>μΑ       | VDD = 2.5V, WDT disabled<br>VDD = 4.0V, WDT disabled<br>VDD = 6.0V, WDT disabled<br>VDD = 6.0V, WDT enabled                            |  |  |
| Power-Down Current <sup>(5)</sup> Industrial     | IPD  |            | 1.0<br>2.0<br>3.0<br>3.0<br>5.0 | 8.0<br>10*<br>20*<br>18<br>45 | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT disabled<br>VDD = 4.0V, WDT disabled<br>VDD = 4.0V, WDT enabled<br>VDD = 6.0V, WDT disabled<br>VDD = 6.0V, WDT enabled |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

#### 13.2 DC Characteristics: PIC16CR54A-04E, 10E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins                                  |                    | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ (extended) |                    |                 |                |  |  |  |
|--|--------------------|---|--------------------|-----------------|----------------|--|--|--|
| Characteristic   | Characteristic Sym |   | Typ <sup>(1)</sup> | Max             | Units          | Conditions   |  |  |
| Supply Voltage<br>RC and XT options<br>HS options                        | VDD                | 3.25<br>4.5   |                    | 6.0<br>5.5      | V              |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>                                | Vdr                |   | 1.5*               |                 | V              | Device in SLEEP mode   |  |  |
| VDD Start Voltage to ensure<br>Power-on Reset                            | VPOR               |   | Vss                |                 | V              | See Section 7.4 for details on<br>Power-on Reset                                     |  |  |
| VDD Rise Rate to ensure<br>Power-on Reset                                | SVDD               | 0.05*   |                    |                 | V/ms           | See Section 7.4 for details on Power-on Reset  |  |  |
| Supply Current <sup>(3)</sup> RC <sup>(4)</sup> and XT options HS option | IDD                |   | 1.8<br>4.8<br>9.0  | 3.3<br>10<br>20 | mA<br>mA<br>mA | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 10 MHz, VDD = 5.5V<br>Fosc = 16 MHz, VDD = 5.5V |  |  |
| Power-Down Current <sup>(5)</sup>  | IPD                |   | 5.0<br>0.8         | 22<br>18        | μΑ<br>μΑ       | VDD = 3.25V, WDT enabled<br>VDD = 3.25V, WDT disabled                                |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:  $OSC1 = external \ square \ wave, from \ rail-to-rail; all \ I/O \ pins \ tristated, pulled to \\ Vss, TOCKI = VDD, \overline{MCLR} = VDD; WDT \ enabled/disabled \ as \ specified.$
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16CR54A PIC16C5X

# 13.3 <u>DC Characteristics:</u> <u>PIC16LCR54A-04 (Commercial)</u> <u>PIC16LCR54A-04I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins         |      | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |                                 |                               |                            |  |  |  |
|---|------|---|---------------------------------|-------------------------------|----------------------------|--|--|--|
| Characteristic                                  | Sym  | Min   | Typ <sup>(1)</sup>              | Max                           | Units                      | Conditions   |  |  |
| Supply Voltage                                  | Vdd  | 2.0   |                                 | 6.25                          | V                          |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>       | Vdr  |   | 1.5*                            |                               | V                          | Device in SLEEP mode   |  |  |
| VDD Start Voltage to ensure<br>Power-on Reset   | VPOR |   | Vss                             |                               | V                          | See Section 7.4 for details on Power-on Reset  |  |  |
| VDD Rise Rate to ensure<br>Power-on Reset       | SVDD | 0.05*   |                                 |                               | V/ms                       | See Section 7.4 for details on Power-on Reset  |  |  |
| Supply Current <sup>(3)</sup>                   | ldd  |   | 10                              | 20<br>70                      | μA<br>μA                   | Fosc = 32 kHz, VDD = 2.0V<br>Fosc = 32 kHz, VDD = 6.0V   |  |  |
| Power-Down Current <sup>(5)</sup> Commercial    | IPD  |   | 1.0<br>2.0<br>3.0<br>5.0        | 6.0<br>8.0*<br>15<br>25       | μΑ<br>μΑ<br>μΑ<br>μΑ       | VDD = 2.5V, WDT disabled<br>VDD = 4.0V, WDT disabled<br>VDD = 6.0V, WDT disabled<br>VDD = 6.0V, WDT enabled                |  |  |
| Power-Down Current <sup>(5)</sup><br>Industrial | IPD  |   | 1.0<br>2.0<br>3.0<br>3.0<br>5.0 | 8.0<br>10*<br>20*<br>18<br>45 | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT disabled VDD = 4.0V, WDT disabled VDD = 4.0V, WDT enabled VDD = 6.0V, WDT disabled VDD = 6.0V, WDT enabled |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

#### 13.4 <u>DC Characteristics: PIC16CR54A-04, 10, 20, PIC16LCR54A-04 (Commercial)</u> PIC16CR54A-04I, 10I, 20I, PIC16LCR54A-04I (Industrial)

DC Characteristics
All Pins Except
Power Supply Pins

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

Operating Voltage VDD range is described in Section 13.1 and Section 13.3.

| Characteristic                          | Sym  | Min      | Typ <sup>(1)</sup> | Max      | Units | Conditions                                     |
|---|------|----------|--------------------|----------|-------|--|
| Input Low Voltage                       | VIL  |          |                    |          |       |  |
| I/O ports                               |      | Vss      |                    | 0.2 VDD  | V     | Pin at hi-impedance                            |
| MCLR (Schmitt Trigger)                  |      | Vss      |                    | 0.15 VDD | V     |  |
| T0CKI (Schmitt Trigger)                 |      | Vss      |                    | 0.15 VDD | V     |  |
| OSC1 (Schmitt Trigger)                  |      | Vss      |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup>                  |
| OSC1                                    |      | Vss      |                    | 0.15 VDD | V     | XT, HS and LP options                          |
| Input High Voltage                      | ViH  |          |                    |          |       |  |
| I/O ports                               |      | 2.0      |                    | Vdd      | V     | $VDD = 3.0V \text{ to } 5.5V^{(5)}$            |
|   |      | 0.6 VDD  |                    | Vdd      | V     | Full V <sub>DD</sub> range <sup>(5)</sup>      |
| MCLR (Schmitt Trigger)                  |      | 0.85 VDD |                    | Vdd      | V     |  |
| T0CKI (Schmitt Trigger)                 |      | 0.85 VDD |                    | Vdd      | V     |  |
| OSC1 (Schmitt Trigger)                  |      | 0.85 VDD |                    | VDD      | V     | RC option only <sup>(4)</sup>                  |
| OSC1                                    |      | 0.85 VDD |                    | VDD      | V     | XT, HS and LP options                          |
| Hysteresis of Schmitt<br>Trigger inputs | VHYS | 0.15VDD* |                    |          | V     |  |
| Input Leakage Current <sup>(3)</sup>    | lıL  |          |                    |          |       | For V <sub>DD</sub> ≤ 5.5V                     |
| I/O ports                               |      | -1.0     |                    | +1.0     | μΑ    | VSS ≤ VPIN ≤ VDD,                              |
|   |      | _        |                    |          |       | Pin at hi-impedance                            |
| MCLR                                    |      | -5.0     |                    |          | μΑ    | $VPIN = VSS + 0.25V^{(2)}$                     |
|   |      |          | 0.5                | +5.0     | μΑ    | VPIN = VDD <sup>(2)</sup>                      |
| T0CKI                                   |      | -3.0     | 0.5                | +3.0     | μΑ    | VSS ≤ VPIN ≤ VDD                               |
| OSC1                                    |      | -3.0     | 0.5                | +3.0     | μΑ    | $VSS \leq VPIN \leq VDD$ ,                     |
|   |      |          |                    |          | ·     | XT, HS and LP options                          |
| Output Low Voltage                      | Vol  |          |                    |          |       |  |
| I/O ports                               |      |          |                    | 0.5      | V     | IOL = 10 mA, VDD = 6.0V                        |
| OSC2/CLKOUT                             |      |          |                    | 0.5      | V     | IOL = 1.9  mA, VDD = 6.0V,                     |
|   |      |          |                    |          |       | RC option only                                 |
| Output High Voltage <sup>(3)</sup>      | Vон  |          |                    |          |       |  |
| I/O ports                               |      | VDD -0.5 |                    |          | V     | IOH = -4.0  mA, VDD = 6.0V                     |
| OSC2/CLKOUT                             |      | VDD -0.5 |                    |          | V     | IOH = $-0.8$ mA, VDD = $6.0$ V, RC option only |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
  - 3: Negative current is defined as coming out of the pin.
  - 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
  - 5: The user may use the better of the two specifications.

PIC16CR54A PIC16C5X

#### 13.5 DC Characteristics: PIC16CR54A-04E, 10E, 20E (Extended)

| DC Characteristics<br>All Pins Except<br>Power Supply Pins   |      | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ Operating Voltage VDD range is described in Section 13.2. |                          |   |                                       |   |  |  |  |  |
|--|------|--|--------------------------|---|---------------------------------------|---|--|--|--|--|
| Characteristic   | Sym  | Min  | Typ <sup>(1)</sup>       | Max   | Units                                 | Conditions  |  |  |  |  |
| Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1   | VIL  | Vss<br>Vss<br>Vss<br>Vss<br>Vss  |                          | 0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.3 VDD | V<br>V<br>V                           | Pin at hi-impedance  RC option only <sup>(4)</sup> XT, HS and LP options  |  |  |  |  |
| Input High Voltage I/O ports  MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 | ViH  | 0.45 VDD<br>2.0<br>0.36 VDD<br>0.85 VDD<br>0.85 VDD<br>0.85 VDD<br>0.7 VDD   |                          | VDD VDD VDD VDD VDD VDD VDD VDD                         | V V V V V V V V V V V V V V V V V V V | For all $VDD^{(5)}$<br>$4.0V < VDD \le 5.5V^{(5)}$<br>VDD > 5.5V<br>RC option only <sup>(4)</sup><br>XT, HS and LP options  |  |  |  |  |
| Hysteresis of Schmitt<br>Trigger inputs  | VHYS | 0.15VDD*   |                          |   | V                                     |   |  |  |  |  |
| Input Leakage Current <sup>(3)</sup> I/O ports  MCLR  TOCKI OSC1   | lıL  | -1.0<br>-5.0<br>-3.0<br>-3.0   | 0.5<br>0.5<br>0.5<br>0.5 | +1.0<br>+5.0<br>+3.0<br>+3.0                            | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ            | For VDD $\leq$ 5.5V<br>VSS $\leq$ VPIN $\leq$ VDD,<br>Pin at hi-impedance<br>VPIN = VSS + 0.25V <sup>(2)</sup><br>VPIN = VDD <sup>(2)</sup><br>VSS $\leq$ VPIN $\leq$ VDD<br>VSS $\leq$ VPIN $\leq$ VDD,<br>XT, HS and LP options |  |  |  |  |
| Output Low Voltage I/O ports OSC2/CLKOUT   | Vol  |  |                          | 0.6<br>0.6  | V<br>V                                | IOL = 8.7 mA, VDD = 4.5V<br>IOL = 1.6 mA, VDD = 4.5V,<br>RC option only   |  |  |  |  |
| Output High Voltage (3) I/O ports OSC2/CLKOUT  | Vон  | VDD -0.7<br>VDD -0.7   |                          |   | V<br>V                                | IOH = -5.4 mA, VDD = 4.5V<br>IOH = -1.0 mA, VDD = 4.5V,<br>RC option only   |  |  |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

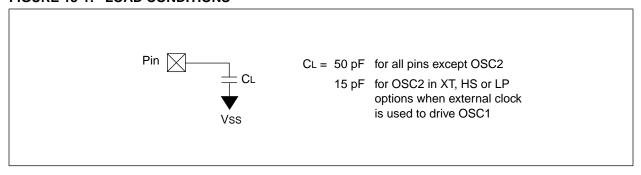
# 13.6 <u>Timing Parameter Symbology and Load Conditions</u>

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS

| Z. 1 PPO |   |     |                |  |
|----------|---|-----|----------------|--|
| Т        |   |     |                |  |
| F        | Frequency                               | Т   | Time           |  |
| Lowerd   | case subscripts (pp) and their meanings | :   |                |  |
| pp       |   |     |                |  |
| 2        | to                                      | mc  | MCLR           |  |
| ck       | CLKOUT                                  | osc | oscillator     |  |
| су       | cycle time                              | os  | OSC1           |  |
| drt      | device reset timer                      | t0  | T0CKI          |  |
| io       | I/O port                                | wdt | watchdog timer |  |
| Upperd   | case letters and their meanings:        |     |                |  |
| S        |   |     |                |  |
| F        | Fall                                    | Р   | Period         |  |
| Н        | High                                    | R   | Rise           |  |
| I        | Invalid (Hi-impedance)                  | V   | Valid          |  |
| L        | Low                                     | Z   | Hi-impedance   |  |

#### FIGURE 13-1: LOAD CONDITIONS



PIC16CR54A PIC16C5X

#### 13.7 <u>Timing Diagrams and Specifications</u>

#### FIGURE 13-2: EXTERNAL CLOCK TIMING - PIC16CR54A

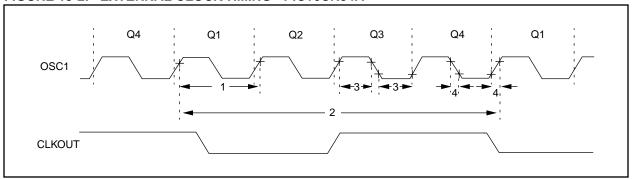


TABLE 13-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR54A

AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature  $0^{\circ}C \leq TA \leq +70^{\circ}C \text{ (commercial)} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \text{ (industrial)} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 13.1, Section 13.2 and Section 13.3.

| Parameter<br>No. | Sym | Characteristic                          | Min | Тур <sup>(1)</sup> | Max | Units | Conditions       |
|------------------|-----|---|-----|--------------------|-----|-------|------------------|
| Fosc             |     | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4.0 | MHz   | XT osc mode      |
|                  |     |   | DC  | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |     |   | DC  | _                  | 10  | MHz   | HS osc mode (10) |
|                  |     |   | DC  | _                  | 20  | MHz   | HS osc mode (20) |
|                  |     |   | DC  | _                  | 200 | kHz   | LP osc mode      |
|                  |     | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4.0 | MHz   | RC osc mode      |
|                  |     |   | 0.1 | _                  | 4.0 | MHz   | XT osc mode      |
|                  |     |   | 4.0 | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |     |   | 4.0 | _                  | 10  | MHz   | HS osc mode (10) |
|                  |     |   | 4.0 | _                  | 20  | MHz   | HS osc mode (20) |
|                  |     |   | 5.0 | _                  | 200 | kHz   | LP osc mode      |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

#### TABLE 13-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR54A (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 13.1, Section 13.2 and Section 13.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Тур <sup>(1)</sup> | Max    | Units | Conditions       |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | _      | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | _      | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | _      | μs    | LP osc mode      |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode      |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | 250    | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | 250    | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | 200    | μs    | LP osc mode      |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      | _     |                  |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 50*  | _                  | _      | ns    | XT oscillator    |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator    |
|                  |            |                                       | 2.0* | _                  | _      | μs    | LP oscillator    |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator    |
|                  |            |                                       | _    | _                  | 25*    | ns    | HS oscillator    |
|                  |            |                                       | _    | _                  | 50*    | ns    | LP oscillator    |

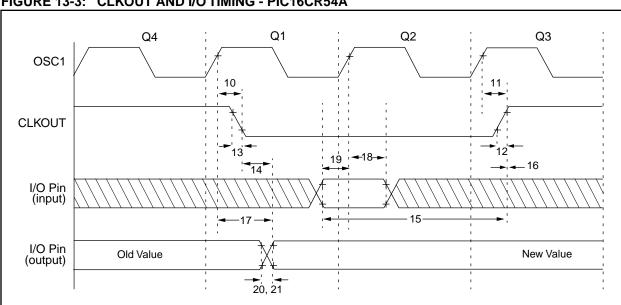
<sup>\*</sup> These parameters are characterized but not tested.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

<sup>2:</sup> All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.



Note: All tests must be done with specified capacitive loads (see data sheet) 50 pF on I/O pins and CLKOUT.

#### FIGURE 13-3: CLKOUT AND I/O TIMING - PIC16CR54A

**TABLE 13-3: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16CR54A** 

| AC Chara         | cteristics |   |              |                    |      |       |  |  |  |
|------------------|------------|---|--------------|--------------------|------|-------|--|--|--|
| Parameter<br>No. | Sym        | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |  |  |  |
| 10               | TosH2ckL   | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                               | _            | 15                 | 30** | ns    |  |  |  |
| 11               | TosH2ckH   | OSC1 <sup>↑</sup> to CLKOUT <sup>(2)</sup>                    | _            | 15                 | 30** | ns    |  |  |  |
| 12               | TckR       | CLKOUT rise time <sup>(2)</sup>                               | _            | 5.0                | 15** | ns    |  |  |  |
| 13               | TckF       | CLKOUT fall time <sup>(2)</sup>                               | _            | 5.0                | 15** | ns    |  |  |  |
| 14               | TckL2ioV   | CLKOUT↓ to Port out valid <sup>(2)</sup>                      | _            | _                  | 40** | ns    |  |  |  |
| 15               | TioV2ckH   | Port in valid before CLKOUT <sup>(2)</sup>                    | 0.25 TCY+30* | _                  | _    | ns    |  |  |  |
| 16               | TckH2ioI   | Port in hold after CLKOUT <sup>(2)</sup>                      | 0*           | _                  | _    | ns    |  |  |  |
| 17               | TosH2ioV   | OSC1 <sup>↑</sup> (Q1 cycle) to Port out valid <sup>(3)</sup> | _            | _                  | 100* | ns    |  |  |  |
| 18               | TosH2ioI   | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)     | TBD          | _                  | _    | ns    |  |  |  |
| 19               | TioV2osH   | Port input valid to OSC1↑ (I/O in setup time)                 | TBD          | _                  | _    | ns    |  |  |  |
| 20               | TioR       | Port output rise time <sup>(3)</sup>                          | _            | 10                 | 25** | ns    |  |  |  |
| 21               | TioF       | Port output fall time <sup>(3)</sup>                          | _            | 10                 | 25** | ns    |  |  |  |

These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 13-1 for loading conditions.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

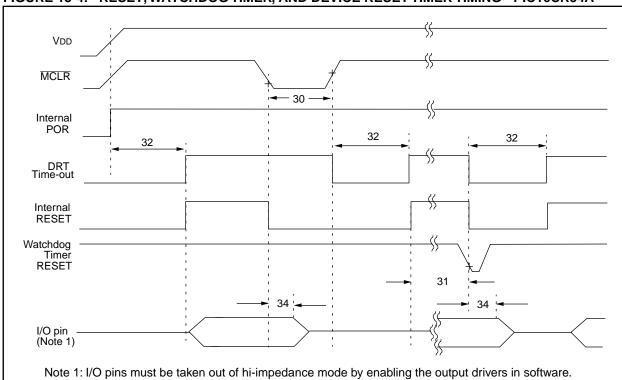


FIGURE 13-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16CR54A

TABLE 13-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16CR54A

| AC Characteristics Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) $-40^{\circ}C \le TA \le +125^{\circ}C$ (extended)  Operating Voltage VDD range is described in Section 13.1, Section 13. |      |  |      |     |      | 13.2 and Section 13.3. |                         |
|--|------|--|------|-----|------|------------------------|-------------------------|
| Parameter<br>No.   | Sym  | Characteristic Min Typ <sup>(1)</sup> Max Units Conditions |      |     |      |                        | Conditions              |
| 30   | TmcL | MCLR Pulse Width (low)                                     | 1.0* | _   | _    | μs                     | VDD = 5.0V              |
| 31   | Twdt | Watchdog Timer Time-out Period (No Prescaler)              | 7.0* | 18* | 40*  | ms                     | VDD = 5.0V (Commercial) |
| 32   | TDRT | Device Reset Timer Period                                  | 7.0* | 18* | 30*  | ms                     | VDD = 5.0V (Commercial) |
| 34   | Tioz | I/O Hi-impedance from MCLR Low                             | _    | _   | 1.0* | μs                     |                         |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16CR54A PIC16C5X

# FIGURE 13-5: TIMERO CLOCK TIMINGS - PIC16CR54A

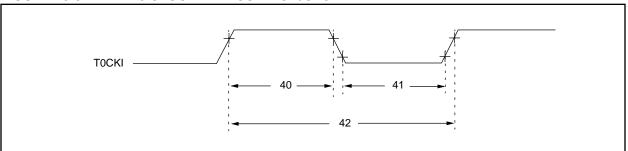


TABLE 13-5: TIMERO CLOCK REQUIREMENTS - PIC16CR54A

| Section 13.3. |      |                             |              | ocure 0°C ≤<br>-40°C ≤<br>-40°C ≤ | TA ≤ +<br>TA ≤ +<br>TA ≤ + | 70°C (<br>85°C<br>125°C | (comme<br>(industr<br>(exten | ercial)<br>rial)  |
|---------------|------|-----------------------------|--------------|-----------------------------------|----------------------------|-------------------------|------------------------------|---|
| Parameter No. | Sym  | Characteristic              |              | Min                               | Typ <sup>(1)</sup>         | Max                     | Units                        | Conditions  |
| 40            | Tt0H | T0CKI High Pulse Width - No | Prescaler    | 0.5 Tcy + 20*                     | _                          |                         | ns                           |   |
|               |      | - Wit                       | th Prescaler | 10*                               | _                          | _                       | ns                           |   |
| 41            | Tt0L | T0CKI Low Pulse Width - No  | Prescaler    | 0.5 Tcy + 20*                     | _                          | _                       | ns                           |   |
|               |      | - Wit                       | th Prescaler | 10*                               | _                          | _                       | ns                           |   |
| 42            | Tt0P | TOCKI Period                |              | 20 or <u>Tcy + 40</u> *<br>N      | _                          | _                       | ns                           | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |

These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**NOTES:** 

PIC16C54A PIC16C5X

#### 14.0 ELECTRICAL CHARACTERISTICS - PIC16C54A

# Absolute Maximum Ratings<sup>†</sup>

| Ambient temperature under bias                                |                           |
|---|---------------------------|
| Storage temperature   | –65°C to +150°C           |
| Voltage on VDD with respect to Vss                            |                           |
| Voltage on MCLR with respect to Vss                           | 0 to +14V                 |
| Voltage on all other pins with respect to Vss                 | $-0.6V$ to $(VDD + 0.6V)$ |
| Total power dissipation <sup>(1)</sup>                        | 800 mW                    |
| Max. current out of Vss pin                                   | 150 mA                    |
| Max. current into VDD pin                                     | 100 mA                    |
| Max. current into an input pin (T0CKI only)                   | ±500 μA                   |
| Input clamp current, IiK (VI < 0 or VI > VDD)                 | ±20 mA                    |
| Output clamp current, IOK (VO < 0 or VO > VDD)                | ±20 mA                    |
| Max. output current sunk by any I/O pin                       | 25 mA                     |
| Max. output current sourced by any I/O pin                    | 20 mA                     |
| Max. output current sourced by a single I/O port (PORTA or B) | 50 mA                     |
| Max. output current sunk by a single I/O port (PORTA or B)    | 50 mA                     |

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD -  $\sum$  IOH} +  $\sum$  {(VDD-VOH) x IOH} +  $\sum$ (VOL x IOL)

<sup>†</sup> NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16C54A

TABLE 14-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16C54A-04  | PIC16C54A-10  | PIC16C54A-20  | PIC16LC54A-04   |
|-----|---|---|---|---|
| RC  | VDD: 3.0V to 6.25V IDD: 2.4 mA max. at 5.5V IPD: 4.0 μA max. at 3.0V WDT dis Freq: 4 MHz max.                         | VDD: 3.0V to 6.25V<br>IDD: 1.7 mA typ. at<br>5.5V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max. | VDD: 3.0V to 6.25V<br>IDD: 1.7 mA typ. at<br>5.5V<br>IPD: 0.25 µA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max. | VDD: 3.0V to 6.25V IDD: 0.5 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                                |
| ХТ  | VDD: 3.0V to 6.25V<br>IDD 2.4 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 4 MHz max.           | VDD: 3.0V to 6.25V IDD: 1.7 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                | VDD: 3.0V to 6.25V<br>IDD: 1.7 mA typ. at<br>5.5V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max. | VDD: 3.0V to 6.25V<br>IDD: 0.5 mA typ. at<br>5.5V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.                 |
| HS  | N/A   | VDD: 4.5V to 5.5V<br>IDD: 8.0 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 10 MHz max.    | VDD: 4.5V to 5.5V<br>IDD: 16 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 20 MHz max.     | Do not use in<br>HS mode  |
| LP  | VDD: 3.0V to 6.25V<br>IDD: 14 μA typ. at<br>32kHz, 3.0V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 200 kHz max. | Do not use in<br>LP mode  | Do not use in<br>LP mode  | VDD: 2.5V to 6.25V<br>IDD: 27 μA max. at<br>32kHz, 2.5V<br>WDT dis<br>IPD: 4.0 μA max. at<br>2.5V WDT dis<br>Freq: 200 kHz max. |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

| osc | PIC16C54A/JW  | PIC16LV54A-02  |
|-----|---|--|
| RC  | VDD: 3.0V to 6.25V<br>IDD: 2.4 mA max. at 5.5V  | VDD: 2.0V to 3.8V<br>IDD: 0.5 mA typ. at<br>3.0V   |
| NO  | IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.   | IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 2.0 MHz max.   |
| XT  | VDD: 3.0V to 6.25V<br>IDD 2.4 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.                   | VDD: 2.0V to 3.8V<br>IDD: 0.5 mA typ. at<br>3.0V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 2.0 MHz max. |
| HS  | VDD: 4.5V to 5.5V<br>IDD: 8 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 10 MHz max.                      | Do not use in<br>HS mode   |
| LP  | VDD: 2.5V to 6.25V<br>IDD: 27 μA max. at<br>32kHz, 2.5V<br>WDT dis<br>IPD: 4.0 μA max. at<br>2.5V WDT dis<br>Freq: 200 kHz max. | VDD: 2.0V to 3.8V IDD: 27 μA max. at 32kHz, 2.5V WDT dis IPD: 4.0 μA max. at 2.5V WDT dis Freq: 200 kHz max.   |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

PIC16C54A PIC16C5X

14.1 <u>DC Characteristics:</u> <u>PIC16C54A-04, 10, 20 (Commercial)</u> <u>PIC16C54A-04I, 10I, 20I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins   |      | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |                           |                              |                            |  |  |
|---|------|---|---------------------------|------------------------------|----------------------------|--|--|
| Characteristic Sym  |      | Min   | Typ <sup>(1)</sup>        | Max                          | Units                      | Conditions   |  |
| Supply Voltage XT, RC and LP options HS option  | VDD  | 3.0<br>4.5  |                           | 6.25<br>5.5                  | V                          |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>   | VDR  |   | 1.5*                      |                              | V                          | Device in SLEEP mode   |  |
| VDD start voltage to ensure<br>Power-On Reset   | VPOR |   | Vss                       |                              | V                          | See Section 7.4 for details on<br>Power-on Reset   |  |
| VDD rise rate to ensure<br>Power-On Reset   | SVDD | 0.05*   |                           |                              | V/ms                       | See Section 7.4 for details on<br>Power-on Reset   |  |
| Supply Current <sup>(3)</sup> XT and RC <sup>(4)</sup> options HS option  LP option, Commercial LP option, Industrial | IDD  |   | 1.8<br>2.4<br>4.5<br>14   | 2.4<br>8.0<br>16<br>29<br>37 | mA<br>mA<br>mA<br>μA<br>μA | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 10 MHz, VDD = 5.5V<br>Fosc = 20 MHz, VDD = 5.5V<br>Fosc = 32 kHz, VDD = 3.0V, WDT disabled<br>Fosc = 32 kHz, VDD = 3.0V, WDT disabled |  |
| Power Down Current <sup>(5)</sup> Commercial Industrial   | IPD  |   | 4.0<br>0.25<br>5.0<br>0.3 | 12<br>4.0<br>14<br>5.0       | μΑ<br>μΑ<br>μΑ<br>μΑ       | VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled<br>VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled   |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C54A

#### 14.2 DC Characteristics: PIC16C54A-04E, 10E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins       | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ (extended) |       |                    |     |       |  |
|---|---|-------|--------------------|-----|-------|--|
| Characteristic                                | Sym   | Min   | Typ <sup>(1)</sup> | Max | Units | Conditions                                       |
| Supply Voltage                                | VDD   |       |                    |     |       |  |
| XT and RC options                             |   | 3.5   |                    | 5.5 | V     |  |
| HS option                                     |   | 4.5   |                    | 5.5 | V     |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR   |       | 1.5*               |     | V     | Device in SLEEP mode                             |
| VDD start voltage to ensure<br>Power-On Reset | VPOR  |       | Vss                |     | V     | See Section 7.4 for details on Power-on Reset    |
| VDD rise rate to ensure<br>Power-On Reset     | SVDD  | 0.05* |                    |     | V/ms  | See Section 7.4 for details on<br>Power-on Reset |
| Supply Current <sup>(3)</sup>                 | IDD   |       |                    |     |       |  |
| XT and RC <sup>(4)</sup> options              |   |       | 1.8                | 3.3 | mA    | Fosc = 4.0 MHz, VDD = 5.5V                       |
| HS option                                     |   |       | 4.8                | 10  | mA    | Fosc = 10 MHz, VDD = 5.5V                        |
|   |   |       | 9.0                | 20  | mA    | Fosc = 20 MHz, VDD = 5.5V                        |
| Power Down Current <sup>(5)</sup>             | IPD   |       |                    |     |       |  |
| XT and RC options                             |   |       | 5.0                | 22  | μΑ    | VDD = 3.5V, WDT enabled                          |
|   |   |       | 0.8                | 18  | μA    | VDD = 3.5V, WDT disabled                         |
| HS option                                     |   |       | 4.0                | 22  | μΑ    | VDD = 3.5V, WDT enabled                          |
|   |   |       | 0.25               | 18  | μΑ    | VDD = 3.5V, WDT disabled                         |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C54A PIC16C5X

14.3 DC Characteristics: PIC16LC54A-04 (Commercial)

PIC16LC54A-04I (Industrial) PIC16LC54A-04E (Extended)

DC Characteristics
Power Supply Pins

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)  $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +03 °C (industrial)

|   | -40°C ≤ TA ≤ +125°C (extended) |       |                    |      |       |  |  |
|---|--------------------------------|-------|--------------------|------|-------|--|--|
| Characteristic                            | Sym                            | Min   | Typ <sup>(1)</sup> | Max  | Units | Conditions                             |  |
| Supply Voltage                            | VDD                            |       |                    |      |       |  |  |
| XT and RC options                         |                                | 3.0   |                    | 6.25 | V     |  |  |
| LP options                                |                                | 2.5   |                    | 6.25 | V     |  |  |
| RAM Data Retention Voltage <sup>(2)</sup> | VDR                            |       | 1.5*               |      | V     | Device in SLEEP mode                   |  |
| VDD start voltage to ensure               | VPOR                           |       | Vss                |      | V     | See Section 7.4 for details on         |  |
| Power-On Reset                            |                                |       |                    |      |       | Power-on Reset                         |  |
| V <sub>DD</sub> rise rate to ensure       | SVDD                           | 0.05* |                    |      | V/ms  | See Section 7.4 for details on         |  |
| Power-On Reset                            |                                |       |                    |      |       | Power-on Reset                         |  |
| Supply Current <sup>(3)</sup>             | IDD                            |       |                    |      |       |  |  |
| XT and RC <sup>(4)</sup> options          |                                |       | 0.5                | 25   | mΑ    | Fosc = 4.0 MHz, VDD = 5.5V             |  |
| LP option, Commercial                     |                                |       | 11                 | 27   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |
| LP option, Industrial                     |                                |       | 11                 | 35   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |
| LP option, Extended                       |                                |       | 11                 | 37   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |
| Power Down Current <sup>(5)</sup>         | IPD                            |       |                    |      |       |  |  |
| Commercial                                |                                |       | 2.5                | 12   | μΑ    | VDD = 2.5V, WDT enabled                |  |
|   |                                |       | 0.25               | 4.0  | μA    | VDD = 2.5V, WDT disabled               |  |
| Industrial                                |                                |       | 2.5                | 14   | μA    | VDD = 2.5V, WDT enabled                |  |
|   |                                |       | 0.25               | 5.0  | μA    | VDD = 2.5V, WDT disabled               |  |
| Extended                                  |                                |       | 2.5                | 15   | μΑ    | VDD = 2.5V, WDT enabled                |  |
|   |                                |       | 0.25               | 7.0  | μΑ    | VDD = 2.5V, WDT disabled               |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C54A

# 14.4 <u>DC Characteristics:</u> <u>PIC16LV54A-02 (Commercial)</u> <u>PIC16LV54A-02 (Industrial)</u>

| DC Characteristics<br>Power Supply Pins  | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-20^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |       |                           |                        |                      |  |
|--|---|-------|---------------------------|------------------------|----------------------|--|
| Characteristic   | Sym   | Min   | Typ <sup>(1)</sup>        | Max                    | Units                | Conditions   |
| Supply Voltage<br>XT, RC and LP options  | VDD   | 2.0   |                           | 3.8                    | V                    |  |
| RAM Data Retention Voltage <sup>(2)</sup>  | VDR   |       | 1.5*                      |                        | V                    | Device in SLEEP mode   |
| VDD start voltage to ensure Power-On Reset   | VPOR  |       | Vss                       |                        | V                    | See Section 7.4 for details on Power-on Reset  |
| VDD rise rate to ensure<br>Power-On Reset  | SVDD  | 0.05* |                           |                        | V/ms                 | See Section 7.4 for details on<br>Power-on Reset   |
| Supply Current <sup>(3)</sup> XT and RC <sup>(4)</sup> options LP option, Commercial LP option, Industrial | IDD   |       | 0.5<br>11<br>14           | 27<br>35               | μΑ                   | Fosc = 2.0 MHz, VDD = 3.0V<br>Fosc = 32 kHz, VDD = 2.5V, WDT disabled<br>Fosc = 32 kHz, VDD = 2.5V, WDT disabled |
| Power Down Current <sup>(5)(6)</sup> Commercial Industrial   | IPD   |       | 2.5<br>0.25<br>3.5<br>0.3 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT enabled VDD = 2.5V, WDT disabled VDD = 2.5V, WDT enabled VDD = 2.5V, WDT disabled                |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
  - 6: The oscillator start-up time can be as much as 8 seconds for XT and LP oscillator selection, if the SLEEP mode is entered or during initial power-up.

PIC16C54A PIC16C5X

# 14.5 <u>DC Characteristics:</u> <u>PIC16C54A-04, 10, 20, PIC16LC54A-04, PIC16LV54A-02 (Commercial)</u> <u>PIC16C54A-04I, 10I, 20I, PIC16LC54A-04I, PIC16LV54A-02I (Industrial)</u> <u>PIC16C54A-04E, 10E, 20E (Extended)</u>

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

DC Characteristics
All Pins Except
Power Supply Pins

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

 $-20^{\circ}C \leq \text{Ta} \leq +85^{\circ}C$  (industrial - PIC16LV54A-02I)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 14.1, Section 14.2 and Section 14.3.

| Characteristic                       | Sym  | Min        | Typ <sup>(1)</sup> | Max      | Units | Conditions                            |
|--------------------------------------|------|------------|--------------------|----------|-------|---------------------------------------|
| Input Low Voltage                    | VIL  |            |                    |          |       |                                       |
| I/O ports                            |      | Vss        |                    | 0.2 Vdd  | V     | Pin at hi-impedance                   |
| MCLR (Schmitt Trigger)               |      | Vss        |                    | 0.15 VDD | V     |                                       |
| T0CKI (Schmitt Trigger)              |      | Vss        |                    | 0.15 VDD | V     |                                       |
| OSC1 (Schmitt Trigger)               |      | Vss        |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup>         |
| OSC1                                 |      | Vss        |                    | 0.3 VDD  | V     | XT, HS and LP options                 |
| Input High Voltage                   | ViH  |            |                    |          |       |                                       |
| I/O ports                            |      | 0.2 VDD+1V |                    | Vdd      | V     | For all VDD <sup>(5)</sup>            |
|                                      |      | 2.0        |                    | Vdd      | V     | $ 4.0V < VDD \le 5.5V^{(5)}$          |
| MCLR (Schmitt Trigger)               |      | 0.85 Vdd   |                    | Vdd      | V     |                                       |
| T0CKI (Schmitt Trigger)              |      | 0.85 Vdd   |                    | Vdd      | V     |                                       |
| OSC1 (Schmitt Trigger)               |      | 0.85 Vdd   |                    | Vdd      | V     | RC option only <sup>(4)</sup>         |
| OSC1                                 |      | 0.7 VDD    |                    | VDD      | V     | XT, HS and LP options                 |
| Hysteresis of Schmitt                | VHYS | 0.15Vpp*   |                    |          | V     |                                       |
| Trigger inputs                       |      |            |                    |          |       |                                       |
| Input Leakage Current <sup>(3)</sup> | lıL  |            |                    |          |       | For V <sub>DD</sub> ≤ 5.5V            |
| I/O ports                            |      | -1.0       | 0.5                | +1.0     | μA    | VSS ≤ VPIN ≤ VDD,                     |
|                                      |      |            |                    |          | '     | Pin at hi-impedance                   |
| MCLR                                 |      | -5.0       |                    | +5.0     | μA    | VPIN = VSS +0.25V(2)                  |
|                                      |      |            | 0.5                | +3.0     | μA    | $VPIN = VDD^{(2)}$                    |
| тоскі                                |      | -3.0       | 0.5                | +3.0     | μA    | Vss ≤ Vpin ≤ Vdd                      |
| OSC1                                 |      | -3.0       | 0.5                |          | μA    | $Vss \leq Vpin \leq Vdd$ ,            |
|                                      |      |            |                    |          | '     | XT, HS and LP options                 |
| Output Low Voltage                   | Vol  |            |                    |          |       |                                       |
| I/O ports                            |      |            |                    | 0.6      | V     | IOL = 8.7 mA, VDD = 4.5V              |
| OSC2/CLKOUT                          |      |            |                    | 0.6      | V     | IOL = 1.6  mA, VDD = 4.5V,            |
|                                      |      |            |                    |          |       | RC option only                        |
| Output High Voltage                  | Vон  |            |                    |          |       |                                       |
| I/O ports <sup>(3)</sup>             |      | VDD-0.7    |                    |          | V     | IOH = -5.4 mA, VDD = 4.5V             |
| OSC2/CLKOUT                          |      | VDD-0.7    |                    |          | V     | IOH = -1.0  mA, VDD = 4.5V,           |
|                                      |      |            |                    |          |       | RC option only                        |
| * Tl                                 | ٠    |            | _                  |          |       | · · · · · · · · · · · · · · · · · · · |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

PIC16C54A

# 14.6 <u>Timing Parameter Symbology and Load Conditions</u>

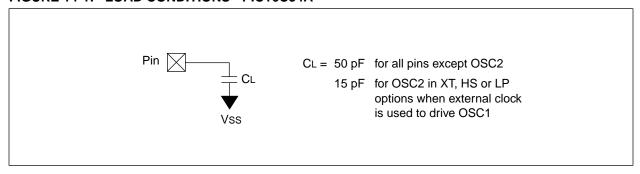
The timing parameter symbols have been created following one of the following formats:

# 1. TppS2ppS

2. TppS

| Т     |   |     |                |  |
|-------|---|-----|----------------|--|
| F     | Frequency                               | Т   | Time           |  |
| Lower | case subscripts (pp) and their meanings | S:  |                |  |
| рр    |   |     |                |  |
| 2     | to                                      | mc  | MCLR           |  |
| ck    | CLKOUT                                  | osc | oscillator     |  |
| су    | cycle time                              | os  | OSC1           |  |
| drt   | device reset timer                      | t0  | T0CKI          |  |
| io    | I/O port                                | wdt | watchdog timer |  |
| Upper | case letters and their meanings:        | ·   |                |  |
| S     |   |     |                |  |
| F     | Fall                                    | P   | Period         |  |
| Н     | High                                    | R   | Rise           |  |
| I     | Invalid (Hi-impedance)                  | V   | Valid          |  |
| L     | Low                                     | Z   | Hi-impedance   |  |

#### FIGURE 14-1: LOAD CONDITIONS - PIC16C54A



PIC16C54A PIC16C5X

#### 14.7 <u>Timing Diagrams and Specifications</u>

# FIGURE 14-2: EXTERNAL CLOCK TIMING - PIC16C54A

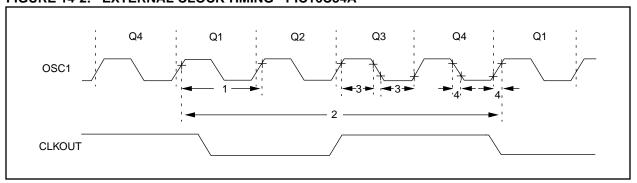


TABLE 14-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54A

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)  $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-20^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial - PIC16LV54A-02I)

DS30453A-page 111

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 14.1, Section 14.2 and Section 14.3.

| Parameter No. | Sym  | Characteristic                          | Min | Typ <sup>(1)</sup> | Max | Units | Conditions               |
|---------------|------|---|-----|--------------------|-----|-------|--------------------------|
|               | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4.0 | MHz   | XT osc mode              |
|               |      |   | DC  | _                  | 2.0 | MHz   | XT osc mode (PIC16LV54A) |
|               |      |   | DC  | _                  | 4.0 | MHz   | HS osc mode (04)         |
|               |      |   | DC  | _                  | 10  | MHz   | HS osc mode (10)         |
|               |      |   | DC  | _                  | 20  | MHz   | HS osc mode (20)         |
|               |      |   | DC  | _                  | 200 | kHz   | LP osc mode              |
|               |      | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4.0 | MHz   | RC osc mode              |
|               |      |   | DC  | _                  | 2.0 | MHz   | RC osc mode (PIC16LV54A) |
|               |      |   | 0.1 | _                  | 4.0 | MHz   | XT osc mode              |
|               |      |   | 0.1 | _                  | 2.0 | MHz   | XT osc mode (PIC16LV54A) |
|               |      |   | 4   | _                  | 4.0 | MHz   | HS osc mode (04)         |
|               |      |   | 4   | _                  | 10  | MHz   | HS osc mode (10)         |
|               |      |   | 4   | _                  | 20  | MHz   | HS osc mode (20)         |
|               |      |   | 5   | _                  | 200 | kHz   | LP osc mode              |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

PIC16C54A

#### TABLE 14-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54A (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C} \text{ (commercial)}$ 

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

 $-20^{\circ}C \le TA \le +85^{\circ}C$  (industrial - PIC16LV54A-02I)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 14.1, Section 14.2 and Section 14.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Typ <sup>(1)</sup> | Max    | Units | Conditions               |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|--------------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | XT osc mode (PIC16LV54A) |
|                  |            |                                       | 250  | _                  | _      | ns    | HS osc mode (04)         |
|                  |            |                                       | 100  | _                  | _      | ns    | HS osc mode (10)         |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (20)         |
|                  |            |                                       | 5.0  | _                  | _      | μs    | LP osc mode              |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | RC osc mode (PIC16LV54A) |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | XT osc mode (PIC16LV54A) |
|                  |            |                                       | 250  | _                  | 250    | ns    | HS osc mode (04)         |
|                  |            |                                       | 100  | _                  | 250    | ns    | HS osc mode (10)         |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (20)         |
|                  |            |                                       | 5.0  | _                  | 200    | μs    | LP osc mode              |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      | _     |                          |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 85*  | _                  | _      | ns    | XT oscillator            |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator            |
|                  |            |                                       | 2.0* | _                  | _      | μs    | LP oscillator            |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator            |
|                  |            |                                       | —    | _                  | 25*    | ns    | HS oscillator            |
|                  |            |                                       | _    |                    | 50*    | ns    | LP oscillator            |

These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TCY) equals four times the input oscillator time base period.

PIC16C54A PIC16C5X

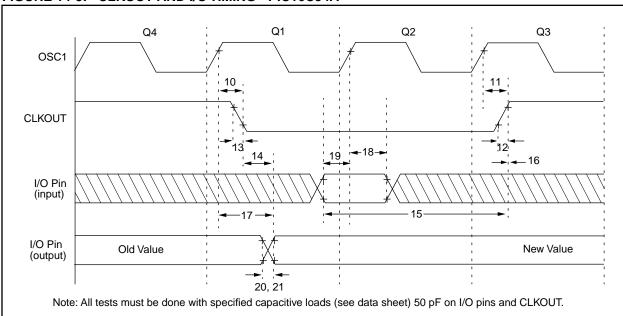


FIGURE 14-3: CLKOUT AND I/O TIMING - PIC16C54A

TABLE 14-3: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C54A

| AC Characteristics Standard Operating Conditions (unless otherwise specified) |  |  |  |  |  |
|---|--|--|--|--|--|
|   | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)                  |  |  |  |  |
|   | -40°C ≤ TA ≤ +85°C (industrial)  |  |  |  |  |
|   | $-20^{\circ}$ C $\leq$ TA $\leq$ +85 $^{\circ}$ C (industrial - PIC16LV54A-02I)          |  |  |  |  |
|   | $-40^{\circ}$ C $\leq$ TA $\leq$ +125 $^{\circ}$ C (extended)                            |  |  |  |  |
|   | Operating Voltage VDD range is described in Section 14.1, Section 14.2 and Section 14.3. |  |  |  |  |

| Parameter<br>No. | Sym      | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |
|------------------|----------|---|--------------|--------------------|------|-------|
| 10               | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                               | _            | 15                 | 30** | ns    |
| 11               | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                               | _            | 15                 | 30** | ns    |
| 12               | TckR     | CLKOUT rise time <sup>(2)</sup>                               | _            | 5.0                | 15** | ns    |
| 13               | TckF     | CLKOUT fall time <sup>(2)</sup>                               | _            | 5.0                | 15** | ns    |
| 14               | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>                      | _            | _                  | 40** | ns    |
| 15               | TioV2ckH | Port in valid before CLKOUT <sup>(2)</sup>                    | 0.25 TCY+30* | _                  | _    | ns    |
| 16               | TckH2ioI | Port in hold after CLKOUT <sup>(2)</sup>                      | 0*           | _                  | _    | ns    |
| 17               | TosH2ioV | OSC1 <sup>↑</sup> (Q1 cycle) to Port out valid <sup>(3)</sup> | _            | _                  | 100* | ns    |
| 18               | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)     | TBD          | _                  | _    | ns    |
| 19               | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)                 | TBD          | _                  | _    | ns    |
| 20               | TioR     | Port output rise time <sup>(3)</sup>                          | _            | 10                 | 25** | ns    |
| 21               | TioF     | Port output fall time <sup>(3)</sup>                          | _            | 10                 | 25** | ns    |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 14-1 for loading conditions.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C54A

FIGURE 14-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16C54A

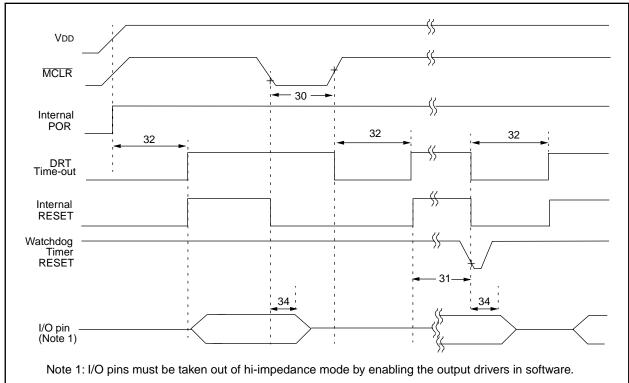


TABLE 14-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C54A

#### AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

 $-20^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial - PIC16LV54A-02I)

 $-40^{\circ}C \le TA \le +125^{\circ}C$  (extended)

Operating Voltage VDD range is described in Section 14.1, Section 14.2 and Section 14.3.

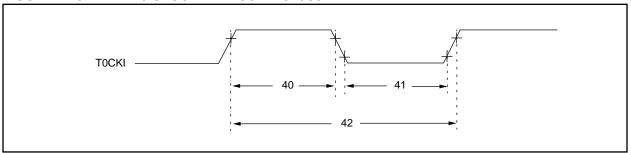
| Parameter No. | Sym  | Characteristic                                   | Min         | Typ <sup>(1)</sup> | Max         | Units | Conditions                                 |
|---------------|------|--|-------------|--------------------|-------------|-------|--|
| 30            | TmcL | MCLR Pulse Width (low)                           | 100*<br>1μs | _                  | _           | ns    | VDD = 5.0V<br>VDD = 5.0V (PIC16LV54A only) |
| 31            | Twdt | Watchdog Timer Time-out<br>Period (No Prescaler) | 9.0*        | 18*                | 30*         | ms    | VDD = 5.0V (Commercial)                    |
| 32            | TDRT | Device Reset Timer Period                        | 9.0*        | 18*                | 30*         | ms    | VDD = 5.0V (Commercial)                    |
| 34            | Tioz | I/O Hi-impedance from MCLR Low                   | _           |                    | 100*<br>1μs | ns    | (PIC16LV54A only)                          |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C5X PIC16C54A

# FIGURE 14-5: TIMER0 CLOCK TIMINGS - PIC16C54A



**TABLE 14-5: TIMERO CLOCK REQUIREMENTS - PIC16C54A** 

| AC  | Chara | cteristics Standard Operating Conditions (unless otherwise specified) |   |                         |        |          |                       |  |
|---|-------|---|---|-------------------------|--------|----------|-----------------------|--|
|   |       | Operating Tempera   | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) |                         |        |          |                       |  |
|   |       |   | –40°C ≤   | ≤ <b>T</b> A ≤ <b>+</b> | -85°C  | (industi | rial)                 |  |
|   |       |   | –20°C ≤   | ≤ Ta ≤ +                | -85°C  | (industr | ial - PIC16LV54A-02I) |  |
|   |       |   | –40°C ≤   | ≤ <b>T</b> A ≤ <b>+</b> | -125°C | C (exten | ided)                 |  |
| Operating Voltage VDD range is described in Section 14.1, Section 1 |       |   |   | 14.1, Section 14.2 and  |        |          |                       |  |
|   |       | Section 14.3.   |   |                         |        |          |                       |  |
| Parameter   | Sym   | Characteristic  | Min   | Typ(1)                  | Max    | Unite    | Conditions            |  |
| No.   | Sylli | Characteristic  | IVIIII  | ıyp. /                  | IVIAX  | Ullits   | Conditions            |  |
| 40  | TtOH  | T0CKI High Pulse Width - No Prescaler                                 | 0.5 Tcy + 20*   |                         |        | ns       |                       |  |
|   | 1     | 1001ti riigiri disc Widiri - No i rescalei                            | 0.5 101 + 20  |                         | _      | 115      |                       |  |

|   | No. | Sym  | Characteristic                        | IVIII                        | ıyp, , | IVIAX | Units | Conditions  |
|---|-----|------|---------------------------------------|------------------------------|--------|-------|-------|---|
| ľ | 40  | Tt0H | T0CKI High Pulse Width - No Prescaler | 0.5 Tcy + 20*                | _      |       | ns    |   |
|   |     |      | - With Prescaler                      | 10*                          | _      | ı     | ns    |   |
|   | 41  | Tt0L | T0CKI Low Pulse Width - No Prescaler  | 0.5 Tcy + 20*                | _      | _     | ns    |   |
|   |     |      | - With Prescaler                      | 10*                          | _      | _     | ns    |   |
|   | 42  | Tt0P | T0CKI Period                          | 20 or <u>Tcy + 40</u> *<br>N | _      | _     | ns    | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |

\* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C54A

**NOTES:** 

PIC16CR57B PIC16C5X

### 15.0 ELECTRICAL CHARACTERISTICS - PIC16CR57B

# **Absolute Maximum Ratings†**

| Ambient Temperature under bias  | –55°C to +125°C      |
|---|----------------------|
| Storage Temperature   | –65°C to +150°C      |
| Voltage on VDD with respect to Vss  | 0 to +7.5\           |
| Voltage on MCLR with respect to Vss   | 0 to +14\            |
| Voltage on all other pins with respect to Vss   | 0.6V to (VDD + 0.6V) |
| Total Power Dissipation <sup>(1)</sup>  | 800 mW               |
| Max. Current out of Vss pin   |                      |
| Max. Current into VDD pin   | 100 mA               |
| Max. Current into an input pin (T0CKI only)   | ±500 μΑ              |
| Input Clamp Current, Iik (VI < 0 or VI > VDD)   | ±20 mA               |
| Output Clamp Current, IOK (VO < 0 or VO > VDD)  | ±20 mA               |
| Max. Output Current sunk by any I/O pin   | 25 mA                |
| Max. Output Current sourced by any I/O pin  | 20 mA                |
| Max. Output Current sourced by a single I/O port (PORTA, B or C)                                    | 50 mA                |
| Max. Output Current sunk by a single I/O port (PORTA, B or C)                                       | 50 mA                |
| <b>Note 1:</b> Power Dissipation is calculated as follows: PDIS = VDD x {IDD - $\sum$ IOH} + $\sum$ |                      |

<sup>†</sup>NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those

indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for

extended periods may affect device reliability.

PIC16C5X PIC16CR57B

TABLE 15-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16CR57B-04   | PIC16CR57B-10  | PIC16CR57B-20  | PIC16LCR57B-04  |
|-----|---|--|--|---|
| RC  | VDD: 3.0V to 6.25V<br>IDD: 2.5 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 4.0 MHz max | N/A  | N/A  | N/A   |
| XT  | VDD: 3.0V to 6.25V<br>IDD: 2.5 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 4.0 MHz max | N/A  | N/A  | N/A   |
| HS  | N/A   | VDD: 4.5V to 5.5V<br>IDD: 10 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 10 MHz max | VDD: 4.5V to 5.5V<br>IDD: 20 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 20 MHz max | N/A   |
| LP  | N/A   | N/A  | N/A  | VDD: 2.5V to 6.25V<br>IDD: 32 μA max at 32 kHz,<br>2.5V<br>IPD: 4.0 μA max at 2.5V,<br>WDT dis<br>Freq: 200 kHz max |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

PIC16CR57B PIC16C5X

# 15.1 <u>DC Characteristics:</u> <u>PIC16CR57B-04, 10, 20 (Commercial)</u> PIC16CR57B-04I, 10I, 20I (Industrial)

| DC Characteristics<br>Power Supply Pins                                  |      | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $0^{\circ}\text{C} \le \text{Ta} \le +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ (industrial) |                            |                        |                      |  |  |
|--|------|---|----------------------------|------------------------|----------------------|--|--|
| Characteristic   | Sym  | Min   | Typ <sup>(1)</sup>         | Max                    | Units                | Conditions   |  |
| Supply Voltage<br>RC and XT options<br>HS option                         | VDD  | 3.0<br>4.5  |                            | 6.25<br>5.5            | V                    |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>                                | Vdr  |   | 1.5*                       |                        | V                    | Device in SLEEP mode   |  |
| VDD Start Voltage to ensure<br>Power-on Reset                            | VPOR |   | Vss                        |                        | V                    | See Section 7.4 for details on<br>Power-on Reset   |  |
| VDD Rise Rate to ensure<br>Power-on Reset                                | SVDD | 0.05*   |                            |                        | V/ms                 | See Section 7.4 for details on<br>Power-on Reset   |  |
| Supply Current <sup>(3)</sup> RC <sup>(4)</sup> and XT options HS option | IDD  |   | 1.9<br>2.5<br>4.7          | 2.5<br>8.0<br>17       | mA<br>mA<br>mA       | Fosc = 4 MHz, VDD = 5.5V<br>Fosc = 10 MHz, VDD = 5.5V<br>Fosc = 20 MHz, VDD = 5.5V                         |  |
| Power-Down Current <sup>(5)</sup> Commercial Industrial                  | IPD  |   | 4.0<br>0.25<br>4.0<br>0.25 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled<br>VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to
       Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C5X PIC16CR57B

#### 15.2 DC Characteristics: PIC16CR57B-04E, 10E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins                                  |      | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ (extended) |                    |                 |                          |  |  |  |
|--|------|---|--------------------|-----------------|--------------------------|--|--|--|
| Characteristic Sy  |      | Min   | Typ <sup>(1)</sup> | Max             | Units                    | Conditions   |  |  |
| Supply Voltage<br>RC and XT options<br>HS options                        | VDD  | 3.25<br>4.5   |                    | 6.0<br>5.5      | V                        |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>                                | Vdr  |   | 1.5*               |                 | V                        | Device in SLEEP mode   |  |  |
| VDD Start Voltage to ensure<br>Power-on Reset                            | VPOR |   | Vss                |                 | V                        | See Section 7.4 for details on<br>Power-on Reset                                   |  |  |
| VDD Rise Rate to ensure<br>Power-on Reset                                | SVDD | 0.05*   |                    |                 | V/ms                     | See Section 7.4 for details on<br>Power-on Reset                                   |  |  |
| Supply Current <sup>(3)</sup> RC <sup>(4)</sup> and XT options HS option | IDD  |   | 1.9<br>4.8<br>9.0  | 3.3<br>10<br>20 | mA<br>mA<br>mA           | Fosc = 4 MHz, Vdd = 5.5V<br>Fosc = 10 MHz, Vdd = 5.5V<br>Fosc = 20 MHz, Vdd = 5.5V |  |  |
| Power-Down Current <sup>(5)</sup>  | IPD  |   | 5.0<br>0.8         | 22<br>18        | μ <b>Α</b><br>μ <b>Α</b> | VDD = 3.25V, WDT enabled<br>VDD = 3.25V, WDT disabled                              |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:  $OSC1 = external \ square \ wave, from \ rail-to-rail; all \ I/O \ pins \ tristated, pulled to \\ Vss, TOCKI = VDD, \overline{MCLR} = VDD; WDT \ enabled/disabled \ as \ specified.$
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16CR57B PIC16C5X

# 15.3 <u>DC Characteristics:</u> <u>PIC16LCR57B-04 (Commercial)</u> <u>PIC16LCR57B-04I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins                 | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |       |                          |                        |                      |  |
|---|---|-------|--------------------------|------------------------|----------------------|--|
| Characteristic  | Sym   | Min   | Typ <sup>(1)</sup>       | Max                    | Units                | Conditions   |
| Supply Voltage  | Vdd   | 2.5   |                          | 6.25                   | V                    | LP option  |
| RAM Data Retention Voltage <sup>(2)</sup>               | Vdr   |       | 1.5*                     |                        | V                    | Device in SLEEP mode   |
| VDD Start Voltage to ensure<br>Power-on Reset           | VPOR  |       | Vss                      |                        | V                    | See Section 7.4 for details on Power-on Reset  |
| VDD Rise Rate to ensure<br>Power-on Reset               | SVDD  | 0.05* |                          |                        | V/ms                 | See Section 7.4 for details on Power-on Reset  |
| Supply Current <sup>(3)</sup> Commercial Industrial     | IDD   |       | 12<br>15                 | 28<br>37               | μΑ<br>μΑ             | Fosc = 32 kHz, VDD = 2.5V,<br>WDT disabled<br>Fosc = 32 kHz, VDD = 2.5V,<br>WDT disabled                   |
| Power-Down Current <sup>(5)</sup> Commercial Industrial | IPD   |       | 3.5<br>0.2<br>3.5<br>0.2 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled<br>VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C5X PIC16CR57B

# 15.4 <u>DC Characteristics: PIC16CR57B-04, 10, 20, PIC16LCR57B-04 (Commercial) PIC16CR57B-04I, 10I, 20I, PIC16LCR57B-04I (Industrial)</u>

DC Characteristics All Pins Except Power Supply Pins Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

Operating Voltage VDD range is described in Section 15.1 and Section 15.3.

| Characteristic                       | Sym  | Min      | Typ <sup>(1)</sup> | Max      | Units | Conditions                    |
|--------------------------------------|------|----------|--------------------|----------|-------|-------------------------------|
| Input Low Voltage                    | VIL  |          |                    |          |       |                               |
| I/O ports                            |      | Vss      |                    | 0.2 VDD  | V     | Pin at hi-impedance           |
| MCLR (Schmitt Trigger)               |      | Vss      |                    | 0.15 VDD | V     |                               |
| T0CKI (Schmitt Trigger)              |      | Vss      |                    | 0.15 VDD | V     |                               |
| OSC1 (Schmitt Trigger)               |      | Vss      |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup> |
| OSC1                                 |      | Vss      |                    | 0.3 VDD  | V     | XT, HS and LP options         |
| Input High Voltage                   | ViH  |          |                    |          |       |                               |
| I/O ports                            |      | 0.45 VDD |                    | Vdd      | V     | For all VDD <sup>(5)</sup>    |
|                                      |      | 2.0      |                    | Vdd      | V     | $4.0V < VDD \le 5.5V^{(5)}$   |
|                                      |      | 0.36 VDD |                    | Vdd      | V     | VDD > 5.5V                    |
| MCLR (Schmitt Trigger)               |      | 0.85 Vdd |                    | Vdd      | V     |                               |
| T0CKI (Schmitt Trigger)              |      | 0.85 Vdd |                    | Vdd      | V     |                               |
| OSC1 (Schmitt Trigger)               |      | 0.85 Vdd |                    | Vdd      | V     | RC option only <sup>(4)</sup> |
| OSC1                                 |      | 0.7 VDD  |                    | VDD      | V     | XT, HS and LP options         |
| Hysteresis of Schmitt                | VHYS | 0.15Vpp* |                    |          | V     |                               |
| Trigger inputs                       |      |          |                    |          |       |                               |
| Input Leakage Current <sup>(3)</sup> | lıL  |          |                    |          |       | For VDD ≤ 5.5V                |
| I/O ports                            |      | -1.0     |                    | +1.0     | μΑ    | $VSS \leq VPIN \leq VDD$ ,    |
|                                      |      |          |                    |          |       | Pin at hi-impedance           |
| MCLR                                 |      | -5.0     |                    |          | μA    | $VPIN = VSS + 0.25V^{(2)}$    |
|                                      |      |          | 0.5                | +5.0     | μA    | $VPIN = VDD^{(2)}$            |
| TOCKI                                |      | -3.0     | 0.5                | +3.0     | μA    | VSS ≤ VPIN ≤ VDD              |
| OSC1                                 |      | -3.0     | 0.5                | +3.0     | μA    | $VSS \leq VPIN \leq VDD$ ,    |
|                                      |      |          |                    |          | ·     | XT, HS and LP options         |
| Output Low Voltage                   | Vol  |          |                    |          |       |                               |
| I/O ports                            |      |          |                    | 0.6      | V     | IOL = 8.7  mA, VDD = 4.5V     |
| OSC2/CLKOUT                          |      |          |                    | 0.6      | V     | IOL = 1.6  mA, VDD = 4.5V,    |
|                                      |      |          |                    |          |       | RC option only                |
| Output High Voltage <sup>(3)</sup>   | Vон  |          |                    | <u> </u> |       |                               |
| I/O ports                            |      | VDD -0.7 |                    |          | V     | IOH = -5.4  mA, VDD = 4.5V    |
| OSC2/CLKOUT                          |      | VDD -0.7 |                    |          | V     | IOH = -1.0  mA, VDD = 4.5V,   |
|                                      |      |          |                    |          |       | RC option only                |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

<sup>2:</sup> The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

<sup>3:</sup> Negative current is defined as coming out of the pin.

<sup>4:</sup> For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

<sup>5:</sup> The user may use the better of the two specifications.

PIC16CR57B PIC16C5X

#### 15.5 DC Characteristics: PIC16CR57B-04E, 10E, 20E (Extended)

| DC Characteristics<br>All Pins Except<br>Power Supply Pins   |      | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ Operating Voltage VDD range is described in Section 15.2. |                    |  |                            |   |  |  |
|--|------|--|--------------------|--|----------------------------|---|--|--|
| Characteristic   | Sym  | Min  | Typ <sup>(1)</sup> | Max  | Units                      | Conditions  |  |  |
| Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1   | VIL  | Vss<br>Vss<br>Vss<br>Vss<br>Vss  |                    | 0.2 VDD<br>0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.3 VDD | V<br>V<br>V<br>V           | Pin at hi-impedance  RC option only <sup>(4)</sup> XT, HS and LP options  |  |  |
| Input High Voltage I/O ports  MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 | VIH  | 0.45 VDD<br>2.0<br>0.36 VDD<br>0.85 VDD<br>0.85 VDD<br>0.85 VDD<br>0.7 VDD   |                    | VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD          | V<br>V<br>V<br>V<br>V      | For all $VDD^{(5)}$<br>$4.0V < VDD \le 5.5V^{(5)}$<br>VDD > 5.5V<br>RC option only <sup>(4)</sup><br>XT, HS and LP options  |  |  |
| Hysteresis of Schmitt<br>Trigger inputs  | VHYS | 0.15VDD*   |                    |  | V                          |   |  |  |
| Input Leakage Current <sup>(3)</sup> I/O ports  MCLR  TOCKI OSC1   | lıL  | -1.0<br>-5.0<br>-3.0<br>-3.0   | 0.5<br>0.5<br>0.5  | +1.0<br>+5.0<br>+3.0<br>+3.0                           | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | For Vdd $\leq$ 5.5V<br>Vss $\leq$ Vpin $\leq$ Vdd,<br>Pin at hi-impedance<br>Vpin = Vss + 0.25 V <sup>(2)</sup><br>Vpin = Vdd <sup>(2)</sup><br>Vss $\leq$ Vpin $\leq$ Vdd<br>Vss $\leq$ Vpin $\leq$ Vdd, |  |  |
| Output Low Voltage I/O ports OSC2/CLKOUT   | VoL  |  |                    | 0.6<br>0.6   | V                          | XT, HS and LP options  IOL = 8.7 mA, VDD = 4.5V IOL = 1.6 mA, VDD = 4.5V, RC option only  |  |  |
| Output High Voltage <sup>(3)</sup> I/O ports OSC2/CLKOUT   | Voн  | VDD -0.7<br>VDD -0.7   |                    |  | V<br>V                     | IOH = -5.4 mA, VDD = 4.5V<br>IOH = -1.0 mA, VDD = 4.5V,<br>RC option only   |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

PIC16C5X PIC16CR57B

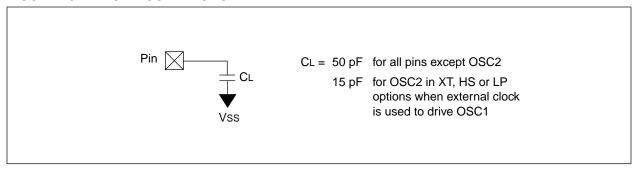
# 15.6 <u>Timing Parameter Symbology and Load Conditions</u>

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS

| z. rpps |  |     |                |  |
|---------|--|-----|----------------|--|
| Т       |  |     |                |  |
| F       | Frequency                                | Т   | Time           |  |
| Lowerd  | case subscripts (pp) and their meanings: |     |                |  |
| рр      |  |     |                |  |
| 2       | to                                       | mc  | MCLR           |  |
| ck      | CLKOUT                                   | osc | oscillator     |  |
| су      | cycle time                               | os  | OSC1           |  |
| drt     | device reset timer                       | tO  | T0CKI          |  |
| io      | I/O port                                 | wdt | watchdog timer |  |
| Upper   | case letters and their meanings:         |     |                |  |
| S       |  |     |                |  |
| F       | Fall                                     | P   | Period         |  |
| Н       | High                                     | R   | Rise           |  |
| I       | Invalid (Hi-impedance)                   | V   | Valid          |  |
| 1       | Low                                      | 7   | Hi-impedance   |  |

# FIGURE 15-1: LOAD CONDITIONS



PIC16CR57B PIC16C5X

### 15.7 <u>Timing Diagrams and Specifications</u>

# FIGURE 15-2: EXTERNAL CLOCK TIMING - PIC16CR57B

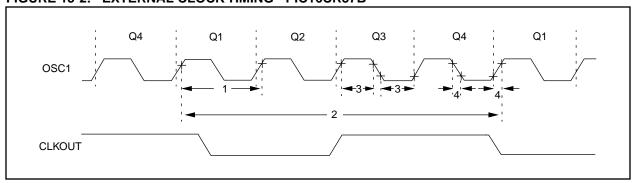


TABLE 15-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR57B

AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature  $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$  (commercial)  $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$  (industrial)  $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 15.1, Section 15.2 and Section 15.3.

| Parameter<br>No. | Sym  | Characteristic                          | Min | Typ <sup>(1)</sup> | Max | Units | Conditions       |
|------------------|------|---|-----|--------------------|-----|-------|------------------|
|                  | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4.0 | MHz   | XT osc mode      |
|                  |      |   | DC  | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |      |   | DC  | _                  | 10  | MHz   | HS osc mode (10) |
|                  |      |   | DC  | _                  | 20  | MHz   | HS osc mode (20) |
|                  |      |   | DC  | _                  | 200 | kHz   | LP osc mode      |
|                  |      | Oscillator Frequency(2)                 | DC  | _                  | 4.0 | MHz   | RC osc mode      |
|                  |      |   | 0.1 | _                  | 4.0 | MHz   | XT osc mode      |
|                  |      |   | 4.0 | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |      |   | 4.0 | _                  | 10  | MHz   | HS osc mode (10) |
|                  |      |   | 4.0 | _                  | 20  | MHz   | HS osc mode (20) |
|                  |      |   | 5.0 | _                  | 200 | kHz   | LP osc mode      |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

PIC16C5X PIC16CR57B

#### TABLE 15-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR57B (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C} \text{ (commercial)}$ 

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 15.1, Section 15.2 and Section 15.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Тур <sup>(1)</sup> | Max    | Units | Conditions       |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | _      | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | _      | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | _      | μs    | LP osc mode      |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode      |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | 250    | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | 250    | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | 200    | μs    | LP osc mode      |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      |       |                  |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 85*  | _                  | _      | ns    | XT oscillator    |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator    |
|                  |            |                                       | 2.0* | _                  | _      | μs    | LP oscillator    |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator    |
|                  |            |                                       | _    | _                  | 25*    | ns    | HS oscillator    |
|                  |            |                                       | -    | _                  | 50*    | ns    | LP oscillator    |

<sup>\*</sup> These parameters are characterized but not tested.

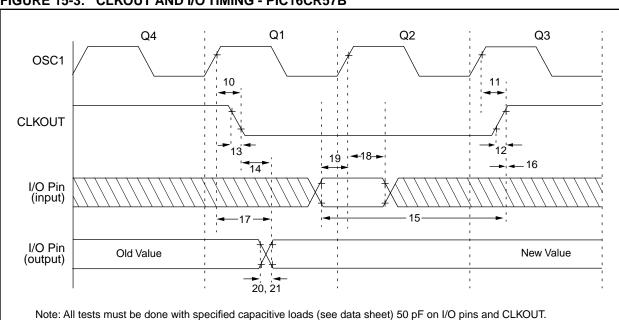
When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

<sup>2:</sup> All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

PIC16CR57B PIC16C5X



#### FIGURE 15-3: CLKOUT AND I/O TIMING - PIC16CR57B

TABLE 15-3: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16CR57B

|                  |          | Operating Temperature $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C} \text{ (commercial)} \\ -40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C} \text{ (industrial)} \\ -40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C} \text{ (extended)} \\ \text{Operating Voltage VDD range is described in Section 15.1, Section 15.2 at Section 15.3.}$ |              |                    |      |       |  |  |
|------------------|----------|---|--------------|--------------------|------|-------|--|--|
| Parameter<br>No. | Sym      | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |  |  |
| 10               | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(2)</sup>   | _            | 15                 | 30** | ns    |  |  |
| 11               | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>   | _            | 15                 | 30** | ns    |  |  |
| 12               | TckR     | CLKOUT rise time <sup>(2)</sup>   | _            | 5.0                | 15** | ns    |  |  |
| 13               | TckF     | CLKOUT fall time <sup>(2)</sup>   | _            | 5.0                | 15** | ns    |  |  |
| 14               | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>  | _            | _                  | 40** | ns    |  |  |
| 15               | TioV2ckH | Port in valid before CLKOUT <sup>(2)</sup>  | 0.25 TCY+30* | _                  | _    | ns    |  |  |
| 16               | TckH2ioI | Port in hold after CLKOUT <sup>(2)</sup>  | 0*           | _                  | _    | ns    |  |  |
| 17               | TosH2ioV | OSC1 <sup>↑</sup> (Q1 cycle) to Port out valid <sup>(3)</sup>   | _            | _                  | 100* | ns    |  |  |
| 18               | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)   | TBD          |                    | _    | ns    |  |  |
| 19               | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)   | TBD          |                    | _    | ns    |  |  |
| 20               | TioR     | Port output rise time <sup>(3)</sup>  | _            | 10                 | 25** | ns    |  |  |
| 21               | TioF     | Port output fall time <sup>(3)</sup>  | _            | 10                 | 25** | ns    |  |  |

Standard Operating Conditions (unless otherwise specified)

**AC Characteristics** 

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 15-1 for loading conditions.

<sup>\*</sup> These parameters are characterized but not tested.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C5X PIC16CR57B

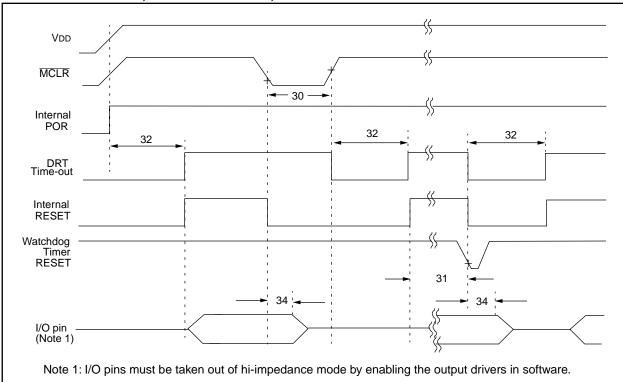


FIGURE 15-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16CR57B

TABLE 15-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16CR57B

| AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) $-40^{\circ}C \le TA \le +125^{\circ}C$ (extended) Operating Voltage VDD range is described in Section 15.1, Section 15.2 and Section |      |   |      |                    |      | 15.2 and Section 15.3. |                         |
|---|------|---|------|--------------------|------|------------------------|-------------------------|
| Parameter<br>No.  | Sym  | Characteristic                                | Min  | Typ <sup>(1)</sup> | Max  | Units                  | Conditions              |
| 30  | TmcL | MCLR Pulse Width (low)                        | 1.0* | _                  | _    | μs                     | VDD = 5.0V              |
| 31  | Twdt | Watchdog Timer Time-out Period (No Prescaler) | 9.0* | 18*                | 30*  | ms                     | VDD = 5.0V (Commercial) |
| 32  | TDRT | Device Reset Timer Period                     | 9.0* | 18*                | 30*  | ms                     | VDD = 5.0V (Commercial) |
| 34  | Tioz | I/O Hi-impedance from MCLR Low                | _    | _                  | 1.0* | μs                     |                         |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16CR57B PIC16C5X

# FIGURE 15-5: TIMER0 CLOCK TIMINGS - PIC16CR57B

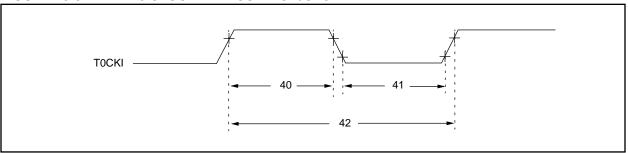


TABLE 15-5: TIMERO CLOCK REQUIREMENTS - PIC16CR57B

| AC               | Chara | cteristics         | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) $-40^{\circ}C \le TA \le +125^{\circ}C$ (extended)  Operating Voltage VDD range is described in Section 15.1, Section 15.2 Section 15.3. |                              |     |       |            | ercial)<br>rial)<br>ded)                                  |
|------------------|-------|--------------------|--|------------------------------|-----|-------|------------|---|
| Parameter<br>No. | Sym   | Characteristic     | Min  | Typ <sup>(1)</sup>           | Max | Units | Conditions |   |
| 40               | TtOH  | T0CKI High Pulse \ | Width - No Prescaler   | 0.5 Tcy + 20*                | _   | _     | ns         |   |
|                  |       |                    | - With Prescaler   | 10*                          | _   | _     | ns         |   |
| 41               | Tt0L  | T0CKI Low Pulse V  | Vidth - No Prescaler   | 0.5 Tcy + 20*                | _   | _     | ns         |   |
|                  |       |                    | - With Prescaler   | 10*                          | _   | _     | ns         |   |
| 42               | Tt0P  | T0CKI Period       |  | 20 or <u>Tcy + 40</u> *<br>N | _   |       | ns         | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C5X PIC16CR57B

**NOTES:** 

PIC16C58A PIC16C5X

### 16.0 ELECTRICAL CHARACTERISTICS - PIC16C58A

# Absolute Maximum Ratings<sup>†</sup>

| Ambient Temperature under bias   | 55°C to +125°C       |
|--|----------------------|
| Storage Temperature  | –65°C to +150°C      |
| Voltage on VDD with respect to Vss   |                      |
| Voltage on MCLR with respect to Vss  | 0 to +14V            |
| Voltage on all other pins with respect to Vss  | 0.6V to (VDD + 0.6V) |
| Total Power Dissipation <sup>(1)</sup>   | 800 mW               |
| Max. Current out of Vss pin  | 150 mA               |
| Max. Current into VDD pin  | 100 mA               |
| Max. Current into an input pin (T0CKI only)  | ±500 μA              |
| Input Clamp Current, Iik (VI < 0 or VI > VDD)  | ±20 mA               |
| Output Clamp Current, loκ (Vo < 0 or Vo > VDD)   | ±20 mA               |
| Max. Output Current sunk by any I/O pin  | 25 mA                |
| Max. Output Current sourced by any I/O pin   | 20 mA                |
| Max. Output Current sourced by a single I/O port (PORTA or B)                            | 50 mA                |
| Max. Output Current sunk by a single I/O port (PORTA or B)                               | 50 mA                |
| Note 4. Device Discipation is calculated as follows: Ddis. Van v. (Inn. 7 Iou) . 7 (Val. |                      |

Note 1: Power Dissipation is calculated as follows: Pdis = VDD x {IDD -  $\sum$  IOH} +  $\sum$  {(VDD-VOH) x IOH} +  $\sum$ (VOL x IOL)

<sup>†</sup> NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16C58A

TABLE 16-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16C58A-04  | PIC16C58A-10  | PIC16C58A-20  | PIC16LC58A-04   |  |  |
|-----|---|---|---|---|--|--|
| RC  | VDD: 3.0V to 6.25V IDD: 2.5 mA max. at 5.5V IPD: 4.0 μA max. at 3.0V WDT dis Freq: 4.0 MHz max.                       | VDD: 3.0V to 6.25V<br>IDD: 1.8 mA typ. at<br>5.5V<br>IPD: 0.25 µA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max. | VDD: 3.0V to 6.25V<br>IDD: 1.8 mA typ. at<br>5.5V<br>IPD: 0.25 µA typ. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max. | VDD: 3.0V to 6.25V IDD: 0.5 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                                |  |  |
| ХТ  | VDD: 3.0V to 6.25V<br>IDD 2.5 mA max. at 5.5V<br>IPD: 4.0 μA max. at 3.0V WDT dis Freq: 4.0 MHz max.                  | VDD: 3.0V to 6.25V IDD: 1.8 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                | VDD: 3.0V to 6.25V IDD: 1.8 mA typ. at 5.5V IPD: 0.25 µA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                | VDD: 3.0V to 6.25V IDD: 0.5 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.                                |  |  |
| HS  | N/A   | VDD: 4.5V to 5.5V IDD: 8.0 mA max. at 5.5V IPD: 4.0 μA max. at 3.0V WDT dis Freq: 10 MHz max.                   | VDD: 4.5V to 5.5V IDD: 17 mA max. at 5.5V IPD: 4.0 μA max. at 3.0V WDT dis Freq: 20 MHz max.                    | Do not use in<br>HS mode  |  |  |
| LP  | VDD: 3.0V to 6.25V<br>IDD: 15 μA typ. at<br>32kHz, 3.0V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 200 kHz max. | Do not use in<br>LP mode  | Do not use in<br>LP mode  | VDD: 2.5V to 6.25V<br>IDD: 28 μA max. at<br>32kHz, 2.5V<br>WDT dis<br>IPD: 4.0 μA max. at<br>2.5V WDT dis<br>Freq: 200 kHz max. |  |  |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

| osc                                   | PIC16C58A/JW   | PIC16LV58A-02   |
|---------------------------------------|--|---|
| RC                                    | VDD: 3.0V to 6.25V<br>IDD: 2.5 mA max. at 5.5V                     | VDD: 2.0V to 3.8V IDD: 0.5 mA typ. at 3.0V                        |
|                                       | IPD: 4.0 µA max. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.          | IPD: 0.25 µA typ. at 3.0V WDT dis Freq: 2.0 MHz max.              |
| хт                                    | VDD: 3.0V to 6.25V<br>IDD 2.5 mA max. at 5.5V                      | VDD: 2.0V to 3.8V<br>IDD: 0.5 mA typ. at<br>3.0V                  |
| \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.          | IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 2.0 MHz max.              |
| HS                                    | VDD: 4.5V to 5.5V IDD: 17 mA max. at 5.5V                          | Do not use in   |
|                                       | IPD: 4.0 µA max. at 3.0V WDT dis Freq: 20 MHz max.                 | HS mode   |
| LP                                    | VDD: 2.5V to 6.25V<br>IDD: 28 μA max. at<br>32kHz, 2.5V<br>WDT dis | VDD: 2.0V to 3.8V<br>IDD: 27 μA max. at<br>32kHz, 2.5V<br>WDT dis |
|                                       | IPD: 4.0 μA max. at 2.5V WDT dis Freq: 200 kHz max.                | IPD: 4.0 μA max. at 2.5V WDT dis Freq: 200 kHz max.               |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

PIC16C58A PIC16C5X

16.1 <u>DC Characteristics:</u> <u>PIC16C58A-04, 10, 20 (Commercial)</u> <u>PIC16C58A-04I, 10I, 20I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins  | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |            |                               |                              |                            |  |  |  |
|--|---|------------|-------------------------------|------------------------------|----------------------------|--|--|--|
| Characteristic   | Sym   | Min        | Typ <sup>(1)</sup> Max Units  |                              | Units                      | Conditions   |  |  |
| Supply Voltage XT, RC and LP options HS option   | VDD   | 3.0<br>4.5 |                               | 6.25<br>5.5                  | V                          |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>  | VDR   |            | 1.5*                          |                              | V                          | Device in SLEEP mode   |  |  |
| VDD start voltage to ensure<br>Power-On Reset  | VPOR  |            | Vss                           |                              | V                          | See Section 7.4 for details on Power-on Reset  |  |  |
| VDD rise rate to ensure<br>Power-On Reset  | SVDD  | 0.05*      |                               |                              | V/ms                       | See Section 7.4 for details on Power-on Reset  |  |  |
| Supply Current <sup>(3)</sup> XT and RC <sup>(4)</sup> options HS option LP option, Commercial LP option, Industrial | IDD   |            | 1.9<br>2.5<br>4.7<br>15<br>18 | 2.5<br>8.0<br>17<br>31<br>39 | mA<br>mA<br>mA<br>μA<br>μA | FOSC = 4.0 MHz, VDD = 5.5V<br>FOSC = 10 MHz, VDD = 5.5V<br>FOSC = 20 MHz, VDD = 5.5V<br>FOSC = 32 kHz, VDD = 3.0V, WDT disabled<br>FOSC = 32 kHz, VDD = 3.0V, WDT disabled |  |  |
| Power Down Current <sup>(5)</sup> Commercial Industrial  | IPD   |            | 4.0<br>0.25<br>5.0<br>0.3     | 12<br>4.0<br>14<br>5.0       | μΑ<br>μΑ<br>μΑ<br>μΑ       | VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled<br>VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled   |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C58A

#### 16.2 DC Characteristics: PIC16C58A-04E, 10E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins       | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ (extended) |       |                    |     |       |  |  |
|---|--|-------|--------------------|-----|-------|--|--|
| Characteristic                                | Sym  | Min   | Typ <sup>(1)</sup> | Max | Units | Conditions                                       |  |
| Supply Voltage                                | VDD  |       |                    |     |       |  |  |
| XT and RC options                             |  | 3.5   |                    | 5.5 | V     |  |  |
| HS option                                     |  | 4.5   |                    | 5.5 | V     |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR  |       | 1.5*               |     | V     | Device in SLEEP mode                             |  |
| VDD start voltage to ensure<br>Power-On Reset | VPOR   |       | Vss                |     | V     | See Section 7.4 for details on<br>Power-on Reset |  |
| VDD rise rate to ensure<br>Power-On Reset     | SVDD   | 0.05* |                    |     | V/ms  | See Section 7.4 for details on<br>Power-on Reset |  |
| Supply Current <sup>(3)</sup>                 | IDD  |       |                    |     |       |  |  |
| XT and RC <sup>(4)</sup> options              |  |       | 1.9                | 3.3 | mA    | Fosc = 4.0 MHz, VDD = 5.5V                       |  |
| HS option                                     |  |       | 4.8                | 10  | mA    | Fosc = 10 MHz, VDD = 5.5V                        |  |
|   |  |       | 9.0                | 20  | mA    | Fosc = 20 MHz, VDD = 5.5V                        |  |
| Power Down Current <sup>(5)</sup>             | IPD  |       |                    |     |       |  |  |
| XT and RC options                             |  |       | 5.0                | 22  | μΑ    | VDD = 3.5V, WDT enabled                          |  |
| ·   |  |       | 0.8                | 18  | μA    | VDD = 3.5V, WDT disabled                         |  |
| HS option                                     |  |       | 4.0                | 22  | μA    | VDD = 3.5V, WDT enabled                          |  |
|   |  |       | 0.25               | 18  | μA    | VDD = 3.5V, WDT disabled                         |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C58A PIC16C5X

16.3 DC Characteristics: PIC16LC58A-04 (Commercial)

PIC16LC58A-04I (Industrial) PIC16LC58A-04 (Extended)

DC Characteristics
Power Supply Pins

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)  $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

-40 °C ≤ TA ≤ +03 °C (industrial) -40°C ≤ TA ≤ +125°C (extended)

| -40°C ≤ IA ≤ +125°C (extended)            |      |       |                    |      |       |  |  |  |
|---|------|-------|--------------------|------|-------|--|--|--|
| Characteristic                            | Sym  | Min   | Typ <sup>(1)</sup> | Max  | Units | Conditions                             |  |  |
| Supply Voltage                            | VDD  |       |                    |      |       |  |  |  |
| XT and RC options                         |      | 3.0   |                    | 6.25 | V     |  |  |  |
| LP options                                |      | 2.5   |                    | 6.25 | V     |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup> | VDR  |       | 1.5*               |      | ٧     | Device in SLEEP mode                   |  |  |
| VDD start voltage to ensure               | VPOR |       | Vss                |      | V     | See Section 7.4 for details on         |  |  |
| Power-On Reset                            |      |       |                    |      |       | Power-on Reset                         |  |  |
| VDD rise rate to ensure                   | SVDD | 0.05* |                    |      | V/ms  | See Section 7.4 for details on         |  |  |
| Power-On Reset                            |      |       |                    |      |       | Power-on Reset                         |  |  |
| Supply Current <sup>(3)</sup>             | IDD  |       |                    |      |       |  |  |  |
| XT and RC <sup>(4)</sup> options          |      |       | 0.5                | 2.5  | mΑ    | Fosc = 4.0 MHz, VDD = 5.5V             |  |  |
| LP option, Commercial                     |      |       | 12                 | 27   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |  |
| LP option, Industrial                     |      |       | 12                 | 35   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |  |
| LP option, Extended                       |      |       | 12                 | 37   | μΑ    | Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |  |
| Power Down Current <sup>(5)</sup>         | IPD  |       |                    |      |       |  |  |  |
| Commercial                                |      |       | 2.5                | 12   | μΑ    | VDD = 2.5V, WDT enabled                |  |  |
|   |      |       | 0.25               | 4.0  | μΑ    | VDD = 2.5V, WDT disabled               |  |  |
| Industrial                                |      |       | 2.5                | 14   | μΑ    | VDD = 2.5V, WDT enabled                |  |  |
|   |      |       | 0.25               | 5.0  | μΑ    | VDD = 2.5V, WDT disabled               |  |  |
| Extended                                  |      |       | 2.5                | 15   | μΑ    | VDD = 2.5V, WDT enabled                |  |  |
|   |      |       | 0.25               | 7.0  | μΑ    | VDD = 2.5V, WDT disabled               |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

PIC16C5X PIC16C58A

16.4 <u>DC Characteristics:</u> <u>PIC16LV58A-02 (Commercial)</u> PIC16LV58A-02 (Industrial)

| DC Characteristics<br>Power Supply Pins  |      |       | ard Ope<br>ing Tem               | _                      | re                   | tions (unless otherwise specified)<br>$0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)<br>$20^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |  |  |
|--|------|-------|----------------------------------|------------------------|----------------------|---|--|--|
| Characteristic   | Sym  | Min   | Min Typ <sup>(1)</sup> Max Units |                        | Units                | Conditions  |  |  |
| Supply Voltage<br>XT, RC and LP options  | VDD  | 2.0   |                                  | 3.8                    | V                    |   |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>  | VDR  |       | 1.5*                             |                        | V                    | Device in SLEEP mode  |  |  |
| VDD start voltage to ensure Power-On Reset   | VPOR |       | Vss                              |                        | V                    | See section on Power-On Reset for details   |  |  |
| VDD rise rate to ensure<br>Power-On Reset  | SVDD | 0.05* |                                  |                        | V/ms                 | See section on Power-On Reset for details   |  |  |
| Supply Current <sup>(3)</sup> XT and RC <sup>(4)</sup> options LP option, Commercial LP option, Industrial | IDD  |       | 0.5<br>11<br>14                  | 1.8<br>27<br>35        | μΑ                   | Fosc = 2.0 MHz, VDD = 3.0V<br>Fosc = 32 kHz, VDD = 2.5V, WDT disabled<br>Fosc = 32 kHz, VDD = 2.5V, WDT disabled                              |  |  |
| Power Down Current <sup>(5)(6)</sup> Commercial Industrial   | IPD  |       | 2.5<br>0.25<br>2.5<br>0.25       | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT enabled VDD = 2.5V, WDT disabled VDD = 2.5V, WDT enabled VDD = 2.5V, WDT disabled   |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
  - 6: The oscillator start-up time can be as much as 8 seconds for XT and LP oscillator selection, if the SLEEP mode is entered or during initial power-up.

PIC16C58A PIC16C5X

# 16.5 <u>DC Characteristics:</u> <u>PIC16C58A-04, 10, 20, PIC16LC58A-04, PIC16LV58A-02 (Commercial)</u> <u>PIC16C58A-04I, 10I, 20I, PIC16LC58A-04I, PIC16LV58A-02I (Industrial)</u> <u>PIC16C58A-04E, 10E, 20E (Extended)</u>

Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

DC Characteristics
All Pins Except
Power Supply Pins

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +85°C (industrial)

 $-20^{\circ}C \leq T\text{A} \leq +85^{\circ}C$  (industrial - PIC16LV58A)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 16.1, Section 16.2 and Section 16.3.

| Characteristic                       | Sym  | Min        | Typ <sup>(1)</sup> | Max      | Units | Conditions                    |
|--------------------------------------|------|------------|--------------------|----------|-------|-------------------------------|
| Input Low Voltage                    | VIL  |            |                    |          |       |                               |
| I/O ports                            |      | Vss        |                    | 0.2 VDD  | V     | Pin at hi-impedance           |
| MCLR (Schmitt Trigger)               |      | Vss        |                    | 0.15 VDD | V     |                               |
| T0CKI (Schmitt Trigger)              |      | Vss        |                    | 0.15 VDD | V     |                               |
| OSC1 (Schmitt Trigger)               |      | Vss        |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup> |
| OSC1                                 |      | Vss        |                    | 0.3 VDD  | V     | XT, HS and LP options         |
| Input High Voltage                   | VIH  |            |                    |          |       |                               |
| I/O ports                            |      | 0.2 VDD+1V |                    | Vdd      | V     | For all VDD <sup>(5)</sup>    |
|                                      |      | 2.0        |                    | Vdd      | V     | $4.0V < VDD \le 5.5V^{(5)}$   |
| MCLR (Schmitt Trigger)               |      | 0.85 Vdd   |                    | Vdd      | V     |                               |
| T0CKI (Schmitt Trigger)              |      | 0.85 Vdd   |                    | Vdd      | V     |                               |
| OSC1 (Schmitt Trigger)               |      | 0.85 Vdd   |                    | Vdd      | V     | RC option only <sup>(4)</sup> |
| OSC1                                 |      | 0.7 VDD    |                    | VDD      | V     | XT, HS and LP options         |
| Hysteresis of Schmitt                | VHYS | 0.15Vpp*   |                    |          | V     |                               |
| Trigger inputs                       |      |            |                    |          |       |                               |
| Input Leakage Current <sup>(3)</sup> | lı∟  |            |                    |          |       | For VDD ≤ 5.5V                |
| I/O ports                            |      | -1.0       | 0.5                | +1.0     | μΑ    | VSS ≤ VPIN ≤ VDD,             |
|                                      |      |            |                    |          |       | Pin at hi-impedance           |
| MCLR                                 |      | -5.0       |                    |          | μΑ    | VPIN = VSS +0.25V(2)          |
|                                      |      |            | 0.5                | +5.0     | μA    | $VPIN = VDD^{(2)}$            |
| TOCKI                                |      | -3.0       | 0.5                | +3.0     | μA    | Vss ≤ Vpin ≤ Vdd              |
| OSC1                                 |      | -3.0       | 0.5                | +3.0     | μA    | $Vss \leq Vpin \leq Vdd$ ,    |
|                                      |      |            |                    |          |       | XT, HS and LP options         |
| Output Low Voltage                   | VoL  |            |                    |          |       |                               |
| I/O ports                            |      |            |                    | 0.6      | V     | IOL = 8.7 mA, VDD = 4.5V      |
| OSC2/CLKOUT                          |      |            |                    | 0.6      | V     | IOL = 1.6 mA, VDD = 4.5V,     |
|                                      |      |            |                    |          |       | RC option only                |
| Output High Voltage                  | Vон  |            |                    |          |       |                               |
| I/O ports <sup>(3)</sup>             |      | VDD-0.7    |                    |          | V     | IOH = -5.4 mA, VDD = 4.5V     |
| OSC2/CLKOUT                          |      | VDD-0.7    |                    |          | V     | IOH = -1.0  mA, VDD = 4.5V,   |
|                                      |      |            |                    |          |       | RC option only                |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

PIC16C58A

# 16.6 <u>Timing Parameter Symbology and Load Conditions</u>

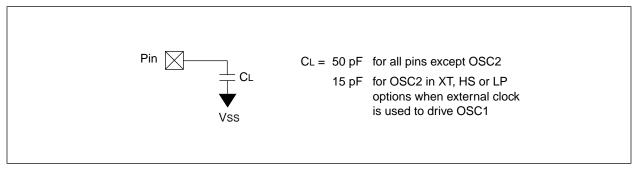
The timing parameter symbols have been created following one of the following formats:

# 1. TppS2ppS

| 2  | Т | n | n.S         |
|----|---|---|-------------|
| ۷. |   | ν | $\nu \circ$ |

| Т     |   |     |                |  |
|-------|---|-----|----------------|--|
| F     | Frequency                               | Т   | Time           |  |
| Lower | case subscripts (pp) and their meanings | S:  |                |  |
| рр    |   |     |                |  |
| 2     | to                                      | mc  | MCLR           |  |
| ck    | CLKOUT                                  | osc | oscillator     |  |
| су    | cycle time                              | os  | OSC1           |  |
| drt   | device reset timer                      | t0  | T0CKI          |  |
| io    | I/O port                                | wdt | watchdog timer |  |
| Upper | case letters and their meanings:        | ·   |                |  |
| S     |   |     |                |  |
| F     | Fall                                    | P   | Period         |  |
| Н     | High                                    | R   | Rise           |  |
| I     | Invalid (Hi-impedance)                  | V   | Valid          |  |
| L     | Low                                     | Z   | Hi-impedance   |  |

#### FIGURE 16-1: LOAD CONDITIONS - PIC16C58A



PIC16C58A PIC16C5X

### 16.7 <u>Timing Diagrams and Specifications</u>

# FIGURE 16-2: EXTERNAL CLOCK TIMING - PIC16C58A

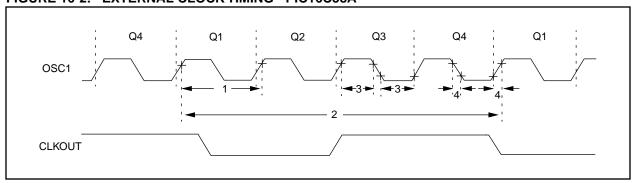


TABLE 16-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C58A

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)  $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-20^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial - PIC16LV58A)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 16.1, Section 16.2 and Section 16.3.

| Parameter<br>No. | Sym  | Characteristic                          | Min | Typ <sup>(1)</sup> | Max | Units | Conditions               |
|------------------|------|---|-----|--------------------|-----|-------|--------------------------|
|                  | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4.0 | MHz   | XT osc mode              |
|                  |      |   | DC  | _                  | 2.0 | MHz   | XT osc mode (PIC16LV58A) |
|                  |      |   | DC  | _                  | 4.0 | MHz   | HS osc mode (04)         |
|                  |      |   | DC  | _                  | 10  | MHz   | HS osc mode (10)         |
|                  |      |   | DC  | _                  | 20  | MHz   | HS osc mode (20)         |
|                  |      |   | DC  | _                  | 200 | kHz   | LP osc mode              |
|                  |      | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4.0 | MHz   | RC osc mode              |
|                  |      |   | DC  | _                  | 2.0 | MHz   | RC osc mode (PIC16LV58A) |
|                  |      |   | 0.1 | _                  | 4.0 | MHz   | XT osc mode              |
|                  |      |   | 0.1 | _                  | 2.0 | MHz   | XT osc mode (PIC16LV58A) |
|                  |      |   | 4.0 | _                  | 4.0 | MHz   | HS osc mode (04)         |
|                  |      |   | 4.0 | _                  | 10  | MHz   | HS osc mode (10)         |
|                  |      |   | 4.0 | _                  | 20  | MHz   | HS osc mode (20)         |
|                  |      |   | 5.0 | _                  | 200 | kHz   | LP osc mode              |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TcY) equals four times the input oscillator time base period.

PIC16C58A

#### TABLE 16-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C58A (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C} \text{ (commercial)}$ 

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +85°C (industrial)

 $-20^{\circ}C \leq T\text{A} \leq +85^{\circ}C \text{ (industrial - PIC16LV58A)}$ 

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 16.1, Section 16.2 and Section 16.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Тур <sup>(1)</sup> | Max    | Units | Conditions               |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|--------------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | XT osc mode (PIC16LV58A) |
|                  |            |                                       | 250  | _                  | _      | ns    | HS osc mode (04)         |
|                  |            |                                       | 100  | _                  | _      | ns    | HS osc mode (10)         |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (20)         |
|                  |            |                                       | 5.0  | _                  | _      | μs    | LP osc mode              |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | RC osc mode (PIC16LV58A) |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode              |
|                  |            |                                       | 500  | _                  | _      | ns    | XT osc mode (PIC16LV58A) |
|                  |            |                                       | 250  | _                  | 250    | ns    | HS osc mode (04)         |
|                  |            |                                       | 100  | _                  | 250    | ns    | HS osc mode (10)         |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (20)         |
|                  |            |                                       | 5.0  | _                  | 200    | μs    | LP osc mode              |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      | _     |                          |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 50*  | _                  | _      | ns    | XT oscillator            |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator            |
|                  |            |                                       | 2.0* | _                  | _      | μs    | LP oscillator            |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator            |
|                  |            |                                       | —    | _                  | 25*    | ns    | HS oscillator            |
|                  |            |                                       |      | _                  | 50*    | ns    | LP oscillator            |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TCY) equals four times the input oscillator time base period.

PIC16C58A PIC16C5X

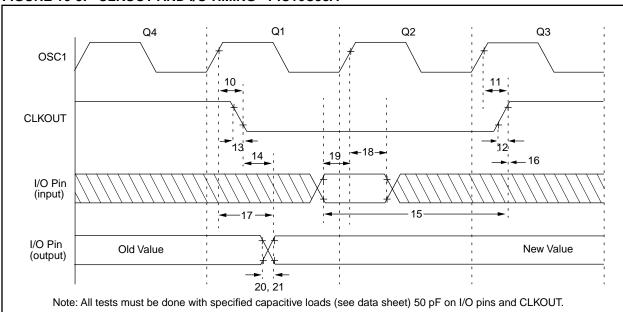


FIGURE 16-3: CLKOUT AND I/O TIMING - PIC16C58A

TABLE 16-3: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C58A

| AC Characteristics | Standard Operating Conditions (unless otherwise specified)                 |  |  |  |  |  |  |  |  |  |  |
|--------------------|--|--|--|--|--|--|--|--|--|--|--|
|                    | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)    |  |  |  |  |  |  |  |  |  |  |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +85 $^{\circ}$ C (industrial)             |  |  |  |  |  |  |  |  |  |  |
|                    | -20°C ≤ TA ≤ +85°C (industrial - PIC16LV58A)                               |  |  |  |  |  |  |  |  |  |  |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +125 $^{\circ}$ C (extended)              |  |  |  |  |  |  |  |  |  |  |
|                    | Operating Voltage VDD range is described in Section 16.1, Section 16.2 and |  |  |  |  |  |  |  |  |  |  |
|                    | Section 16.3.  |  |  |  |  |  |  |  |  |  |  |

| Parameter<br>No. | Sym      | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |
|------------------|----------|---|--------------|--------------------|------|-------|
| 10               | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                                       | _            | 15                 | 30** | ns    |
| 11               | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                                       | _            | 15                 | 30** | ns    |
| 12               | TckR     | CLKOUT rise time <sup>(2)</sup>                                       | _            | 5                  | 15** | ns    |
| 13               | TckF     | CLKOUT fall time <sup>(2)</sup>                                       | _            | 5                  | 15** | ns    |
| 14               | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>                              | _            | _                  | 40** | ns    |
| 15               | TioV2ckH | Port in valid before CLKOUT↑(2)                                       | 0.25 TCY+30* | _                  | _    | ns    |
| 16               | TckH2ioI | Port in hold after CLKOUT <sup>(2)</sup>                              | 0*           | _                  | _    | ns    |
| 17               | TosH2ioV | OSC1 <sup>↑</sup> (Q1 cycle) to Port out valid <sup>(3)</sup>         | _            | _                  | 100* | ns    |
| 18               | TosH2ioI | OSC1 <sup>↑</sup> (Q2 cycle) to Port input invalid (I/O in hold time) | TBD          | _                  | _    | ns    |
| 19               | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)                         | TBD          | _                  | _    | ns    |
| 20               | TioR     | Port output rise time <sup>(3)</sup>                                  | _            | 10                 | 25** | ns    |
| 21               | TioF     | Port output fall time <sup>(3)</sup>                                  | _            | 10                 | 25** | ns    |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 16-1 for loading conditions.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C58A

FIGURE 16-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16C58A

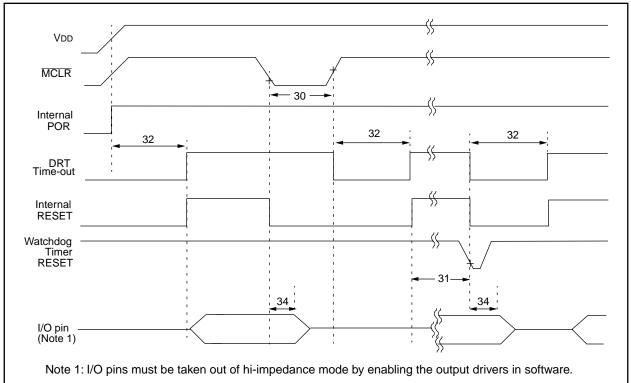


TABLE 16-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C58A

#### AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-20^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial - PIC16LV58A)

 $-40^{\circ}C \leq T \texttt{A} \leq +125^{\circ}C$  (extended)

Operating Voltage VDD range is described in Section 16.1, Section 16.2 and Section 16.3.

| Parameter No. | Sym  | Characteristic                                   | Min         | Typ <sup>(1)</sup> | Max         | Units | Conditions                                 |
|---------------|------|--|-------------|--------------------|-------------|-------|--|
| 30            | TmcL | MCLR Pulse Width (low)                           | 100*<br>1μs | _                  | _           | ns    | VDD = 5.0V<br>VDD = 5.0V (PIC16LV58A only) |
| 31            | Twdt | Watchdog Timer Time-out<br>Period (No Prescaler) | 9.0*        | 18*                | 30*         | ms    | VDD = 5.0V (Commercial)                    |
| 32            | TDRT | Device Reset Timer Period                        | 9.0*        | 18*                | 30*         | ms    | VDD = 5.0V (Commercial)                    |
| 34            | Tioz | I/O Hi-impedance from MCLR Low                   |             |                    | 100*<br>1μs | ns    | (PIC16LV58A only)                          |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C58A PIC16C5X

# FIGURE 16-5: TIMERO CLOCK TIMINGS - PIC16C58A

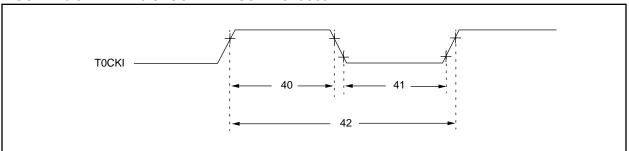


TABLE 16-5: TIMERO CLOCK REQUIREMENTS - PIC16C58A

| AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \leq TA \leq +70^{\circ}C \text{ (commercial)}\\ -40^{\circ}C \leq TA \leq +85^{\circ}C \text{ (industrial)}\\ -20^{\circ}C \leq TA \leq +85^{\circ}C \text{ (industrial - PIC16LV58A)}\\ -40^{\circ}C \leq TA \leq +125^{\circ}C \text{ (extended)}\\ \text{Operating Voltage VDD range is described in Section 16.1, Section 16.2 a Section 16.3.}$ |      |                                       |                         |                    |     |       |                       |  |  |
|---|------|---------------------------------------|-------------------------|--------------------|-----|-------|-----------------------|--|--|
| Parameter No.   | Sym  | Characteristic                        | Min                     | Typ <sup>(1)</sup> | Max | Units | Conditions            |  |  |
| 40  | Tt0H | T0CKI High Pulse Width - No Prescaler | 0.5 Tcy + 20*           | _                  | _   | ns    |                       |  |  |
|   |      | - With Prescaler                      | 10*                     | _                  | _   | ns    |                       |  |  |
| 41  | TtOL | T0CKI Low Pulse Width - No Prescaler  | 0.5 Tcy + 20*           | _                  | _   | ns    |                       |  |  |
|   |      | - With Prescaler                      | 10*                     | _                  | _   | ns    |                       |  |  |
| 42  | Tt0P | T0CKI Period                          | 20 or <u>TCY + 40</u> * | _                  | _   | ns    | Whichever is greater. |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Ν

N = Prescale Value (1, 2, 4,..., 256) PIC16C58A

**NOTES:** 

#### 17.0 ELECTRICAL CHARACTERISTICS - PIC16CR58A

## **Absolute Maximum Ratings†**

| Ambient Temperature under bias                                | –55°C to +125°C     |
|---|---------------------|
| Storage Temperature   | 65°C to +150°C      |
| Voltage on VDD with respect to Vss                            |                     |
| Voltage on MCLR with respect to Vss                           | 0 to +14\           |
| Voltage on all other pins with respect to Vss                 | 0.6V to (VDD + 0.6V |
| Total Power Dissipation <sup>(1)</sup>                        | 800 mV              |
| Max. Current out of Vss pin                                   | 150 m/              |
| Max. Current into Vdd pin                                     | 100 m/              |
| Max. Current into an input pin (T0CKI only)                   | ±500 μΑ             |
| Input Clamp Current, IIK (VI < 0 or VI > VDD)                 | ±20 m/              |
| Output Clamp Current, IOK (VO < 0 or VO> VDD)                 | ±20 m/              |
| Max. Output Current sunk by any I/O pin                       |                     |
| Max. Output Current sourced by any I/O pin                    | 20 m/               |
| Max. Output Current sourced by a single I/O port (PORTA or B) | 50 mA               |
| Max. Output Current sunk by a single I/O port (PORTA or B)    | 50 mA               |
|   |                     |

**Note 1:** Power Dissipation is calculated as follows: PDIS = VDD x {IDD -  $\Sigma$  IOH} +  $\Sigma$  {(VDD-VOH) x IOH} +  $\Sigma$ (VOL x IOL)

<sup>†</sup>NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 17-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16CR58A-04   | PIC16CR58A-10   | PIC16CR58A-20  | PIC16LCR58A-04  |
|-----|---|---|--|---|
| RC  | VDD: 3.0V to 6.25V IDD: 2.5 mA max at 5.5V IPD: 4.0 μA max at 3.0V, WDT dis Freq: 4.0 MHz max | N/A   | N/A  | N/A   |
| XT  | VDD: 3.0V to 6.25V IDD: 2.5 mA max at 5.5V IPD: 4.0 μA max at 3.0V, WDT dis Freq: 4.0 MHz max | N/A   | N/A  | N/A   |
| HS  | N/A   | VDD: 4.5V to 5.5V<br>IDD: 8.0 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 10 MHz max | VDD: 4.5V to 5.5V<br>IDD: 17 mA max at 5.5V<br>IPD: 4.0 μA max at 3.0V,<br>WDT dis<br>Freq: 20 MHz max | N/A   |
| LP  | N/A   | N/A   | N/A  | VDD: 2.5V to 6.25V<br>IDD: 28 μA max at 32 kHz,<br>2.5V<br>IPD: 4.0 μA max at 2.5V,<br>WDT dis<br>Freq: 200 kHz max |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

# 17.1 DC Characteristics: PIC16CR58A-04, 10, 20 (Commercial) PIC16CR58A-04I, 10I, 20I (Industrial)

| DC Characteristics<br>Power Supply Pins                                  |      | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |                            |                        |                      |  |  |  |
|--|------|---|----------------------------|------------------------|----------------------|--|--|--|
| Characteristic   | Sym  | Min   | Typ <sup>(1)</sup>         | Max                    | Units                | Conditions   |  |  |
| Supply Voltage<br>RC and XT options<br>HS option                         | VDD  | 3.0<br>4.5  |                            | 6.25<br>5.5            | V                    |  |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>                                | Vdr  |   | 1.5*                       |                        | V                    | Device in SLEEP mode   |  |  |
| VDD Start Voltage to ensure Power-on Reset                               | VPOR |   | Vss                        |                        | V                    | See Section 7.4 for details on<br>Power-on Reset   |  |  |
| VDD Rise Rate to ensure<br>Power-on Reset                                | SVDD | 0.05*   |                            |                        | V/ms                 | See Section 7.4 for details on<br>Power-on Reset   |  |  |
| Supply Current <sup>(3)</sup> RC <sup>(4)</sup> and XT options HS option | IDD  |   | 1.9<br>2.5<br>4.7          | 2.5<br>8.0<br>17       | mA<br>mA<br>mA       | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 10 MHz, VDD = 5.5V<br>Fosc = 20 MHz, VDD = 5.5V                       |  |  |
| Power-Down Current <sup>(5)</sup> Commercial Industrial                  | IPD  |   | 4.0<br>0.25<br>4.0<br>0.25 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled<br>VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to
       Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

#### 17.2 DC Characteristics: PIC16CR58A-04E, 10E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins                                  | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ (extended) |             |                    |                 |                |  |  |
|--|---|-------------|--------------------|-----------------|----------------|--|--|
| Characteristic   | Sym   | Min         | Typ <sup>(1)</sup> | Max             | Units          | Conditions   |  |
| Supply Voltage<br>RC and XT options<br>HS options                        | VDD   | 3.25<br>4.5 |                    | 6.0<br>5.5      | V              |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>                                | Vdr   |             | 1.5*               |                 | V              | Device in SLEEP mode   |  |
| VDD Start Voltage to ensure<br>Power-on Reset                            | VPOR  |             | Vss                |                 | V              | See Section 7.4 for details on<br>Power-on Reset                                     |  |
| VDD Rise Rate to ensure<br>Power-on Reset                                | SVDD  | 0.05*       |                    |                 | V/ms           | See Section 7.4 for details on<br>Power-on Reset                                     |  |
| Supply Current <sup>(3)</sup> RC <sup>(4)</sup> and XT options HS option | IDD   |             | 1.9<br>4.8<br>9.0  | 3.3<br>10<br>20 | mA<br>mA<br>mA | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 10 MHz, VDD = 5.5V<br>Fosc = 20 MHz, VDD = 5.5V |  |
| Power-Down Current <sup>(5)</sup>  | IPD   |             | 5.0<br>0.8         | 22<br>18        | μΑ<br>μΑ       | VDD = 3.25V, WDT enabled<br>VDD = 3.25V, WDT disabled                                |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:  $OSC1 = external \ square \ wave, from \ rail-to-rail; all \ I/O \ pins \ tristated, pulled to \\ Vss, TOCKI = VDD, \overline{MCLR} = VDD; WDT \ enabled/disabled \ as \ specified.$
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

# 17.3 <u>DC Characteristics:</u> <u>PIC16LCR58A-04 (Commercial)</u> <u>PIC16LCR58A-04I (Industrial)</u>

| DC Characteristics<br>Power Supply Pins                 | Standard Operating Conditions (unless otherwise specified)<br>Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |                            |                          |                        |                      |  |  |
|---|---|----------------------------|--------------------------|------------------------|----------------------|--|--|
| Characteristic  | Sym   | Min Typ <sup>(1)</sup> Max |                          | Units                  | Conditions           |  |  |
| Supply Voltage  | VDD   | 2.5                        |                          | 6.25                   | V                    | LP option  |  |
| RAM Data Retention Voltage <sup>(2)</sup>               | Vdr   |                            | 1.5*                     |                        | V                    | Device in SLEEP mode   |  |
| VDD Start Voltage to ensure Power-on Reset              | VPOR  |                            | Vss                      |                        | V                    | See Section 7.4 for details on<br>Power-on Reset   |  |
| VDD Rise Rate to ensure<br>Power-on Reset               | SVDD  | 0.05*                      |                          |                        | V/ms                 | See Section 7.4 for details on Power-on Reset  |  |
| Supply Current <sup>(3)</sup> Commercial Industrial     | IDD   |                            | 12<br>15                 | 28<br>37               | μΑ<br>μΑ             | Fosc = 32 kHz, VDD = 2.5V,<br>WDT disabled<br>Fosc = 32 kHz, VDD = 2.5V,<br>WDT disabled                   |  |
| Power-Down Current <sup>(5)</sup> Commercial Industrial | IPD   |                            | 3.5<br>0.2<br>3.5<br>0.2 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled<br>VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

#### 17.4 <u>DC Characteristics: PIC16CR58A-04, 10, 20, PIC16LCR58A-04 (Commercial)</u> PIC16CR58A-04I, 10I, 20I, PIC16LCR58A-04I (Industrial)

DC Characteristics All Pins Except Power Supply Pins Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +85 $^{\circ}$ C (industrial)

Operating Voltage VDD range is described in Section 17.1 and Section 17.3.

| opolaring voltage v22 lange to december in and deciden in a |      |          |                    |          |       |                               |  |  |  |  |  |
|---|------|----------|--------------------|----------|-------|-------------------------------|--|--|--|--|--|
| Characteristic  | Sym  | Min      | Typ <sup>(1)</sup> | Max      | Units | Conditions                    |  |  |  |  |  |
| Input Low Voltage   | VIL  |          |                    |          |       |                               |  |  |  |  |  |
| I/O ports   |      | Vss      |                    | 0.2 VDD  | V     | Pin at hi-impedance           |  |  |  |  |  |
| MCLR (Schmitt Trigger)                                      |      | Vss      |                    | 0.15 VDD | V     |                               |  |  |  |  |  |
| T0CKI (Schmitt Trigger)                                     |      | Vss      |                    | 0.15 VDD | V     |                               |  |  |  |  |  |
| OSC1 (Schmitt Trigger)                                      |      | Vss      |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup> |  |  |  |  |  |
| OSC1  |      | Vss      |                    | 0.3 VDD  | V     | XT, HS and LP options         |  |  |  |  |  |
| Input High Voltage  | ViH  |          |                    |          |       |                               |  |  |  |  |  |
| I/O ports   |      | 0.45 VDD |                    | Vdd      | V     | For all VDD <sup>(5)</sup>    |  |  |  |  |  |
|   |      | 2.0      |                    | Vdd      | V     | $4.0V < VDD \le 5.5V^{(5)}$   |  |  |  |  |  |
|   |      | 0.36 VDD |                    | Vdd      | V     | VDD > 5.5V                    |  |  |  |  |  |
| MCLR (Schmitt Trigger)                                      |      | 0.85 VDD |                    | Vdd      | V     |                               |  |  |  |  |  |
| T0CKI (Schmitt Trigger)                                     |      | 0.85 VDD |                    | Vdd      | V     |                               |  |  |  |  |  |
| OSC1 (Schmitt Trigger)                                      |      | 0.85 VDD |                    | Vdd      | V     | RC option only <sup>(4)</sup> |  |  |  |  |  |
| OSC1  |      | 0.7 VDD  |                    | VDD      | V     | XT, HS and LP options         |  |  |  |  |  |
| Hysteresis of Schmitt                                       | VHYS | 0.15Vpp* |                    |          | V     |                               |  |  |  |  |  |
| Trigger inputs  |      |          |                    |          |       |                               |  |  |  |  |  |
| Input Leakage Current <sup>(3)</sup>                        | lıL  |          |                    |          |       | For VDD ≤ 5.5V                |  |  |  |  |  |
| I/O ports   |      | -1.0     |                    | +1.0     | μΑ    | VSS ≤ VPIN ≤ VDD,             |  |  |  |  |  |
|   |      |          |                    |          |       | Pin at hi-impedance           |  |  |  |  |  |
| MCLR  |      | -5.0     |                    |          | μA    | VPIN = VSS + 0.25V(2)         |  |  |  |  |  |
|   |      |          | 0.5                | +5.0     | μA    | VPIN = VDD <sup>(2)</sup>     |  |  |  |  |  |
| T0CKI   |      | -3.0     | 0.5                | +3.0     | μA    | VSS ≤ VPIN ≤ VDD              |  |  |  |  |  |
| OSC1  |      | -3.0     | 0.5                | +3.0     | μA    | $VSS \leq VPIN \leq VDD$ ,    |  |  |  |  |  |
|   |      |          |                    |          | ·     | XT, HS and LP options         |  |  |  |  |  |
| Output Low Voltage  | Vol  |          |                    |          |       |                               |  |  |  |  |  |
| I/O ports   |      |          |                    | 0.6      | V     | IOL = 8.7  mA, VDD = 4.5V     |  |  |  |  |  |
| OSC2/CLKOUT   |      |          |                    | 0.6      | V     | IOL = 1.6  mA, VDD = 4.5V,    |  |  |  |  |  |
|   |      |          |                    |          |       | RC option only                |  |  |  |  |  |
| Output High Voltage <sup>(3)</sup>                          | Vон  |          |                    |          |       |                               |  |  |  |  |  |
| I/O ports   |      | VDD -0.7 |                    |          | V     | IOH = -5.4  mA, VDD = 4.5V    |  |  |  |  |  |
| OSC2/CLKOUT   |      | VDD -0.7 |                    |          | V     | IOH = -1.0  mA, VDD = 4.5V,   |  |  |  |  |  |
|   |      |          |                    |          |       | RC option only                |  |  |  |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

<sup>2:</sup> The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

#### 17.5 DC Characteristics: PIC16CR58A-04E, 10E, 20E (Extended)

| DC Characteristics<br>All Pins Except<br>Power Supply Pins   |      | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ (extended)  Operating Voltage VDD range is described in Section 17.2. |                    |  |                            |   |  |  |  |  |  |
|--|------|--|--------------------|--|----------------------------|---|--|--|--|--|--|
| Characteristic   | Sym  | Min  | Typ <sup>(1)</sup> | Max  | Units                      | Conditions  |  |  |  |  |  |
| Input Low Voltage I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1   | VIL  | Vss<br>Vss<br>Vss<br>Vss<br>Vss  |                    | 0.2 VDD<br>0.15 VDD<br>0.15 VDD<br>0.15 VDD<br>0.3 VDD | V<br>V<br>V<br>V           | Pin at hi-impedance  RC option only <sup>(4)</sup> XT, HS and LP options  |  |  |  |  |  |
| Input High Voltage I/O ports  MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 | VIH  | 0.45 VDD<br>2.0<br>0.36 VDD<br>0.85 VDD<br>0.85 VDD<br>0.85 VDD<br>0.7 VDD   |                    | VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD<br>VDD          | V<br>V<br>V<br>V<br>V      | For all $VDD^{(5)}$<br>$4.0V < VDD \le 5.5V^{(5)}$<br>VDD > 5.5V<br>RC option only <sup>(4)</sup><br>XT, HS and LP options  |  |  |  |  |  |
| Hysteresis of Schmitt<br>Trigger inputs  | VHYS | 0.15VDD*   |                    |  | V                          |   |  |  |  |  |  |
| Input Leakage Current <sup>(3)</sup> I/O ports  MCLR  TOCKI OSC1   | IιL  | -1.0<br>-5.0<br>-3.0<br>-3.0   | 0.5<br>0.5<br>0.5  | +1.0<br>+5.0<br>+3.0<br>+3.0                           | μΑ<br>μΑ<br>μΑ<br>μΑ<br>μΑ | For VDD $\leq$ 5.5V<br>VSS $\leq$ VPIN $\leq$ VDD,<br>Pin at hi-impedance<br>VPIN = VSS + 0.25V <sup>(2)</sup><br>VPIN = VDD <sup>(2)</sup><br>VSS $\leq$ VPIN $\leq$ VDD<br>VSS $\leq$ VPIN $\leq$ VDD,<br>XT, HS and LP options |  |  |  |  |  |
| Output Low Voltage I/O ports OSC2/CLKOUT   | Vol  |  |                    | 0.6<br>0.6   | V<br>V                     | IOL = 8.7 mA, VDD = 4.5V<br>IOL = 1.6 mA, VDD = 4.5V,<br>RC option only   |  |  |  |  |  |
| Output High Voltage <sup>(3)</sup> I/O ports OSC2/CLKOUT   | Vон  | VDD -0.7<br>VDD -0.7   |                    |  | V<br>V                     | IOH = -5.4 mA, VDD = 4.5V<br>IOH = -1.0 mA, VDD = 4.5V,<br>RC option only   |  |  |  |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

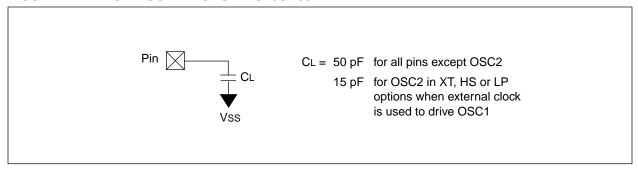
## 17.6 <u>Timing Parameter Symbology and Load Conditions</u>

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS

| 2. TppS |  |     |                |  |
|---------|--|-----|----------------|--|
| Т       |  |     |                |  |
| F       | Frequency                              | T   | Time           |  |
| Lowerd  | case subscripts (pp) and their meaning | s:  |                |  |
| рр      |  |     |                |  |
| 2       | to                                     | mc  | MCLR           |  |
| ck      | CLKOUT                                 | osc | oscillator     |  |
| су      | cycle time                             | os  | OSC1           |  |
| drt     | device reset timer                     | tO  | TOCKI          |  |
| io      | I/O port                               | wdt | watchdog timer |  |
| Upperd  | case letters and their meanings:       |     |                |  |
| S       |  |     |                |  |
| F       | Fall                                   | Р   | Period         |  |
| Н       | High                                   | R   | Rise           |  |
| I       | Invalid (Hi-impedance)                 | V   | Valid          |  |
| L       | Low                                    | Z   | Hi-impedance   |  |

## FIGURE 17-1: LOAD CONDITIONS - PIC16CR58A



#### 17.7 <u>Timing Diagrams and Specifications</u>

## FIGURE 17-2: EXTERNAL CLOCK TIMING - PIC16CR58A

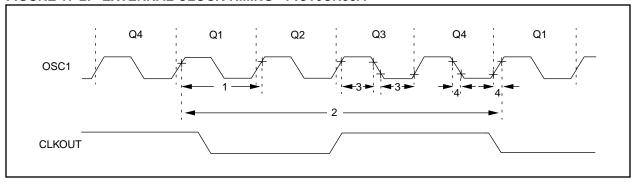


TABLE 17-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR58A

AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature  $0^{\circ}C \leq TA \leq +70^{\circ}C \text{ (commercial)} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \text{ (industrial)} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 17.1, Section 17.2 and Section 17.3.

| Parameter<br>No. | Sym  | Characteristic                          | Min | Typ <sup>(1)</sup> | Max | Units | Conditions       |
|------------------|------|---|-----|--------------------|-----|-------|------------------|
|                  | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC  | _                  | 4.0 | MHz   | XT osc mode      |
|                  |      |   | DC  | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |      |   | DC  | _                  | 10  | MHz   | HS osc mode (10) |
|                  |      |   | DC  | _                  | 20  | MHz   | HS osc mode (20) |
|                  |      |   | DC  | _                  | 200 | kHz   | LP osc mode      |
|                  |      | Oscillator Frequency <sup>(2)</sup>     | DC  | _                  | 4.0 | MHz   | RC osc mode      |
|                  |      |   | 0.1 | _                  | 4.0 | MHz   | XT osc mode      |
|                  |      |   | 4.0 | _                  | 4.0 | MHz   | HS osc mode (04) |
|                  |      |   | 4.0 | _                  | 10  | MHz   | HS osc mode (10) |
|                  |      |   | 4.0 | _                  | 20  | MHz   | HS osc mode (20) |
|                  |      |   | 5.0 | _                  | 200 | kHz   | LP osc mode      |
|                  |      |   |     |                    |     |       |                  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TCY) equals four times the input oscillator time base period.

#### TABLE 17-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR58A (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C} \text{ (commercial)}$ 

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +85°C (industrial)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 17.1, Section 17.2 and Section 17.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Тур <sup>(1)</sup> | Max    | Units | Conditions       |
|------------------|------------|---------------------------------------|------|--------------------|--------|-------|------------------|
| 1                | Tosc       | External CLKIN Period <sup>(2)</sup>  | 250  | _                  | _      | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | _      | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | _      | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | _      | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | _      | μs    | LP osc mode      |
|                  |            | Oscillator Period <sup>(2)</sup>      | 250  | _                  | _      | ns    | RC osc mode      |
|                  |            |                                       | 250  | _                  | 10,000 | ns    | XT osc mode      |
|                  |            |                                       | 250  | _                  | 250    | ns    | HS osc mode (04) |
|                  |            |                                       | 100  | _                  | 250    | ns    | HS osc mode (10) |
|                  |            |                                       | 50   | _                  | 250    | ns    | HS osc mode (20) |
|                  |            |                                       | 5.0  | _                  | 200    | μs    | LP osc mode      |
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _      | _     |                  |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 85*  | _                  | _      | ns    | XT oscillator    |
|                  |            |                                       | 20*  | _                  | _      | ns    | HS oscillator    |
|                  |            |                                       | 2.0* | _                  | _      | μs    | LP oscillator    |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25*    | ns    | XT oscillator    |
|                  |            |                                       | _    | _                  | 25*    | ns    | HS oscillator    |
|                  |            |                                       | —    | –                  | 50*    | ns    | LP oscillator    |

<sup>\*</sup> These parameters are characterized but not tested.

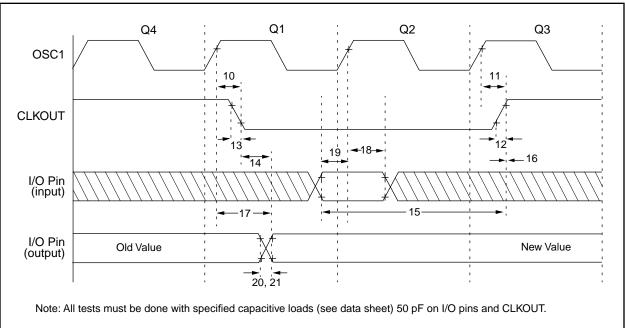
When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

<sup>2:</sup> All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

FIGURE 17-3: CLKOUT AND I/O TIMING - PIC16CR58A



**TABLE 17-3:** 

**CLKOUT AND I/O TIMING REQUIREMENTS - PIC16CR58A** 

| AC Characteristics | Standard Operating Conditions (unless otherwise specified)                 |  |  |  |  |  |  |  |  |
|--------------------|--|--|--|--|--|--|--|--|--|
|                    | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)    |  |  |  |  |  |  |  |  |
|                    | $-40$ °C $\leq$ TA $\leq$ +85°C (industrial)                               |  |  |  |  |  |  |  |  |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +125 $^{\circ}$ C (extended)              |  |  |  |  |  |  |  |  |
|                    | Operating Voltage VDD range is described in Section 17.1, Section 17.2 and |  |  |  |  |  |  |  |  |
|                    | Section 17.3.  |  |  |  |  |  |  |  |  |

| Parameter<br>No. | Sym      | Characteristic  | Min          | Тур <sup>(1)</sup> | Max  | Units |
|------------------|----------|---|--------------|--------------------|------|-------|
| 10               | TosH2ckL | OSC1 <sup>↑</sup> to CLKOUT↓ <sup>(2)</sup>               | _            | 15                 | 30** | ns    |
| 11               | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                           | _            | 15                 | 30** | ns    |
| 12               | TckR     | CLKOUT rise time <sup>(2)</sup>                           | _            | 5.0                | 15** | ns    |
| 13               | TckF     | CLKOUT fall time <sup>(2)</sup>                           | _            | 5.0                | 15** | ns    |
| 14               | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>                  | _            | _                  | 40** | ns    |
| 15               | TioV2ckH | Port in valid before CLKOUT <sup>(2)</sup>                | 0.25 TCY+30* | _                  | _    | ns    |
| 16               | TckH2ioI | Port in hold after CLKOUT <sup>(2)</sup>                  | 0*           | _                  | _    | ns    |
| 17               | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid <sup>(3)</sup>         | _            | _                  | 100* | ns    |
| 18               | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time) | TBD          | _                  | _    | ns    |
| 19               | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)             | TBD          | _                  | _    | ns    |
| 20               | TioR     | Port output rise time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |
| 21               | TioF     | Port output fall time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |

These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 17-1 for loading conditions.

<sup>\*\*</sup> These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

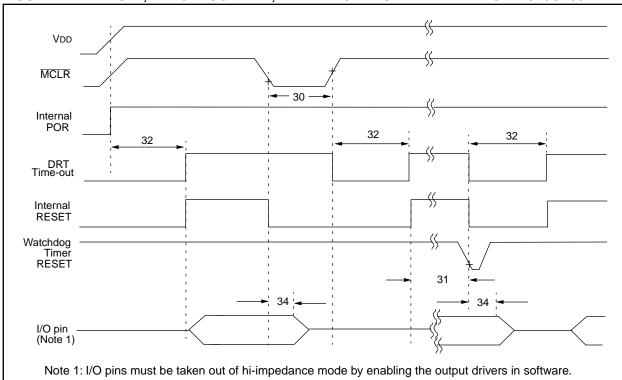


FIGURE 17-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16CR58A

TABLE 17-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16CR58A

| AC Charac     | teristics |  |      |     |      |    |                         |  |
|---------------|-----------|--|------|-----|------|----|-------------------------|--|
| Parameter No. | Sym       | Characteristic Min Typ <sup>(1)</sup> Max Units Conditions |      |     |      |    |                         |  |
| 30            | TmcL      | MCLR Pulse Width (low)                                     | 1.0* | _   | _    | μs | VDD = 5.0V              |  |
| 31            | Twdt      | Watchdog Timer Time-out Period (No Prescaler)              | 9.0* | 18* | 30*  | ms | VDD = 5.0V (Commercial) |  |
| 32            | TDRT      | Device Reset Timer Period                                  | 9.0* | 18* | 30*  | ms | VDD = 5.0V (Commercial) |  |
| 34 Tioz       |           | I/O Hi-impedance from MCLR Low                             | _    | _   | 1.0* | μs |                         |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## FIGURE 17-5: TIMERO CLOCK TIMINGS - PIC16CR58A

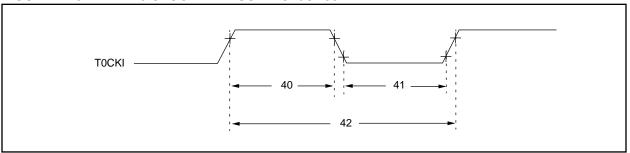


TABLE 17-5: TIMERO CLOCK REQUIREMENTS - PIC16CR58A

| AC Characteristics |      |                                       |                      |                              |     |       |            |   |  |
|--------------------|------|---------------------------------------|----------------------|------------------------------|-----|-------|------------|---|--|
| Parameter No.      | Sym  | Characteristic                        | Min                  | Typ <sup>(1)</sup>           | Max | Units | Conditions |   |  |
| 40                 | Tt0H | T0CKI High Pulse Width - No Prescaler |                      | 0.5 Tcy + 20*                | _   | _     | ns         |   |  |
|                    |      |                                       | - With Prescaler     | 10*                          | _   | _     | ns         |   |  |
| 41                 | Tt0L | T0CKI Low Pulse V                     | Vidth - No Prescaler | 0.5 Tcy + 20*                | _   | _     | ns         |   |  |
|                    |      |                                       | - With Prescaler     | 10*                          | _   | _     | ns         |   |  |
| 42                 | Tt0P | T0CKI Period                          |                      | 20 or <u>Tcy + 40</u> *<br>N | _   |       | ns         | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**NOTES:** 

#### 18.0 DC AND AC CHARACTERISTICS - PIC16C54A/CR57B/C58A/CR58A

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean +  $3\sigma$ ) and (mean -  $3\sigma$ ) respectively, where  $\sigma$  is standard deviation.

Fosc Frequency normalized to +25°C Fosc (25°C) 1.10 Rext  $\geq$  10 k $\Omega$ 1.08 Cext = 100 pF1.06 1.04 1.02 1.00 0.98 VDD = 5.5 V0.96 0.94 VDD = 3.5 V0.92 0.90 0.88 0 10 20 25 30 40 50 60 70 T(°C)

FIGURE 18-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

TABLE 18-1: RC OSCILLATOR FREQUENCIES

| Cext   | Rext  | Average<br>Fosc @ 5V, 25°C |       |  |  |
|--------|-------|----------------------------|-------|--|--|
| 20 pF  | 3.3 k | 4.973 MHz                  | ± 27% |  |  |
|        | 5 k   | 3.82 MHz                   | ± 21% |  |  |
|        | 10 k  | 2.22 MHz                   | ± 21% |  |  |
|        | 100 k | 262.15 kHz                 | ± 31% |  |  |
| 100 pF | 3.3 k | 1.63 MHz                   | ± 13% |  |  |
|        | 5 k   | 1.19 MHz                   | ± 13% |  |  |
|        | 10 k  | 684.64 kHz                 | ± 18% |  |  |
|        | 100 k | 71.56 kHz                  | ± 25% |  |  |
| 300 pF | 3.3 k | 660 kHz                    | ± 10% |  |  |
|        | 5.0 k | 484.1 kHz                  | ± 14% |  |  |
|        | 10 k  | 267.63 kHz                 | ± 15% |  |  |
|        | 160 k | 29.44 kHz                  | ± 19% |  |  |

The frequencies are measured on DIP packages.

The percentage variation indicated here is part-to-part variation due to normal process distribution. The variation indicated is  $\pm 3$  standard deviation from average value for VDD = 5 V.

FIGURE 18-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 20 PF

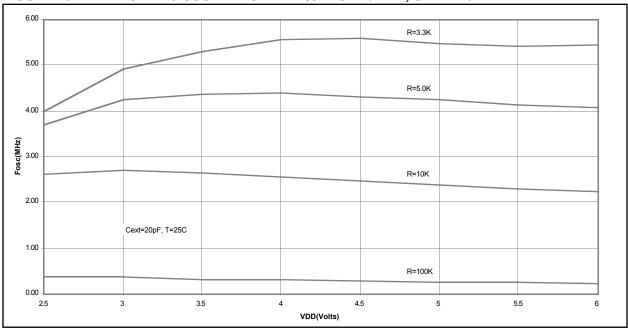


FIGURE 18-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 100 PF

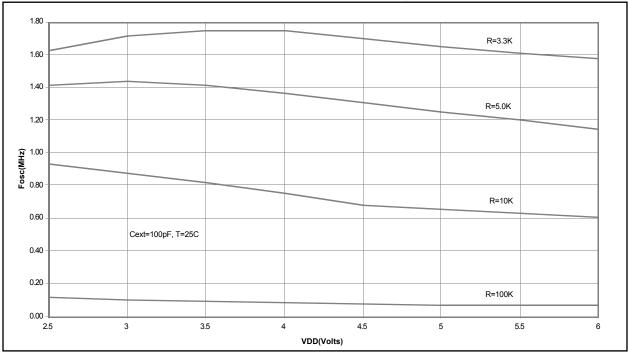


FIGURE 18-4: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 300 PF

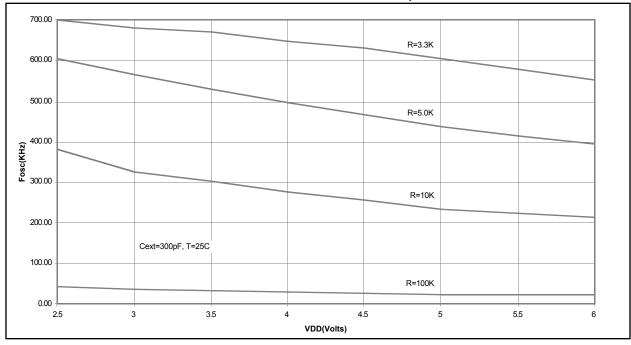


FIGURE 18-5: TYPICAL IPD vs. VDD, WATCHDOG DISABLED (25°C)

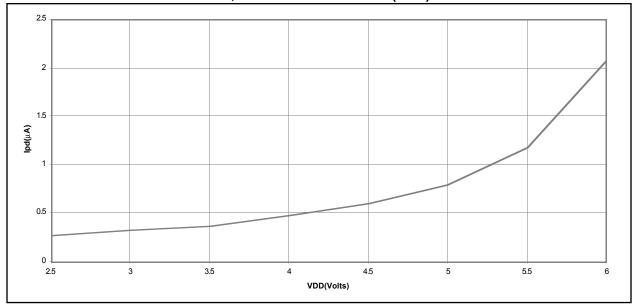


FIGURE 18-6: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (25°C)

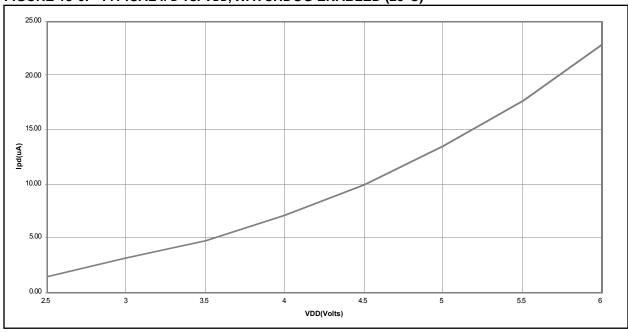
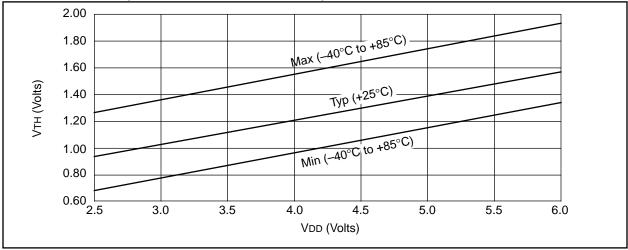


FIGURE 18-7: VTH (INPUT THRESHOLD VOLTAGE) OF I/O PINS vs. VDD



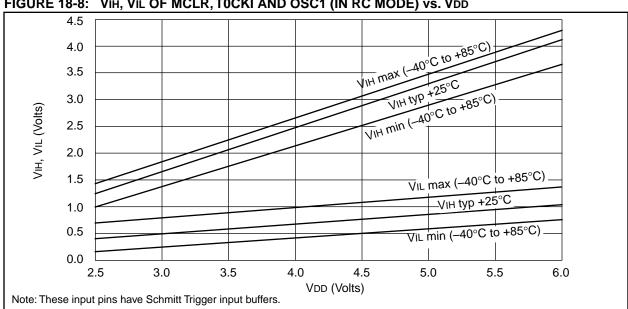


FIGURE 18-8: VIH, VIL OF MCLR, TOCKI AND OSC1 (IN RC MODE) vs. VDD



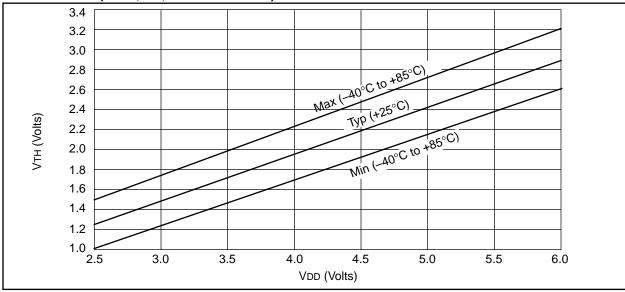


FIGURE 18-10: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 20 PF, 25°C)

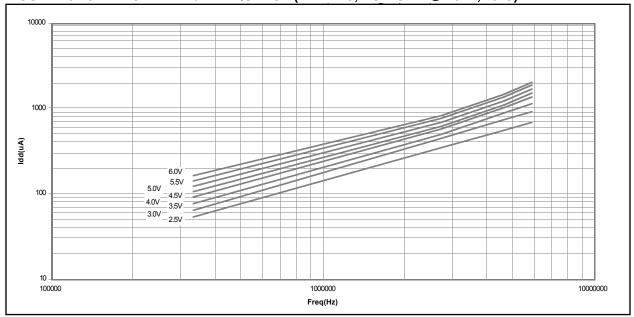


FIGURE 18-11: MAXIMUM IDD vs. FREQUENCY (WDT DIS, RC MODE @ 20 PF, -40°C TO +85°C)

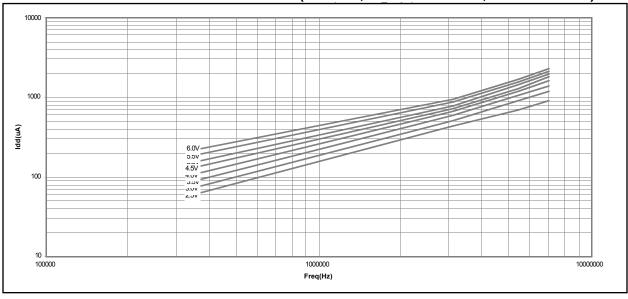


FIGURE 18-12: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 100 PF, 25°C)

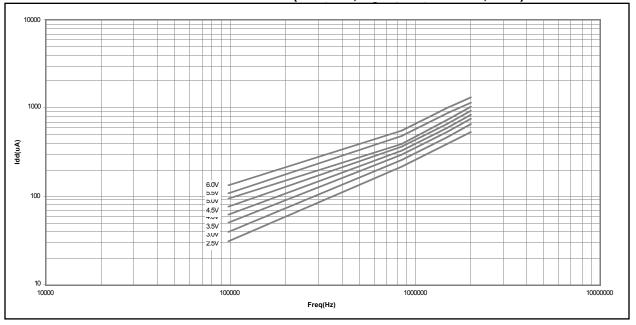


FIGURE 18-13: MAXIMUM IDD vs. FREQUENCY (WDT DIS, RC MODE @ 100 PF, -40°C TO +85°C)

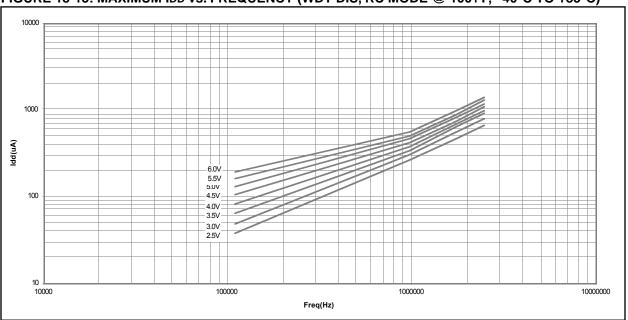


FIGURE 18-14: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 300 PF, 25°C)

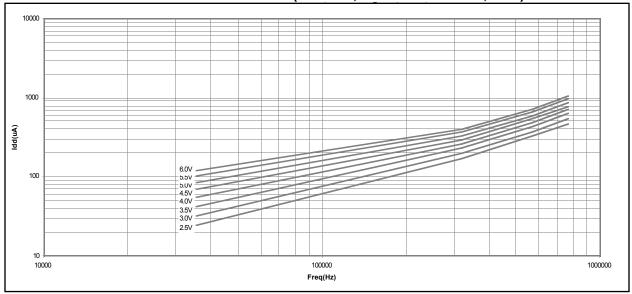


FIGURE 18-15: MAXIMUM IDD vs. FREQUENCY (WDT DIS, RC MODE @ 300 PF, -40°C TO +85°C)

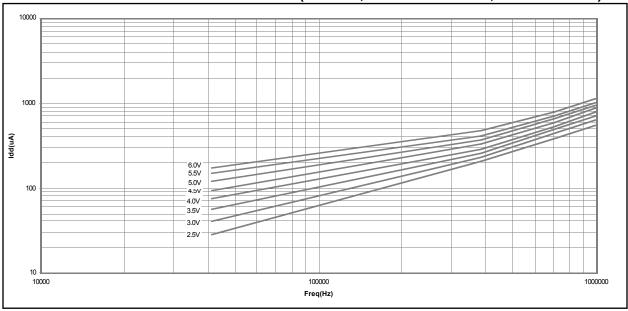


FIGURE 18-16: WDT TIMER TIME-OUT PERIOD vs. VDD

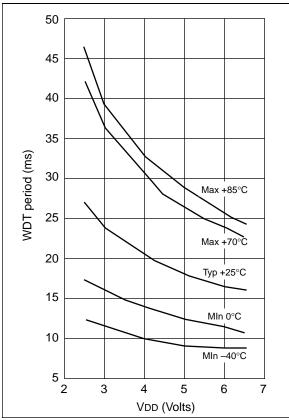


TABLE 18-2: INPUT CAPACITANCE FOR PIC16C54A/C58A

| Pin         | Typical Capacitance (pF) |          |  |  |  |
|-------------|--------------------------|----------|--|--|--|
| r III       | 18L PDIP                 | 18L SOIC |  |  |  |
| RA port     | 5.0                      | 4.3      |  |  |  |
| RB port     | 5.0                      | 4.3      |  |  |  |
| MCLR        | 17.0                     | 17.0     |  |  |  |
| OSC1        | 4.0                      | 3.5      |  |  |  |
| OSC2/CLKOUT | 4.3                      | 3.5      |  |  |  |
| TOCKI       | 3.2                      | 2.8      |  |  |  |

All capacitance values are typical at  $25^{\circ}$ C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

FIGURE 18-17: TRANSCONDUCTANCE (gm)
OF HS OSCILLATOR vs. VDD

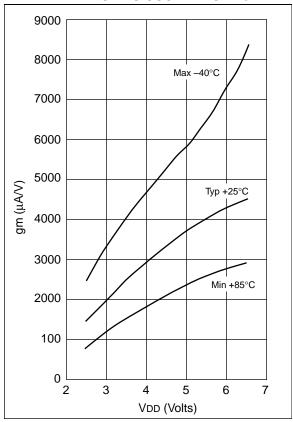


FIGURE 18-18: TRANSCONDUCTANCE (gm)
OF LP OSCILLATOR vs. VDD

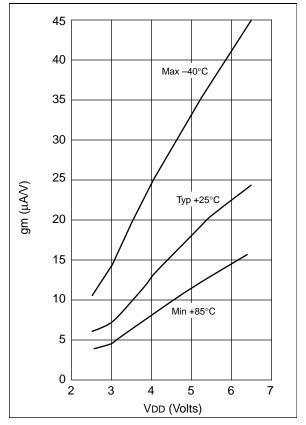


FIGURE 18-19: TRANSCONDUCTANCE (gm)
OF XT OSCILLATOR vs. VDD

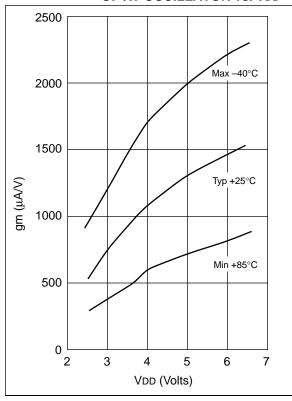


FIGURE 18-20: IOH vs. VOH, VDD = 3 V

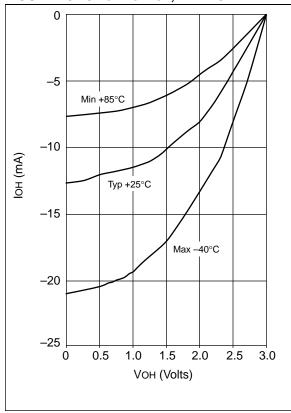


FIGURE 18-21: IOH vs. VOH, VDD = 5 V

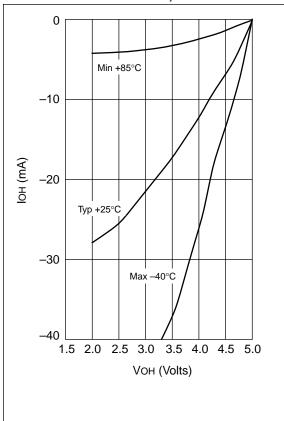


FIGURE 18-22: IOL vs. Vol, VDD = 3 V

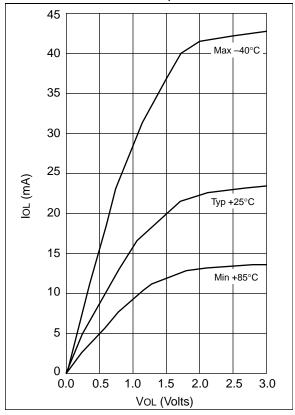
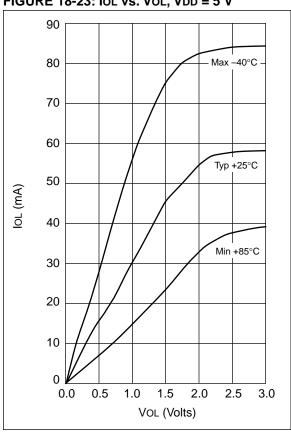


FIGURE 18-23: IOL vs. VOL, VDD = 5 V



| 1 | 6  | CEV | , |
|---|----|-----|---|
|   | יס | しつス | L |

PIC16C54A/CR57B/C58A/CR58A

**NOTES:** 

# 19.0 ELECTRICAL CHARACTERISTICS - PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B

## Absolute Maximum Ratings<sup>†</sup>

| Ambient temperature under bias                     | –55°C to +125°C |
|--|-----------------|
| Storage temperature                                | 65°C to +150°C  |
| Voltage on VDD with respect to Vss                 | 0 to +7.5V      |
| Voltage on MCLR with respect to Vss                |                 |
| Voltage on all other pins with respect to Vss      |                 |
| Total power dissipation <sup>(1)</sup>             | 800 mW          |
| Max. current out of Vss pin                        | 150 mA          |
| Max. current into VDD pin                          | 100 mA          |
| Max. current into an input pin (T0CKI only)        | ±500 μA         |
| Input clamp current, IiK (VI < 0 or VI > VDD)      | ±20 mA          |
| Output clamp current, IOK (VO < 0 or VO > VDD)     | ±20 mA          |
| Max. output current sunk by any I/O pin            | 25 mA           |
| Max. output current sourced by any I/O pin         | 20 mA           |
| Max. output current sourced by a single I/O port A | 50 mA           |
| Max. output current sourced by a single I/O port B | 50 mA           |
| Max. output current sunk by a single I/O port A    | 50 mA           |
| Max. output current sunk by a single I/O port B    | 50 mA           |
|  |                 |

**Note 1:** Power dissipation is calculated as follows: Pdis = VDD x {IDD -  $\Sigma$  IOH} +  $\Sigma$  {(VDD-VOH) x IOH} +  $\Sigma$ (VOL x IOL)

<sup>†</sup> NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 19-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

| osc | PIC16C5X-04  | PIC16C5X-20   | PIC16C5X/JW  |  |  |
|-----|--|---|--|--|--|
| RC  | VDD: 3.0V to 5.5V<br>IDD: 2.4 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis                              | VDD: 3.0V to 5.5V<br>IDD: 1.7 mA typ. at<br>5.5V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis                    | VDD: 3.0V to 5.5V<br>IDD: 2.4 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis  |  |  |
|     | Freq: 4 MHz max.   | Freq: 4.0 MHz max.  | Freq: 4.0 MHz max.   |  |  |
| ХТ  | VDD: 3.0V to 5.5V<br>IDD 2.4 mA max. at 5.5V<br>IPD: 4.0 μA max. at 3.0V WDT dis Freq: 4 MHz max.                    | VDD: 3.0V to 5.5V IDD: 1.7 mA typ. at 5.5V IPD: 0.25 μA typ. at 3.0V WDT dis Freq: 4.0 MHz max.             | VDD: 3.0V to 5.5V<br>IDD 2.4 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 4.0 MHz max.                   |  |  |
| HS  | N/A  | VDD: 4.5V to 5.5V<br>IDD: 16 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 20 MHz max. | VDD: 4.5V to 5.5V<br>IDD: 16 mA max. at<br>5.5V<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 20 MHz max.                    |  |  |
| LP  | VDD: 3.0V to 5.5V<br>IDD: 14 μA typ. at<br>32kHz, 3.0V<br>IPD: 0.25 μA typ. at<br>3.0V WDT dis<br>Freq: 200 kHz max. | Do not use in<br>LP mode  | VDD: 3.0V to 5.5V<br>IDD: 32 μA max. at<br>32kHz, 3.0V<br>WDT dis<br>IPD: 4.0 μA max. at<br>3.0V WDT dis<br>Freq: 200 kHz max. |  |  |

The shaded sections indicate oscillator selections which should work by design, but are not tested. It is recommended that the user select the device type from information in unshaded sections.

19.1 DC Characteristics: PIC16C5X-04, 20 (Commercial)

PIC16CR5X-04, 20 (Commercial) PIC16C5X-04I, 20I (Industrial) PIC16CR5X-04I, 20I (Industrial)

| 3.0<br>4.5 | Typ <sup>(1)</sup>     | <b>Max</b> 5.5 5.5             | Units<br>V<br>V   | Conditions  |
|------------|------------------------|--------------------------------|---|---|
|            | 1.5*                   |                                |   |   |
|            | 1.5*                   |                                | I   |   |
|            |                        |                                | V   | Device in SLEEP mode  |
|            | Vss                    |                                | V   | See Section 7.4 for details on Power-on Reset   |
| 0.05*      |                        |                                | V/ms  | See Section 7.4 for details on<br>Power-on Reset  |
|            | 1.8<br>4.5<br>14<br>17 | 2.4<br>16<br>32<br>40          | mA<br>μA  | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 20 MHz, VDD = 5.5V<br>Fosc = 32 kHz, VDD = 3.0V, WDT disabled<br>Fosc = 32 kHz, VDD = 3.0V, WDT disabled |
|            | 4.0<br>0.25<br>4.0     | 12<br>4.0<br>14                | μΑ<br>μΑ<br>μΑ  | VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled<br>VDD = 3.0V, WDT enabled<br>VDD = 3.0V, WDT disabled                                    |
|            |                        | 0.05*  1.8 4.5 14 17  4.0 0.25 | 1.8 2.4<br>4.5 16<br>14 32<br>17 40<br>4.0 12<br>0.25 4.0<br>4.0 14 | 1.8 2.4 mA<br>4.5 16 mA<br>14 32 μA<br>17 40 μA<br>4.0 12 μA<br>0.25 4.0 μA<br>4.0 14 μA  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:

      OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to

      Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

## 19.2 <u>DC Characteristics: PIC16C5X-04E, 20E (Extended)</u> PIC16CR5X-04E, 20E (Extended)

| DC Characteristics<br>Power Supply Pins       | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ (extended) |       |                    |          |          |   |  |
|---|---|-------|--------------------|----------|----------|---|--|
| Characteristic                                | Sym   | Min   | Typ <sup>(1)</sup> | Max      | Units    | Conditions  |  |
| Supply Voltage                                | VDD   |       |                    |          |          |   |  |
| XT and RC options                             |   | 3.0   |                    | 5.5      | V        |   |  |
| HS option                                     |   | 4.5   |                    | 5.5      | V        |   |  |
| RAM Data Retention Voltage <sup>(2)</sup>     | VDR   |       | 1.5*               |          | V        | Device in SLEEP mode                                |  |
| VDD start voltage to ensure<br>Power-On Reset | VPOR  |       | Vss                |          | V        | See Section 7.4 for details on Power-on Reset       |  |
| VDD rise rate to ensure<br>Power-On Reset     | SVDD  | 0.05* |                    |          | V/ms     | See Section 7.4 for details on<br>Power-on Reset    |  |
| Supply Current <sup>(3)</sup>                 | IDD   |       |                    |          |          |   |  |
| XT and RC <sup>(4)</sup> options              |   |       | 1.8                | 3.3      | mA       | Fosc = 4.0 MHz, VDD = 5.5V                          |  |
| HS option                                     |   |       | 9.0                | 20       | mA       | Fosc = 20 MHz, VDD = 5.5V                           |  |
| Power Down Current <sup>(5)</sup>             | IPD   |       | 0.3<br>4.5         | 18<br>22 | μA<br>μA | VDD = 3.5V, WDT disabled<br>VDD = 3.5V, WDT enabled |  |
|   |   |       |                    |          |          |   |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:  $\text{OSC1} = \text{external square wave, from rail-to-rail; all I/O pins tristated, pulled to } \\ \text{Vss, TOCKI} = \text{VDD, } \overline{\text{MCLR}} = \text{VDD; WDT enabled/disabled as specified.}$
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in  $k\Omega$ .
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

19.3 <u>DC Characteristics:</u> <u>PIC16LCR5X-04 (Commercial)</u> PIC16LCR5X-04I (Industrial)

| DC Characteristics<br>Power Supply Pins  | Standard Operating Conditions (unless otherwise specified)  Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial) $-40^{\circ}C \le TA \le +85^{\circ}C$ (industrial) |            |                            |                        |                      |  |  |
|--|---|------------|----------------------------|------------------------|----------------------|--|--|
| Characteristic   | Sym   | Min        | Typ <sup>(1)</sup>         | Max                    | Units                | Conditions   |  |
| Supply Voltage<br>XT and RC options<br>LP options  | VDD   | 3.0<br>2.5 |                            | 5.5<br>5.5             | >>                   |  |  |
| RAM Data Retention Voltage <sup>(2)</sup>  | VDR   |            | 1.5*                       |                        | V                    | Device in SLEEP mode   |  |
| VDD start voltage to ensure<br>Power-On Reset  | VPOR  |            | Vss                        |                        | V                    | See Section 7.4 for details on Power-on Reset  |  |
| VDD rise rate to ensure<br>Power-On Reset  | SVDD  | 0.05*      |                            |                        | V/ms                 | See Section 7.4 for details on<br>Power-on Reset   |  |
| Supply Current <sup>(3)</sup> XT and RC <sup>(4)</sup> options LP option, Commercial LP option, Industrial | IDD   |            | 0.5<br>11<br>14            | 2.4<br>27<br>35        | mA<br>μA<br>μA       | Fosc = 4.0 MHz, VDD = 5.5V<br>Fosc = 32 kHz, VDD = 2.5V WDT disabled<br>Fosc = 32 kHz, VDD = 2.5V WDT disabled |  |
| Power Down Current <sup>(5)</sup> Commercial Industrial  | IPD   |            | 2.5<br>0.25<br>2.5<br>0.25 | 12<br>4.0<br>14<br>5.0 | μΑ<br>μΑ<br>μΑ<br>μΑ | VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled<br>VDD = 2.5V, WDT enabled<br>VDD = 2.5V, WDT disabled     |  |

<sup>\*</sup> These parameters are characterized but not tested.

- Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
  - 2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active operation mode are:
       OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to
       Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.
  - 4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kΩ.
  - 5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

19.4 DC Characteristics: PIC16C5X-04, 20, PIC16LCR5X-04 (Commercial)

PIC16CR5X-04, 20, PIC16CR5X-04I, 20I (Commercial)

PIC16C5X-04I, 20I, PIC16LC5X-04I (Industrial)

PIC16C5X-04E, 20E (Extended)

Standard Operating Conditions (unless otherwise specified)

**Operating Temperature**  $0^{\circ}C \leq TA \leq +70^{\circ}C$  (commercial)

**DC Characteristics**  $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$  (industrial) **All Pins Except**  $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended) **Power Supply Pins** 

Operating Voltage VDD range is described in Section 19.1, Section 19.2 and

Section 19.3.

| Georgia 13.3.                        |      |               |                    |          |       |                                       |  |  |  |
|--------------------------------------|------|---------------|--------------------|----------|-------|---------------------------------------|--|--|--|
| Characteristic                       | Sym  | Min           | Typ <sup>(1)</sup> | Max      | Units | Conditions                            |  |  |  |
| Input Low Voltage                    | VIL  |               |                    |          |       |                                       |  |  |  |
| I/O Ports                            |      | Vss           |                    | 0.8 Vdd  | V     | Pin at hi-impedance 4.5V , VDD ≤ 5.5V |  |  |  |
| I/O Ports                            |      | Vss           |                    | 0.15 VDD | V     | Pin at hi-impedance 2.5V , VDD ≤ 4.5V |  |  |  |
| MCLR (Schmitt Trigger)               |      | Vss           |                    | 0.15 VDD | V     |                                       |  |  |  |
| T0CKI (Schmitt Trigger)              |      | Vss           |                    | 0.15 VDD | V     |                                       |  |  |  |
| OSC1 (Schmitt Trigger)               |      | Vss           |                    | 0.15 VDD | V     | RC option only <sup>(4)</sup>         |  |  |  |
| OSC1                                 |      |               |                    | 0.3 Vdd  |       | XT, HS and LP options                 |  |  |  |
| Input High Voltage                   | VIH  |               |                    |          |       |                                       |  |  |  |
| I/O ports                            |      | 0.25 VDD+0.8V |                    | Vdd      | V     | For all VDD <sup>(5)</sup>            |  |  |  |
|                                      |      | 2.0           |                    | Vdd      | V     | $4.5V < VDD \le 5.5V^{(5)}$           |  |  |  |
| MCLR (Schmitt Trigger)               |      | 0.85 VDD      |                    | Vdd      | V     |                                       |  |  |  |
| T0CKI (Schmitt Trigger)              |      | 0.85 VDD      |                    | Vdd      | V     |                                       |  |  |  |
| OSC1 (Schmitt Trigger)               |      | 0.85 VDD      |                    | Vdd      | V     | RC option only <sup>(4)</sup>         |  |  |  |
| OSC1                                 |      | 0.7 VDD       |                    | Vdd      | V     | XT, HS and LP options                 |  |  |  |
| Hysteresis of Schmitt                | VHYS | 0.15Vpp*      |                    |          | V     |                                       |  |  |  |
| Trigger inputs                       |      |               |                    |          |       |                                       |  |  |  |
| Input Leakage Current <sup>(3)</sup> | lıL  |               |                    |          |       | For V <sub>DD</sub> ≤ 5.5V            |  |  |  |
| I/O ports                            |      | -1.0          | 0.5                | +1.0     | μA    | $Vss \leq Vpin \leq Vdd$ ,            |  |  |  |
|                                      |      |               |                    |          | •     | Pin at hi-impedance                   |  |  |  |
| MCLR                                 |      | -5.0          |                    | +5.0     | μA    | $VPIN = VSS + 0.25V^{(2)}$            |  |  |  |
|                                      |      |               | 0.5                | +3.0     | μA    | $V_{PIN} = V_{DD}(2)$                 |  |  |  |
| тоскі                                |      | -3.0          | 0.5                | +3.0     | μA    | Vss ≤ Vpin ≤ Vdd                      |  |  |  |
| OSC1                                 |      | -3.0          | 0.5                |          | μΑ    | Vss ≤ Vpin ≤ Vdd,                     |  |  |  |
|                                      |      |               |                    |          |       | XT, HS and LP options                 |  |  |  |
| Output Low Voltage                   | VoL  |               |                    |          |       |                                       |  |  |  |
| I/O ports                            |      |               |                    | 0.6      | V     | IOL = 8.7 mA, VDD = 4.5V              |  |  |  |
| OSC2/CLKOUT                          |      |               |                    | 0.6      | V     | IOL = 1.6  mA, VDD = 4.5 V,           |  |  |  |
|                                      |      |               |                    |          |       | RC option only                        |  |  |  |
| Output High Voltage                  | Vон  |               |                    |          |       |                                       |  |  |  |
| I/O ports <sup>(3)</sup>             |      | VDD-0.7       |                    |          | V     | IOH = -5.4 mA, VDD = 4.5V             |  |  |  |
| OSC2/CLKOUT                          |      | VDD-0.7       |                    |          | V     | IOH = -1.0  mA, VDD = 4.5V,           |  |  |  |
|                                      |      |               |                    |          |       | RC option only                        |  |  |  |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.
- 3: Negative current is defined as coming out of the pin.
- 4: For the RC option, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.
- 5: The user may use the better of the two specifications.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

## 19.5 <u>Timing Parameter Symbology and Load Conditions</u>

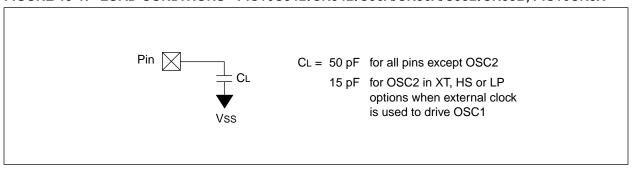
The timing parameter symbols have been created following one of the following formats:

## 1. TppS2ppS

2. TppS

| pp C   |  |     |                |  |
|--------|--|-----|----------------|--|
| Т      |  |     |                |  |
| F      | Frequency                                | Т   | Time           |  |
| Lowerd | case subscripts (pp) and their meanings: |     |                |  |
| рр     |  |     |                |  |
| 2      | to                                       | mc  | MCLR           |  |
| ck     | CLKOUT                                   | osc | oscillator     |  |
| су     | cycle time                               | os  | OSC1           |  |
| drt    | device reset timer                       | t0  | T0CKI          |  |
| io     | I/O port                                 | wdt | watchdog timer |  |
| Upper  | case letters and their meanings:         |     |                |  |
| S      |  |     |                |  |
| F      | Fall                                     | P   | Period         |  |
| Н      | High                                     | R   | Rise           |  |
| 1      | Invalid (Hi-impedance)                   | V   | Valid          |  |
| l ı    | Low                                      | 7   | Hi-impedance   |  |

## FIGURE 19-1: LOAD CONDITIONS - PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B, PIC16CR5X



#### 19.6 <u>Timing Diagrams and Specifications</u>

FIGURE 19-2: EXTERNAL CLOCK TIMING - PIC16C5X, PIC16CR5X

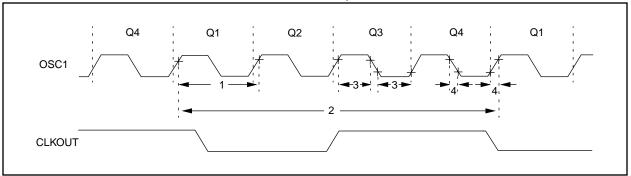


TABLE 19-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C} \text{ (commercial)}$ 

 $-40^{\circ}$ C  $\leq$  TA  $\leq$  +85°C (industrial)

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$  (extended)

Operating Voltage VDD range is described in Section 19.1, Section 19.2 and Section 19.3.

| Parameter No. | Sym  | Characteristic                          | Min   | Тур <sup>(1)</sup> | Max   | Units | Conditions       |  |
|---------------|------|---|-------|--------------------|-------|-------|------------------|--|
|               | Fosc | External CLKIN Frequency <sup>(2)</sup> | DC    | _                  | 4.0   | MHz   | XT osc mode      |  |
|               |      |   | DC    | _                  | 4.0   | MHz   | HS osc mode (04) |  |
|               |      |   | DC    | _                  | 20    | MHz   | HS osc mode (20) |  |
|               |      |   | DC    | _                  | 200   | kHz   | LP osc mode      |  |
|               |      | Oscillator Frequency <sup>(2)</sup>     | DC    | _                  | 4.0   | MHz   | RC osc mode      |  |
|               |      |   | 0.455 | _                  | 4.0   | MHz   | XT osc mode      |  |
|               |      |   | 4     | _                  | 4.0   | MHz   | HS osc mode (04) |  |
|               |      |   | 4     | _                  | 20    | MHz   | HS osc mode (20) |  |
|               |      |   | 5     | _                  | 200   | kHz   | LP osc mode      |  |
| 1             | Tosc | External CLKIN Period <sup>(2)</sup>    | 250   | _                  | _     | ns    | XT osc mode      |  |
|               |      |   | 250   | _                  | _     | ns    | HS osc mode (04) |  |
|               |      |   | 50    | _                  | _     | ns    | HS osc mode (20) |  |
|               |      |   | 5.0   | _                  | _     | μs    | LP osc mode      |  |
|               |      | Oscillator Period <sup>(2)</sup>        | 250   | _                  | _     | ns    | RC osc mode      |  |
|               |      |   | 250   | _                  | 2,200 | ns    | XT osc mode      |  |
|               |      |   | 250   | _                  | 250   | ns    | HS osc mode (04) |  |
|               |      |   | 50    | _                  | 250   | ns    | HS osc mode (20) |  |
|               |      |   | 5.0   | _                  | 200   | μs    | LP osc mode      |  |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

<sup>2:</sup> All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

#### TABLE 19-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X (CON'T)

AC Characteristics Standard Operating Conditions (unless otherwise specified)

Operating Temperature  $0^{\circ}C \le TA \le +70^{\circ}C$  (commercial)

 $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C} \text{ (industrial)}$ 

 $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 19.1, Section 19.2 and Section 19.3.

| Parameter<br>No. | Sym        | Characteristic                        | Min  | Typ <sup>(1)</sup> | Max | Units | Conditions    |
|------------------|------------|---------------------------------------|------|--------------------|-----|-------|---------------|
| 2                | Tcy        | Instruction Cycle Time <sup>(3)</sup> | _    | 4/Fosc             | _   | _     |               |
| 3                | TosL, TosH | Clock in (OSC1) Low or High Time      | 50*  | _                  | _   | ns    | XT oscillator |
|                  |            |                                       | 20*  | _                  | _   | ns    | HS oscillator |
|                  |            |                                       | 2.0* | _                  | _   | μs    | LP oscillator |
| 4                | TosR, TosF | Clock in (OSC1) Rise or Fall Time     | _    | _                  | 25* | ns    | XT oscillator |
|                  |            |                                       | —    | _                  | 25* | ns    | HS oscillator |
|                  |            |                                       | _    | _                  | 50* | ns    | LP oscillator |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- 2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
  - When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 3: Instruction cycle period (TCY) equals four times the input oscillator time base period.

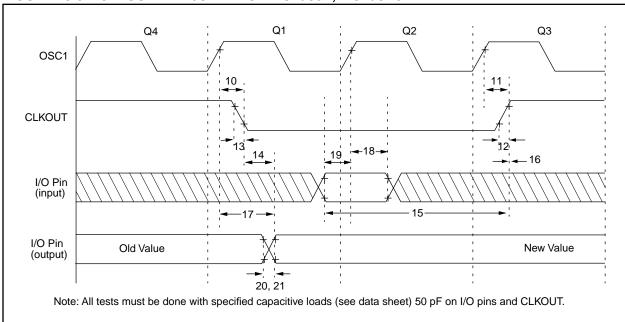


FIGURE 19-3: CLKOUT AND I/O TIMING - PIC16C5X, PIC16CR5X

TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X

| AC Characteristics | AC Characteristics Standard Operating Conditions (unless otherwise specified)            |  |  |  |  |
|--------------------|--|--|--|--|--|
|                    | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)                  |  |  |  |  |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +85 $^{\circ}$ C (industrial)                           |  |  |  |  |
|                    | $-40^{\circ}$ C $\leq$ TA $\leq$ +125 $^{\circ}$ C (extended)                            |  |  |  |  |
|                    | Operating Voltage VDD range is described in Section 19.1, Section 19.2 and Section 19.3. |  |  |  |  |

| Parameter<br>No. | Sym      | Characteristic  | Min          | Typ <sup>(1)</sup> | Max  | Units |
|------------------|----------|---|--------------|--------------------|------|-------|
| 10               | TosH2ckL | OSC1↑ to CLKOUT↓ <sup>(2)</sup>                           | _            | 15                 | 30** | ns    |
| 11               | TosH2ckH | OSC1↑ to CLKOUT↑ <sup>(2)</sup>                           | _            | 15                 | 30** | ns    |
| 12               | TckR     | CLKOUT rise time <sup>(2)</sup>                           | _            | 5.0                | 15** | ns    |
| 13               | TckF     | CLKOUT fall time <sup>(2)</sup>                           | _            | 5.0                | 15** | ns    |
| 14               | TckL2ioV | CLKOUT↓ to Port out valid <sup>(2)</sup>                  | _            | _                  | 40** | ns    |
| 15               | TioV2ckH | Port in valid before CLKOUT <sup>(2)</sup>                | 0.25 TCY+30* | _                  | _    | ns    |
| 16               | TckH2ioI | Port in hold after CLKOUT↑(2)                             | 0*           | _                  | _    | ns    |
| 17               | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid <sup>(3)</sup>         | _            | _                  | 100* | ns    |
| 18               | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time) | TBD          | _                  | _    | ns    |
| 19               | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)             | TBD          | _                  | _    | ns    |
| 20               | TioR     | Port output rise time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |
| 21               | TioF     | Port output fall time <sup>(3)</sup>                      | _            | 10                 | 25** | ns    |

<sup>\*</sup> These parameters are characterized but not tested.

- 2: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.
- 3: See Figure 19-1 for loading conditions.

 $<sup>^{\</sup>star\star}$  These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16C5X, PIC16CR5X

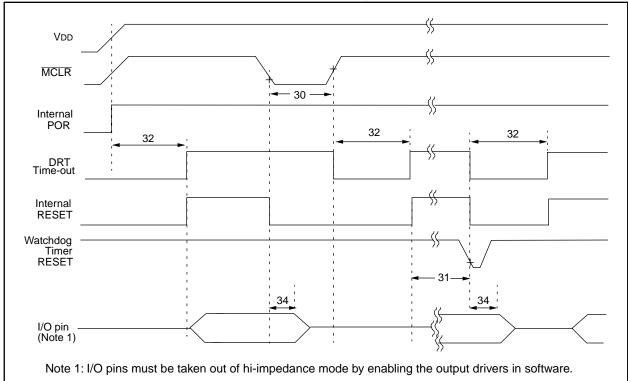


TABLE 19-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C5X, PIC16CR5X

# AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)

 $-40^{\circ}C \le TA \le +85^{\circ}C$  (industrial)

 $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C} \text{ (extended)}$ 

Operating Voltage VDD range is described in Section 19.1, Section 19.2 and Section 19.3.

| Parameter No. | Sym  | Characteristic                                |       | Typ <sup>(1)</sup> | Max   | Units | Conditions              |
|---------------|------|---|-------|--------------------|-------|-------|-------------------------|
| 30            | TmcL | MCLR Pulse Width (low)                        | 1000* | _                  | _     | ns    | VDD = 5.0V              |
| 31            | Twdt | Watchdog Timer Time-out Period (No Prescaler) | 9.0*  | 18*                | 30*   | ms    | VDD = 5.0V (Commercial) |
| 32            | TDRT | Device Reset Timer Period                     | 9.0*  | 18*                | 30*   | ms    | VDD = 5.0V (Commercial) |
| 34            | Tioz | I/O Hi-impedance from MCLR Low                | 100*  | 300*               | 1000* | ns    |                         |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

#### FIGURE 19-5: TIMERO CLOCK TIMINGS - PIC16C5X, PIC16CR5X

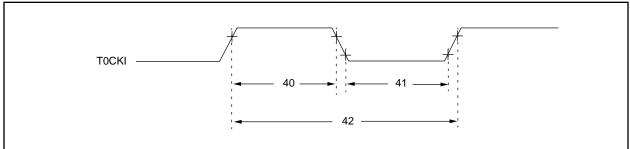


TABLE 19-5: TIMERO CLOCK REQUIREMENTS - PIC16C5X, PIC16CR5X

| AC Characteristics   |      | cteristics Standard Operatir          | Standard Operating Conditions (unless otherwise specified)               |                    |          |       |            |  |
|--|------|---------------------------------------|--|--------------------|----------|-------|------------|--|
|  |      | Operating Tempera                     | Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ (commercial)  |                    |          |       | ercial)    |  |
|  |      |                                       | $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ (industrial) |                    |          |       |            |  |
|  |      |                                       | -40°C ≤ TA ≤ +125°C (extended)   |                    |          |       |            |  |
| Operating Voltage VDD range is described in Section 19.1, Section 19.2 Section 19.3. |      |                                       |  |                    |          | ,     |            |  |
| Parameter No.  | Sym  | Characteristic                        | Min  | Typ <sup>(1)</sup> | Max      | Units | Conditions |  |
| 40   | Tt0H | T0CKI High Pulse Width - No Prescaler | 0.5 Tcy + 20*  | <b> </b>           | _        | ns    |            |  |
|  |      | - With Prescaler                      | 10*  |                    | <u> </u> | ns    |            |  |

| No. | Sym  | Characteristic                        | Min                          | Typ <sup>(1)</sup> | Max | Units | Conditions  |
|-----|------|---------------------------------------|------------------------------|--------------------|-----|-------|---|
| 40  | Tt0H | T0CKI High Pulse Width - No Prescaler | 0.5 Tcy + 20*                | _                  | _   | ns    |   |
|     |      | - With Prescaler                      | 10*                          |                    |     | ns    |   |
| 41  | TtOL | T0CKI Low Pulse Width - No Prescaler  | 0.5 Tcy + 20*                |                    |     | ns    |   |
|     |      | - With Prescaler                      | 10*                          |                    |     | ns    |   |
| 42  | Tt0P | TOCKI Period                          | 20 or <u>Tcy + 40</u> *<br>N |                    | _   | ns    | Whichever is greater.  N = Prescale Value (1, 2, 4,, 256) |

<sup>\*</sup> These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

# 20.0 DC AND AC CHARACTERISTICS - PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean +  $3\sigma$ ) and (mean -  $3\sigma$ ) respectively, where  $\sigma$  is standard deviation.

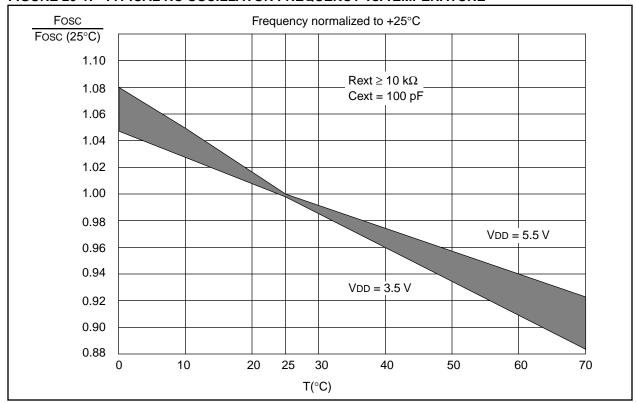


FIGURE 20-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

TABLE 20-1: RC OSCILLATOR FREQUENCIES

| Cext   | Rext  | Average<br>Fosc @ 5V, 25°C |       |  |
|--------|-------|----------------------------|-------|--|
| 20 pF  | 3.3 k | 4.973 MHz                  | ± 27% |  |
|        | 5 k   | 3.82 MHz                   | ± 21% |  |
|        | 10 k  | 2.22 MHz                   | ± 21% |  |
|        | 100 k | 262.15 kHz                 | ± 31% |  |
| 100 pF | 3.3 k | 1.63 MHz                   | ± 13% |  |
|        | 5 k   | 1.19 MHz                   | ± 13% |  |
|        | 10 k  | 684.64 kHz                 | ± 18% |  |
|        | 100 k | 71.56 kHz                  | ± 25% |  |
| 300 pF | 3.3 k | 660 kHz                    | ± 10% |  |
|        | 5.0 k | 484.1 kHz                  | ± 14% |  |
|        | 10 k  | 267.63 kHz                 | ± 15% |  |
|        | 160 k | 29.44 kHz                  | ± 19% |  |

The frequencies are measured on DIP packages.

The percentage variation indicated here is part-to-part variation due to normal process distribution. The variation indicated is  $\pm 3$  standard deviation from average value for VDD = 5 V.

FIGURE 20-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 20 PF

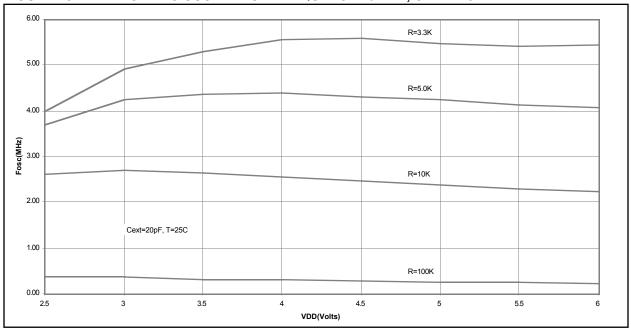


FIGURE 20-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 100 PF

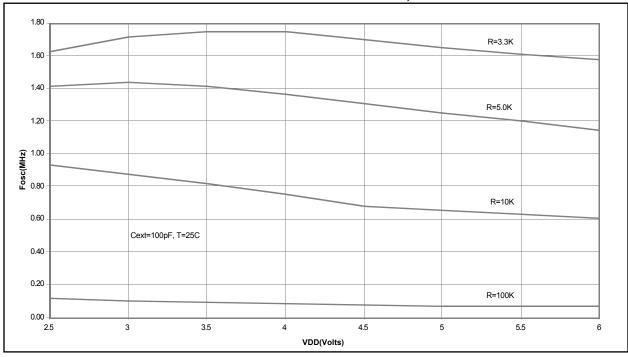


FIGURE 20-4: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 300 PF

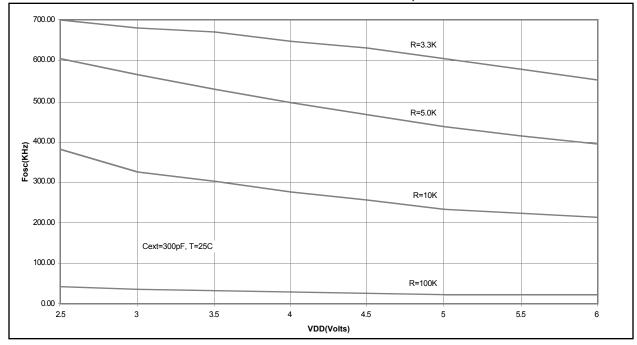


FIGURE 20-5: TYPICAL IPD vs. VDD, WATCHDOG DISABLED (25°C)

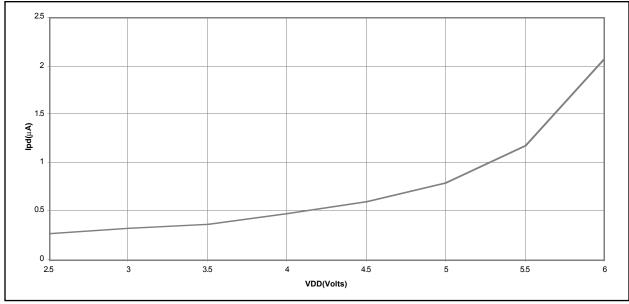


FIGURE 20-6: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (25°C)

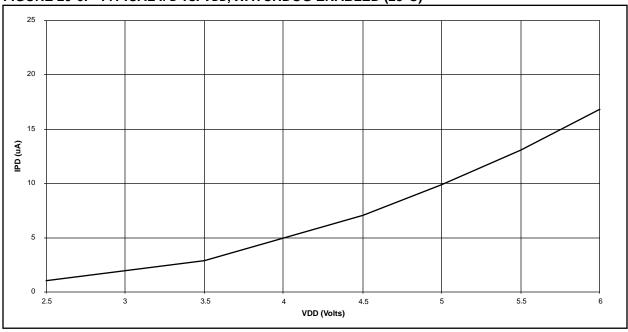
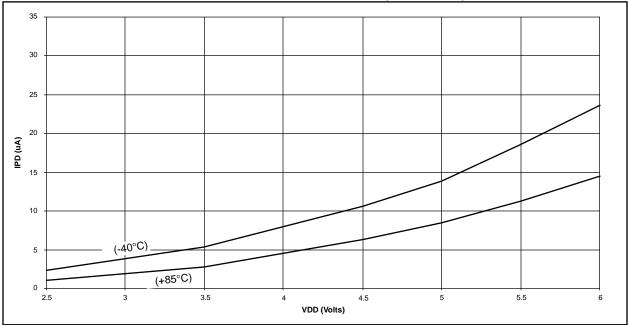


FIGURE 20-7: TYPICAL IPD vs. VDD, WATCHDOG ENABLED (-40°C, 85°C)





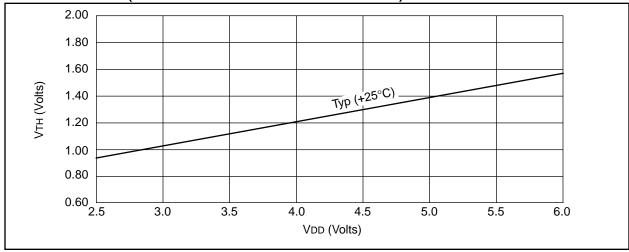


FIGURE 20-9: VIH, VIL OF MCLR, TOCKI AND OSC1 (IN RC MODE) vs. VDD

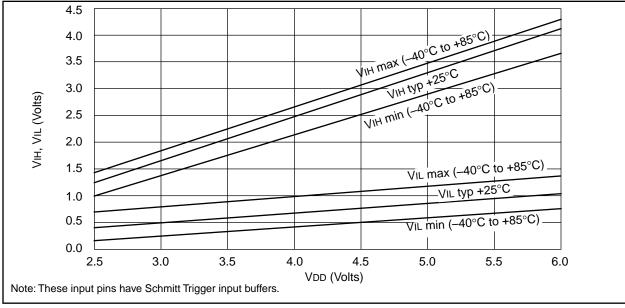


FIGURE 20-10: VTH (INPUT THRESHOLD TRIP POINT VOLTAGE) OF OSC1 INPUT (IN XT, HS, AND LP MODES) vs. VDD

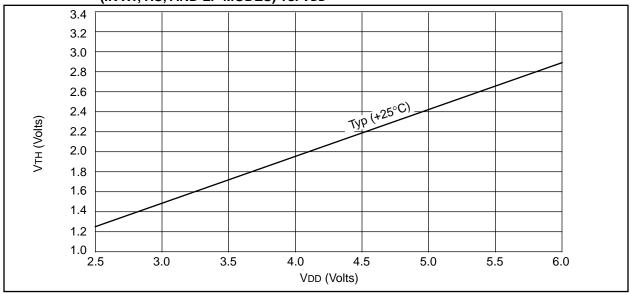


FIGURE 20-11: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 20 PF, 25°C)

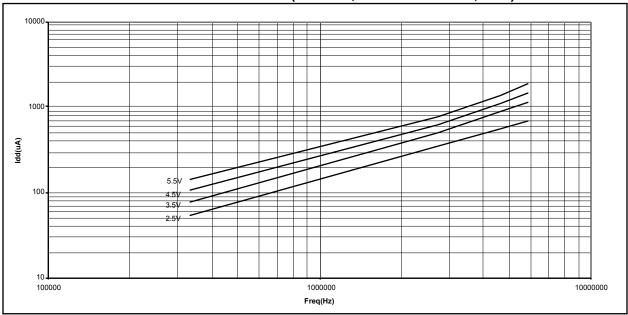


FIGURE 20-12: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 100 PF, 25°C)

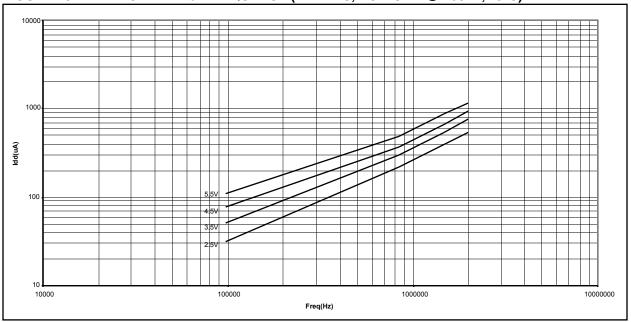


FIGURE 20-13: TYPICAL IDD vs. FREQUENCY (WDT DIS, RC MODE @ 300 PF, 25°C)

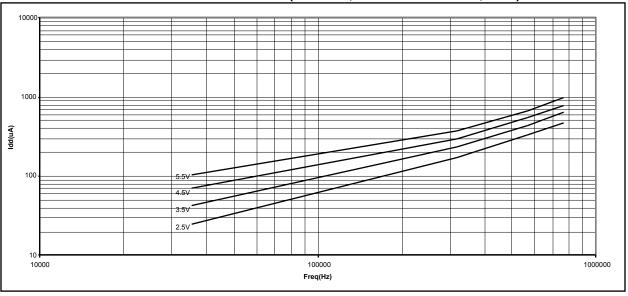


FIGURE 20-14: WDT TIMER TIME-OUT PERIOD vs. VDD

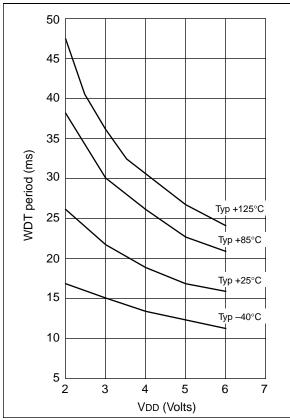


TABLE 20-2: INPUT CAPACITANCE FOR PIC16C54s/C58s

| Pin         | Typical Capacitance (pF) |          |  |  |
|-------------|--------------------------|----------|--|--|
| FIII        | 18L PDIP                 | 18L SOIC |  |  |
| RA port     | 5.0                      | 4.3      |  |  |
| RB port     | 5.0                      | 4.3      |  |  |
| MCLR        | 17.0                     | 17.0     |  |  |
| OSC1        | 4.0                      | 3.5      |  |  |
| OSC2/CLKOUT | 4.3                      | 3.5      |  |  |
| TOCKI       | 3.2                      | 2.8      |  |  |

All capacitance values are typical at 25°C. A part-to-part variation of  $\pm 25\%$  (three standard deviations) should be taken into account.

© 1997 Microchip Technology Inc.

FIGURE 20-15: IOH vs. VOH, VDD = 3 V

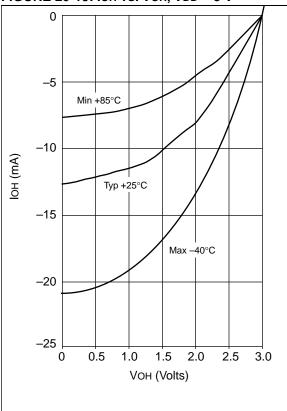


FIGURE 20-16: IOH vs. VOH, VDD = 5 V

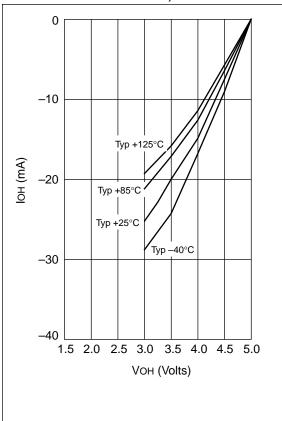


FIGURE 20-17: IOL vs. VOL, VDD = 3 V

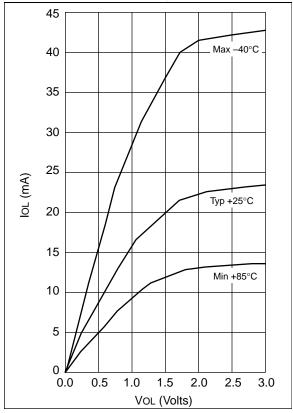
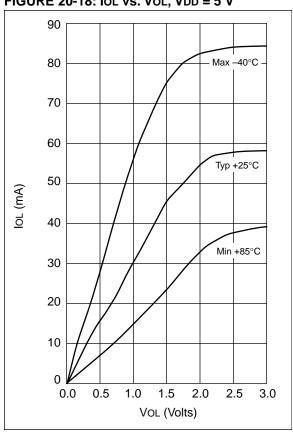


FIGURE 20-18: IOL vs. VOL, VDD = 5 V



|     |   | <u> ←</u> E | V |
|-----|---|-------------|---|
| IC1 | O | しつ          | Λ |

PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B

**NOTES:** 

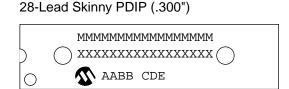
#### 21.0 PACKAGING INFORMATION

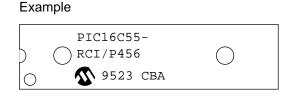
#### 21.1 Package Marking Information

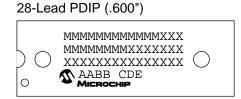
# 18-Lead PDIP MMMMMMMMMMMMXXX MMMMMMMMMXXXXXXX AABB CDE



Example









| ∣∟ | .egend: MMM      | Microchip part number information                                   |
|----|------------------|---|
|    | XXX              | Customer specific information*                                      |
|    | AA               | Year code (last two digits of calendar year)                        |
|    | BB               | Week code (week of January 1 is week '01')                          |
|    | С                | Facility code of the plant at which wafer is manufactured           |
|    |                  | C = Chandler, Arizona, U.S.A.,                                      |
|    |                  | S = Tempe, Arizona, U.S.A.  |
|    | D                | Mask revision number  |
|    | E                | Assembly code of the plant or country of origin in which            |
|    |                  | part was assembled  |
| N  | lote: In the eve | ent the full Microchip part number cannot be marked on one line,    |
|    | it will be       | carried over to the next line thus limiting the number of available |
|    | characte         | rs for customer specific information.                               |

<sup>\*</sup> Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

#### 18-Lead SOIC

MMMMMMMM XXXXXXXXX AABB CDE

#### 28-Lead SOIC

MMMMMMMMMMMMMMXX
XXXXXXXXXXXXXXXXXXXX

AABB CDE

#### 20-Lead SSOP



#### 28-Lead SSOP



#### Example

PIC16C54-XTI/S0218 O **3** 9518 CDK

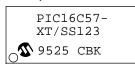
#### Example



#### Example



#### Example



| Legend: MMM      | Microchip part number information                                  |
|------------------|--|
| XXX              | Customer specific information*                                     |
| AA               | Year code (last two digits of calendar year)                       |
| BB               | Week code (week of January 1 is week '01')                         |
| C                | Facility code of the plant at which wafer is manufactured          |
|                  | C = Chandler, Arizona, U.S.A.,                                     |
|                  | S = Tempe, Arizona, U.S.A.   |
| D                | Mask revision number   |
| E                | Assembly code of the plant or country of origin in which           |
|                  | part was assembled   |
| Note: In the eve | nt the full Microchip part number cannot be marked on one line,    |
| it will be c     | arried over to the next line thus limiting the number of available |
| characters       | s for customer specific information                                |

<sup>\*</sup> Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

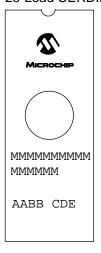
#### 18-Lead CERDIP Windowed



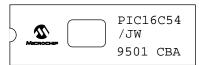
#### 28-Lead CERDIP Skinny Windowed



#### 28-Lead CERDIP Windowed



#### Example



#### Example



#### Example

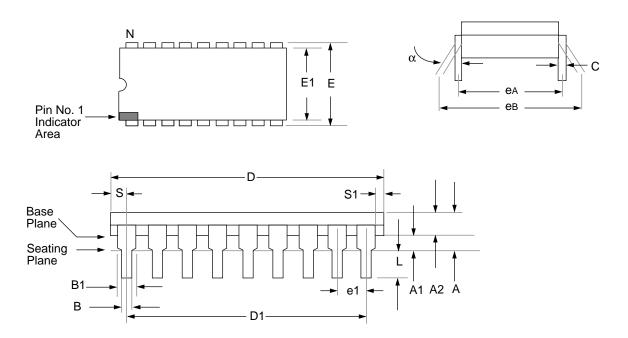


| Legend: MMM | Microchip part number information                         |
|-------------|---|
| XXX         | Customer specific information*                            |
| AA          | Year code (last two digits of calendar year)              |
| BB          | Week code (week of January 1 is week '01')                |
| С           | Facility code of the plant at which wafer is manufactured |
|             | C = Chandler, Arizona, U.S.A.,                            |
|             | S = Tempe, Arizona, U.S.A.                                |
| D           | Mask revision number                                      |
| E           | Assembly code of the plant or country of origin in which  |
|             | part was assembled  |

**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

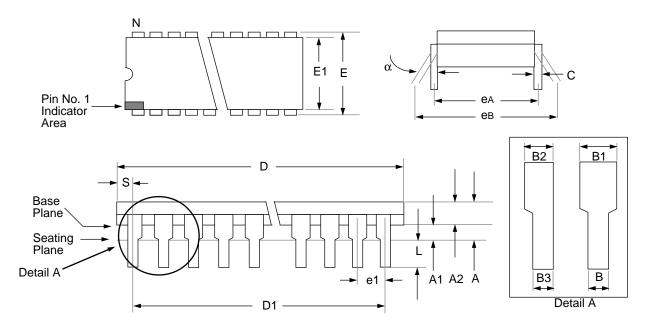
\* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

## 21.2 <u>18-Lead Plastic Dual In-Line (PDIP) - 300 mil</u>



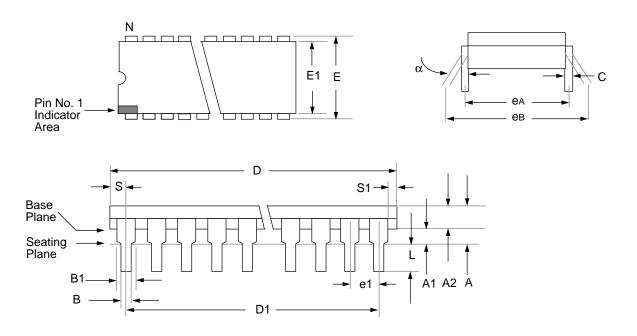
| Package Group: Plastic Dual In-Line (PLA) |             |        |           |        |       |           |  |  |
|---|-------------|--------|-----------|--------|-------|-----------|--|--|
|   | Millimeters |        |           | Inches |       |           |  |  |
| Symbol                                    | Min         | Max    | Notes     | Min    | Max   | Notes     |  |  |
| α   | 0°          | 10°    |           | 0°     | 10°   |           |  |  |
| А   | _           | 4.064  |           | _      | 0.160 |           |  |  |
| A1  | 0.381       | _      |           | 0.015  | _     |           |  |  |
| A2  | 3.048       | 3.810  |           | 0.120  | 0.150 |           |  |  |
| В   | 0.355       | 0.559  |           | 0.014  | 0.022 |           |  |  |
| B1  | 1.524       | 1.524  | Reference | 0.060  | 0.060 | Reference |  |  |
| С   | 0.203       | 0.381  | Typical   | 0.008  | 0.015 | Typical   |  |  |
| D   | 22.479      | 23.495 |           | 0.885  | 0.925 |           |  |  |
| D1  | 20.320      | 20.320 | Reference | 0.800  | 0.800 | Reference |  |  |
| E   | 7.620       | 8.255  |           | 0.300  | 0.325 |           |  |  |
| E1  | 6.096       | 7.112  |           | 0.240  | 0.280 |           |  |  |
| e1  | 2.489       | 2.591  | Typical   | 0.098  | 0.102 | Typical   |  |  |
| eA  | 7.620       | 7.620  | Reference | 0.300  | 0.300 | Reference |  |  |
| eВ  | 7.874       | 9.906  |           | 0.310  | 0.390 |           |  |  |
| L   | 3.048       | 3.556  |           | 0.120  | 0.140 |           |  |  |
| N   | 18          | 18     |           | 18     | 18    |           |  |  |
| S   | 0.889       | _      |           | 0.035  | _     |           |  |  |
| S1  | 0.127       | _      |           | 0.005  | _     |           |  |  |

## 21.3 <u>28-Lead Plastic Dual In-Line (PDIP) - 300 mil</u>



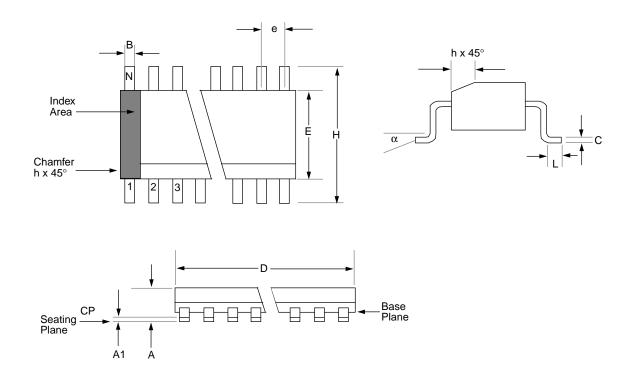
| Package Group: Plastic Dual In-Line (PLA) |        |             |           |        |       |           |  |  |
|---|--------|-------------|-----------|--------|-------|-----------|--|--|
|   |        | Millimeters |           | Inches |       |           |  |  |
| Symbol                                    | Min    | Max         | Notes     | Min    | Max   | Notes     |  |  |
| α   | 0°     | 10°         |           | 0°     | 10°   |           |  |  |
| Α   | 3.632  | 4.572       |           | 0.143  | 0.180 |           |  |  |
| A1  | 0.381  | _           |           | 0.015  | _     |           |  |  |
| A2  | 3.175  | 3.556       |           | 0.125  | 0.140 |           |  |  |
| В   | 0.406  | 0.559       |           | 0.016  | 0.022 |           |  |  |
| B1  | 1.016  | 1.651       | Typical   | 0.040  | 0.065 | Typical   |  |  |
| B2  | 0.762  | 1.016       | 4 places  | 0.030  | 0.040 | 4 places  |  |  |
| В3  | 0.203  | 0.508       | 4 places  | 0.008  | 0.020 | 4 places  |  |  |
| С   | 0.203  | 0.331       | Typical   | 0.008  | 0.013 | Typical   |  |  |
| D   | 34.163 | 35.179      |           | 1.385  | 1.395 |           |  |  |
| D1  | 33.020 | 33.020      | Reference | 1.300  | 1.300 | Reference |  |  |
| Е   | 7.874  | 8.382       |           | 0.310  | 0.330 |           |  |  |
| E1  | 7.112  | 7.493       |           | 0.280  | 0.295 |           |  |  |
| e1  | 2.540  | 2.540       | Typical   | 0.100  | 0.100 | Typical   |  |  |
| eA  | 7.874  | 7.874       | Reference | 0.310  | 0.310 | Reference |  |  |
| eB  | 8.128  | 9.652       |           | 0.320  | 0.380 |           |  |  |
| L   | 3.175  | 3.683       |           | 0.125  | 0.145 |           |  |  |
| N   | 28     | -           |           | 28     | -     |           |  |  |
| S   | 0.584  | 1.220       |           | 0.023  | 0.048 |           |  |  |

#### 21.4 <u>28-Lead Plastic Dual In-Line (PDIP) - 600 mil</u>



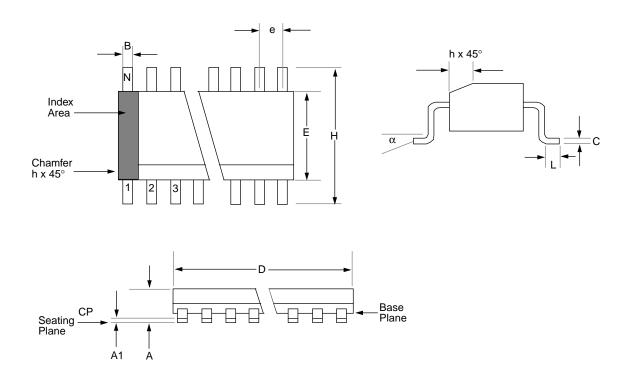
|        | Package Group: Plastic Dual In-Line (PLA) |             |           |       |       |           |  |  |  |
|--------|---|-------------|-----------|-------|-------|-----------|--|--|--|
|        |   | Millimeters |           |       |       |           |  |  |  |
| Symbol | Min                                       | Max         | Notes     | Min   | Max   | Notes     |  |  |  |
| α      | 0°  | 10°         |           | 0°    | 10°   |           |  |  |  |
| Α      | _   | 5.080       |           | _     | 0.200 |           |  |  |  |
| A1     | 0.508                                     | _           |           | 0.020 | _     |           |  |  |  |
| A2     | 3.175                                     | 4.064       |           | 0.125 | 0.160 |           |  |  |  |
| В      | 0.355                                     | 0.559       |           | 0.014 | 0.022 |           |  |  |  |
| B1     | 1.270                                     | 1.778       | Typical   | 0.050 | 0.070 | Typical   |  |  |  |
| С      | 0.203                                     | 0.381       | Typical   | 0.008 | 0.015 | Typical   |  |  |  |
| D      | 35.052                                    | 37.084      |           | 1.380 | 1.460 |           |  |  |  |
| D1     | 33.020                                    | 33.020      | Reference | 1.300 | 1.300 | Reference |  |  |  |
| Е      | 15.240                                    | 15.875      |           | 0.600 | 0.625 |           |  |  |  |
| E1     | 12.827                                    | 13.970      |           | 0.505 | 0.550 |           |  |  |  |
| e1     | 2.489                                     | 2.591       | Typical   | 0.098 | 0.102 | Typical   |  |  |  |
| eA     | 15.240                                    | 15.240      | Reference | 0.600 | 0.600 | Reference |  |  |  |
| eB     | 15.240                                    | 17.272      |           | 0.600 | 0.680 |           |  |  |  |
| Ĺ      | 2.921                                     | 3.683       |           | 0.115 | 0.145 |           |  |  |  |
| N      | 28  | 28          |           | 28    | 28    |           |  |  |  |
| S      | 0.889                                     | _           |           | 0.035 | _     |           |  |  |  |
| S1     | 0.508                                     | _           |           | 0.020 | _     |           |  |  |  |

## 21.5 <u>18-Lead Plastic Surface Mount (SOIC) - 300 mil</u>



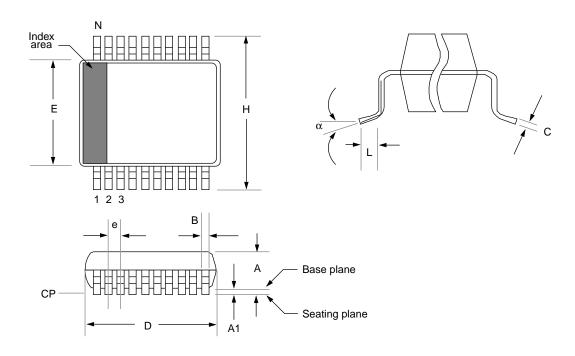
| Package Group: Plastic SOIC (SO) |        |             |           |       |       |           |
|----------------------------------|--------|-------------|-----------|-------|-------|-----------|
|                                  |        | Millimeters |           |       |       |           |
| Symbol                           | Min    | Max         | Notes     | Min   | Max   | Notes     |
| α                                | 0°     | 8°          |           | 0°    | 8°    |           |
| Α                                | 2.362  | 2.642       |           | 0.093 | 0.104 |           |
| A1                               | 0.101  | 0.300       |           | 0.004 | 0.012 |           |
| В                                | 0.355  | 0.483       |           | 0.014 | 0.019 |           |
| С                                | 0.241  | 0.318       |           | 0.009 | 0.013 |           |
| D                                | 11.353 | 11.735      |           | 0.447 | 0.462 |           |
| Е                                | 7.416  | 7.595       |           | 0.292 | 0.299 |           |
| е                                | 1.270  | 1.270       | Reference | 0.050 | 0.050 | Reference |
| Н                                | 10.007 | 10.643      |           | 0.394 | 0.419 |           |
| h                                | 0.381  | 0.762       |           | 0.015 | 0.030 |           |
| L                                | 0.406  | 1.143       |           | 0.016 | 0.045 |           |
| N                                | 18     | 18          |           | 18    | 18    |           |
| CP                               | _      | 0.102       |           | _     | 0.004 |           |

## 21.6 <u>28-Lead Plastic Surface Mount (SOIC) - 300 mil</u>



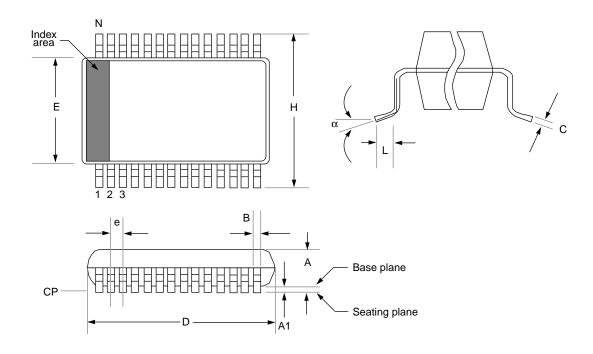
|        | Package Group: Plastic SOIC (SO) |             |         |        |       |         |  |
|--------|----------------------------------|-------------|---------|--------|-------|---------|--|
|        |                                  | Millimeters |         | Inches |       |         |  |
| Symbol | Min                              | Max         | Notes   | Min    | Max   | Notes   |  |
| α      | 0°                               | 8°          |         | 0°     | 8°    |         |  |
| Α      | 2.362                            | 2.642       |         | 0.093  | 0.104 |         |  |
| A1     | 0.101                            | 0.300       |         | 0.004  | 0.012 |         |  |
| В      | 0.355                            | 0.483       |         | 0.014  | 0.019 |         |  |
| С      | 0.241                            | 0.318       |         | 0.009  | 0.013 |         |  |
| D      | 17.703                           | 18.085      |         | 0.697  | 0.712 |         |  |
| Е      | 7.416                            | 7.595       |         | 0.292  | 0.299 |         |  |
| е      | 1.270                            | 1.270       | Typical | 0.050  | 0.050 | Typical |  |
| Н      | 10.007                           | 10.643      |         | 0.394  | 0.419 |         |  |
| h      | 0.381                            | 0.762       |         | 0.015  | 0.030 |         |  |
| L      | 0.406                            | 1.143       |         | 0.016  | 0.045 |         |  |
| N      | 28                               | 28          |         | 28     | 28    |         |  |
| СР     | _                                | 0.102       |         | _      | 0.004 |         |  |

## 21.7 <u>20-Lead Plastic Surface Mount (SSOP) - 209 mil</u>



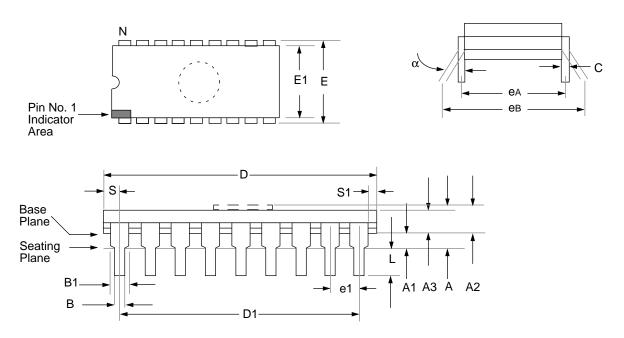
|        | Package Group: Plastic SSOP |             |           |       |       |           |  |
|--------|-----------------------------|-------------|-----------|-------|-------|-----------|--|
|        |                             | Millimeters |           |       |       |           |  |
| Symbol | Min                         | Max         | Notes     | Min   | Max   | Notes     |  |
| α      | 0°                          | 8°          |           | 0°    | 8°    |           |  |
| Α      | 1.730                       | 1.990       |           | 0.068 | 0.078 |           |  |
| A1     | 0.050                       | 0.210       |           | 0.002 | 0.008 |           |  |
| В      | 0.250                       | 0.380       |           | 0.010 | 0.015 |           |  |
| С      | 0.130                       | 0.220       |           | 0.005 | 0.009 |           |  |
| D      | 7.070                       | 7.330       |           | 0.278 | 0.289 |           |  |
| Е      | 5.200                       | 5.380       |           | 0.205 | 0.212 |           |  |
| е      | 0.650                       | 0.650       | Reference | 0.026 | 0.026 | Reference |  |
| Н      | 7.650                       | 7.900       |           | 0.301 | 0.311 |           |  |
| L      | 0.550                       | 0.950       |           | 0.022 | 0.037 |           |  |
| N      | 20                          | 20          |           | 20    | 20    |           |  |
| CP     | -                           | 0.102       |           | -     | 0.004 |           |  |

#### 21.8 <u>28-Lead Plastic Surface Mount (SSOP) - 209 mil</u>



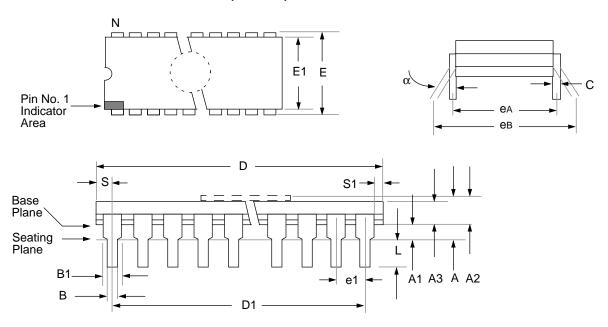
|        | Package Group: Plastic SSOP |             |           |       |       |           |  |
|--------|-----------------------------|-------------|-----------|-------|-------|-----------|--|
|        |                             | Millimeters |           |       |       |           |  |
| Symbol | Min                         | Max         | Notes     | Min   | Max   | Notes     |  |
| α      | 0°                          | 8°          |           | 0°    | 8°    |           |  |
| Α      | 1.730                       | 1.990       |           | 0.068 | 0.078 |           |  |
| A1     | 0.050                       | 0.210       |           | 0.002 | 0.008 |           |  |
| В      | 0.250                       | 0.380       |           | 0.010 | 0.015 |           |  |
| С      | 0.130                       | 0.220       |           | 0.005 | 0.009 |           |  |
| D      | 10.070                      | 10.330      |           | 0.396 | 0.407 |           |  |
| E      | 5.200                       | 5.380       |           | 0.205 | 0.212 |           |  |
| е      | 0.650                       | 0.650       | Reference | 0.026 | 0.026 | Reference |  |
| Н      | 7.650                       | 7.900       |           | 0.301 | 0.311 |           |  |
| L      | 0.550                       | 0.950       |           | 0.022 | 0.037 |           |  |
| N      | 28                          | 28          |           | 28    | 28    |           |  |
| СР     | -                           | 0.102       |           | -     | 0.004 |           |  |

## 21.9 <u>18-Lead Ceramic Dual In-Line (CERDIP) with Window - 300 mil</u>



| Package Group: Ceramic Dual In-Line (CDP) |        |             |           |       |        |           |
|---|--------|-------------|-----------|-------|--------|-----------|
|   |        | Millimeters |           |       | Inches |           |
| Symbol                                    | Min    | Max         | Notes     | Min   | Max    | Notes     |
| α   | 0°     | 10°         |           | 0°    | 10°    |           |
| Α   | _      | 5.080       |           | _     | 0.200  |           |
| A1  | 0.381  | 1.7780      |           | 0.015 | 0.070  |           |
| A2  | 3.810  | 4.699       |           | 0.150 | 0.185  |           |
| A3  | 3.810  | 4.445       |           | 0.150 | 0.175  |           |
| В   | 0.355  | 0.585       |           | 0.014 | 0.023  |           |
| B1  | 1.270  | 1.651       | Typical   | 0.050 | 0.065  | Typical   |
| С   | 0.203  | 0.381       | Typical   | 0.008 | 0.015  | Typical   |
| D   | 22.352 | 23.622      |           | 0.880 | 0.930  |           |
| D1  | 20.320 | 20.320      | Reference | 0.800 | 0.800  | Reference |
| E   | 7.620  | 8.382       |           | 0.300 | 0.330  |           |
| E1  | 5.588  | 7.874       |           | 0.220 | 0.310  |           |
| e1  | 2.540  | 2.540       | Reference | 0.100 | 0.100  | Reference |
| eA  | 7.366  | 8.128       | Typical   | 0.290 | 0.320  | Typical   |
| eВ  | 7.620  | 10.160      |           | 0.300 | 0.400  |           |
| L   | 3.175  | 3.810       |           | 0.125 | 0.150  |           |
| N   | 18     | 18          |           | 18    | 18     |           |
| S   | 0.508  | 1.397       |           | 0.020 | 0.055  |           |
| S1  | 0.381  | 1.270       |           | 0.015 | 0.050  |           |

#### 21.10 28-Lead Ceramic Dual In-Line (CERDIP) with Window - 600 mil



| Package Group: Ceramic Dual In-Line (CDP) |        |             |           |       |       |           |
|---|--------|-------------|-----------|-------|-------|-----------|
|   |        | Millimeters |           |       |       |           |
| Symbol                                    | Min    | Max         | Notes     | Min   | Max   | Notes     |
| α   | 0°     | 10°         |           | 0°    | 10°   |           |
| Α   | _      | 5.461       |           | _     | 0.215 |           |
| A1  | 0.381  | 1.524       |           | 0.015 | 0.060 |           |
| A2  | 3.810  | 4.699       |           | 0.150 | 0.185 |           |
| A3  | 3.810  | 4.445       |           | 0.150 | 0.175 |           |
| В   | 0.355  | 0.585       |           | 0.014 | 0.023 |           |
| B1  | 1.270  | 1.651       | Typical   | 0.050 | 0.065 | Typical   |
| С   | 0.203  | 0.381       | Typical   | 0.008 | 0.015 | Typical   |
| D   | 36.195 | 37.465      |           | 1.425 | 1.475 |           |
| D1  | 33.020 | 33.020      | Reference | 1.300 | 1.300 | Reference |
| Е   | 15.240 | 15.875      |           | 0.600 | 0.625 |           |
| E1  | 12.954 | 15.240      |           | 0.510 | 0.600 |           |
| e1  | 2.540  | 2.540       | Typical   | 0.100 | 0.100 | Typical   |
| eA  | 14.986 | 15.748      | Reference | 0.590 | 0.620 | Reference |
| eB  | 15.240 | 18.034      |           | 0.600 | 0.710 |           |
| L   | 3.175  | 3.810       |           | 0.125 | 0.150 |           |
| N   | 28     | 28          |           | 28    | 28    |           |
| S   | 1.016  | 2.286       |           | 0.040 | 0.090 |           |
| S1  | 0.381  | 1.778       |           | 0.015 | 0.070 |           |

#### **APPENDIX A: COMPATIBILITY**

To convert code written for PIC16CXX to PIC16C5X, the user should take the following steps:

- Check any CALL, GOTO or instructions that modify the PC to determine if any program memory page select operations (PA2, PA1, PA0 bits) need to be made.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- Eliminate any special function register page switching. Redefine data variables to reallocate them
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to proper value for processor used.
- Remove any use of the ADDLW and SUBLW instructions.
- 7. Rewrite any code segments that use interrupts.

**NOTES:** 

| INDEX  | ICEPIC Low-Cost PIC16CXXX In-Circuit Emulator   |        |
|--|---|--------|
| ٨  | ID Locations                                    | ,      |
| A  | INDF  |        |
| Absolute Maximum   | INDF Register                                   |        |
| Ratings 59, 67, 89, 103, 117, 131, 145, 171                                    | Indirect Data Addressing                        |        |
| ALU9   | Instruction Cycle                               |        |
| Applications5  | Instruction Flow/Pipelining                     |        |
| Architectural Overview9  | Instruction Set Summary                         | 4      |
| Assembler MPASM Assembler56  | K   |        |
| MPASIM ASSEMBLEI56   | KEELOQ® Evaluation and Programming Tools        | 57     |
| В  | TREEZE Z Z Valdation and T rogramming Toolo     |        |
| Block Diagram  | L   |        |
| On-Chip Reset Circuit36  | Loading of PC                                   | 22, 23 |
| PIC16C5X Series10  | M   |        |
| Timer027   | M   |        |
| TMR0/WDT Prescaler30   | MCLR  |        |
| Watchdog Timer40   | Memory Map                                      |        |
| Brown-Out Protection Circuit41   | PIC16C52  |        |
| •  | PIC16C54s/CR54s/C55s                            |        |
| C  | PIC16C56s/CR56s                                 |        |
| Carry bit9   | PIC16C57s/CR57s/C58s                            |        |
| Clocking Scheme13  | Memory Organization                             |        |
| Code Protection31, 42  | Data Memory                                     |        |
| Configuration Bits31   | Program Memory                                  |        |
| Configuration Word31   | MP-DriveWay™ - Application Code Generator       |        |
| PIC16C52/C54/C54A/C55/C56/C57/C58A32   | MPLAB™ C  | 57     |
| PIC16CR54A/C54B/CR54B/C56A/CR56A/  | MPLAB™ Integrated Development                   |        |
| CR57B/C58B/CR58A/CR58B31   | Environment Software                            | 5      |
| D  | 0   |        |
| _  | One-Time-Programmable (OTP) Devices             | -      |
| DC and AC Characteristics - PIC16C54/55/56/5781                                | OPTION  |        |
| DC and AC Characteristics -  | OPTION Register                                 |        |
| PIC16C54A/CR57B/C58A/CR58A   | OSC selection                                   |        |
| DC and AC Characteristics -  | Oscillator Configurations                       |        |
| PIC16C54B/CR54B/CS6A/CR56A/C58B/CR58B  | Oscillator Types                                |        |
|  | HS  | 33     |
| 60, 61, 69, 70, 71, 72, 73, 91, 105, 119, 133, 147, 173<br>Development Support | LP  |        |
| Development Tools  | RC  |        |
| Device Varieties   | XT  |        |
| Digit Carry bit9   |   |        |
| bigit duriy bit  | Р   |        |
| E  | Package Marking Information                     | 193    |
| Electrical Characteristics   | Packaging Information                           | 193    |
| PIC16C5259   | PC  | 22     |
| PIC16C54/55/56/5767  | PCL   |        |
| PIC16C54A103   | PIC16C54/55/56/57 Product Identification System |        |
| PIC16C54B/CR54B/C56A/CR56A/C58B/CR58B 171                                      | PIC16C5X Product Identification System          | 215    |
| PIC16C58A131   | PICDEM-1 Low-Cost PIC16/17 Demo Board           |        |
| PIC16CR54A89   | PICDEM-2 Low-Cost PIC16CXX Demo Board           |        |
| PIC16CR57B117  | PICDEM-3 Low-Cost PIC16CXXX Demo Board          |        |
| PIC16CR58A145  | PICMASTER® In-Circuit Emulator                  |        |
| External Power-On Reset Circuit37  | PICSTART® Plus Entry Level Development System   |        |
| F  | Pin Configurations                              | 2      |
|  | Pinout Description - PIC16C52s, PIC16C54s,      |        |
| Family of Devices  | PIC16CR54s, PIC16C56s, PIC16CR56s,              |        |
| PIC16C5X6  | PIC16C58s, PIC16CR58s                           | 1      |
| Features1  | Pinout Description - PIC16C55s, PIC16C57s,      |        |
| FSR  | PIC16CR57s                                      | 12     |
| FSR Register   | POR   | 04 6   |
| Fuzzy Logic Dev. System (fuzzyTECH®-MP)57                                      | Device Reset Timer (DRT)                        |        |
| 1  | PD  |        |
| - I/O Interfereing   | Power-On Reset (POR)31,                         |        |
| I/O Interfacing  | TO<br>PORTA                                     | ,      |
| I/O Programming Considerations 25  |   | 25, 36 |

| PORTC   |          | LIST OF EX   | XAMPLES                                  |
|---|----------|--------------|--|
| Power-Down Mode (SLEEP)                       |          | Example 3-1: | Instruction Pipeline Flow                |
| Prescaler                                     |          |              | Indirect Addressing                      |
| PRO MATE® II Universal Programmer             |          |              | How To Clear RAM Using Indirect          |
| Program Counter                               | 22       | Example 4 2. | Addressing                               |
| Q   |          | Example 5-1: | Read-Modify-Write Instructions on an     |
|   | 40       |              | I/O Port                                 |
| Q cycles                                      |          | Example 6-1: | Changing Prescaler (Timer0→WDT) 30       |
| Quick-Turnaround-Production (QTP) Devices     | /        |              | Changing Prescaler (WDT→Timer0) 30       |
| R   |          |              |  |
| RC Oscillator                                 | 34       | LIST OF FI   | GURES                                    |
| Read Only Memory (ROM) Devices                | -        | Figure 3-1:  | PIC16C5X Series Block Diagram10          |
| Read-Modify-Write                             |          | Figure 3-2:  | Clock/Instruction Cycle                  |
| Register File Map                             | 20       | Figure 4-1:  | PIC16C52 Program Memory Map              |
| PIC16C52, PIC16C54s, PIC16CR54s,              |          | •            | and Stack                                |
| PIC16C55s, PIC16C56s, PIC16CR56s              | 17       | Figure 4-2:  | PIC16C54s/CR54s/C55s                     |
| PIC16C57s/CR57s                               |          |              | Program Memory Map and Stack 15          |
| PIC16C58s/CR58s                               |          | Figure 4-3:  | PIC16C56s/CR56s Program Memory           |
| Registers                                     | _        |              | Map and Stack 15                         |
| Special Function                              | 19       | Figure 4-4:  | PIC16C57s/CR57s/C58s/CR58s               |
| Reset   |          |              | Program Memory Map and Stack 16          |
| Reset on Brown-Out                            | •        | Figure 4-5:  | PIC16C52, PIC16C54s, PIC16CR54s,         |
| •   |          |              | PIC16C55s, PIC16C56s, PIC16CR56s         |
| S   |          |              | Register File Map 17                     |
| SEEVAL® Evaluation and Programming System     | 57       | Figure 4-6:  | PIC16C57s/CR57s Register File Map 18     |
| Serialized Quick-Turnaround-Production (SQTP) |          | Figure 4-7:  | PIC16C58s/CR58s Register File Map 18     |
| Devices                                       | 7        | Figure 4-8:  | STATUS Register (Address:03h) 20         |
| SLEEP   |          | Figure 4-9:  | OPTION Register21                        |
| Software Simulator (MPLAB™ SIM)               |          | Figure 4-10: | Loading of PC Branch Instructions -      |
| Special Features of the CPU                   |          |              | PIC16C52, PIC16C54s, PIC16CR54s,         |
| Special Function Registers                    | 19       |              | PIC16C55s                                |
| Stack   | 23       | Figure 4-11: | Loading of PC Branch Instructions -      |
| STATUS  |          | =            | PIC16C56s/PIC16CR56s                     |
| STATUS Register                               | 9, 20    | Figure 4-12: | Loading of PC Branch Instructions -      |
| Т   |          |              | PIC16C57s/PIC16CR57s, and                |
|   |          | Figure 4.40. | PIC16C58s/PIC16CR58s                     |
| Timer0  | 20       | Figure 4-13: | Direct/Indirect Addressing               |
| Switching Prescaler Assignment                |          | Figure 5-1:  | Equivalent Circuit                       |
| Timer0 (TMR0) Module TMR0 with External Clock |          | Figure 5-2:  | for a Single I/O Pin                     |
| Timing Diagrams and                           | 29       | Figure 5-2.  | Successive I/O Operation                 |
| Specifications                                | 153 178  | Figure 6-2:  | Electrical Structure of TOCKI Pin        |
| Timing Parameter Symbology and                | 155, 176 | Figure 6-3:  | Timer0 Timing: Internal Clock/           |
| Load Conditions                               | 152 177  | riguic 0 5.  | No Prescale                              |
| TMR0  |          | Figure 6-4:  | Timer0 Timing: Internal Clock/           |
| TRIS  |          | riguic o 4.  | Prescale 1:2                             |
| TRIS Registers                                |          | Figure 6-5:  | Timer0 Timing With External Clock        |
| <b>G</b>                                      | 20       | Figure 6-6:  | Block Diagram of the Timer0/WDT          |
| U   |          | r iguio o o. | Prescaler                                |
| UV Erasable Devices                           | 7        | Figure 7-1:  | Configuration Word for                   |
|   |          | ga           | PIC16CR54A/C54B/CR54B/C56A/              |
| W   |          |              | CR56A/CR57B/C58B/CR58A/CR58B 31          |
| W   | 36       | Figure 7-2:  | Configuration Word for                   |
| Wake-up from SLEEP                            | 42       | 9            | PIC16C52/C54/C54A/C55/C56/               |
| Watchdog Timer (WDT)                          |          |              | C57/C58A32                               |
| Period  | 39       | Figure 7-3:  | Crystal Operation (or Ceramic Resonator) |
| Programming Considerations                    | 39       | ŭ            | (HS, XT or LP OSC Configuration)         |
| Z   |          | Figure 7-4:  | External Clock Input Operation           |
|   |          | •            | (HS, XT or LP OSC Configuration)         |
| Zero bit                                      | 9        | Figure 7-5:  | External Parallel Resonant Crystal       |
|   |          |              | Oscillator Circuit (using XT, HS or      |
|   |          |              | LP oscillator mode)34                    |
|   |          | Figure 7-6:  | External Series Resonant Crystal         |
|   |          |              | Oscillator Circuit (using XT, HS or      |
|   |          |              | LP oscillator mode)                      |
|   |          | Figure 7-7:  | RC Oscillator Mode                       |

| Figure 7-8:    | Simplified Block Diagram of On-Chip Reset Circuit | 26  | Figure 12-19: | Transconductance (gm) of XT Oscillator vs. VDD8  |
|----------------|---|-----|---------------|--|
| F: 7.0:        |   | 30  | F: 40 00:     |  |
| Figure 7-9:    | External Power-On Reset Circuit                   | 07  |               | IOH vs. VOH, VDD = 5 V8  |
|                | (For Slow VDD Power-Up)                           | 37  | Figure 12-21: |  |
| Figure 7-10:   | Time-Out Sequence on Power-Up                     |     | Figure 12-22: | The state of the s |
|                | (MCLR Not Tied to VDD)                            | 38  | Figure 13-1:  | Load Conditions9   |
| Figure 7-11:   | Time-Out Sequence on Power-Up                     |     | Figure 13-2:  | External Clock Timing - PIC16CR54A9  |
|                | (MCLR Tied to VDD): Fast VDD                      |     | Figure 13-3:  | CLKOUT and I/O Timing - PIC16CR54A9  |
|                | Rise Time   | 38  | Figure 13-4:  | Reset, Watchdog Timer, and Device  |
| Figure 7-12:   | Time-Out Sequence on Power-Up                     |     | 9             | Reset Timer Timing - PIC16CR54A 10   |
|                | (MCLR Tied to VDD): Slow VDD                      |     | Figure 13-5:  | Timer0 Clock Timings - PIC16CR54A 10   |
|                | Rise Time   | 38  | Figure 14-1:  | Load Conditions - PIC16C54A 11   |
| Figuro 7 12:   | Watchdog Timer Block Diagram                      |     | •             |  |
| Figure 7-13:   |   |     | Figure 14-2:  | External Clock Timing - PIC16C54A 11   |
| Figure 7-14:   | Brown-Out Protection Circuit 1                    |     | Figure 14-3:  | CLKOUT and I/O Timing - PIC16C54A 11   |
| Figure 7-15:   | Brown-Out Protection Circuit 2                    |     | Figure 14-4:  | Reset, Watchdog Timer, and   |
| Figure 8-1:    | General Format for Instructions                   | 43  |               | Device Reset Timer Timing -  |
| Figure 10-1:   | Load Conditions - PIC16C52                        | 62  |               | PIC16C54A 11   |
| Figure 10-2:   | External Clock Timing - PIC16C52                  | 63  | Figure 14-5:  | Timer0 Clock Timings - PIC16C54A 11  |
| Figure 10-3:   | CLKOUT and I/O Timing - PIC16C52                  | 64  | Figure 15-1:  | Load Conditions 12   |
| Figure 10-4:   | Reset and Device Reset Timer Timing -             |     | Figure 15-2:  | External Clock Timing - PIC16CR57B 12  |
|                | PIC16C52  | 65  | Figure 15-3:  | CLKOUT and I/O Timing -  |
| Figure 10-5:   | Timer0 Clock Timings - PIC16C52                   |     | riguio 10 o.  | PIC16CR57B12   |
| •              | g .   |     | Figure 45 4.  |  |
| Figure 11-1:   | Load Conditions - PIC16C54/55/56/57               | 74  | Figure 15-4:  | Reset, Watchdog Timer, and Device  |
| Figure 11-2:   | External Clock Timing -                           |     |               | Reset Timer Timing - PIC16CR57B 12   |
|                | PIC16C54/55/56/57                                 | 75  | Figure 15-5:  | Timer0 Clock Timings - PIC16CR57B 12   |
| Figure 11-3:   | CLKOUT and I/O Timing -                           |     | Figure 16-1:  | Load Conditions - PIC16C58A,   |
|                | PIC16C54/55/56/57                                 | 77  |               | PIC16LV58A13   |
| Figure 11-4:   | Reset, Watchdog Timer, and                        |     | Figure 16-2:  | External Clock Timing - PIC16C58A 13   |
|                | Device Reset Timer Timing -                       |     | Figure 16-3:  | CLKOUT and I/O Timing - PIC16C58A 14   |
|                | PIC16C54/55/56/57                                 | 78  | Figure 16-4:  | Reset, Watchdog Timer, and   |
| Figure 11-5:   | Timer0 Clock Timings -                            |     | 9             | Device Reset Timer Timing -  |
| rigaro i i o.  | PIC16C54/55/56/57                                 | 70  |               | PIC16C58A14  |
| Figure 10.1.   |   | 13  | Ciaura 16 Fr  |  |
| Figure 12-1:   | Typical RC Oscillator Frequency vs.               | 04  | Figure 16-5:  | Timer0 Clock Timings - PIC16C58A 14  |
|                | Temperature                                       | 81  | Figure 17-1:  | Load Conditions - PIC16CR58A   |
| Figure 12-2:   | Typical RC Oscillator Frequency vs.               |     | Figure 17-2:  | External Clock Timing - PIC16CR58A 15  |
|                | VDD, CEXT = 20 PF                                 | 82  | Figure 17-3:  | CLKOUT and I/O Timing -  |
| Figure 12-3:   | Typical RC Oscillator Frequency vs.               |     |               | PIC16CR58A15   |
|                | VDD, CEXT = 100 PF                                | 82  | Figure 17-4:  | Reset, Watchdog Timer, and   |
| Figure 12-4:   | Typical RC Oscillator Frequency vs.               |     |               | Device Reset Timer Timing -  |
| Ü              | VDD, CEXT = 300 PF                                | 82  |               | PIC16CR58A15   |
| Figure 12-5:   | Typical IPD vs. VDD, Watchdog Disabled            |     | Figure 17-5:  | Timer0 Clock Timings - PIC16CR58A 15   |
| Figure 12-6:   | Maximum IPD vs. VDD,                              | 00  | Figure 18-1:  | Typical RC Oscillator Frequency vs.  |
| i iguic 12 o.  | Watchdog Disabled                                 | 83  | riguio io i.  | Temperature  |
| C: 01.00 10 7. | =   |     | Figure 10 Or  |  |
| Figure 12-7:   | Typical IPD vs. VDD, Watchdog Enabled             | 03  | Figure 18-2:  | Typical RC Oscillator Frequency vs.  |
| Figure 12-8:   | Maximum IPD vs. VDD,                              |     |               | VDD, CEXT = 20 PF  |
|                | Watchdog Enabled                                  | 83  | Figure 18-3:  | Typical RC Oscillator Frequency vs.  |
| Figure 12-9:   | VTH (Input Threshold Voltage) of                  |     |               | VDD, CEXT = 100 PF   |
|                | I/O Pins vs. VDD                                  | 84  | Figure 18-4:  | Typical RC Oscillator Frequency vs.  |
| Figure 12-10:  | VIH, VIL of MCLR, TOCKI and OSC1                  |     |               | VDD, CEXT = 300 PF 16  |
| •              | (in RC Mode) vs. VDD                              | 84  | Figure 18-5:  | Typical IPD vs. VDD, Watchdog  |
| Figure 12-11   | VTH (Input Threshold Voltage) of                  |     | 9             | Disabled (25°C)  |
| ga.o .z        | OSC1 Input (in XT, HS, and LP modes)              |     | Figure 18-6:  | Typical IPD vs. VDD, Watchdog  |
|                | vs. VDD   | 0.4 | riguic 10-0.  | Enabled (25°C)   |
| Fig 40 40.     |   | 04  | F: 40 7:      | ` ,  |
| Figure 12-12:  | Typical IDD vs. Frequency                         | 0.5 | Figure 18-7:  | VTH (Input Threshold Voltage) of   |
|                | (External Clock, 25°C)                            | 85  |               | I/O Pins vs. VDD   |
| Figure 12-13:  | Maximum IDD vs. Frequency                         |     | Figure 18-8:  | VIH, VIL of MCLR, TOCKI and OSC1   |
|                | (External Clock, -40°C to +85°C)                  | 85  |               | (in RC Mode) vs. VDD   |
| Figure 12-14:  | Maximum IDD vs. Frequency                         |     | Figure 18-9:  | Vтн (Input Threshold Voltage) of   |
|                | (External Clock -55°C to +125°C)                  | 86  |               | OSC1 Input (in XT, HS, and LP modes)   |
| Figure 12-15:  | WDT Timer Time-out Period vs. VDD                 |     |               | vs. VDD  |
|                | Transconductance (gm) of                          |     | Figure 18-10: | Typical IDD vs. Frequency  |
| g 10.          | HS Oscillator vs. VDD                             | 86  |               | (WDT dis, RC Mode @ 20 pF, 25°C) 16  |
| Figure 12 17   | Transconductance (gm) of                          | 00  | Figure 19 11. | Maximum IDD vs. Frequency  |
| i igule 12-17. | , <del>,</del>                                    | 97  | rigule 10-11. |  |
| Fig. 40 40     | LP Oscillator vs. VDD                             |     |               | (WDT Dis, RC Mode @ 20 PF,   |
| rigure 12-18:  | IOH vs. VOH, VDD = 3 V                            | 87  |               | -40°C to +85°C)  |

| Figure 18-12: | Typical IDD vs. Frequency                       |     | LIST OF TA  | ABLES  |
|---------------|---|-----|-------------|--|
|               | (WDT Dis, RC Mode @ 100 PF, 25°C) 1             | 65  | Table 1-1:  | PIC16C5X Family of Devices 6                           |
| Figure 18-13: | Maximum IDD vs. Frequency                       |     | Table 3-1:  | Pinout Description - PIC16C52,                         |
|               | (WDT Dis, RC Mode @ 100 PF,                     | 0.5 |             | PIC16C54s, PIC16CR54s, PIC16C56s,                      |
| E' 40 44      | -40°C to +85°C)                                 | 65  |             | PIC16CR56s, PIC16C58s, PIC16CR58s 11                   |
| Figure 18-14: | Typical IDD vs. Frequency                       | 00  | Table 3-2:  | Pinout Description - PIC16C55s,                        |
| Figure 10 15. | (WDT Dis, RC Mode @ 300 PF, 25°C) 1             | 66  |             | PIC16C57s, PIC16CR57s12                                |
| rigure 16-15. | Maximum IDD vs. Frequency                       |     | Table 4-1:  | Special Function Register Summary 19                   |
|               | (WDT Dis, RC Mode @ 300 PF,                     | 66  | Table 5-1:  | Summary of Port Registers25                            |
| Eiguro 10 16: | -40°C to +85°C)                                 |     | Table 6-1:  | Registers Associated With Timer0 28                    |
| •             |   | 07  | Table 7-1:  | Capacitor Selection                                    |
| rigure 16-17: | Transconductance (gm) of HS Oscillator vs. VDD1 | 60  |             | For Ceramic Resonators - PIC16C5X,                     |
| Eiguro 19 19: | Transconductance (gm) of                        | 00  |             | PIC16CR5X  |
| rigule 10-10. | LP Oscillator vs. VDD1                          | 69  | Table 7-2:  | Capacitor Selection For Crystal                        |
| Figure 19 10: | Transconductance (gm) of                        | 00  |             | Oscillator - PIC16C5X, PIC16CR5X                       |
| rigule 10-19. | XT Oscillator vs. VDD1                          | 69  | Table 7-3:  | Reset Conditions for Special Registers 36              |
| Figure 19 20: | IOH vs. VOH, VDD = 3 V                          |     | Table 7-4:  | Reset Conditions for All Registers36                   |
|               | IOH vs. VOH, VDD = 5 V                          |     | Table 7-5:  | Summary of Registers Associated                        |
|               | IOL vs. VOL, VDD = 3 V                          |     |             | with the Watchdog Timer40                              |
| -             | IOL vs. VOL, VDD = 5 V                          |     | Table 7-6:  | TO/PD Status After Reset 41                            |
| Figure 19-1:  | Load Conditions -                               | 09  | Table 7-7:  | Events Affecting TO/PD Status Bits 41                  |
| riguic 15-1.  | PIC16C54B/CR54B/C56A/CR56A/                     |     | Table 8-1:  | OPCODE Field Descriptions 43                           |
|               | C58B/CR58B, PIC16CR5X1                          | 77  | Table 8-2:  | Instruction Set Summary 44                             |
| Figure 19-2:  | External Clock Timing -                         | , , | Table 9-1:  | Development Tools From Microchip 58                    |
| riguic 13-2.  | PIC16C5X, PIC16CR5X1                            | 78  | Table 10-1: | External Clock Timing Requirements -                   |
| Figure 19-3:  | CLKOUT and I/O Timing -                         | 70  |             | PIC16C5263   |
| riguic 15 5.  | PIC16C5X, PIC16CR5X1                            | 80  | Table 10-2: | CLKOUT and I/O Timing Requirements -                   |
| Figure 19-4:  | Reset, Watchdog Timer, and                      | 00  |             | PIC16C5264   |
| riguic 15 4.  | Device Reset Timer Timing -                     |     | Table 10-3: | Reset and Device Reset Timer -                         |
|               | PIC16C5X, PIC16CR5X1                            | 81  |             | PIC16C5265   |
| Figure 19-5:  | Timer0 Clock Timings -                          | 01  | Table 10-4: | Timer0 Clock Requirements -                            |
| riguio 10 o.  | PIC16C5X, PIC16CR5X                             | 82  |             | PIC16C52   |
| Figure 20-1:  | Typical RC Oscillator Frequency vs.             | 02  | Table 11-1: | Cross Reference of Device Specs for                    |
| ga.o _o       | Temperature                                     | 83  |             | Oscillator Configurations (RC, XT & 10)                |
| Figure 20-2:  | Typical RC Oscillator Frequency vs.             |     |             | and Frequencies of Operation                           |
| 9             | VDD, CEXT = 20 PF                               | 84  | T-1-1- 44 0 | (Commercial Devices)                                   |
| Figure 20-3:  | Typical RC Oscillator Frequency vs.             |     | Table 11-2: | Cross Reference of Device Specs for                    |
| J             | VDD, CEXT = 100 PF1                             | 84  |             | Oscillator Configurations (HS, LP & JW)                |
| Figure 20-4:  | Typical RC Oscillator Frequency vs.             |     |             | and Frequencies of Operation                           |
| · ·           | VDD, CEXT = 300 PF1                             | 85  | Table 11-3: | (Commercial Devices)                                   |
| Figure 20-5:  | Typical IPD vs. VDD, Watchdog                   |     | Table 11-5. | External Clock Timing Requirements - PIC16C54/55/56/57 |
|               | Disabled (25°C) 1                               | 85  | Table 11-4: | CLKOUT and I/O Timing Requirements -                   |
| Figure 20-6:  | Typical IPD vs. VDD, Watchdog                   |     | Table 11-4. | PIC16C54/55/56/5777                                    |
|               | Enabled (25°C) 1                                | 86  | Table 11-5: | Reset, Watchdog Timer, and Device                      |
| Figure 20-7:  | Typical IPD vs. VDD, Watchdog                   |     | Table 11-5. | Reset Timer - PIC16C54/55/56/57                        |
|               | Enabled (-40°C, 85°C)1                          | 86  | Table 11-6: | Timer0 Clock Requirements -                            |
| Figure 20-8:  | Vтн (Input Threshold Trip Point Voltage)        |     | Table 11-0. | PIC16C54/55/56/5779                                    |
|               | of I/O Pins vs. VDD1                            | 87  | Table 12-1: | RC Oscillator Frequencies                              |
| Figure 20-9:  | VIH, VIL of MCLR, TOCKI and OSC1                |     | Table 12-1: | Input Capacitance for PIC16C54/5688                    |
|               | (in RC Mode) vs. VDD1                           | 87  | Table 12-3: | Input Capacitance for PIC16C55/5788                    |
| Figure 20-10: | Vтн (Input Threshold Trip Point Voltage)        |     | Table 13-1: | Cross Reference of Device Specs for                    |
|               | of OSC1 Input (in XT, HS, and LP modes)         |     | Table 10 1. | Oscillator Configurations and Frequencies              |
|               | vs. VDD1  | 88  |             | of Operation (Commercial Devices) 90                   |
| Figure 20-11: | Typical IDD vs. Frequency                       |     | Table 13-2: | External Clock Timing Requirements -                   |
|               | (WDT dis, RC Mode @ 20 PF, 25°C)1               | 88  | 14510 10 2. | PIC16CR54A97   |
| Figure 20-12: | Typical IDD vs. Frequency                       |     | Table 13-3: | CLKOUT and I/O Timing Requirements -                   |
|               | (WDT Dis, RC Mode @ 100 PF, 25°C) 1             | 89  |             | PIC16CR54A   |
| Figure 20-13: | Typical IDD vs. Frequency                       |     | Table 13-4: | Reset, Watchdog Timer, and Device                      |
|               | (WDT Dis, RC Mode @ 300 PF, 25°C) 1             |     |             | Reset Timer - PIC16CR54A                               |
| -             | WDT Timer Time-out Period vs. VDD 1             |     | Table 13-5: | Timer0 Clock Requirements -                            |
| -             | IOH vs. VOH, VDD = 3 V                          |     | -           | PIC16CR54A101  |
| •             | IOH vs. VOH, VDD = 5 V                          |     | Table 14-1: | Cross Reference of Device Specs for                    |
| -             | IOL vs. VOL, VDD = 3 V                          |     |             | Oscillator Configurations and Frequencies              |
| rigure 20-18: | IOL vs. VOL, VDD = 5 V                          | 91  |             | of Operation (Commercial Devices) 104                  |

| Table 14-2: | External Clock Timing Requirements - PIC16C54A111 |
|-------------|---|
| Table 14-3: | CLKOUT and I/O Timing Requirements - PIC16C54A113 |
| Table 14-4: | Reset, Watchdog Timer, and Device                 |
| Table 14-4. | Reset Timer - PIC16C54A114                        |
| Table 14-5: | Timer0 Clock Requirements -                       |
| Table 14-5. |   |
| Table 45 4. | PIC16C54A   |
| Table 15-1: | Cross Reference of Device Specs for               |
|             | Oscillator Configurations and Frequencies         |
|             | of Operation (Commercial Devices)118              |
| Table 15-2: | External Clock Timing Requirements -              |
|             | PIC16CR57B125                                     |
| Table 15-3: | CLKOUT and I/O Timing Requirements -              |
|             | PIC16CR57B127                                     |
| Table 15-4: | Reset, Watchdog Timer, and Device                 |
|             | Reset Timer - PIC16CR57B128                       |
| Table 15-5: | Timer0 Clock Requirements -                       |
|             | PIC16CR57B129                                     |
| Table 16-1: | Cross Reference of Device Specs for               |
|             | Oscillator Configurations and Frequencies         |
|             | of Operation (Commercial Devices) 132             |
| Table 16-2: | External Clock Timing Requirements -              |
|             | PIC16C58A139                                      |
| Table 16-3: | CLKOUT and I/O Timing Requirements -              |
|             | PIC16C58A141                                      |
| Table 16-4: | Reset, Watchdog Timer, and Device                 |
|             | Reset Timer - PIC16C58A142                        |
| Table 16-5: | Timer0 Clock Requirements -                       |
|             | PIC16C58A143                                      |
| Table 17-1: | Cross Reference of Device Specs for               |
| 14510 17 1. | Oscillator Configurations and Frequencies         |
|             | of Operation (Commercial Devices) 146             |
| Table 17-2: | External Clock Timing Requirements -              |
| 14010 17 2. | PIC16CR58A  |
| Table 17-3: | CLKOUT and I/O Timing Requirements -              |
| Table 17-5. | PIC16CR58A155                                     |
| Table 17-4: | Reset, Watchdog Timer, and Device                 |
| Table 17-4. | Reset Timer - PIC16CR58A                          |
| Table 17 F: | Timer0 Clock Requirements -                       |
| Table 17-5: | PIC16CR58A157                                     |
| Table 10 1. |   |
| Table 18-1: | RC Oscillator Frequencies                         |
| Table 18-2: | Input Capacitance for                             |
| T-1-1-404   | PIC16C54A/C58A                                    |
| Table 19-1: | Cross Reference of Device Specs for               |
|             | Oscillator Configurations and Frequencies         |
|             | of Operation (Commercial Devices) 172             |
| Table 19-2: | External Clock Timing Requirements -              |
|             | PIC16C5X, PIC16CR5X178                            |
| Table 19-3: | CLKOUT and I/O Timing Requirements -              |
|             | PIC16C5X, PIC16CR5X180                            |
| Table 19-4: | Reset, Watchdog Timer, and Device                 |
|             | Reset Timer - PIC16C5X, PIC16CR5X 181             |
| Table 19-5: | Timer0 Clock Requirements - PIC16C5X,             |
|             | PIC16CR5X182                                      |
| Table 20-1: | RC Oscillator Frequencies183                      |
| Table 20-2: | Input Capacitance for                             |
|             | PIC16C54s/C58s190                                 |

**NOTES:** 

#### **ON-LINE SUPPORT**

Microchip provides two methods of on-line support. These are the Microchip BBS and the Microchip World Wide Web (WWW) site.

Use Microchip's Bulletin Board Service (BBS) to get current information and help about Microchip products. Microchip provides the BBS communication channel for you to use in extending your technical staff with microcontroller and memory experts.

To provide you with the most responsive service possible, the Microchip systems team monitors the BBS, posts the latest component data and software tool updates, provides technical help and embedded systems insights, and discusses how Microchip products provide project solutions.

The web site, like the BBS, is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape or Microsoft Explorer. Files are also available for FTP download from our FTP site.

#### Connecting to the Microchip Internet Web Site

The Microchip web site is available by using your favorite Internet browser to attach to:

#### www.microchip.com

The file transfer site is available by using an FTP service to connect to:

#### ftp://ftp.futureone.com/pub/microchip

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- Latest Microchip Press Releases
- Technical Support Section with Frequently Asked Questions
- · Design Tips
- · Device Errata
- Job Postings
- Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products

#### Connecting to the Microchip BBS

Connect worldwide to the Microchip BBS using either the Internet or the CompuServe® communications network.

#### Internet:

You can telnet or ftp to the Microchip BBS at the address: mchipbbs.microchip.com

#### **CompuServe Communications Network:**

When using the BBS via the Compuserve Network, in most cases, a local call is your only expense. The Microchip BBS connection does not use CompuServe membership services, therefore you do not need CompuServe membership to join Microchip's BBS. There is no charge for connecting to the Microchip BBS.

The procedure to connect will vary slightly from country to country. Please check with your local CompuServe agent for details if you have a problem. CompuServe service allow multiple users various baud rates depending on the local point of access.

The following connect procedure applies in most locations.

- Set your modem to 8-bit, No parity, and One stop (8N1). This is not the normal CompuServe setting which is 7E1.
- 2. Dial your local CompuServe access number.
- Depress the **<Enter>** key and a garbage string will appear because CompuServe is expecting a 7E1 setting.
- Type +, depress the <Enter> key and "Host Name:" will appear.
- Type MCHIPBBS, depress the **<Enter>** key and you will be connected to the Microchip BBS.

In the United States, to find the CompuServe phone number closest to you, set your modem to 7E1 and dial (800) 848-4480 for 300-2400 baud or (800) 331-7166 for 9600-14400 baud connection. After the system responds with "Host Name:", type NETWORK, depress the **<Enter>** key and follow CompuServe's directions.

For voice information (or calling from overseas), you may call (614) 723-1550 for your local CompuServe number.

Microchip regularly uses the Microchip BBS to distribute technical information, application notes, source code, errata sheets, bug reports, and interim patches for Microchip systems software products. For each SIG, a moderator monitors, scans, and approves or disapproves files submitted to the SIG. No executable files are accepted from the user community in general to limit the spread of computer viruses.

#### Systems Information and Upgrade Hot Line

The Systems Information and Upgrade Line provides system users a listing of the latest versions of all of Microchip's development systems software products. Plus, this line provides information on how customers can receive any currently available upgrade kits. The Hot Line Numbers are:

1-800-755-2345 for U.S. and most of Canada, and 1-602-786-7302 for the rest of the world.

970301

**Trademarks:** The Microchip name, logo, PIC, PICSTART, PICMASTER and PRO MATE are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries. *Flex*ROM, MPLAB and *fuzzy*LAB, are trademarks and SQTP is a service mark of Microchip in the U.S.A.

fuzzyTECH is a registered trademark of Inform Software Corporation. IBM, IBM PC-AT are registered trademarks of International Business Machines Corp. Pentium is a trademark of Intel Corporation. Windows is a trademark and MS-DOS, Microsoft Windows are registered trademarks of Microsoft Corporation. CompuServe is a registered trademark of CompuServe Incorporated.

All other trademarks mentioned herein are the property of their respective companies.

#### **READER RESPONSE**

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (602) 786-7578.

Please list the following information, and use this outline to provide us with your comments about this Data Sheet.

| To:  | Technical Publications Manager   | Total Pages Sent                                 |
|------|--|--|
| RE:  | : Reader Response  |  |
| Fron | om: Name   |  |
|      | Company  |  |
|      |  |  |
|      |  |  |
|      |  | FAX: ()  |
|      | plication (optional):  |  |
| Wo   | ould you like a reply?YN   |  |
| Dev  | vice: PIC16C5X Literature  | Number: DS30453A                                 |
| Que  | estions:   |  |
| 1.   | What are the best features of this document  | ?  |
|      |  |  |
| 2.   | How does this document meet your hardwa  | re and software development needs?               |
|      |  |  |
| 3.   | Do you find the organization of this data she  | et easy to follow? If not, why?                  |
|      | No. 100 control of the control of th |  |
| 4.   | What additions to the data sheet do you thin   | ik would enhance the structure and subject?      |
|      |  |  |
| 5.   | What deletions from the data sheet could be  | e made without affecting the overall usefulness? |
| •    |  |  |
| б.   | Is there any incorrect or misleading information   | ion (what and where)?                            |
| _    |  |  |
| 7.   | How would you improve this document?   |  |
| 0    | How would you improve our coffuers and   | me, and silican products?                        |
| 8.   | How would you improve our software, syste  | ins, and sincon products:                        |
|      |  |  |

#### PIC16C5X PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO.             | <u>-XX</u>                               | <b>X</b><br>T   | <u>/XX</u>  |          | XXX          |
|----------------------|--|---|---|----------|--------------|
| Device               | Frequency<br>Range                       | / Temperature<br>Range  | Packag  | је       | Pattern      |
| Device               | PIC16L0<br>PIC16CI<br>PIC16L0            | 5X <sup>(2)</sup> , PIC16C5X<br>C5X <sup>(2)</sup> , PIC16LC:<br>R5X <sup>(2)</sup> , PIC16CR<br>CR5X <sup>(2)</sup> , PIC16Li<br>V5X <sup>(2)</sup> , PIC16LV5 | 5XT <sup>(3)</sup><br>85XT <sup>(3)</sup><br>CR5XT <sup>(3)</sup> |          |              |
| Frequency<br>Range   | 02<br>04<br>10<br>20<br>b <sup>(1)</sup> | = 2 MHz<br>= 4 MHz<br>= 10 MHz<br>= 20 MHz<br>= No type for JV  | V <sup>(4)</sup> devic  | es       |              |
| Temperature<br>Range | b <sup>(1)</sup><br>I<br>E               | = $0^{\circ}$ C to +7<br>= $-40^{\circ}$ C to +8<br>= $-40^{\circ}$ C to +12  | 5°C (Ind  | dustria  | ıl)          |
| Package              | JW<br>P<br>SO<br>SP<br>SS                | = Windowed CE<br>= PDIP<br>= SOIC (Gull Wi<br>= Skinny PDIP (<br>= SSOP (209 m  | ing, 300 r<br>(28-pin, 30   |          | • /          |
| Pattern              | 3-digit P                                | attern Code for C   | TP. ROM   | 1 (blani | k otherwise) |

#### Examples:

- a) PIC16C54A -04/P 301 = Commercial temp., PDIP package, 4MHz, normal VDD limitis, QTP pattern #301.
- PIC16LC58A 04I/SO = Industrial temp., SOIC package, 4MHz, Extended VDD limits.
- PIC16CR54A 10I/P355 = ROM program memory, Industrial temp., PDIP package, 10MHz, normal VDD limits.

Note 1: b = blank

2: C = Standard VDD range

LC = Extended VDD range

CR = ROM Version, Standard VDD range

LCR = ROM Version, Extended VDD range

LV = Low Voltage VDD range

- 3: T = in tape and reel SOIC, SSOP packages only.
- 4: UV erasable devices are tested to all available voltage/frequency options. Erased devices are oscillator type 04. The user can select 04, 10 or 20 oscillators by programming the appropriate configuration bits.

#### PIC16C54/55/56/57 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information (e.g., on pricing or delivery) refer to the factory or the listed sales office.

| PART NO.             | <u>-XX</u>                                     | <b>X</b>   | <u>/XX</u>                               | XXX       |   |  |   |
|----------------------|--|--|--|-----------|---|--|---|
| Device               | Oscillator<br>Type                             | Temperature<br>Range   | Package                                  | Pattern   |   | Example<br>a) PIC                                | es:<br>:16C54                                     |
| Device               | PIC16C<br>PIC16C                               | 54, PIC16C54T<br>55, PIC16C55T<br>56, PIC16C56T<br>57, PIC16C57T   | (2)<br>(2)                               |           | l | con<br>b) PIC<br>indu                            | nmercia<br>16C55<br>ustrial to<br>16C55<br>RDIP w |
| Oscillator Type      | RC<br>LP<br>XT<br>HS<br>10<br>b <sup>(1)</sup> | = Resistor Capa<br>= Low Power Cr<br>= Standard Crys<br>= High Speed C<br>= 10 MHz Cryst<br>= No type for JV | rystal<br>stal/Resonato<br>rystal<br>al  | r         | C | d) PIC   | RDIP WI<br>16C57<br>rcial ten                     |
| Temperature<br>Range | b <sup>(1)</sup><br>I<br>E                     | = $0^{\circ}$ C to +70<br>= -40°C to +80<br>= -40°C to +120  | 5°C (Industria                           | al)       | 1 | Note 1:<br>2:<br>3:                              | packa   |
| Package              | JW<br>P<br>S<br>SO<br>SP<br>SS                 | = Windowed CE<br>= PDIP<br>= Die in Waffle I<br>= SOIC (Gull W<br>= Skinny PDIP (<br>= SSOP (209 m           | Pack<br>ing, 300 mil b<br>(28 pin, 300 m | • /       |   | availal<br>Erased<br>The us<br>oscilla<br>priate |   |
| Pattern              | 3-digit F                                      | Pattern Code for   | QTP (blank o                             | therwise) |   |  |   |

- XT/PXXX = "XT" oscillator, al temp., PDIP, QTP pattern.
- XTI/SO = "XT" oscillator, emp., SOIC (OTP device)
- /JW = Commercial temp. ith window.
- RC/S = "RC" oscillator, comnp., dice in waffle pack.

ank

- tape and reel SOIC, SSOP ges only.
- asable devices are tested to all ble voltage/frequency options. d devices are oscillator type RC. ser can select RC, LP, XT or HS itors by programming the approconfiguration bits.

#### **Sales and Support**

Products supported by a preliminary Data Sheet may possibly have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. Your local Microchip sales office (see below)
- 2. The Microchip Corporate Literature Center U.S. FAX: (602) 786-7277
- 3. The Microchip's Bulletin Board, via your local CompuServe number (CompuServe membership NOT required).

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

For latest version information and upgrade kits for Microchip Development Tools, please call 1-800-755-2345 or 1-602-786-7302.

| 101 | C        |   |   | V |
|-----|----------|---|---|---|
|     | <b>ט</b> | L | J | Λ |

NOTES:

**NOTES:** 

| D | IC1 | 6         | <b>∩</b> E | V |
|---|-----|-----------|------------|---|
|   |     | <b>יס</b> | しつ         | Λ |

|     |        |   | _          |
|-----|--------|---|------------|
| B I | $\sim$ | _ | <b>C</b> - |
| NI  |        |   | •          |
| . 4 | v      | _ | u.         |

## WORLDWIDE SALES & SERVICE

#### **AMERICAS**

#### **Corporate Office**

Microchip Technology Inc. 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 602-786-7200 Fax: 602-786-7277 Technical Support: 602 786-7627 Web: http://www.microchip.com

#### **Atlanta**

Microchip Technology Inc. 500 Sugar Mill Road, Suite 200B Atlanta, GA 30350 Tel: 770-640-0034 Fax: 770-640-0307

#### **Boston**

Microchip Technology Inc. 5 Mount Royal Avenue Marlborough, MA 01752 Tel: 508-480-9990 Fax: 508-480-8575

Microchip Technology Inc. 333 Pierce Road, Suite 180 Itasca, IL 60143

Tel: 630-285-0071 Fax: 630-285-0075

#### **Dallas**

Microchip Technology Inc. 14651 Dallas Parkway, Suite 816 Dallas, TX 75240-8809 Tel: 972-991-7177 Fax: 972-991-8588

#### Dayton

Microchip Technology Inc. Two Prestige Place, Suite 150 Miamisburg, OH 45342 Tel: 937-291-1654 Fax: 937-291-9175

#### Los Angeles

Microchip Technology Inc. 18201 Von Karman, Suite 1090 Irvine, CA 92612 Tel: 714-263-1888 Fax: 714-263-1338

#### **New York**

Microchip Technology Inc. 150 Motor Parkway, Suite 416 Hauppauge, NY 11788 Tel: 516-273-5305 Fax: 516-273-5335

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

#### Toronto

Microchip Technology Inc. 5925 Airport Road, Suite 200 Mississauga, Ontario L4V 1W1, Canada Tel: 905-405-6279 Fax: 905-405-6253

#### ASIA/PACIFIC

#### **Hong Kong**

Microchip Asia Pacific RM 3801B, Tower Two Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2-401-1200 Fax: 852-2-401-3431

Microchip Technology India No. 6, Legacy, Convent Road Bangalore 560 025, India Tel: 91-80-299-4036 Fax: 91-80-559-9840

#### Korea

Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea

Tel: 82-2-554-7200 Fax: 82-2-558-5934

#### Shanghai

Microchip Technology RM 406 Shanghai Golden Bridge Bldg. 2077 Yan'an Road West, Hongiao District Shanghai, PRC 200335 Tel: 86-21-6275-5700 Fax: 86 21-6275-5060

#### Singapore

Microchip Technology Taiwan Singapore Branch 200 Middle Road #10-03 Prime Centre Singapore 188980 Tel: 65-334-8870 Fax: 65-334-8850

#### Taiwan, R.O.C

Microchip Technology Taiwan 10F-1C 207 Tung Hua North Road Taipei, Taiwan, ROC Tel: 886 2-717-7175 Fax: 886-2-545-0139

#### **EUROPE**

#### **United Kingdom**

Arizona Microchip Technology Ltd. Unit 6, The Courtyard Meadow Bank, Furlong Road Bourne End, Buckinghamshire SL8 5AJ Tel: 44-1628-851077 Fax: 44-1628-850259

Arizona Microchip Technology SARL Zone Industrielle de la Bonde 2 Rue du Buisson aux Fraises 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

#### Germany

Arizona Microchip Technology GmbH Gustav-Heinemann-Ring 125 D-81739 Müchen, Germany Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Arizona Microchip Technology SRL Centro Direzionale Colleone Palazzo Taurus 1 V. Le Colleoni 1 20041 Agrate Brianza Milan Italy Tel: 39-39-6899939 Fax: 39-39-6899883

#### **JAPAN**

Microchip Technology Intl. Inc. Benex S-1 6F 3-18-20, Shin Yokohama Kohoku-Ku, Yokohama Kanagawa 222 Japan Tel: 81-4-5471- 6166 Fax: 81-4-5471-6122

3/24/97



All rights reserved. © 1997, Microchip Technology Incorporated, USA.

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights. The Microchip logo and name are registered trademarks of Microchip Technology Inc. All rights reserved. All other trademarks mentioned herein are the property of their respective companies.